Low-Power, Low-Cost, General Purpose 16-Bit Flash Microcontrollers with nanoWatt XLP Technology

Power Management Modes:

- · Run CPU, Flash, SRAM and Peripherals on
- Doze CPU Clock Runs Slower than Peripherals
- · Idle CPU Off, SRAM and Peripherals on
- Sleep CPU, Flash and Peripherals Off and SRAM on
- · Low-Power Consumption:
 - Run mode currents under 350 µA/MHz at 1.8V
 - Idle mode currents under 80 µA/MHz at 1.8V
 - Sleep mode currents as low as 30 nA at 25°C
 - Watchdog Timer as low as 210 nA at 25°C

High-Performance CPU:

- · Modified Harvard Architecture
- · Up to 16 MIPS Operation @ 32 MHz
- · 8 MHz Internal Oscillator:
 - 4x PLL option
 - Multiple divide options
- 17-Bit x 17-Bit Single-Cycle Hardware Fractional/integer Multiplier
- 32-Bit by 16-Bit Hardware Divider
- 16 x 16-Bit Working Register Array
- C Compiler Optimized Instruction Set Architecture (ISA):
 - 76 base instructions
- Flexible addressing modes
- · Linear Program Memory Addressing
- · Linear Data Memory Addressing
- Two Address Generation Units (AGU) for Separate Read and Write Addressing of Data Memory

Peripheral Features:

- High-Current Sink/Source (18 mA/18 mA) on All I/O Pins
- · Configurable Open-Drain Outputs on Digital I/O Pins
- · Up to Three External Interrupt Sources
- Two 16-Bit Timer/Counters with Selectable Clock Sources
- Up to Two 8-Bit Timers/Counters with Programmable Prescalers
- Two Capture/Compare/PWM (CCP) modules:
 - Modules automatically configure and drive I/O
 - 16-bit Capture with max. resolution 40 ns
 - 16-bit Compare with max. resolution 83.3 ns
 - 1-bit to 10-bit PWM resolution
- · Up to One Enhanced CCP module:
 - Backward compatible with CCP
 - 1, 2 or 4 PWM outputs
 - Programmable dead time
 - Auto-shutdown on external event
- Up to Two Master Synchronous Serial Port modules (MSSPs) with Two Modes of Operation:
 - 3-wire SPI (all four modes)
 - I²C[™] Master, Multi-Master and Slave modes and 7-Bit/10-Bit Addressing
- · Up to Two UART modules:
 - Supports RS-485, RS-232 and LIN/J2602
 - On-chip hardware encoder/decoder for IrDA®
 - Auto-wake-up on Start bit
 - Auto-Baud Detect (ABD)
 - Two-byte transmit and receive FIFO buffers

			Memory				Peripl	Peripherals							
Device	Pins	Flash Program (bytes)	Data (bytes)	FEPROM		Comparators	8/16-Bit Timers	CCP/ECCP	MSSP	UART w/IrDA®	Ultra Low-Power Wake-up				
PIC24F16KL402	28	16K	1024	512	12	2	2/2	2/1	2	2	Υ				
PIC24F08KL402	28	8K	1024	512	12	2	2/2	2/1	2	2	Υ				
PIC24F16KL401	20	16K	1024	512	12	2	2/2	2/1	2	2	Υ				
PIC24F08KL401	20	8K	1024	512	12	2	2/2	2/1	2	2	Υ				
PIC24F08KL302	28	8K	1024	256	_	2	2/2	2/1	2	2	Υ				
PIC24F08KL301	20	8K	1024	256		2	2/2	2/1	2	2	Υ				
PIC24F08KL201	20	8K	512	_	12	1	1/2	2/0	1	1	Υ				
PIC24F08KL200	14	8K	512	_	7	1	1/2	2/0	1	1	Υ				
PIC24F04KL101	20	4K	512	_		1	1/2	2/0	1	1	Υ				
PIC24F04KL100	14	4K	512	_	_	1	1/2	2/0	1	1	Υ				

Analog Features:

- 10-Bit, up to 12-Channel Analog-to-Digital (A/D) Converter:
 - 500 ksps conversion rate
 - Conversion available during Sleep and Idle
- Dual Rail-to-Rail Analog Comparators with Programmable Input/Output Configuration
- · On-Chip Voltage Reference

Special Microcontroller Features:

- · Operating Voltage Range of 1.8V to 3.6V
- 10,000 Erase/Write Cycle Endurance Flash Program Memory, Typical
- 100,000 Erase/Write Cycle Endurance Data EEPROM, Typical
- Flash and Data EEPROM Data Retention: 40 Years Minimum
- Self-Programmable under Software Control
- · Programmable Reference Clock Output

- · Fail-Safe Clock Monitor (FSCM) Operation:
 - Detects clock failure and switches to on-chip, low-power RC oscillator
- Power-on Reset (POR), Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- · Flexible Watchdog Timer (WDT):
 - Uses its own low-power RC oscillator
 - Windowed operating modes
 - Programmable period of 2 ms to 131s
- In-Circuit Serial Programming™ (ICSP™) and In-Circuit Emulation (ICE) via 2 Pins
- · Programmable High/Low-Voltage Detect (HLVD)
- Programmable Brown-out Reset (BOR):
 - Configurable for software controlled operation and shutdown in Sleep mode
 - Selectable trip points (1.8V, 2.7V and 3.0V)
 - Low-power 2.0V POR re-arm

Pin Diagrams: PIC24FXXKL302/402 28-Pin SPDIP/SSOP/SOIC(1) MCLR/VPP/RA5 □ 28 🗖 VDD 27 Vss 26 AN9/T3CK/REFO/SS1/CN11/RB15 VREF+/CVREF+/AN0/SDA2/CN2/RA0 ☐ 2 CVREF-/VREF-/AN1/CN3/RA1 3 4 5 6 7 8 9 1 1 1 **PIC24FXXKL302**⁽²⁾ 26 AN9/13CK/REFO/SS1/CN11/RB15 25 CVREF/AN10/C10UT/ELT0/INT1/CN12/ 25 CVREF/AN10/C10UT/ELT0/INT1/CN12/ 24 AN11/SD01/CN13/RB13 23 AN12/HLVDIN/SS2/CCP2/CN14/RB12 22 PGEC2/SCK1/P1C/CN15/RB11 21 PGED2/SDI1/P1B/CN16/RB10 20 C20UT/CCP1/P1A/INT2/CN8/RA6 20 SD12/CCP3/CN9/RA7 PGED1/AN2/ULPWU/C1IND/C2INB/U2TX/CN4/RB0 CVREF/AN10/C1OUT/FLT0/INT1/CN12/RB14 PGEC1/AN3/C1INC/C2INA/U2RX/CN5/RB1 AN4/C1INB/C2IND/T3G/U1RX/CN6/RB2 C1INA/C2INC/SCL2/CN7/RB3 | 7 | 8 | 9 Vss OSCI/AN13/CLKI/CN30/RA2 OSCO/AN14/CLKO/CN29/RA3 SOSCI/AN15/U2RTS/CN1/RB4 19 SDI2/CCP3/CN9/RA7 □ 10 18 SDA1/T1CK/U1RTS/P1D/CN21/RB9 17 SCL1/U1CTS/CN22/RB8 SOSCO/SCLKI/U2CTS/CN0/RA4 12 16 U1TX/INT0/CN23/RB7 15 PGEC3/ASCL1⁽²⁾/SD02/CN24/RB6 VDD 13 PGED3/ASDA1(2)/SCK2/CN27/RB5 28-Pin QFN⁽¹⁾ VSS <mark>AN9</mark>/T3CK/REFO/<u>SS1</u>/CN11/RB15 CVREF/AN10/C1OUT/FLT0/INT1/CN12/RB14 CVREF-/VREF-/AN1/CN3/RA1 VREF+/CVREF+/AN0/SDA2/CN2/RA0 MCLR/ VPP/RA5 QQ/ 28272625242322 PGED1/AN2/ULPWU/C1IND/C2INB/U2TX/CN4/RB0 AN11/SDO1/CN13/RB13 PGEC1/AN3/C1INC/C2INA/U2RX/CN5/RB1 AN12/HLVDIN/SS2/CCP2/CN14/RB12 20 **24FXXKL302**⁽²⁾ 19 AN4/C1INB/C2IND/T3G/U1RX/CN6/RB2 PGEC2/SCK1/P1C/CN15/RB11 3 C1INA/C2INC/SCL2/CN7/RB3 PGED2/SDI1/P1B/CN16/RB10 18 24FXXKL402 C2OUT/CCP1/P1A/INT2/CN8/RA6 5 17 OSCI/AN13/CLKI/CN30/RA2 6 SDI2/CCP3/CN9/RA7 16 OSCO/AN14/CLKO/CN29/RA3 7 SDA1/T1CK/U1RTS/P1D/CN21/RB9 15 8 9 10 11 12 13 14 PGEC3/ASDA1⁽²)/SCK2/CN27/RE5 PGEC3/ASC11⁽²)/SDO2/CN24/RB6 U1TX/INT0/CN23/RB7 SCL1/U1CTS/CN22/RB8 SOSCO/SCLKI/U2CTS/CN0/RA4 Vbb SOSCI/AN15/U2RTS/CN1/RB4 Contact your Microchip sales team for Chip Scale Package (CSP) availability. Analog features (indicated in red) are not available on PIC24FXXKL302 devices. Alternate location for I²C[™] functionality of MSSP1, as determined by the I2C1SEL Configuration bit.

Pin Diagrams: PIC24FXXKL301/401 20-Pin SPDIP/SSOP/SOIC(1) MCLR/Vpp/RA5 □ PGEC2/VREF+/CVREF+/AN0/SDA2/SDI2/CN2/RA0 2 PGED2/CVREF-/VREF-/AN1/SDO2/CN3/RA1 3 OSCI/AN13/C1INB/C2IND/CLKI/CN30/RA2 7 PGECZ/VREF+/CVREF+/ANO/SDAZ/SDIZ/CNZ/RAO MGLR/VPP/RA5 VDD VSS 20-Pin QFN⁽¹⁾ PGED2/CVREF-/VREF-/AN1/SDO2/CN3/RA1 20 19 18 17 16 PGED1/AN2/ULPWU/C1IND/C2INB/U2TX/P1C/CN4/RB0 1 AN9/SCL2/T3CK/REFO/SCK2/CN11/RB15 PGEC1/AN3/C1INC/C2INA/U2RX/CN5/RB1 2 PIC24FXXKL301⁽²⁾14 CVREF/AN10/SDI1/C1OUT/FLT0/INT1/CN12/RB14 AN4/T3G/U1RX/CN6/RB2 3 13 AN11/SDO1/P1D/CN13/RB13 PIC24FXXKL401 OSCI/AN13/C1INB/C2IND/CLKI/CN30/RA2 4 12 AN12/HLVDIN/SCK1/SS2/CCP2/CN14/RB12 OSCO/AN14/C1INA/C2INC/CLKO/CN29/RA3 | 5 C2OUT/CCP1/P1A/INT2/CN8/RA6 6 7 8 9 10 PGED3/SOSCI/AN15/<u>U2RTS</u>/CN1/RB4 | PGEC3/SOSCO/SCLKI/<u>U2CTS</u>/CN0/RA4 | U1TX/INT0/CN23/RB7 | SCL1/<u>U1CTS</u>/SST/CN22/RB8 | SDA1/T1CK/<u>U1RTS</u>/CCP3/CN21/RB9 | Note 1: Analog features (indicated in red) are not available on PIC24FXXKL301 devices.

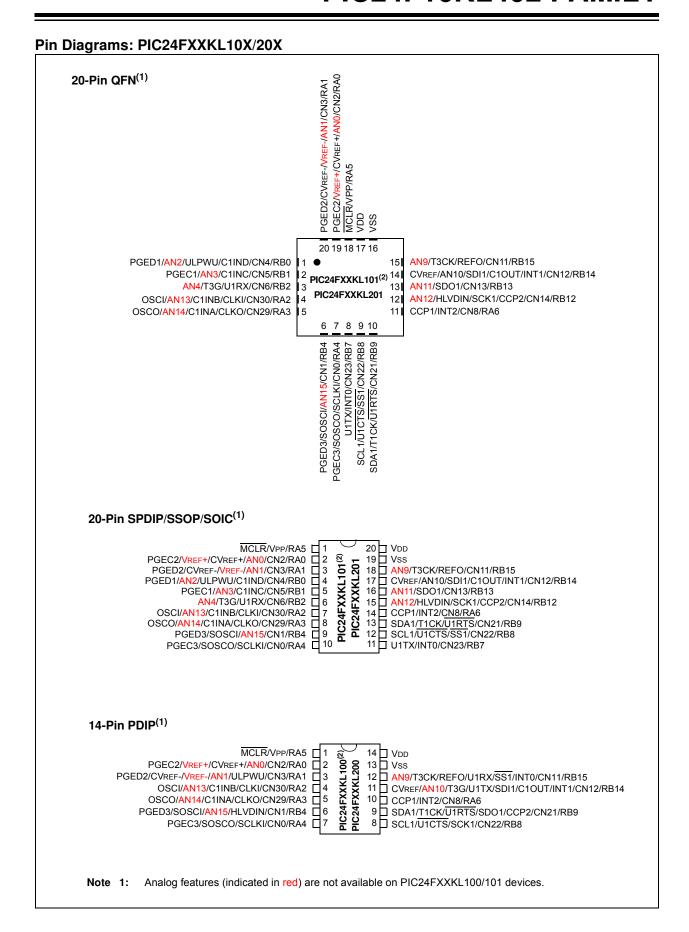


Table of Contents

1.0	Device Overview	9
2.0	Guidelines for Getting Started with 16-Bit Microcontrollers	21
3.0	CPU	25
4.0	Memory Organization	31
5.0	Flash Program Memory	47
6.0	Data EEPROM Memory	53
7.0	Resets	59
8.0	Interrupt Controller	65
9.0	Oscillator Configuration	95
10.0	Power-Saving Features	
11.0	I/O Ports	111
12.0	Timer1	115
13.0	Timer2 Module	117
14.0	Timer3 Module	119
15.0	Timer4 Module	123
16.0	Capture/Compare/PWM (CCP) and Enhanced CCP Modules	
17.0	Master Synchronous Serial Port (MSSP)	
18.0	Universal Asynchronous Receiver Transmitter (UART)	149
19.0	10-Bit High-Speed A/D Converter	157
20.0	Comparator Module	
21.0	Comparator Voltage Reference	171
22.0	High/Low-Voltage Detect (HLVD)	173
23.0	Special Features	175
24.0	Development Support	187
25.0	Instruction Set Summary	191
26.0	Electrical Characteristics	199
27.0	Packaging Information	225
Appe	endix A: Revision History	249
Index	х	251
The I	Microchip Web Site	255
Custo	tomer Change Notification Service	255
Custo	tomer Support	255
Read	der Response	256
Prod	luct Identification System	257

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NOTES:

1.0 DEVICE OVERVIEW

This document contains device-specific information for the following devices:

- PIC24F04KL100
- PIC24F04KL101
- PIC24F08KL200
- PIC24F08KL201
- PIC24F08KL301
- PIC24F08KL302
- PIC24F08KL401
- PIC24F16KL401
- PIC24F08KL402
- PIC24F16KL402

The PIC24F16KL402 family adds an entire range of economical, low pin count and low-power devices to Microchip's portfolio of 16-bit microcontrollers. Aimed at applications that require low-power consumption but more computational ability than an 8-bit platform can provide, these devices offer a range of tailored peripheral sets that allow the designer to optimize both price point and features with no sacrifice of functionality.

1.1 Core Features

1.1.1 16-BIT ARCHITECTURE

Central to all PIC24F devices is the 16-bit modified Harvard architecture, first introduced with Microchip's dsPIC[®] digital signal controllers. The PIC24F CPU core offers a wide range of enhancements, such as:

- 16-bit data and 24-bit address paths with the ability to move information between data and memory spaces
- Linear addressing of up to 12 Mbytes (program space) and 64 Kbytes (data)
- A 16-element working register array with built-in software stack support
- A 17 x 17 hardware multiplier with support for integer math
- Hardware support for 32-bit by 16-bit division
- An instruction set that supports multiple addressing modes and is optimized for high-level languages, such as C
- · Operational performance up to 16 MIPS

1.1.2 POWER-SAVING TECHNOLOGY

All of the devices in the PIC24F16KL402 family incorporate a range of features that can significantly reduce power consumption during operation. Key features include:

 On-the-Fly Clock Switching: The device clock can be changed under software control to the Timer1 source, or the internal, low-power RC oscillator during operation, allowing the user to incorporate power-saving ideas into their software designs.

- Doze Mode Operation: When timing-sensitive applications, such as serial communications, require the uninterrupted operation of peripherals, the CPU clock speed can be selectively reduced, allowing incremental power savings without missing a beat.
- Instruction-Based Power-Saving Modes: The microcontroller can suspend all operations, or selectively shut down its core while leaving its peripherals active, with a single instruction in software.

1.1.3 OSCILLATOR OPTIONS AND FEATURES

The PIC24F16KL402 family offers five different oscillator options, allowing users a range of choices in developing application hardware. These include:

- Two Crystal modes using crystals or ceramic resonators.
- Two External Clock modes offering the option of a divide-by-2 clock output.
- Two Fast Internal Oscillators (FRCs): One with a nominal 8 MHz output and the other with a nominal 500 kHz output. These outputs can also be divided under software control to provide clock speed as low as 31 kHz or 2 kHz.
- A Phase Locked Loop (PLL) frequency multiplier, available to the External Oscillator modes and the 8 MHz FRC Oscillator, which allows clock speeds of up to 32 MHz.
- A separate Internal RC Oscillator (LPRC) with a fixed 31 kHz output, which provides a low-power option for timing-insensitive applications.

The internal oscillator block also provides a stable reference source for the Fail-Safe Clock Monitor (FSCM). This option constantly monitors the main clock source against a reference signal provided by the internal oscillator and enables the controller to switch to the internal oscillator, allowing for continued low-speed operation or a safe application shutdown.

1.1.4 EASY MIGRATION

Regardless of the memory size, all the devices share the same rich set of peripherals, allowing for a smooth migration path as applications grow and evolve.

The consistent pinout scheme used throughout the entire family also helps in migrating to the next larger device. This is true when moving between devices with the same pin count, or even jumping from 20-pin or 28-pin devices to 44-pin/48-pin devices.

The PIC24F family is pin compatible with devices in the dsPIC33 family, and shares some compatibility with the pinout schema for PIC18 and dsPIC30. This extends the ability of applications to grow, from the relatively simple, to the powerful and complex.

1.2 Other Special Features

- Communications: The PIC24F16KL402 family incorporates multiple serial communication peripherals to handle a range of application requirements. The MSSP module implements both SPI and I²C™ protocols, and supports both Master and Slave modes of operation for each. Devices also include one of two UARTs with built-in IrDA[®] encoders/decoders.
- Analog Features: Select members of the PIC24F16KL402 family include a 10-bit A/D Converter module. The A/D module incorporates programmable acquisition time, allowing for a channel to be selected and a conversion to be initiated without waiting for a sampling period, as well as faster sampling speeds.

The comparator modules are configurable for a wide range of operations and can be used as either a single or double comparator module.

1.3 Details on Individual Family Members

Devices in the PIC24F16KL402 family are available in 14-pin, 20-pin and 28-pin packages. The general block diagram for all devices is shown in Figure 1-1.

The PIC24F16KL402 family may be thought of as four different device groups, each offering a slightly different set of features. These differ from each other in multiple ways:

- · The size of the Flash program memory
- · The presence and size of data EEPROM
- The presence of an A/D Converter and the number of external analog channels available
- · The number of analog comparators
- · The number of general purpose timers
- The number and type of CCP modules (i.e., CCP vs. ECCP)
- The number of serial communications modules (both MMSPs and UARTs)

The general differences between the different sub-families is shown in Table 1-1. The feature sets for specific devices are summarized in Table 1-2 and Table 1-3.

A list of the individual pin features available on the PIC24F16KL402 family devices, sorted by function, is provided in Table 1-4 (for PIC24FXXKL40X/30X devices) and Table 1-5 (for PIC24FXXKL20X/10X devices). Note that this table shows the pin location of individual peripheral features and not how they are multiplexed on the same pin. This information is provided in the pinout diagrams in the beginning of this data sheet. Multiplexed features are sorted by the priority given to a feature, with the highest priority peripheral being listed first.

TABLE 1-1: FEATURE COMPARISON FOR PIC24F16KL402 FAMILY GROUPS

Device Group	Program Memory (bytes)	Data EEPROM (bytes)	Timers (8/16-bit)	CCP and ECCP	Serial (MSSP/ UART)	A/D (channels)	Comparators
PIC24FXXKL10X	4K	_	1/2	2/0	1/1	_	1
PIC24FXXKL20X	8K	_	1/2	2/0	1/1	7 or 12	1
PIC24FXXKL30X	8K	256	2/2	2/1	2/2	_	2
PIC24FXXKL40X	8K or 16K	512	2/2	2/1	2/2	12	2

TABLE 1-2: DEVICE FEATURES FOR PIC24F16KL40X/30X DEVICES

				·	1	1			
Features	PIC24F16KL402	PIC24F08KL402	PIC24F08KL302	PIC24F16KL401	PIC24F08KL401	PIC24F08KL301			
Operating Frequency	DC – 32 MHz								
Program Memory (bytes)	16K	8K	8K	16K	8K	8K			
Program Memory (instructions)	5632	2816	2816	5632	2816	2816			
Data Memory (bytes)	1024	1024	1024	1024	1024	1024			
Data EEPROM Memory (bytes)	512	512	256	512	512	256			
Interrupt Sources (soft vectors/NMI traps)	31 (27/4)	31 (27/4)	30 (26/4)	31 (27/4)	31 (27/4)	30 (26/4)			
I/O Ports		PORTA<7:0> PORTB<15:0>		PORTA<6:0> PORTB<15:12,9:7,4,2:0>					
Total I/O Pins		24			18				
Timers (8/16-bit)	2/2	2/2	2/2	2/2	2/2	2/2			
Capture/Compare/PWM modules:									
Total	3	3	3	3	3	3			
Enhanced CCP	1	1	1	1	1	1			
Input Change Notification Interrupt	23	23	23	17	17	17			
Serial Communications:									
UART	2	2	2	2	2	2			
MSSP	2	2	2	2	2	2			
10-Bit Analog-to-Digital Module (input channels)	12	12		12	12	_			
Analog Comparators	2	2	2	2	2	2			
Resets (and delays)	POR, BOR, RESET Instruction, MCLR, WDT, Illegal Opcode, REPEAT Instruction, Hardware Traps, Configuration Word Mismatch (PWRT, OST, PLL Lock)								
Instruction Set	76	Base Instruc	tions, Multiple	Addressing I	Mode Variatio	ns			
Packages	28-Pin P	DIP/SSOP/SO	DIC/QFN	20-Pin SI	PDIP/SSOP/S	OIC/QFN			

TABLE 1-3: DEVICE FEATURES FOR THE PIC24F16KL20X/10X DEVICES

	ILS I OIL IIIL I I		-				
Features	PIC24F08KL201	PIC24F04KL101	PIC24F08KL200	PIC24F04KL100			
Operating Frequency		DC - 3	32 MHz				
Program Memory (bytes)	8K	4K	8K	4K			
Program Memory (instructions)	2816	1408	2816	1408			
Data Memory (bytes)	512	512	512	512			
Data EEPROM Memory (bytes)	_	_	_	_			
Interrupt Sources (soft vectors/NMI traps)	27 (23/4)	26 (22/4)	27 (23/4)	26 (22/4)			
I/O Ports	PORTA PORTB<15:		PORTA PORTB<15	A<5:0> :14,9:8,4,0>			
Total I/O Pins	1	7	1	2			
Timers (8/16-bit)	1/2	1/2 1/2		1/2			
Capture/Compare/PWM modules:							
Total	2	2	2	2			
Enhanced CCP	0	0	0	0			
Input Change Notification Interrupt	17	17	11	11			
Serial Communications:							
UART	1	1	1	1			
MSSP	1	1	1	1			
10-Bit Analog-to-Digital Module (input channels)	12	_	7	_			
Analog Comparators	1	1	1	1			
Resets (and delays)	POR, BOR, RESET Instruction, MCLR, WDT, Illegal Opcode, REPEAT Instruction, Hardware Traps, Configuration Word Mismatch (PWRT, OST, PLL Lock)						
Instruction Set	76 Base	Instructions, Multiple	Addressing Mode \	/ariations			
Packages	20-Pin SPDIP/S	SOP/SOIC/QFN	14-Pin PD	IP/TSSOP			

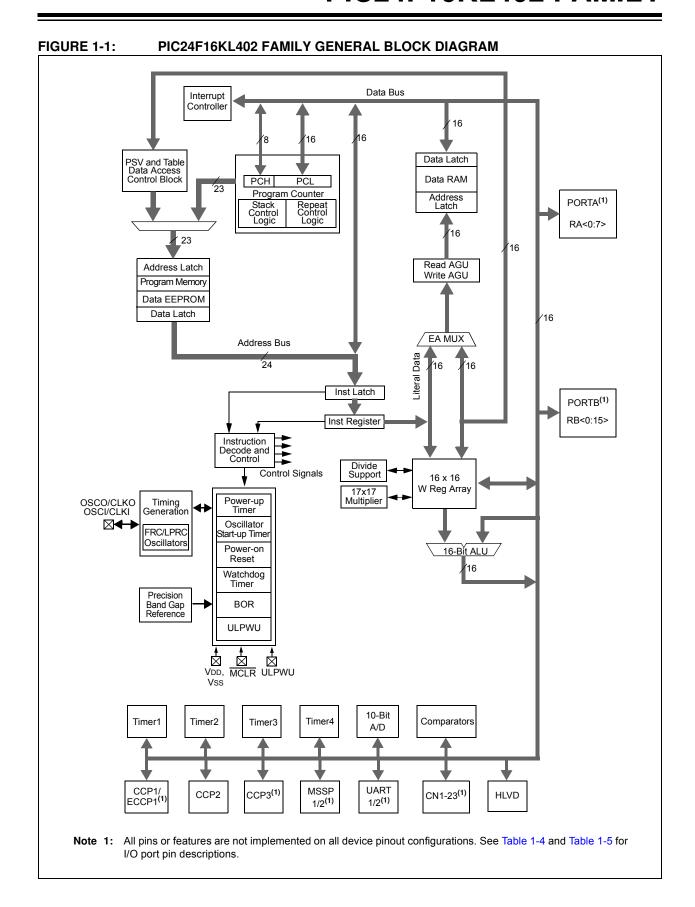


TABLE 1-4: PIC24F16KL40X/30X FAMILY PINOUT DESCRIPTIONS

Punction Punction			Pin N	umber						
AN1	Function	PDIP/ SSOP/		SPDIP/ SSOP/	_	I/O	Buffer	Description		
ANI	AN0	2	19	2	27	I	ANA	A/D Analog Inputs. Not available on PIC24F16KL30X		
AN3	AN1	3	20	3	28	I	ANA	family devices.		
AN4 6 3 6 3 I ANA AN5 — — 7 4 I ANA AN9 18 15 26 23 I ANA AN10 17 14 25 22 I ANA AN11 16 13 24 21 I ANA AN11 16 13 24 21 I ANA AN11 15 12 23 20 I ANA AN11 8 5 10 7 I ANA AN11 8 5 10 7 I ANA AN11 8 5 10 7 I ANA AN15 9 6 11 8 I ANA AN15 9 6 11 8 I ANA AN15 9 6 11 8 I ANA AN16 9 6 11 8 I ANA AN17 1	AN2	4	1	4	1	I	ANA			
ANS	AN3	5	2	5	2	I	ANA			
AN9	AN4	6	3	6	3	I	ANA			
AN10 17 14 25 22 I ANA AN11 16 13 24 21 I ANA AN12 15 12 23 20 I ANA AN13 7 4 9 6 I ANA AN14 8 5 10 7 I ANA AN15 9 6 11 8 I ANA AN15 9 6 11 8 I ANA ASCL1 — 15 12 I/O I²C™ Alternate MSSP1 I²C Clock Input/Output ASDA1 — 14 11 I/O I²C Alternate MSSP1 I²C Clock Input/Output AVDD 20 17 28 25 I ANA Positive Supply for Analog modules AVSS 19 16 27 24 I ANA Ground Reference for Analog modules CCP1 14 11 20 17 I/O ST CCP1/ECCP1 Capture Input/Compare and PWM Output CCP2 15 12 23 20 I/O ST CCP2 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output CCINA 8 5 7 4 I ANA Comparator 1 Input A (+) C1INB 7 4 6 3 I ANA Comparator 1 Input B (-) C1IND 4 1 4 1 4 1 I ANA Comparator 1 Input D (-) C1IND 4 1 4 1 4 1 I ANA Comparator 2 Input B (-) C2INA 5 2 5 2 I ANA Comparator 2 Input B (-) C2INA 5 2 5 7 4 I ANA Comparator 2 Input B (-) C2INA 5 2 5 7 4 I ANA Comparator 2 Input B (-) C2INA 5 2 5 7 4 I ANA Comparator 2 Input B (-) C2INA 5 2 5 7 4 I ANA Comparator 2 Input B (-) C2INA 5 2 5 7 4 I ANA Comparator 2 Input B (-) C2INA 5 2 5 7 4 I ANA Comparator 2 Input B (-) C2INA 5 7 4 6 3 I ANA Comparator 2 Input B (-) C2INA 5 7 4 6 3 I ANA Comparator 2 Input B (-) C2INA 6 7 4 6 3 I ANA Comparator 2 Input C (+) C2INB 4 1 4 1 ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input C (+) C2INB 7 4 6 3 I ANA Comparator 2 Input C (-) C2INC 8 5 7 4 I ANA Comparator 2 Input C (-) C2INC 8 5 7 4 I ANA Comparator 2 Input C (-) C2INC 8 5 7 4 I ANA Comparator 2 Input C (-) C2INC 14 11 20 17 0 — Comparator 2 Input D (-)	AN5	_	_	7	4	I	ANA			
AN11	AN9	18	15	26	23	I	ANA			
AN12 15 12 23 20 I ANA AN13 7 4 9 6 I ANA AN14 8 5 10 7 I ANA AN15 9 6 11 8 I ANA AN15 9 6 11 8 I ANA ASCL1 — — 15 12 I/O I ² C Alternate MSSP1 I ² C Clock Input/Output ASDA1 — — 14 11 I/O I ² C Alternate MSSP1 I ² C Clock Input/Output AVDD 20 17 28 25 I ANA Positive Supply for Analog modules AVSS 19 16 27 24 I ANA Ground Reference for Analog modules CCP1 14 11 20 17 I/O ST CCP1 Capture Input/Compare and PWM Output CCP2 15 12 23 20 I/O ST CCP2 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output C1INA 8 5 7 4 I ANA Comparator 1 Input A (+) C1INB 7 4 6 3 I ANA Comparator 1 Input B (-) C1INC 5 2 5 2 I ANA Comparator 1 Input D (-) C1IND 4 1 4 1 I ANA Comparator 1 Input D (-) C1IOUT 17 14 25 22 O — Comparator 1 Input D (-) C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2IND 7 4 6 3 I ANA Comparator 2 Input B (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2IND 7 4 6 6 3 I ANA Main Clock Input	AN10	17	14	25	22	I	ANA			
AN13 7 4 9 6 I ANA AN14 8 5 10 7 I ANA AN15 9 6 11 8 I ANA AN5 9 6 11 8 I ANA ASCL1 — — 15 12 I/O I²C M Alternate MSSP1 I²C Clock Input/Output ASDA1 — — 14 11 I/O I²C Alternate MSSP1 I²C Data Input/Output AVDD 20 17 28 25 I ANA Positive Supply for Analog modules AVSS 19 16 27 24 I ANA Ground Reference for Analog modules CCP1 14 11 20 17 I/O ST CCP1/ECCP1 Capture Input/Compare and PWM Output CCP2 15 12 23 20 I/O ST CCP2 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output CCINA 8 5 7 4 I ANA Comparator 1 Input A (+) C1INA 8 5 7 4 I ANA Comparator 1 Input B (-) C1INC 5 2 5 2 I ANA Comparator 1 Input D (-) C1IND 4 1 4 1 I ANA Comparator 1 Input D (-) C1OUT 17 14 25 22 O — Comparator 2 Input D (-) C1OUT 17 14 25 2 I ANA Comparator 2 Input B (-) C2INA 5 2 5 2 I ANA Comparator 2 Input B (-) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input D (-) C2OUT 14 11 20 17 O — Comparator 2 Input D (-) C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	AN11	16	13	24	21	I	ANA			
AN14 8 5 10 7 I ANA AN15 9 6 11 8 I ANA ASCL1 — — 15 12 I/O I²C™ Alternate MSSP1 I²C Clock Input/Output ASDA1 — — 14 11 I/O I²C Alternate MSSP1 I²C Data Input/Output AVDD 20 17 28 25 I ANA Positive Supply for Analog modules AVSS 19 16 27 24 I ANA Ground Reference for Analog modules CCP1 14 11 20 17 I/O ST CCP1/ECCP1 Capture Input/Compare and PWM Output CCP2 15 12 23 20 I/O ST CCP2 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output C1INA 8 5 7 4 I ANA Comparator 1 Input A (+) C1INB 7 4 6 3 I ANA Comparator 1 Input B (-) C1INC 5 2 5 2 I ANA Comparator 1 Input D (-) C1OUT 17 14 25 22 O — Comparator 2 Input A (+) C2INA 5 2 5 2 I ANA Comparator 2 Input B (-) C2INA 5 2 5 7 4 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2INC 7 4 6 3 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input D (-) C2OUT 14 11 20 17 0 — Comparator 2 Input D (-)	AN12	15	12	23	20	I	ANA			
AN15 9 6 11 8 I ANA ASCL1	AN13	7	4	9	6	I	ANA			
ASCL1 — — — — — — — — — — — — — — — — — — —	AN14	8	5	10	7	I	ANA			
ASDA1 — — — 14 11 I/O I ² C Alternate MSSP1 I ² C Data Input/Output AVDD 20 17 28 25 I ANA Positive Supply for Analog modules AVSS 19 16 27 24 I ANA Ground Reference for Analog modules CCP1 14 11 20 17 I/O ST CCP1/ECCP1 Capture Input/Compare and PWM Output CCP2 15 12 23 20 I/O ST CCP2 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output C1INA 8 5 7 4 I ANA Comparator 1 Input A (+) C1INB 7 4 6 3 I ANA Comparator 1 Input B (-) C1INC 5 2 5 2 I ANA Comparator 1 Input D (-) C1IND 4 1 4 1 I ANA Comparator 1 Input D (-) C1OUT 17 14 25 22 O — Comparator 1 Input D (-) C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2INC 7 4 6 3 I ANA Comparator 2 Input B (-) C2IND 7 4 6 3 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input C (+) C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	AN15	9	6	11	8	I	ANA			
AVDD 20 17 28 25 I ANA Positive Supply for Analog modules AVSS 19 16 27 24 I ANA Ground Reference for Analog modules CCP1 14 11 20 17 I/O ST CCP1/ECCP1 Capture Input/Compare and PWM Output Output CCP2 15 12 23 20 I/O ST CCP2 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output C1INA 8 5 7 4 I ANA Comparator 1 Input/Compare and PWM Output C1INA 8 5 7 4 I ANA Comparator 1 Input/Compare and PWM Output C1INB 7 4 6 3 I ANA Comparator 1 Input/Compare and PWM Output C1INB 7 4 6 3 I ANA Comparator 1 Input/Compare and PWM Output C1IND 7 14	ASCL1	_	_	15	12	I/O	I ² C™	Alternate MSSP1 I ² C Clock Input/Output		
AVSS 19 16 27 24 I ANA Ground Reference for Analog modules CCP1 14 11 20 17 I/O ST CCP1/ECCP1 Capture Input/Compare and PWM Output CCP2 15 12 23 20 I/O ST CCP2 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output C1INA 8 5 7 4 I ANA Comparator 1 Input A (+) C1INB 7 4 6 3 I ANA Comparator 1 Input B (-) C1INC 5 2 5 2 I ANA Comparator 1 Input D (-) C1IND 4 1 4 1 I ANA Comparator 1 Input D (-) C1OUT 17 14 25 22 O — Comparator 1 Output C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input B (-) C2IND 7 4 6 3 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	ASDA1	-	_	14	11	I/O	I ² C	Alternate MSSP1 I ² C Data Input/Output		
CCP1 14 11 20 17 I/O ST CCP1/ECCP1 Capture Input/Compare and PWM Output CCP2 15 12 23 20 I/O ST CCP2 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output C1INA 8 5 7 4 I ANA Comparator 1 Input A (+) C1INB 7 4 6 3 I ANA Comparator 1 Input B (-) C1INC 5 2 5 2 I ANA Comparator 1 Input C (+) C1IND 4 1 4 1 I ANA Comparator 1 Input D (-) C1OUT 17 14 25 22 O — Comparator 1 Output C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 ANA Comparator 2 Input D (-) <td>AVDD</td> <td>20</td> <td>17</td> <td>28</td> <td>25</td> <td>I</td> <td>ANA</td> <td>Positive Supply for Analog modules</td>	AVDD	20	17	28	25	I	ANA	Positive Supply for Analog modules		
CCP2 15 12 23 20 I/O ST CCP2 Capture Input/Compare and PWM Output CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output C1INA 8 5 7 4 I ANA Comparator 1 Input A (+) C1INB 7 4 6 3 I ANA Comparator 1 Input B (-) C1INC 5 2 5 2 I ANA Comparator 1 Input D (-) C1IND 4 1 4 1 I ANA Comparator 1 Input D (-) C1OUT 17 14 25 22 O — Comparator 1 Output C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input D (-) <	AVss	19	16	27	24	I	ANA	Ground Reference for Analog modules		
CCP3 13 10 19 16 I/O ST CCP3 Capture Input/Compare and PWM Output C1INA 8 5 7 4 I ANA Comparator 1 Input A (+) C1INB 7 4 6 3 I ANA Comparator 1 Input B (-) C1INC 5 2 5 2 I ANA Comparator 1 Input C (+) C1IND 4 1 4 1 I ANA Comparator 1 Input D (-) C1IND 4 1 4 1 I ANA Comparator 1 Output D (-) C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C	CCP1	14	11	20	17	I/O	ST	i i i i i i i i i i i i i i i i i i i		
C1INA 8 5 7 4 I ANA Comparator 1 Input A (+) C1INB 7 4 6 3 I ANA Comparator 1 Input B (-) C1INC 5 2 5 2 I ANA Comparator 1 Input C (+) C1IND 4 1 4 1 I ANA Comparator 1 Input D (-) C1IND 17 14 25 22 O — Comparator 1 Input D (-) C2INA 5 2 5 2 O — Comparator 1 Input D (-) C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input D (-) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2OUT	CCP2	15	12	23	20	I/O	ST	CCP2 Capture Input/Compare and PWM Output		
C1INB 7 4 6 3 I ANA Comparator 1 Input B (-) C1INC 5 2 5 2 I ANA Comparator 1 Input D (-) C1IND 4 1 4 1 I ANA Comparator 1 Input D (-) C1OUT 17 14 25 22 O — Comparator 1 Output C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	CCP3	13	10	19	16	I/O	ST	CCP3 Capture Input/Compare and PWM Output		
C1INC 5 2 5 2 I ANA Comparator 1 Input C (+) C1IND 4 1 4 1 I ANA Comparator 1 Input D (-) C1OUT 17 14 25 22 O — Comparator 1 Output C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	C1INA	8	5	7	4	I	ANA	Comparator 1 Input A (+)		
C1IND 4 1 4 1 I ANA Comparator 1 Input D (-) C1OUT 17 14 25 22 O — Comparator 1 Output C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	C1INB	7	4	6	3	I	ANA	Comparator 1 Input B (-)		
C1OUT 17 14 25 22 O — Comparator 1 Output C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	C1INC	5	2	5	2	I	ANA	Comparator 1 Input C (+)		
C2INA 5 2 5 2 I ANA Comparator 2 Input A (+) C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	C1IND	4	1	4	1	I	ANA	Comparator 1 Input D (-)		
C2INB 4 1 4 1 I ANA Comparator 2 Input B (-) C2INC 8 5 7 4 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	C1OUT	17	14	25	22	0	_	Comparator 1 Output		
C2INC 8 5 7 4 I ANA Comparator 2 Input C (+) C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	C2INA	5	2	5	2	I	ANA	Comparator 2 Input A (+)		
C2IND 7 4 6 3 I ANA Comparator 2 Input D (-) C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	C2INB	4	1	4	1	I	ANA	Comparator 2 Input B (-)		
C2OUT 14 11 20 17 O — Comparator 2 Output CLK I 7 4 9 6 I ANA Main Clock Input	C2INC	8	5	7	4	I	ANA	Comparator 2 Input C (+)		
CLK I 7 4 9 6 I ANA Main Clock Input	C2IND	7	4	6	3	I	ANA	Comparator 2 Input D (-)		
· · · · · · · · · · · · · · · · · · ·	C2OUT	14	11	20	17	0	_	Comparator 2 Output		
CLKO 8 5 10 7 O — System Clock Output	CLK I	7	4	9	6	I	ANA	Main Clock Input		
	CLKO	8	5	10	7	0	_	System Clock Output		

Legend: TTL = TTL input buffer ANA = Analog level input/output

PIC24F16KL40X/30X FAMILY PINOUT DESCRIPTIONS (CONTINUED) **TABLE 1-4:**

			umber				TIONS (CONTINUED)				
Function	20-Pin PDIP/ SSOP/ SOIC	20-Pin QFN	28-Pin SPDIP/ SSOP/ SOIC	28-Pin QFN	I/O	Buffer	Description				
CN0	10	7	12	9	I	ST	Interrupt-on-Change Inputs				
CN1	9	6	11	8	I	ST					
CN2	2	19	2	27	I	ST					
CN3	3	20	3	28	I	ST					
CN4	4	1	4	1	I	ST					
CN5	5	2	5	2	I	ST					
CN6	6	3	6	3	I	ST					
CN7		_	7	4	I	ST					
CN8	14	11	20	17	I	ST					
CN9	_	_	19	16	I	ST					
CN11	18	15	26	23	I	ST					
CN12	17	14	25	22	I	ST					
CN13	16	13	24	21	I	ST					
CN14	15	12	23	20	I	ST					
CN15	_	_	22	19	I	ST					
CN16	_	_	21	18	I	ST					
CN21	13	10	18	15	I	ST					
CN22	12	9	17	14	I	ST					
CN23	11	8	16	13	I	ST					
CN24	_	_	15	12	I	ST					
CN27	_	_	14	11	I	ST					
CN29	8	5	10	7	I	ST					
CN30	7	4	9	6	I	ST					
CVREF	17	14	25	22	I	ANA	Comparator Voltage Reference Output				
CVREF+	2	19	2	27	I	ANA	Comparator Reference Positive Input Voltage				
CVREF-	3	20	3	28	I	ANA	Comparator Reference Negative Input Voltage				
FLT0	17	14	25	22	I	ST	ECCP1 Enhanced PWM Fault Input				
HLVDIN	15	12	23	20	I	ST	High/Low-Voltage Detect Input				
INT0	11	8	16	13	I	ST	Interrupt 0 Input				
INT1	17	14	25	22	I	ST	Interrupt 1 Input				
INT2	14	11	20	17	I	ST	Interrupt 2 Input				
MCLR	1	18	1	26	I	ST	Master Clear (device Reset) Input. This line is brought low to cause a Reset.				
OSCI	7	4	9	6	I	ANA	Main Oscillator Input				
OSCO	8	5	10	7	0	ANA	Main Oscillator Output				
P1A	14	11	20	17	0	_	ECCP1 Output A (Enhanced PWM Mode)				
P1B	5	2	21	18	0	_	ECCP1 Output B (Enhanced PWM Mode)				
P1C	4	1	22	19	0	_	ECCP1 Output C (Enhanced PWM Mode)				
P1D	16	13	18	15	0	_	ECCP1 Output D (Enhanced PWM Mode)				
Legend: T	TI - TTI :	= TTL input buffer ST = Schmitt Trigger input buffer									

Legend: TTL = TTL input buffer

ANA = Analog level input/output

TABLE 1-4: PIC24F16KL40X/30X FAMILY PINOUT DESCRIPTIONS (CONTINUED)

		Pin N	umber						
Function	20-Pin PDIP/ SSOP/ SOIC	20-Pin QFN	28-Pin SPDIP/ SSOP/ SOIC	28-Pin QFN	I/O	Buffer	Description		
PGEC1	5	2	5	2	I/O	ST	ICSP™ Clock 1		
PCED1	4	1	4	1	I/O	ST	ICSP Data 1		
PGEC2	2	19	22	19	I/O	ST	ICSP Clock 2		
PGED2	3	20	21	18	I/O	ST	ICSP Data 2		
PGEC3	10	7	15	12	I/O	ST	ICSP Clock 3		
PGED3	9	6	14	11	I/O	ST	ICSP Data 3		
RA0	2	19	2	27	I/O	ST	PORTA Pins		
RA1	3	20	3	28	I/O	ST			
RA2	7	4	9	6	I/O	ST			
RA3	8	5	10	7	I/O	ST			
RA4	10	7	12	9	I/O	ST			
RA5	1	18	1	26	I	ST			
RA6	14	11	20	17	I/O	ST	-		
RA7	_	_	19	16	I/O	ST			
RB0	4	1	4	1	I/O	ST	PORTB Pins		
RB1	5	2	5	2	I/O	ST			
RB2	6	3	6	3	I/O	ST	-		
RB3	_	_	7	4	I/O	ST			
RB4	9	6	11	8	I/O	ST			
RB5	_	_	14	11	I/O	ST	-		
RB6		_	15	12	I/O	ST			
RB7	11	8	16	13	1/0	ST			
RB8	12	9	17	14	1/0	ST			
RB9	13	10	18	15	I/O	ST ST			
RB10 RB11	_	_	21	18 19	1/0	ST			
RB12	15	12	22			ST			
RB13	15 16	12	23 24	20	I/O I/O	ST			
RB14	17	13 14	25	21 22	1/0	ST	1		
RB15	18	15	26	23	1/0	ST	1		
REFO	18	15	26	23	0	_	Reference Clock Output		
SCK1	15	12	22	19	1/0	ST	MSSP1 SPI Serial Input/Output Clock		
SCK2	18	15	14	11	1/0	ST	MSSP2 SPI Serial Input/Output Clock		
SCL1	12	9	17	14	1/0	I ² C	MSSP1 I ² C Clock Input/Output		
SCL2	18	15	7	4	1/0	I ² C	MSSP2 I ² C Clock Input/Output		
SCLKI	10	7	12	9	1/0	ST	Digital Secondary Clock Input		
SDA1	13	10	18	15	I/O	I ² C	MSSP1 I ² C Data Input/Output		
SDA2	2	19	2	27	I/O	I ² C	MSSP2 I ² C Data Input/Output		
SDI1	17	14	21	18	ı	ST	MSSP1 SPI Serial Data Input		
SDI2	2	19	19	16	i	ST	MSSP2 SPI Serial Data Input		
SD01	16	13	24	21	0	_	MSSP1 SPI Serial Data Output		
SDO2	3	20	15	12	0	_	MSSP2 SPI Serial Data Output		
		anut huffor			L		nitt Trigger input buffer		

Legend: TTL = TTL input buffer

ANA = Analog level input/output

TABLE 1-4: PIC24F16KL40X/30X FAMILY PINOUT DESCRIPTIONS (CONTINUED)

	Pin Number							
Function	20-Pin PDIP/ SSOP/ SOIC	20-Pin QFN	28-Pin SPDIP/ SSOP/ SOIC	28-Pin QFN	I/O	Buffer	Description	
SOSCI	9	6	11	8	I	ANA	Secondary Oscillator Input	
SOSCO	10	7	12	9	0	ANA	Secondary Oscillator Output	
SS1	12	9	26	23	0	_	SPI1 Slave Select	
SS2	15	12	23	20	0	_	SPI2 Slave Select	
T1CK	13	10	18	15	I	ST	Timer1 Clock	
T3CK	18	15	26	23	I	ST	Timer3 Clock	
T3G	6	3	6	3	I	ST	Timer3 External Gate Input	
U1CTS	12	9	17	14	I	ST	UART1 Clear-to-Send Input	
U1RTS	13	10	18	15	0	_	UART1 Request-to-Send Output	
U1RX	6	3	6	3	-	ST	UART1 Receive	
U1TX	11	8	16	13	0	_	UART1 Transmit	
U2CTS	10	7	12	9	Ι	ST	UART2 Clear-to-Send Input	
U2RTS	9	6	11	8	0	_	UART2 Request-to-Send Output	
U2RX	5	2	5	2	-	ST	UART2 Receive	
U2TX	4	1	4	1	0	_	UART2 Transmit	
ULPWU	4	1	4	1	I	ANA	Ultra Low-Power Wake-up Input	
VDD	20	17	13, 28	10, 25	Р	_	Positive Supply for Peripheral Digital Logic and I/O Pins	
VREF+	2	19	2	27	I	ANA	A/D Reference Voltage Input (+)	
VREF-	3	20	3	28	I	ANA	A/D Reference Voltage Input (-)	
Vss	19	16	8, 27	5, 24	Р	_	Ground Reference for Logic and I/O Pins	

Legend: TTL = TTL input buffer

ANA = Analog level input/output

ST = Schmitt Trigger input buffer $I^2C = I^2C^{TM}/SMBus$ input buffer

TABLE 1-5: PIC24F16KL20X/10X FAMILY PINOUT DESCRIPTIONS

		Pin Number	•			
Function	20-Pin PDIP/ SSOP/ SOIC	20-Pin QFN	14-Pin PDIP/ TSSOP	I/O	Buffer	Description
AN0	2	19	2	I	ANA	A/D Analog Inputs. Not available on PIC24F16KL10X
AN1	3	20	3	I	ANA	family devices.
AN2	4	1	_	I	ANA	
AN3	5	2	_	I	ANA	
AN4	6	3	_	I	ANA	
AN9	18	15	12	I	ANA	
AN10	17	14	11	I	ANA	
AN11	16	13	_	I	ANA	
AN12	15	12	_	I	ANA	
AN13	7	4	4	I	ANA	
AN14	8	5	5	I	ANA	
AN15	9	6	6	I	ANA	
AVDD	20	17	14	I	ANA	Positive Supply for Analog modules
AVss	19	16	13	I	ANA	Ground Reference for Analog modules
CCP1	14	11	10	I/O	ST	CCP1 Capture Input/Compare and PWM Output
CCP2	15	12	9	I/O	ST	CCP2 Capture Input/Compare and PWM Output
C1INA	8	5	5	I	ANA	Comparator 1 Input A (+)
C1INB	7	4	4	I	ANA	Comparator 1 Input B (-)
C1INC	5	2	_	I	ANA	Comparator 1 Input C (+)
C1IND	4	1	_	I	ANA	Comparator 1 Input D (-)
C1OUT	17	14	11	0	_	Comparator 1 Output
CLK I	7	4	9	I	ANA	Main Clock Input
CLKO	8	5	10	0	_	System Clock Output
CN0	10	7	7	Ι	ST	Interrupt-on-Change Inputs
CN1	9	6	6	I	ST	
CN2	2	19	2	I	ST	
CN3	3	20	3	I	ST	
CN4	4	1		I	ST	
CN5	5	2		ı	ST	
CN6	6	3		I	ST	
CN8	14	11	10	I	ST	
CN9				I	ST	
CN11	18	15	12	ı	ST	
CN12	17	14	11	I	ST	
CN13	16	13		I	ST	
CN14	15	12		ı	ST	
CN21	13	10	9	I	ST	
CN22	12	9	8	I	ST	
CN23	11	8		I	ST	
CN29	8	5	5	I	ST	
CN30	7	4	4	I	ST	

Legend: TTL = TTL input buffer

ANA = Analog level input/output

TABLE 1-5: PIC24F16KL20X/10X FAMILY PINOUT DESCRIPTIONS (CONTINUED)

		Pin Number	•			
Function	20-Pin PDIP/ SSOP/ SOIC	20-Pin QFN	14-Pin PDIP/ TSSOP	I/O	Buffer	Description
CVREF	17	14	11	I	ANA	Comparator Voltage Reference Output
CVREF+	2	19	2	I	ANA	Comparator Reference Positive Input Voltage
CVREF-	3	20	3	Ι	ANA	Comparator Reference Negative Input Voltage
HLVDIN	15	12	6	Ι	ST	High/Low-Voltage Detect Input
INT0	11	8	12	ı	ST	Interrupt 0 Input
INT1	17	14	11	I	ST	Interrupt 1 Input
INT2	14	11	10	I	ST	Interrupt 2 Input
MCLR	1	18	1	I	ST	Master Clear (device Reset) Input. This line is brought low to cause a Reset.
OSCI	7	4	4	I	ANA	Main Oscillator Input
OSCO	8	5	5	0	ANA	Main Oscillator Output
PGEC1	5	2	_	I/O	ST	ICSP™ Clock 1
PCED1	4	1	_	I/O	ST	ICSP Data 1
PGEC2	2	19	2	I/O	ST	ICSP Clock 2
PGED2	3	20	3	I/O	ST	ICSP Data 2
PGEC3	10	7	7	I/O	ST	ICSP Clock 3
PGED3	9	6	6	I/O	ST	ICSP Data 3
RA0	2	19	2	I/O	ST	PORTA Pins
RA1	3	20	3	I/O	ST	1
RA2	7	4	4	I/O	ST	1
RA3	8	5	5	I/O	ST	
RA4	10	7	7	I/O	ST	
RA5	1	18	1	I	ST	
RA6	14	11	10	I/O	ST	
RB0	4	1	_	I/O	ST	PORTB Pins
RB1	5	2	_	I/O	ST	
RB2	6	3	_	I/O	ST	
RB4	9	6	6	I/O	ST	
RB7	11	8	_	I/O	ST	
RB8	12	9	8	I/O	ST	
RB9	13	10	9	I/O	ST	
RB12	15	12	_	I/O	ST	
RB13	16	13		I/O	ST	
RB14	17	14	11	I/O	ST	
RB15	18	15	12	I/O	ST	
REFO	18	15	12	0	_	Reference Clock Output

Legend: TTL = TTL input buffer

ANA = Analog level input/output

ST = Schmitt Trigger input buffer

 $I^2C = I^2C^{TM}/SMBus$ input buffer

TABLE 1-5: PIC24F16KL20X/10X FAMILY PINOUT DESCRIPTIONS (CONTINUED)

		Pin Number				
Function	20-Pin PDIP/ SSOP/ SOIC	20-Pin QFN	14-Pin PDIP/ TSSOP	I/O	Buffer	Description
SCK1	15	12	8	I/O	ST	MSSP1 SPI Serial Input/Output Clock
SCL1	12	9	8	I/O	I ² C	MSSP1 I ² C Clock Input/Output
SCLKI	10	7	12	I	ST	Digital Secondary Clock Input
SDA1	13	10	9	I/O	I ² C	MSSP1 I ² C Data Input/Output
SDI1	17	14	11	I	ST	MSSP1 SPI Serial Data Input
SDO1	16	13	9	0	_	MSSP1 SPI Serial Data Output
SOSCI	9	6	11	I	ANA	Secondary Oscillator Input
SOSCO	10	7	12	0	ANA	Secondary Oscillator Output
SS1	12	9	12	0	_	SPI1 Slave Select
T1CK	13	10	9	I	ST	Timer1 Clock
T3CK	18	15	12	I	ST	Timer3 Clock
T3G	6	3	11	I	ST	Timer3 External Gate Input
U1CTS	12	9	8	I	ST	UART1 Clear-to-Send Input
U1RTS	13	10	9	0	_	UART1 Request-to-Send Output
U1RX	6	3	12	I	ST	UART1 Receive
U1TX	11	8	11	0	_	UART1 Transmit
ULPWU	3	1	3	I	ANA	Ultra Low-Power Wake-up Input
VDD	20	17	14	Р		Positive Supply for Peripheral Digital Logic and I/O Pins
VREF+	2	19	2	I	ANA	A/D Reference Voltage Input (+)
VREF-	3	20	3	I	ANA	A/D Reference Voltage Input (-)
Vss	19	16	13	Р	_	Ground Reference for Logic and I/O Pins

Legend: TTL = TTL input buffer ANA = Analog level input/output ST = Schmitt Trigger input buffer $I^2C = I^2C^{TM}/SMBus$ input buffer

2.0 GUIDELINES FOR GETTING STARTED WITH 16-BIT MICROCONTROLLERS

2.1 Basic Connection Requirements

Getting started with the PIC24F16KL402 family of 16-bit microcontrollers requires attention to a minimal set of device pin connections before proceeding with development.

The following pins must always be connected:

- All VDD and Vss pins (see Section 2.2 "Power Supply Pins")
- All AVDD and AVss pins, regardless of whether or not the analog device features are used (see Section 2.2 "Power Supply Pins")
- MCLR pin (see Section 2.3 "Master Clear (MCLR) Pin")

These pins must also be connected if they are being used in the end application:

- PGECx/PGEDx pins used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes (see Section 2.4 "ICSP Pins")
- OSCI and OSCO pins when an external oscillator source is used

(see Section 2.5 "External Oscillator Pins")

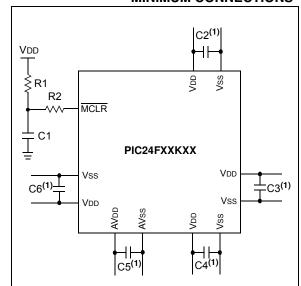
Additionally, the following pins may be required:

 VREF+/VREF- pins are used when external voltage reference for analog modules is implemented

Note: The AVDD and AVss pins must always be connected, regardless of whether any of the analog modules are being used.

The minimum mandatory connections are shown in Figure 2-1.

FIGURE 2-1: RECOMMENDED MINIMUM CONNECTIONS



Key (all values are recommendations):

C1 through C6: 0.1 µF, 20V ceramic

R1: 10 kΩ

R2: 100Ω to 470Ω

Note 1: The example shown is for a PIC24F device with five VDD/Vss and AVDD/AVss pairs.

Other devices may have more or less pairs; adjust the number of decoupling capacitors appropriately.

2.2 Power Supply Pins

2.2.1 DECOUPLING CAPACITORS

The use of decoupling capacitors on every pair of power supply pins, such as VDD, VSS, AVDD and AVSs, is required.

Consider the following criteria when using decoupling capacitors:

- Value and type of capacitor: A 0.1 μ F (100 nF), 10-20V capacitor is recommended. The capacitor should be a low-ESR device, with a resonance frequency in the range of 200 MHz and higher. Ceramic capacitors are recommended.
- Placement on the printed circuit board: The
 decoupling capacitors should be placed as close
 to the pins as possible. It is recommended to
 place the capacitors on the same side of the
 board as the device. If space is constricted, the
 capacitor can be placed on another layer on the
 PCB using a via; however, ensure that the trace
 length from the pin to the capacitor is no greater
 than 0.25 inch (6 mm).
- Handling high-frequency noise: If the board is experiencing high-frequency noise (upward of tens of MHz), add a second ceramic type capacitor in parallel to the above described decoupling capacitor. The value of the second capacitor can be in the range of 0.01 μF to 0.001 μF. Place this second capacitor next to each primary decoupling capacitor. In high-speed circuit designs, consider implementing a decade pair of capacitances as close to the power and ground pins as possible (e.g., 0.1 μF in parallel with 0.001 μF).
- Maximizing performance: On the board layout from the power supply circuit, run the power and return traces to the decoupling capacitors first, and then to the device pins. This ensures that the decoupling capacitors are first in the power chain. Equally important is to keep the trace length between the capacitor and the power pins to a minimum, thereby reducing PCB trace inductance.

2.2.2 TANK CAPACITORS

On boards with power traces running longer than six inches in length, it is suggested to use a tank capacitor for integrated circuits, including microcontrollers, to supply a local power source. The value of the tank capacitor should be determined based on the trace resistance that connects the power supply source to the device, and the maximum current drawn by the device in the application. In other words, select the tank capacitor so that it meets the acceptable voltage sag at the device. Typical values range from 4.7 μF to 47 μF .

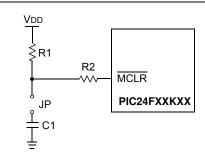
2.3 Master Clear (MCLR) Pin

The MCLR pin provides two specific device functions: Device Reset, and Device Programming and Debugging. If programming and debugging are not required in the end application, a direct connection to VDD may be all that is required. The addition of other components, to help increase the application's resistance to spurious Resets from voltage sags, may be beneficial. A typical configuration is shown in Figure 2-1. Other circuit designs may be implemented, depending on the application's requirements.

During programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the MCLR pin. Consequently, specific voltage levels (VIH and VIL) and fast signal transitions must not be adversely affected. Therefore, specific values of R1 and C1 will need to be adjusted based on the application and PCB requirements. For example, it is recommended that the capacitor, C1, be isolated from the MCLR pin during programming and debugging operations by using a jumper (Figure 2-2). The jumper is replaced for normal run-time operations.

Any components associated with the \overline{MCLR} pin should be placed within 0.25 inch (6 mm) of the pin.

FIGURE 2-2: EXAMPLE OF MCLR PIN CONNECTIONS



- Note 1: R1 \leq 10 k Ω is recommended. A suggested starting value is 10 k Ω . Ensure that the MCLR pin VIH and VIL specifications are met.
 - 2: $R2 \le 470\Omega$ will limit any current flowing into \overline{MCLR} from the external capacitor, C, in the event of \overline{MCLR} pin breakdown, due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS). Ensure that the \overline{MCLR} pin VIH and VIL specifications are met.

2.4 ICSP Pins

The PGC and PGD pins are used for In-Circuit Serial Programming $^{\text{TM}}$ (ICSP $^{\text{TM}}$) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of ohms, not to exceed 100Ω .

Pull-up resistors, series diodes and capacitors on the PGC and PGD pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits, and pin input voltage high (VIH) and input low (VIL) requirements.

For device emulation, ensure that the "Communication Channel Select" (i.e., PGCx/PGDx pins), programmed into the device, matches the physical connections for the ICSP to the Microchip debugger/emulator tool.

For more information on available Microchip development tools connection requirements, refer to **Section 24.0 "Development Support"**.

2.5 External Oscillator Pins

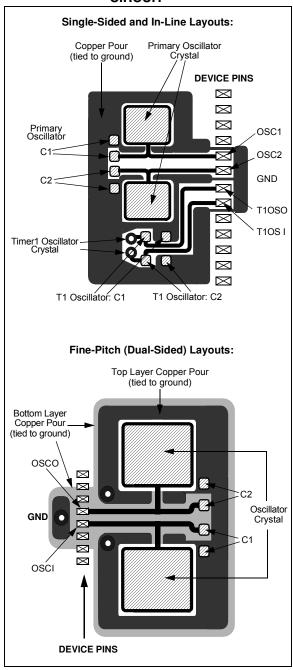
Many microcontrollers have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator (refer to Section 9.0 "Oscillator Configuration" for details).

The oscillator circuit should be placed on the same side of the board as the device. Place the oscillator circuit close to the respective oscillator pins with no more than 0.5 inch (12 mm) between the circuit components and the pins. The load capacitors should be placed next to the oscillator itself, on the same side of the board.

Use a grounded copper pour around the oscillator circuit to isolate it from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed.

Layout suggestions are shown in Figure 2-3. In-line packages may be handled with a single-sided layout that completely encompasses the oscillator pins. With fine-pitch packages, it is not always possible to completely surround the pins and components. A suitable solution is to tie the broken guard sections to a mirrored ground layer. In all cases, the guard trace(s) must be returned to ground.

FIGURE 2-3: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT



In planning the application's routing and I/O assignments, ensure that adjacent port pins and other signals, in close proximity to the oscillator, are benign (i.e., free of high frequencies, short rise and fall times, and other similar noise).

For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate web site (www.microchip.com):

- AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC™ and PICmicro[®] Devices"
- AN849, "Basic PICmicro® Oscillator Design"
- AN943, "Practical PICmicro[®] Oscillator Analysis and Design"
- · AN949, "Making Your Oscillator Work"

2.6 Unused I/Os

Unused I/O pins should be configured as outputs and driven to a logic low state. Alternatively, connect a 1 k Ω to 10 k Ω resistor to Vss on unused pins and drive the output to logic low.

3.0 CPU

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the CPU, refer to the "PIC24F Family Reference Manual", Section 2. "CPU" (DS39703).

The PIC24F CPU has a 16-bit (data) modified Harvard architecture with an enhanced instruction set and a 24-bit instruction word with a variable length opcode field. The Program Counter (PC) is 23 bits wide and addresses up to 4M instructions of user program memory space. A single-cycle instruction prefetch mechanism is used to help maintain throughput and provides predictable execution. All instructions execute in a single cycle, with the exception of instructions that change the program flow, the double-word move (MOV.D) instruction and the table instructions. Overhead-free program loop constructs are supported using the REPEAT instructions, which are interruptible at any point.

PIC24F devices have sixteen, 16-bit working registers in the programmer's model. Each of the working registers can act as a data, address or address offset register. The 16th working register (W15) operates as a Software Stack Pointer (SSP) for interrupts and calls.

The upper 32 Kbytes of the data space memory map can optionally be mapped into program space at any 16K word boundary of either program memory or data EEPROM memory, defined by the 8-bit Program Space Visibility Page Address (PSVPAG) register. The program to data space mapping feature lets any instruction access program space as if it were data space.

The Instruction Set Architecture (ISA) has been significantly enhanced beyond that of the PIC18, but maintains an acceptable level of backward compatibility. All PIC18 instructions and addressing modes are supported, either directly, or through simple macros. Many of the ISA enhancements have been driven by compiler efficiency needs.

The core supports Inherent (no operand), Relative, Literal, Memory Direct and three groups of addressing modes. All modes support Register Direct and various Register Indirect modes. Each group offers up to seven addressing modes. Instructions are associated with predefined addressing modes depending upon their functional requirements.

For most instructions, the core is capable of executing a data (or program data) memory read, a working register (data) read, a data memory write and a program (instruction) memory read per instruction cycle. As a result, three parameter instructions can be supported, allowing trinary operations (i.e., A + B = C) to be executed in a single cycle.

A high-speed, 17-bit by 17-bit multiplier has been included to significantly enhance the core arithmetic capability and throughput. The multiplier supports Signed, Unsigned and Mixed mode, 16-bit by 16-bit or 8-bit by 8-bit integer multiplication. All multiply instructions execute in a single cycle.

The 16-bit ALU has been enhanced with integer divide assist hardware that supports an iterative non-restoring divide algorithm. It operates in conjunction with the REPEAT instruction looping mechanism and a selection of iterative divide instructions to support 32-bit (or 16-bit), divided by a 16-bit integer signed and unsigned division. All divide operations require 19 cycles to complete, but are interruptible at any cycle boundary.

The PIC24F has a vectored exception scheme, with up to eight sources of non-maskable traps and up to 118 interrupt sources. Each interrupt source can be assigned to one of seven priority levels.

A block diagram of the CPU is illustrated in Figure 3-1.

3.1 Programmer's Model

Figure 3-2 displays the programmer's model for the PIC24F. All registers in the programmer's model are memory mapped and can be manipulated directly by instructions.

Table 3-1 provides a description of each register. All registers associated with the programmer's model are memory mapped.

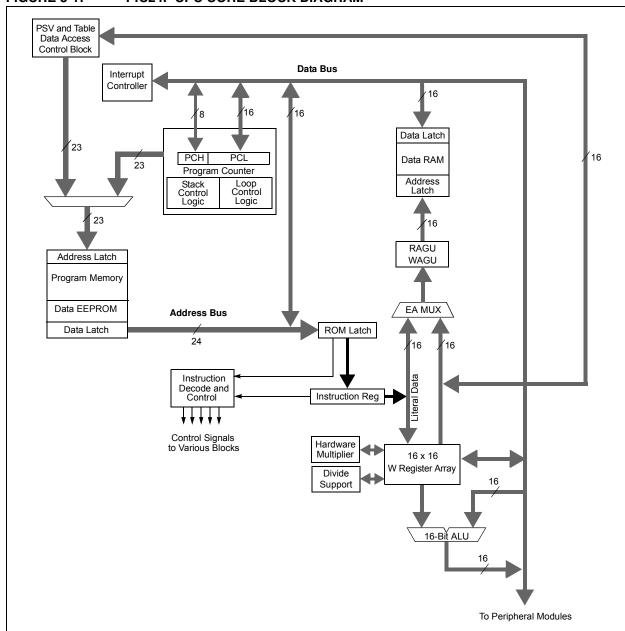


FIGURE 3-1: PIC24F CPU CORE BLOCK DIAGRAM

TABLE 3-1: CPU CORE REGISTERS

Register(s) Name	Description
W0 through W15	Working Register Array
PC	23-Bit Program Counter
SR	ALU STATUS Register
SPLIM	Stack Pointer Limit Value Register
TBLPAG	Table Memory Page Address Register
PSVPAG	Program Space Visibility Page Address Register
RCOUNT	Repeat Loop Counter Register
CORCON	CPU Control Register

FIGURE 3-2: PROGRAMMER'S MODEL 15 0 W0 (WREG) **Divider Working Registers** W2 Multiplier Registers W3 W4 W5 W6 W7 Working/Address Registers W8 W9 W10 W11 W12 W13 W14 Frame Pointer Stack Pointer W15 0 Stack Pointer Limit **SPLIM** 0 Value Register PC 0 **Program Counter** 0 Table Memory Page Address Register **TBLPAG** Program Space Visibility Page Address Register **PSVPAG** 15 Repeat Loop Counter **RCOUNT** Register 15 SRH SRL ALU STATUS Register (SR) ra n ov CPU Control Register (CORCON) Registers or bits are shadowed for ${\tt PUSH.S}$ and ${\tt POP.S}$ instructions.

3.2 CPU Control Registers

REGISTER 3-1: SR: ALU STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
		_	_	_	_	_	DC
bit 15							bit 8

R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R-0	R/W-0	R/W-0	R/W-0	R/W-0
IPL2 ⁽²⁾	IPL1 ⁽²⁾			N OV		Z	С
bit 7							bit 0

Legend: HSC = Hardware Settable/Clearable bit

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-9 **Unimplemented:** Read as '0'

bit 8 **DC:** ALU Half Carry/Borrow bit

1 = A carry-out from the 4th low-order bit (for byte-sized data) or 8th low-order bit (for word-sized data) of the result occurred

0 = No carry-out from the 4th or 8th low-order bit of the result has occurred

bit 7-5 IPL<2:0>: CPU Interrupt Priority Level (IPL) Status bits^(1,2)

111 = CPU Interrupt Priority Level is 7 (15); user interrupts disabled

110 = CPU Interrupt Priority Level is 6 (14)

101 = CPU Interrupt Priority Level is 5 (13)

100 = CPU Interrupt Priority Level is 4 (12)

011 = CPU Interrupt Priority Level is 3 (11)

010 = CPU Interrupt Priority Level is 2 (10)

001 = CPU Interrupt Priority Level is 1 (9)

000 = CPU Interrupt Priority Level is 0 (8)

bit 4 RA: REPEAT Loop Active bit

1 = REPEAT loop in progress

0 = REPEAT loop not in progress

bit 3 N: ALU Negative bit

1 = Result was negative

0 = Result was non-negative (zero or positive)

bit 2 **OV:** ALU Overflow bit

1 = Overflow occurred for signed (2's complement) arithmetic in this arithmetic operation

0 = No overflow has occurred

bit 1 Z: ALU Zero bit

1 = An operation, which effects the Z bit, has set it at some time in the past

0 = The most recent operation, which effects the Z bit, has cleared it (i.e., a non-zero result)

bit 0 C: ALU Carry/Borrow bit

1 = A carry-out from the Most Significant bit (MSb) of the result occurred

0 = No carry-out from the Most Significant bit (MSb) of the result occurred

Note 1: The IPL Status bits are read-only when NSTDIS (INTCON1<15>) = 1.

2: The IPL Status bits are concatenated with the IPL3 bit (CORCON<3>) to form the CPU Interrupt Priority Level (IPL). The value in parentheses indicates the IPL when IPL3 = 1.

REGISTER 3-2: CORCON: CPU CONTROL REGISTER

U-0	U-0 U-0		U-0	U-0	U-0	U-0	U-0
		_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	R/C-0	R/W-0	U-0	U-0	
_			_	IPL3 ⁽¹⁾	PSV	_	_	
bit 7							bit 0	

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-4 **Unimplemented:** Read as '0'

bit 3 **IPL3:** CPU Interrupt Priority Level Status bit⁽¹⁾

1 = CPU Interrupt Priority Level is greater than 7

0 = CPU Interrupt Priority Level is 7 or less

bit 2 **PSV:** Program Space Visibility in Data Space Enable bit

1 = Program space is visible in data space0 = Program space is not visible in data space

bit 1-0 **Unimplemented:** Read as '0'

Note 1: User interrupts are disabled when IPL3 = 1.

3.3 Arithmetic Logic Unit (ALU)

The PIC24F ALU is 16 bits wide and is capable of addition, subtraction, bit shifts and logic operations. Unless otherwise mentioned, arithmetic operations are 2's complement in nature. Depending on the operation, the ALU may affect the values of the Carry (C), Zero (Z), Negative (N), Overflow (OV) and Digit Carry (DC) Status bits in the SR register. The C and DC Status bits operate as Borrow and Digit Borrow bits, respectively, for subtraction operations.

The ALU can perform 8-bit or 16-bit operations, depending on the mode of the instruction that is used. Data for the ALU operation can come from the W register array, or data memory, depending on the addressing mode of the instruction. Likewise, output data from the ALU can be written to the W register array or a data memory location.

The PIC24F CPU incorporates hardware support for both multiplication and division. This includes a dedicated hardware multiplier and support hardware division for a 16-bit divisor.

3.3.1 MULTIPLIER

The ALU contains a high-speed, 17-bit x 17-bit multiplier. It supports unsigned, signed or mixed sign operation in several Multiplication modes:

- 16-bit x 16-bit signed
- 16-bit x 16-bit unsigned
- 16-bit signed x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit unsigned
- 16-bit unsigned x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit signed
- 8-bit unsigned x 8-bit unsigned

3.3.2 DIVIDER

The divide block supports 32-bit/16-bit and 16-bit/16-bit signed and unsigned integer divide operations with the following data sizes:

- 1. 32-bit signed/16-bit signed divide
- 2. 32-bit unsigned/16-bit unsigned divide
- 3. 16-bit signed/16-bit signed divide
- 4. 16-bit unsigned/16-bit unsigned divide

The quotient for all divide instructions ends up in W0 and the remainder in W1. Sixteen-bit signed and unsigned DIV instructions can specify any W register for both the 16-bit divisor (Wn), and any W register (aligned) pair (W(m + 1):Wm) for the 32-bit dividend. The divide algorithm takes one cycle per bit of divisor, so both 32-bit/16-bit and 16-bit/16-bit instructions take the same number of cycles to execute.

3.3.3 MULTI-BIT SHIFT SUPPORT

The PIC24F ALU supports both single bit and single-cycle, multi-bit arithmetic and logic shifts. Multi-bit shifts are implemented using a shifter block, capable of performing up to a 15-bit arithmetic right shift, or up to a 15-bit left shift, in a single cycle. All multi-bit shift instructions only support Register Direct Addressing for both the operand source and result destination.

A full summary of instructions that use the shift operation is provided in Table 3-2.

TABLE 3-2: INSTRUCTIONS THAT USE THE SINGLE AND MULTI-BIT SHIFT OPERATION

Instruction	Description
ASR	Arithmetic shift right source register by one or more bits.
SL	Shift left source register by one or more bits.
LSR	Logical shift right source register by one or more bits.

4.0 MEMORY ORGANIZATION

As Harvard architecture devices, the PIC24F microcontrollers feature separate program and data memory space and bussing. This architecture also allows the direct access of program memory from the data space during code execution.

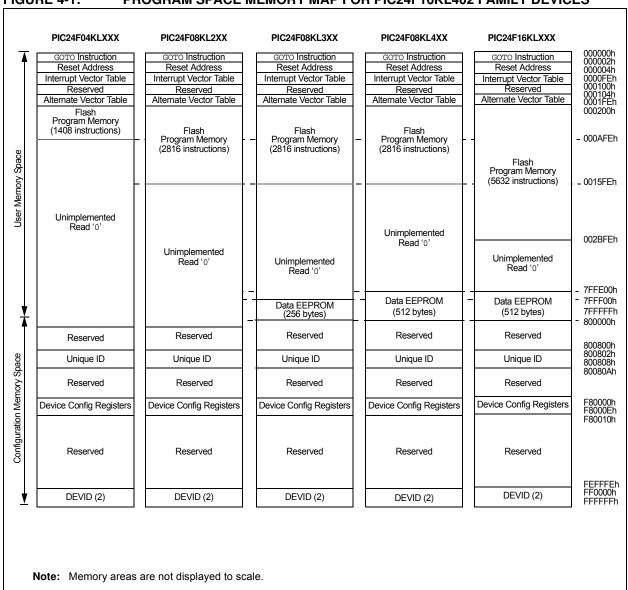
4.1 Program Address Space

The program address memory space of the PIC24F16KL402 family is 4M instructions. The space is addressable by a 24-bit value derived from either the 23-bit Program Counter (PC) during program execution, or from a table operation or data space remapping, as described in Section 4.3 "Interfacing Program and Data Memory Spaces".

User access to the program memory space is restricted to the lower half of the address range (000000h to 7FFFFFh). The exception is the use of TBLRD/TBLWT operations, which use TBLPAG<7> to permit access to the Configuration bits and Device ID sections of the configuration memory space.

Memory maps for the PIC24F16KL402 family of devices are shown in Figure 4-1.

FIGURE 4-1: PROGRAM SPACE MEMORY MAP FOR PIC24F16KL402 FAMILY DEVICES



4.1.1 PROGRAM MEMORY ORGANIZATION

The program memory space is organized in word-addressable blocks. Although it is treated as 24 bits wide, it is more appropriate to think of each address of the program memory as a lower and upper word, with the upper byte of the upper word being unimplemented. The lower word always has an even address, while the upper word has an odd address, as shown in Figure 4-2.

Program memory addresses are always word-aligned on the lower word, and addresses are incremented or decremented by two during code execution. This arrangement also provides compatibility with data memory space addressing and makes it possible to access data in the program memory space.

4.1.2 HARD MEMORY VECTORS

All PIC24F devices reserve the addresses between 00000h and 000200h for hard-coded program execution vectors. A hardware Reset vector is provided to redirect code execution from the default value of the PC on device Reset to the actual start of code. A GOTO instruction is programmed by the user at 000000h, with the actual address for the start of code at 000002h.

PIC24F devices also have two Interrupt Vector Tables (IVT), located from 000004h to 0000FFh and 000104h to 0001FFh. These vector tables allow each of the many device interrupt sources to be handled by separate ISRs. A more detailed discussion of the Interrupt Vector Tables is provided in **Section 8.1** "Interrupt Vector Table (IVT)".

4.1.3 DATA EEPROM

In the PIC24F16KL402 family, the data EEPROM is mapped to the top of the user program memory space, starting at address, 7FFE00, and expanding up to address, 7FFFFF.

The data EEPROM is organized as 16-bit wide memory and 256 words deep. This memory is accessed using table read and write operations, similar to the user code memory.

4.1.4 DEVICE CONFIGURATION WORDS

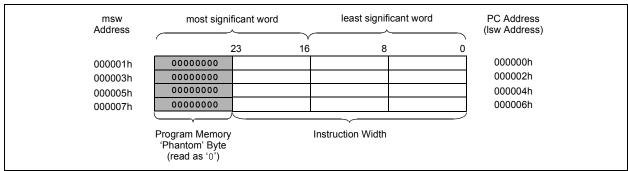
Table 4-1 provides the addresses of the device Configuration Words for the PIC24F16KL402 family. Their location in the memory map is shown in Figure 4-1.

For more information on device Configuration Words, see Section 23.0 "Special Features".

TABLE 4-1: DEVICE CONFIGURATION
WORDS FOR PIC24F16KL402
FAMILY DEVICES

Configuration Words	Configuration Word Addresses
FBS	F80000
FGS	F80004
FOSCSEL	F80006
FOSC	F80008
FWDT	F8000A
FPOR	F8000C
FICD	F8000E





4.2 **Data Address Space**

The PIC24F core has a separate, 16-bit wide data memory space, addressable as a single linear range. The data space is accessed using two Address Generation Units (AGUs); one each for read and write operations. The data space memory map is shown in Figure 4-3.

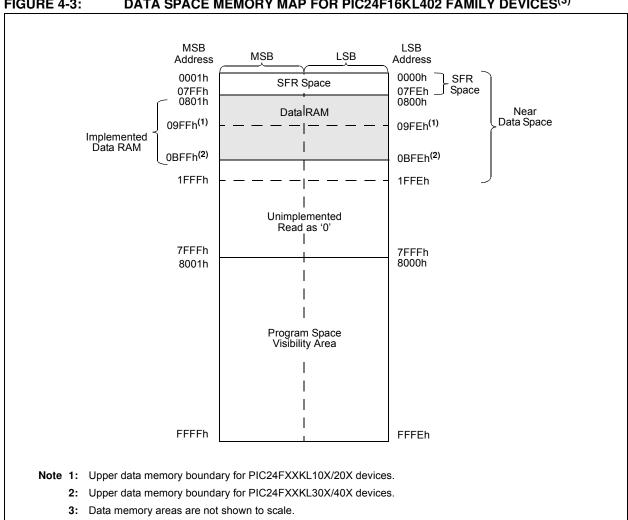
All Effective Addresses (EAs) in the data memory space are 16 bits wide and point to bytes within the data space. This gives a data space address range of 64 Kbytes or 32K words. The lower half of the data memory space (that is, when EA<15> = 0) is used for implemented memory addresses, while the upper half (EA<15> = 1) is reserved for the Program Space Visibility (PSV) area (see Section 4.3.3 "Reading Data From Program Memory Using Program Space Visibility").

Depending on the particular device, PIC24F16KL402 family devices implement either 512 or 1024 words of data memory. If an EA points to a location outside of this area, an all zero word or byte will be returned.

4.2.1 DATA SPACE WIDTH

The data memory space is organized byte-addressable, 16-bit wide blocks. Data is aligned in data memory and registers as 16-bit words, but all the data space EAs resolve to bytes. The Least Significant Bytes (LSBs) of each word have even addresses, while the Most Significant Bytes (MSBs) have odd addresses.

DATA SPACE MEMORY MAP FOR PIC24F16KL402 FAMILY DEVICES(3) FIGURE 4-3:



4.2.2 DATA MEMORY ORGANIZATION AND ALIGNMENT

To maintain backward compatibility with PIC® devices and improve data space memory usage efficiency, the PIC24F instruction set supports both word and byte operations. As a consequence of byte accessibility, all Effective Address (EA) calculations are internally scaled to step through word-aligned memory. For example, the core recognizes that Post-Modified Register Indirect Addressing mode [Ws++] will result in a value of Ws + 1 for byte operations and Ws + 2 for word operations.

Data byte reads will read the complete word, which contains the byte, using the LSB of any EA to determine which byte to select. The selected byte is placed onto the LSB of the data path. That is, data memory and the registers are organized as two parallel, byte-wide entities with shared (word) address decode, but separate write lines. Data byte writes only write to the corresponding side of the array or register, which matches the byte address.

All word accesses must be aligned to an even address. Mis-aligned word data fetches are not supported, so care must be taken when mixing byte and word operations, or translating from 8-bit MCU code. If a mis-aligned read or write is attempted, an address error trap will be generated. If the error occurred on a read, the instruction underway is completed; if it occurred on a write, the instruction will be executed, but the write will not occur. In either case, a trap is then executed, allowing the system and/or user to examine the machine state prior to execution of the address Fault.

All byte loads into any W register are loaded into the LSB; the MSB is not modified.

A Sign-Extend (SE) instruction is provided to allow the users to translate 8-bit signed data to 16-bit signed values. Alternatively, for 16-bit unsigned data, users

can clear the MSB of any W register by executing a Zero-Extend (\mathbb{ZE}) instruction on the appropriate address.

Although most instructions are capable of operating on word or byte data sizes, it should be noted that some instructions operate only on words.

4.2.3 NEAR DATA SPACE

The 8-Kbyte area between 0000h and 1FFFh is referred to as the Near Data Space (NDS). Locations in this space are directly addressable via a 13-bit absolute address field within all memory direct instructions. The remainder of the data space is addressable indirectly. Additionally, the whole data space is addressable using MOV instructions, which support Memory Direct Addressing (MDA) with a 16-bit address field. For PIC24F16KL402 family devices, the entire implemented data memory lies in Near Data Space.

4.2.4 SFR SPACE

The first 2 Kbytes of the Near Data Space, from 0000h to 07FFh, are primarily occupied with Special Function Registers (SFRs). These are used by the PIC24F core and peripheral modules for controlling the operation of the device.

SFRs are distributed among the modules that they control and are generally grouped together by the module. Much of the SFR space contains unused addresses; these are read as '0'. The SFR space, where the SFRs are actually implemented, is provided in Table 4-2. Each implemented area indicates a 32-byte region, where at least one address is implemented as an SFR. A complete listing of implemented SFRs, including their addresses, is provided in Table 4-3 through Table 4-18.

TABLE 4-2: IMPLEMENTED REGIONS OF SFR DATA SPACE

	SFR Space Address														
	xx00	xx20	xx40	xx60	08xx	xxA0	xxC0	xxE0							
000h		Core		ICN			_								
100h	Timers	- TMR	_	_	_ C0	CP —	_	_							
200h	MSSP	UART	_	_	_	_	I/O	_							
300h	A	/D	_	_	_	_	_	_							
400h	_	_	_	_	_	_	_ AN	SEL —							
500h	_	_	_	_	_	_	_	_							
600h	_	CMP —	_	_	_	_	_	_							
700h	_	_	System	NVM/PMD	_	_	_	_							

Legend: — = No implemented SFRs in this block.

TABLE 4-3: CPU CORE REGISTERS MAP

File Name	Start Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
WREG0	0000								Working	Register 0								0000
WREG1	0002								Working	Register 1								0000
WREG2	0004								Working	Register 2								0000
WREG3	0006								Working	Register 3								0000
WREG4	8000		Working Register 4													0000		
WREG5	000A		Working Register 5													0000		
WREG6	000C		Working Register 6												0000			
WREG7	000E		Working Register 7													0000		
WREG8	0010		Working Register 8													0000		
WREG9	0012								Working	Register 9								0000
WREG10	0014								Working I	Register 10								0000
WREG11	0016								Working	Register 11								0000
WREG12	0018								Working I	Register 12								0000
WREG13	001A								Working I	Register 13								0000
WREG14	001C								Working I	Register 14								0000
WREG15	001E							V	Vorking Regist	ter 15							_	0800
SPLIM	0020							Sta	ack Pointer Li	mit Value Reg	gister							xxxx
PCL	002E							Prog	gram Counter	Low Word Re	egister							0000
PCH	0030	_	_	_	_	1	_	_	_	_		1	Program C	ounter Reg	ister High By	∕te		0000
TBLPAG	0032	_	_	_	_	1	_	_	_			Table M	emory Pag	ge Address	Register			0000
PSVPAG	0034	_	_	_	_	1	_	_	_		Pr	ogram Spa	ce Visibilit	y Page Add	dress Registe	er		0000
RCOUNT	0036							F	Repeat Loop (Counter Regis	ster							xxxxx
SR	0042	_	_	_	_	_	_	_	DC	IPL2	IPL1	IPL0	RA	N	OV	Z	С	0000
CORCON	0044	_	_	_		_	_	-	_	-	_	_	_	IPL3	PSV	_	_	0000
DISICNT	0052	_							Disabl	e Interrupts C	Counter Reg	ister						xxxx

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CNPD1	0056	CN15PDE(1)	CN14PDE ⁽¹⁾	CN13PDE ⁽¹⁾	CN12PDE	CN11PDE	_	CN9PDE ⁽²⁾	CN8PDE	CN7PDE ⁽²⁾	CN6PDE(1)	CN5PDE(1)	CN4PDE ⁽¹⁾	CN3PDE	CN2PDE	CN1PDE	CN0PDE	0000
CNPD2	0058	_	CN30PDE	CN29PDE	_	CN27PDE ⁽²⁾	_	_	CN24PDE ⁽²⁾	CN23PDE(1)	CN22PDE	CN21PDE	_	_	_	1	CN16PDE ⁽²⁾	0000
CNEN1	0062	CN15IE ⁽¹⁾	CN14IE ⁽¹⁾	CN13IE ⁽¹⁾	CN12IE	CN11IE	_	CN9IE ⁽¹⁾	CN8IE	CN7IE(1)	CN6IE ⁽²⁾	CN5PIE ⁽²⁾	CN4IE ⁽²⁾	CN3IE	CNIE	CN1IE	CN0IE	0000
CNEN2	0064	_	CN30IE	CN29IE	_	CN27IE ⁽²⁾	_	_	CN24IE ⁽²⁾	CN23IE ⁽¹⁾	CN22IE	CN21IE	_	_	_	1	CN16IE ⁽²⁾	0000
CNPU1	006E	CN15PUE ⁽¹⁾	CN14PUE ⁽¹⁾	CN13PUE ⁽¹⁾	CN12PUE	CN11PUE	_	CN9PUE ⁽¹⁾	CN8PUE	CN7PUE(1)	CN6PUE ⁽²⁾	CN5PUE ⁽²⁾	CN4PUE ⁽²⁾	CN3PUE	CN2PUE	CN1PUE	CN0PUE	0000
CNPU2	0070	_	CN30PUE	CN29PUE	_	CN27PUE ⁽²⁾	_	_	CN24PUE ⁽²⁾	CN23PUE ⁽¹⁾	CN22PUE	CN21PUE	_	_	_	_	CN16PUE ⁽²⁾	0000
Logond		- unimplement	od road as 'n	, Docot value	e are chown	in hovadocim	al											

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits are unimplemented in 14-pin devices; read as '0'.

2: These bits are unimplemented in 14-pin and 20-pin devices; read as '0'.

TABLE 4-5: INTERRUPT CONTROLLER REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
INTCON1	0800	NSTDIS	_	_	_	1	-	_	_	-	_	_	MATHERR	ADDRERR	STKERR	OSCFAIL	_	0000
INTCON2	0082	ALTIVT	DISI	-	_	-	ı	_	_	-	_	_	_	_	INT2EP	INT1EP	INT0EP	0000
IFS0	0084	NVMIF	_	AD1IF	U1TXIF	U1RXIF	ı	_	T3IF	T2IF	CCP2IF	_	_	T1IF	CCP1IF	_	INT0IF	0000
IFS1	0086	U2TXIF	U2RXIF	INT2IF	_	T4IF ⁽¹⁾	ı	CCP3IF(1)	_	-	_	_	INT1IF	CNIF	CMIF	BCL1IF	SSP1IF	0000
IFS2	8800	_	_		_	1		_	_		_	T3GIF	_	_	_	_	_	0000
IFS3	008A	_	_		_	1		_	_		_	_	_	_	BCL2IF(1)	SSP2IF ⁽¹⁾	_	0000
IFS4	008C	_	_	_	_	_	_	_	HLVDIF	_	_	_	_	_	U2ERIF	U1ERIF	_	0000
IFS5	008E	_	_		_	1		_	_		_	_	_	_	_	_	ULPWUIF	0000
IEC0	0094	NVMIE	_	AD1IE	U1TXIE	U1RXIE		_	T3IE	T2IE	CCP2IE	_	_	T1IE	CCP1IE	_	INT0IE	0000
IEC1	0096	U2TXIE	U2RXIE	INT2IE	_	T4IE ⁽¹⁾		CCP3IE(1)	_		_	_	INT1IE	CNIE	CMIE	BCL1IE	SSP1IE	0000
IEC2	0098	_	_	_	_	_	_	_	_	_	_	T3GIE	_	_	_	_	_	0000
IEC3	009A	_	_	_	_	_	_	_	_	_	_	_	_	_	BCL2IE(1)	SSP2IE(1)	_	0000
IEC4	009C	_	_		_	1		_	HLVDIE		_	_	_	_	U2ERIE	U1ERIE	_	0000
IEC5	009E	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	ULPWUIE	0000
IPC0	00A4	_	T1IP2	T1IP1	T1IP0	_	CCP1IP2	CCP1IP1	CCP1IP0	_	_	_	_	_	INT0IP2	INT0IP1	INT0IP0	4404
IPC1	00A6	_	T2IP2	T2IP1	T2IP0	_	CCP2IP2	CCP2IP1	CCP2IP0	_	_	_	_	_	_	_	_	4400
IPC2	00A8	_	U1RXIP2	U1RXIP1	U1RXIP0	_	_	_	_	_	_	_	_	_	T3IP2	T3IP1	T3IP0	4004
IPC3	00AA	_	NVMIP2	NVMIP1	NVMIP0	_	_	_	_	_	AD1IP2	AD1IP1	AD1IP0	_	U1TXIP2	U1TXIP1	U1TXIP0	4044
IPC4	00AC	_	CNIP2	CNIP1	CNIP0	1	CMIP2	CMIP1	CMIP0		BCL1IP2	BCL1IP1	BCL1IP0	_	SSP1IP2	SSP1IP1	SS1IP0	4444
IPC5	00AE	_	_	1	_	1	ı	_	_	-	_	_	_	_	INT1IP2	INT1IP1	INT1IP0	0004
IPC6	00B0	_	T4IP2 ⁽¹⁾	T4IP1 ⁽¹⁾	T4IP0 ⁽¹⁾	1	ı	_	_	-	CCP3IP2 ⁽¹⁾	CCP3IP1 ⁽¹⁾	CCP3IP0 ⁽¹⁾	_	_	_	_	4040
IPC7	00B2	_	U2TXIP2	U2TXIP1	U2TXIP0	1	U2RXIP2	U2RXIP1	U2RXIP0	-	INT2IP2	INT2IP1	INT2IP0	_	_	_	_	4440
IPC9	00B6	_	_	1	_	1	ı	_	_	-	T3GIP2	T3GIP1	T3GIP0	_	_	_	_	0040
IPC12	00BC	_	_	1	_	1	BCL2IP2 ⁽¹⁾	BCL2IP1(1)	BCL2IP0 ⁽¹⁾	-	SSP2IP2 ⁽¹⁾	SSP2IP1(1)	SSP2IP0 ⁽¹⁾	_	_	_	_	0440
IPC16	00C4	_	_	-	_	-	U2ERIP2	U2ERIP1	U2ERIP0	-	U1ERIP2	U1ERIP1	U1ERIP0	_	-	_	_	0440
IPC18	00C8	_	_	_	_	_	1	_	_	I	_	_	_	_	HLVDIP2	HLVDIP1	HLVDIP0	0004
IPC20	00CC		_		_	_	1	_	_	I	_	_	_		ULPWUIP2	ULPWUIP1	ULPWUIP0	0004
INTTREG	00E0	CPUIRQ	_	VHOLD	_	ILR3	ILR2	ILR1	ILR0	-	VECNUM6	VECNUM5	VECNUM4	VECNUM3	VECNUM2	VECNUM1	VECNUM0	0000

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X family devices; read as '0'.

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets		
TMR1	0100						<u> </u>			Timer1 Reg	gister							0000		
PR1	0102								Tin	ner1 Period	Register							FFFF		
T1CON	0104	TON	_	TSIDL	_	_	_	T1ECS1	T1ECS0	_	TGATE	TCKPS1	TCKPS0	_	TSYNC	TCS	_	0000		
TMR2	0106	_	_	_	_	_	_	_	_				Timer2 R	egister				0000		
PR2	0108	_	_	_	_	_	_	_	_	Timer2 Period Register										
T2CON	010A	_	_	_	_	_	_	_	_	TOOLITION TOOLITION TOOLITION TARROOM TOOKING TOOKING										
TMR3	010C									Timer3 Reg	gister							0000		
T3GCON	010E	_	_	_	_	_	_	_	_	TMR3GE	TG3POL	T3GTM	T3GSPM	T3GGO	T3GVAL	T3GSS1	T3GSS0	0000		
T3CON	0110	_	_	_	_	_	_	_	_	TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	SOSCEN	T3SYNC	_	TMR3ON	0000		
TMR4 ⁽¹⁾	0112	_	_	_	_	_	_	_	_				Timer4 R	egister				0000		
PR4 ⁽¹⁾	0114	_	_	_	_	_	_	_	_	Timer4 Register										
T4CON ⁽¹⁾	0116	_	_	_	_	_	_	_	_	— T40UTPS3 T40UTPS2 T40UTPS1 T40UTPS0 TMR40N T4CKPS1 T4CKPS0										
CCPTMRS0 ⁽¹⁾	013C	_	_	_	_	_	_	_	_											

Note 1: These bits and/or registers are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X family devices; read as '0'.

TABLE 4-7: CCP/ECCP REGISTER MAP

IABLE + 7	•		<u> </u>	alo i Ei															
File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets	
CCP1CON	0190	1	_	_	_	_	_	_	_	PM1 ⁽¹⁾	PM0 ⁽¹⁾	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	0000	
CCPR1L	0192	-	_	_	_	_	_	1	_			Capture/Co	ompare/PWN	И1 Register	Low Byte			0000	
CCPR1H	0194	-	_	_	_	_	_	_	_			Capture/Co	mpare/PWN	/11 Register	High Byte			0000	
ECCP1DEL ⁽¹⁾	0196	-	_	_	_	_	_	_	_	Capture/Compare/PWM1 Register High Byte PRSEN PDC6 PDC5 PDC4 PDC3 PDC2 PDC1 PDC0								0000	
ECCP1AS ⁽¹⁾	0198	-	_	_	_	_	_	_	_	ECCPASE	ECCPAS2	ECCPAS1	ECCPAS0	PSSAC1	PSSAC0	PSSBD1	PSSBD0	0000	
PSTR1CON(1)	019A	_	_	_	_	_	_	_	_	CMPL1	CMPL0	_	STRSYNC	STRD	STRC	STRB	STRA	0001	
CCP2CON	019C	-	_	_	_	_	_	_	_	_	_	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	0000	
CCPR2L	019E	-	_	_	_	_	_	_	_			Capture/Co	ompare/PWN	И2 Register	Low Byte			0000	
CCPR2H	01A0	1	_	_	_	_	_	_	_			Capture/Co	mpare/PWN	//2 Register	High Byte			0000	
CCP3CON(1)	01A8	1	_	_	_	_	_	_	_	— — DC3B1 DC3B0 CCP3M3 CCP3M2 CCP3M1 CCP3M0									
CCPR3L ⁽¹⁾	01AA	_	_	_	_	_	_	_	_	Capture/Compare/PWM3 Register Low Byte									
CCPR3H ⁽¹⁾	01AC	_	_	_	_	_	_	_	_	Capture/Compare/PWM3 Register High Byte									

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits and/or registers are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X family devices; read as '0'.

TABLE 4-8: MSSP REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets			
SSP1BUF	0200	_	_	_	_		_	_	_			MSSP1 F	Receive Buff	er/Transmit	Register			00xx			
SSP1CON1	0202	_	_	_	_	_	_	_	_	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000			
SSP1CON2	0204	_	_	_	_	-	_	_	_	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000			
SSP1CON3	0206	_	_	_	_	-	_	_	_	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	0000			
SSP1STAT	0208	_	_	_	_	-	_	_	_	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	0000			
SSP1ADD	020A	_	_	_	-	-	_	_	_	 MSSP1 Address Register (I²C™ Slave Mode) MSSP1 Baud Rate Reload Register (I²C Master Mode) MSSP1 Address Mask Register (I²C Slave Mode) 											
SSP1MSK	020C	_	_	_	_	_	_	_	_	— MSSP1 Address Mask Register (I ² C Slave Mode)											
SSP2BUF ⁽¹⁾	0210	_	_	_	_	_	_	_	_			MSSP2 F	Receive Buff	er/Transmit	Register			00xx			
SSP2CON1 ⁽¹⁾	0212	_	_	_	_	_	_	_	_	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000			
SSP2CON2 ⁽¹⁾	0214	_	_	_	_	-	_	_	_	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000			
SSP2CON3 ⁽¹⁾	0216	_	_	_	_	-	_	_	_	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	0000			
SSP2STAT ⁽¹⁾	0218	_	_	_	_	-	_	_	_	010 015 00 0 00											
SSP2ADD ⁽¹⁾	021A	_	_	_			_	-	_	MSSP2 Address Register (I ² C Slave Mode) MSSP2 Baud Rate Reload Register (I ² C Master Mode)											
SSP2MSK ⁽¹⁾	021C	_		_	_		-	_		MOODS Address Mark Desister (20 Oleve Made)											

Note 1: These bits and/or registers are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X family devices; read as '0'.

TABLE 4-9: UART REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
U1MODE	0220	UARTEN	_	USIDL	IREN	RTSMD	1	UEN1	UEN0	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL1	PDSEL0	STSEL	0000
U1STA	0222	UTXISEL1	UTXINV	UTXISEL0	_	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL1	URXISEL0	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
U1TXREG	0224	-	WATER															xxxx
U1RXREG	0226	-																0000
U1BRG	0228							Baud Ra	te Generat	tor Prescaler	Register							0000
U2MODE	0230	UARTEN		USIDL	IREN	RTSMD	-	UEN1	UEN0	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL1	PDSEL0	STSEL	0000
U2STA	0232	UTXISEL1	UTXINV	UTXISEL0	_	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL1	URXISEL0	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
U2TXREG	0234	-		_	_	_	-	-				UART2	Transmit R	egister				xxxx
U2RXREG	0236	_	_	_	_	_	_	_				UART2	Receive Re	egister				0000
U2BRG	0238							Baud Ra	te Generat	tor Prescaler	Register							0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7 ⁽¹⁾	Bit 6	Bit 5 ⁽²⁾	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
02C0	-	-	_	_	_	_	_	_	TRISA7	TRISA6	_	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	00DF
02C2	-	-	_	_	_	_	_	_	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0	xxxx
02C4	-	-	_	_	_	_	_	_	LATA7	LATA6	_	LATA4	LATA3	LATA2	LATA1	LATA0	xxxx
02C6	_	_	_	_	_	_	-	ı	ODA7	ODA6	_	ODA4	ODA3	ODA2	ODA1	ODA0	0000
	02C0 02C2 02C4	02C0 — 02C2 — 02C4 —	02C0 — — — 02C2 — — — 02C4 — —	02C0 — — — — — — — — — — — — — — — — — — —	02C0 — — — — — — — — — — — — — — — — — — —	02C0 — — — — — — — — — — — — — — — — — — —	02C0 — — — — — — — — — — — — — — — — — — —	02C0 — — — — — 02C2 — — — — — 02C4 — — — — —	02C0 — — — — — 02C2 — — — — — 02C4 — — — — —	02C0 — — — — — TRISA7 02C2 — — — — — RA7 02C4 — — — — — LATA7	02C0 — — — — — TRISA7 TRISA6 02C2 — — — — — RA7 RA6 02C4 — — — — — LATA7 LATA6	02C0 — — — — — TRISA7 TRISA6 — 02C2 — — — — — RA7 RA6 RA5 02C4 — — — — — LATA7 LATA6 —	02C0 — — — — — TRISA7 TRISA6 — TRISA4 02C2 — — — — — RA7 RA6 RA5 RA4 02C4 — — — — — LATA7 LATA6 — LATA4	02C0 — — — — — TRISA7 TRISA6 — TRISA4 TRISA3 02C2 — — — — — — RA7 RA6 RA5 RA4 RA3 02C4 — — — — — LATA6 — LATA4 LATA3	02C0 — — — — — TRISA7 TRISA6 — TRISA3 TRISA2 02C2 — — — — — RA7 RA6 RA5 RA4 RA3 RA2 02C4 — — — — — LATA7 LATA6 — LATA4 LATA3 LATA2	02C0 — — — — — TRISA7 TRISA6 — TRISA4 TRISA3 TRISA2 TRISA1 02C2 — — — — — RA7 RA6 RA5 RA4 RA3 RA2 RA1 02C4 — — — — — LATA6 — LATA4 LATA3 LATA2 LATA1	02C0 — — — — — TRISA7 TRISA6 — TRISA3 TRISA2 TRISA1 TRISA0 02C2 — — — — — RA7 RA6 RA5 RA4 RA3 RA2 RA1 RA0 02C4 — — — — — LATA6 — LATA4 LATA3 LATA2 LATA1 LATA0

Note 1: These ports and their associated bits are unimplemented on 14-pin and 20-pin devices; read as '0'.

2: PORTA<5> is unavailable when \overline{MCLR} functionality is enabled (MCLRE Configuration bit = 1).

TABLE 4-11: PORTB REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13 ⁽¹⁾	Bit 12 ⁽¹⁾	Bit 11 ⁽²⁾	Bit 10 ⁽²⁾	Bit 9	Bit 8	Bit 7 ⁽¹⁾	Bit 6 ⁽²⁾	Bit 5 ⁽²⁾	Bit 4	Bit 3 ⁽²⁾	Bit 2 ⁽¹⁾	Bit 1 ⁽¹⁾	Bit 0	All Resets
TRISB	02C8	TRISB15	TRISB14	TRISB13	TRISB12	TRISB11	TRISB10	TRISB9	TRISB8	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	FFFF
PORTB	02CA	RB15	RB14	RB13	RB12	RB11	RB10	RB9	RB8	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx
LATB	02CC	LATB15	LATB14	LATB13	LATB12	LATB11	LATB10	LATB9	LATB8	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	xxxx
ODCB	02CE	ODB15	ODB14	ODB13	ODB12	ODB11	ODB10	ODB9	ODB8	ODB7	ODB6	ODB5	ODB4	ODB3	ODB2	ODB1	ODB0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These ports and their associated bits are unimplemented on 14-pin and 20-pin devices.

2: These ports and their associated bits are unimplemented in 14-pin devices.

TABLE 4-12: PAD CONFIGURATION REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PADCFG1	02FC	-	_	_	_	SDO2DIS ⁽¹⁾	SCK2DIS ⁽¹⁾	SDO1DIS	SCK1DIS	_	_	1	-	1	1	_	1	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X family devices; read as '0'.

TABLE 4-13: A/D REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
ADC1BUF0	0300								A/D B	uffer 0								xxxx
ADC1BUF1	0302								A/D B	uffer 1								xxxx
AD1CON1	0320	ADON	_	ADSIDL	_	-	_	FORM1	FORM0	SSRC2	SSRC1	SSRC0	-	-	ASAM	SAMP	DONE	0000
AD1CON2	0322	VCFG2	VCFG1	VCFG0	OFFCAL	-	CSCNA	-	_	-	ı	SMPI3	SMPI2	SMPI1	SMPI0	BUFM	ALTS	0000
AD1CON3	0324	ADRC	EXTSAM	PUMPEN	SAMC4	SAMC3	SAMC2	SAMC1	SAMC0	-	ı	ADCS5	ADCS4	ADCS3	ADCS2	ADCS1	ADCS0	0000
AD1CHS	0328	CH0NB	_	_	_	CH0SB3	CH0SB2	CH0SB1	CH0SB0	CH0NA				CH0SA3	CH0SA2	CH0SA1	CH0SA0	0000
AD1CSSL	0330	CSSL15	CSSL14	CSSL13	CSSL12 ⁽¹⁾	CSSL11 ⁽¹⁾	CSSL10	CSSL9	CSSL8	CSSL7	CSSL6	_	CSSL4 ⁽¹⁾	CSSL3 ⁽¹⁾	CSSL2 ⁽¹⁾	CSSL1	CSSL0	0000

PIC24F16KL402 FAMILY

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits are unimplemented in 14-pin devices; read as '0'.

TABLE 4-14: ANALOG SELECT REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
ANCFG	04DE	1	1	_	_	_	1	-	_	-	-	_	-	_	_	1	VBGEN	0000
ANSA	04E0	_	_	_	_	_	_	_	_	_	_	_	_	ANSA3	ANSA2	ANSA1	ANSA0	000F
ANSB	04E2	ANSB15	ANSB14	ANSB13	ANSB12 ⁽¹⁾	_	_	_	_	_	_	_	ANSB4	ANSB3 ⁽²⁾	ANSB2 ⁽¹⁾	ANSB1 ⁽¹⁾	ANSB0 ⁽¹⁾	F01F ⁽³⁾

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits are unimplemented in 14-pin devices; read as '0'.

2: These bits are unimplemented in 14-pin and 20-pin devices; read as '0'

3: Reset value for 28-pin devices is shown.

TABLE 4-15: COMPARATOR REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CMSTAT	0630	CMIDL	1	_	_	_	_	C2EVT ⁽¹⁾	C1EVT	_	_	-	1	_	_	C2OUT	C1OUT	xxxx
CVRCON	0632	-	-	_	_	_	_	_	_	CVREN	CVROE	CVRSS	CVR4	CVR3	CVR2	CVR1	CVR0	0000
CM1CON	0634	CON	COE	CPOL	CLPWR	_	_	CEVT	COUT	EVPOL1	EVPOL0	_	CREF	_	_	CCH1	CCH0	xxxx
CM2CON ⁽¹⁾	0636	CON	COE	CPOL	CLPWR	_	_	CEVT	COUT	EVPOL1	EVPOL0	_	CREF	_	_	CCH1	CCH0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits and/or registers are unimplemented in PIC24FXXKL10X/20X devices; read as '0'.

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RCON	0740	TRAPR	IOPUWR	SBOREN	_	-	-	CM	PMSLP	EXTR	SWR	SWDTEN	WDTO	SLEEP	IDLE	BOR	POR	(Note 1)
OSCCON	0742	_	COSC2	COSC1	COSC0	_	NOSC2	NOSC1	NOSC0	CLKLOCK	_	LOCK	_	CF	SOSCDRV	SOSCEN	OSWEN	(Note 2)
CLKDIV	0744	ROI	DOZE2	DOZE1	DOZE0	DOZEN	RCDIV2	RCDIV1	RCDIV0	_	_	_		_	_	_	_	3100
OSCTUN	0748	_	_	_	_	_	_	_	_	_	_	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0	0000
REFOCON	074E	ROEN	_	ROSSLP	ROSEL	RODIV3	RODIV2	RODIV1	RODIV0	_	_	_	_	_	_	_	_	0000
HLVDCON	0756	HLVDEN	_	HLSIDL	_	_	_	_	_	VDIR	BGVST	IRVST	_	HLVDL3	HLVDL2	HLVDL1	HLVDL0	0000

Note 1: RCON register Reset values are dependent on the type of Reset.

2: OSCCON register Reset values are dependent on configuration fuses and by type of Reset.

TABLE 4-17: NVM REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
NVMCON	0760	WR	WREN	WRERR	PGMONLY	_	-	_	_	_	ERASE	NVMOP5	NVMOP4	NVMOP3	NVMOP2	NVMOP1	NVMOP0	0000
NVMKEY	0766	_	-	_	_	_	_	_	_				NVM Key	Register				0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-18: ULTRA LOW-POWER WAKE-UP REGISTER MAP

	File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
ι	JLPWCON	0768	ULPEN	_	ULPSIDL	_	_	_	_	ULPSINK	_	_	_	_	_	_	_	_	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-19: PMD REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1	0770	_	T4MD	T3MD	T2MD	T1MD	_	_	_	SSP1MD	U2MD	U1MD	_	_		1	ADC1MD	0000
PMD2	0772	_	_	_	_	_	_	ı	_	_	ı	_	-	_	CCP3MD	CCP2MD	CCP1MD	0000
PMD3	0774	_	_	_	_	_	CMPMD	ı	_	_	ı	_	-	_	_	SSP2MD	ı	0000
PMD4	0776	_	_	_	_	_	_	_	_	ULPWUMD	_	_	EEMD	REFOMD	_	HLVDMD	_	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

4.2.5 SOFTWARE STACK

In addition to its use as a working register, the W15 register in PIC24F devices is also used as a Software Stack Pointer. The pointer always points to the first available free word and grows from lower to higher addresses. It predecrements for stack pops and post-increments for stack pushes, as shown in Figure 4-4.

Note that for a PC push during any CALL instruction, the MSB of the PC is zero-extended before the push, ensuring that the MSB is always clear.

Note: A PC push during exception processing will concatenate the SRL register to the MSB of the PC prior to the push.

The Stack Pointer Limit Value (SPLIM) register, associated with the Stack Pointer, sets an upper address boundary for the stack. SPLIM is uninitialized at Reset. As is the case for the Stack Pointer, SPLIM<0> is forced to '0' as all stack operations must be word-aligned. Whenever an EA is generated, using W15 as a source or destination pointer, the resulting address is compared with the value in SPLIM. If the contents of the Stack Pointer (W15) and the SPLIM register are equal, and a push operation is performed, a stack error trap will not occur. The stack error trap will occur on a subsequent push operation.

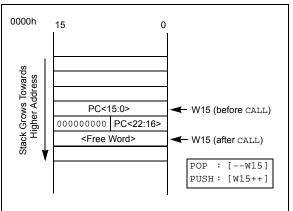
Thus, for example, if it is desirable to cause a stack error trap when the stack grows beyond address, 0DF6, in RAM, initialize the SPLIM with the value, 0DF4.

Similarly, a Stack Pointer underflow (stack error) trap is generated when the Stack Pointer address is found to be less than 0800h. This prevents the stack from interfering with the Special Function Register (SFR) space.

Note: A write to the SPLIM register should not be immediately followed by an indirect

read operation using W15.

FIGURE 4-4: CALL STACK FRAME



4.3 Interfacing Program and Data Memory Spaces

The PIC24F architecture uses a 24-bit wide program space and 16-bit wide data space. The architecture is also a modified Harvard scheme, meaning that data can also be present in the program space. To use this data successfully, it must be accessed in a way that preserves the alignment of information in both spaces.

Apart from the normal execution, the PIC24F architecture provides two methods by which the program space can be accessed during operation:

- Using table instructions to access individual bytes or words anywhere in the program space
- Remapping a portion of the program space into the data space, PSV

Table instructions allow an application to read or write small areas of the program memory. This makes the method ideal for accessing data tables that need to be updated from time to time. It also allows access to all bytes of the program word. The remapping method allows an application to access a large block of data on a read-only basis, which is ideal for look-ups from a large table of static data. It can only access the least significant word (lsw) of the program word.

4.3.1 ADDRESSING PROGRAM SPACE

Since the address ranges for the data and program spaces are 16 and 24 bits, respectively, a method is needed to create a 23-bit or 24-bit program address from 16-bit data registers. The solution depends on the interface method to be used.

For table operations, the 8-bit Table Memory Page Address register (TBLPAG) is used to define a 32K word region within the program space. This is concatenated with a 16-bit EA to arrive at a full 24-bit program space address. In this format, the Most Significant bit (MSb) of TBLPAG is used to determine if the operation occurs in the user memory (TBLPAG<7> = 0) or the configuration memory (TBLPAG<7> = 1).

For remapping operations, the 8-bit Program Space Visibility Page Address register (PSVPAG) is used to define a 16K word page in the program space. When the MSb of the EA is '1', PSVPAG is concatenated with the lower 15 bits of the EA to form a 23-bit program space address. Unlike the table operations, this limits remapping operations strictly to the user memory area.

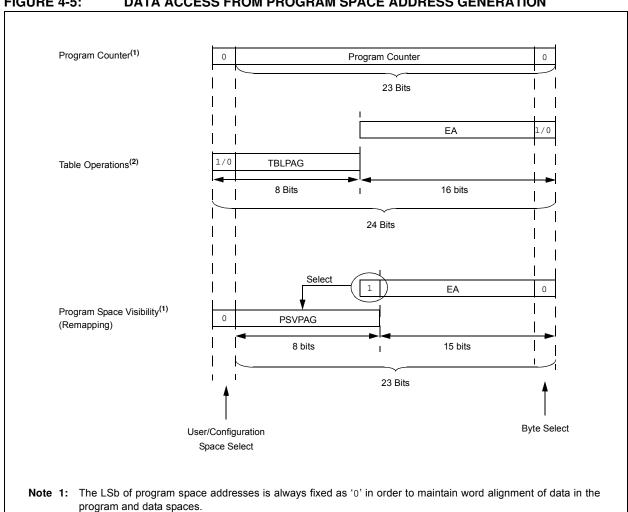
Table 4-20 and Figure 4-5 show how the program EA is created for table operations and remapping accesses from the data EA. Here, P<23:0> bits refer to a program space word, whereas the D<15:0> bits refer to a data space word.

PROGRAM SPACE ADDRESS CONSTRUCTION **TABLE 4-20:**

Access Type	Access	Program Space Address									
Access Type	Space	<23>	<22:16>	<15>	<14:1>	<0>					
Instruction Access	User	0		PC<22:1>		0					
(Code Execution)			0xx xxxx x	xxx xxxx	xxxx xxx0						
TBLRD/TBLWT	User	TB	LPAG<7:0>		Data EA<15:0>						
(Byte/Word Read/Write)		0:	xxx xxxx	xxxx xxxx xxxx xxxx							
	Configuration	TB	LPAG<7:0>	Data EA<15:0>							
		1:	xxx xxxx	XXX	x xxxx xxxx x	xxx					
Program Space Visibility	User	0	PSVPAG<7:	0> ⁽²⁾ Data EA<14		0>(1)					
(Block Remap/Read)		0	xxxx xxx	¢Χ	xxx xxxx xxxx xxx						

- Data EA<15> is always '1' in this case, but is not used in calculating the program space address. Bit 15 of Note 1: the address is PSVPAG<0>.
 - 2: PSVPAG can have only two values ('00' to access program memory and FF to access data EEPROM) on PIC24F16KL402 family devices.

FIGURE 4-5: DATA ACCESS FROM PROGRAM SPACE ADDRESS GENERATION



2: Table operations are not required to be word-aligned. Table read operations are permitted in the configuration

memory space.

4.3.2 DATA ACCESS FROM PROGRAM MEMORY AND DATA EEPROM MEMORY USING TABLE INSTRUCTIONS

The TBLRDL and TBLWTL instructions offer a direct method of reading or writing the lower word of any address within the program memory without going through data space. It also offers a direct method of reading or writing a word of any address within data EEPROM memory. The TBLRDH and TBLWTH instructions are the only method to read or write the upper 8 bits of a program space word as data.

Note: The TBLRDH and TBLWTH instructions are not used while accessing data EEPROM memory.

The PC is incremented by two for each successive 24-bit program word. This allows program memory addresses to directly map to data space addresses. Program memory can thus be regarded as two, 16-bit word-wide address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space which contains the least significant data word, and TBLRDH and TBLWTH access the space which contains the upper data byte.

Two table instructions are provided to move byte or word-sized (16-bit) data to and from program space. Both function as either byte or word operations.

 TBLRDL (Table Read Low): In Word mode, it maps the lower word of the program space location (P<15:0>) to a data address (D<15:0>).

- In Byte mode, either the upper or lower byte of the lower program word is mapped to the lower byte of a data address. The upper byte is selected when the byte select is '1'; the lower byte is selected when it is '0'.
- TBLRDH (Table Read High): In Word mode, it maps the entire upper word of a program address (P<23:16>) to a data address. Note that D<15:8>, the 'phantom' byte, will always be '0'.

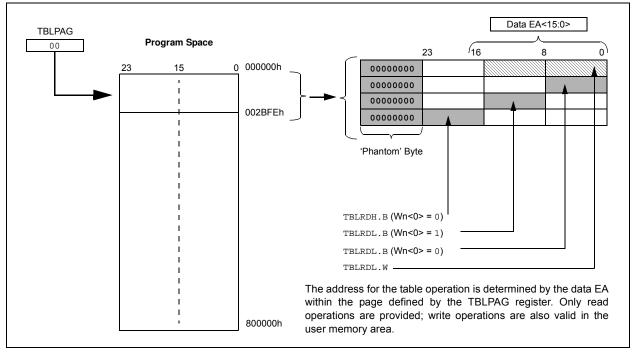
In Byte mode, it maps the upper or lower byte of the program word to D<7:0> of the data address, as above. Note that the data will always be '0' when the upper 'phantom' byte is selected (byte select = 1).

In a similar fashion, two table instructions, TBLWTH and TBLWTL, are used to write individual bytes or words to a program space address. The details of their operation are explained in Section 5.0 "Flash Program Memory".

For all table operations, the area of program memory space to be accessed is determined by the Table Memory Page Address register (TBLPAG). TBLPAG covers the entire program memory space of the device, including user and configuration spaces. When TBLPAG<7> = 0, the table page is located in the user memory space. When TBLPAG<7> = 1, the page is located in configuration space.

Note: Only table read operations will execute in the configuration memory space, and only then, in implemented areas, such as the Device ID. Table write operations are not allowed.

FIGURE 4-6: ACCESSING PROGRAM MEMORY WITH TABLE INSTRUCTIONS



4.3.3 READING DATA FROM PROGRAM MEMORY USING PROGRAM SPACE VISIBILITY

The upper 32 Kbytes of data space may optionally be mapped into a 16K word page of the program space. This provides transparent access of stored constant data from the data space without the need to use special instructions (i.e., TBLRDL/H).

Program space access through the data space occurs if the MSb of the data space EA is '1' and PSV is enabled by setting the PSV bit in the CPU Control (CORCON<2>) register. The location of the program memory space to be mapped into the data space is determined by the Program Space Visibility Page Address (PSVPAG) register. This 8-bit register defines any one of 256 possible pages of 16K words in program space. In effect, PSVPAG functions as the upper 8 bits of the program memory address, with 15 bits of the EA functioning as the lower bits.

By incrementing the PC by 2 for each program memory word, the lower 15 bits of data space addresses directly map to the lower 15 bits in the corresponding program space addresses.

Data reads from this area add an additional cycle to the instruction being executed, since two program memory fetches are required.

Although each data space address, 8000h and higher, maps directly into a corresponding program memory address (see Figure 4-7), only the lower 16 bits of the 24-bit program word are used to contain the data. The upper 8 bits of any program space location, used as data, should be programmed with '1111 1111' or '0000 0000' to force a NOP. This prevents possible issues should the area of code ever be accidentally executed.

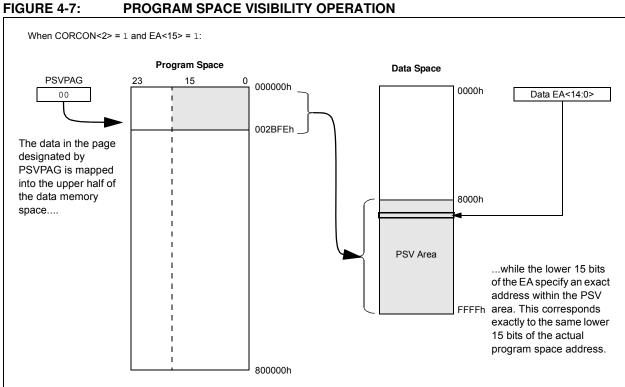
Note: PSV access is temporarily disabled during table reads/writes.

For operations that use PSV and are executed outside of a REPEAT loop, the MOV and MOV.D instructions will require one instruction cycle, in addition to the specified execution time. All other instructions will require two instruction cycles in addition to the specified execution

For operations that use PSV, which are executed inside a REPEAT loop, there will be some instances that require two instruction cycles, in addition to the specified execution time of the instruction:

- · Execution in the first iteration
- · Execution in the last iteration
- Execution prior to exiting the loop due to an interrupt
- · Execution upon re-entering the loop after an interrupt is serviced

Any other iteration of the REPEAT loop will allow the instruction accessing data, using PSV, to execute in a single cycle.



5.0 **FLASH PROGRAM MEMORY**

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on Flash Programming, refer to the "PIC24F Family Reference Manual", Section 4. "Program Memory" (DS39715).

The PIC24F16KL402 family of devices contains internal Flash program memory for storing and executing application code. The memory is readable, writable and erasable when operating with VDD over 1.8V.

Flash memory can be programmed in three ways:

- In-Circuit Serial Programming™ (ICSP™)
- Run-Time Self Programming (RTSP)
- · Enhanced In-Circuit Serial Programming (Enhanced ICSP)

ICSP allows a PIC24F device to be serially programmed while in the end application circuit. This is simply done with two lines for the programming clock and programming data (which are named PGECx and PGEDx, respectively), and three other lines for power (VDD), ground (Vss) and Master Clear/Program mode Entry Voltage (MCLR/VPP). This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or custom firmware to be programmed.

Run-Time Self Programming (RTSP) is accomplished using TBLRD (table read) and TBLWT (table write) instructions. With RTSP, the user may write program memory data in blocks of 32 instructions (96 bytes) at a time, and erase program memory in blocks of 32, 64 and 128 instructions (96,192 and 384 bytes) at a time.

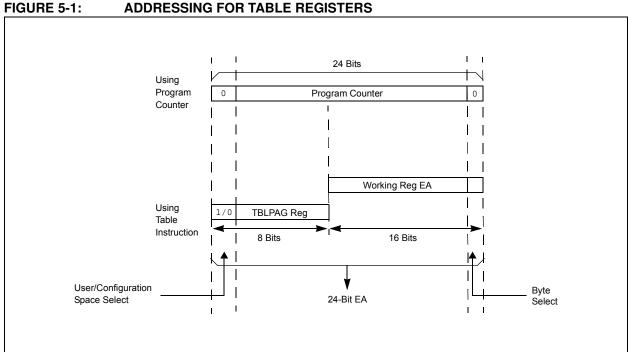
The NVMOP<1:0> (NVMCON<1:0>) bits decide the erase block size.

5.1 Table Instructions and Flash **Programming**

Regardless of the method used, Flash memory programming is done with the table read and write instructions. These allow direct read and write access to the program memory space from the data memory while the device is in normal operating mode. The 24-bit target address in the program memory is formed using the TBLPAG<7:0> bits and the Effective Address (EA) from a W register, specified in the table instruction, as depicted in Figure 5-1.

The TBLRDL and TBLWTL instructions are used to read or write to bits<15:0> of program memory. TBLRDL and TBLWTL can access program memory in both Word and Byte modes.

The TBLRDH and TBLWTH instructions are used to read or write to bits<23:16> of program memory. TBLRDH and TBLWTH can also access program memory in Word or Byte mode.



5.2 RTSP Operation

The PIC24F Flash program memory array is organized into rows of 32 instructions or 96 bytes. RTSP allows the user to erase blocks of 1 row, 2 rows and 4 rows (32, 64 and 128 instructions) at a time, and to program one row at a time.

The 1-row (96 bytes), 2-row (192 bytes) and 4-row (384 bytes) erase blocks and single row write block (96 bytes) are edge-aligned, from the beginning of program memory.

When data is written to program memory using TBLWT instructions, the data is not written directly to memory. Instead, data written using table writes is stored in holding latches until the programming sequence is executed.

Any number of TBLWT instructions can be executed and a write will be successfully performed. However, 32 TBLWT instructions are required to write the full row of memory.

The basic sequence for RTSP programming is to set up a Table Pointer, then do a series of TBLWT instructions to load the buffers. Programming is performed by setting the control bits in the NVMCON register.

Data can be loaded in any order and the holding registers can be written to multiple times before performing a write operation. Subsequent writes, however, will wipe out any previous writes.

Note: Writing to a location multiple times without erasing it is not recommended.

All of the table write operations are single-word writes (two instruction cycles), because only the buffers are written. A programming cycle is required for programming each row.

5.3 Enhanced In-Circuit Serial Programming

Enhanced ICSP uses an on-board bootloader, known as the program executive, to manage the programming process. Using an SPI data frame format, the program executive can erase, program and verify program memory. For more information on Enhanced ICSP, see the device programming specification.

5.4 Control Registers

There are two SFRs used to read and write the program Flash memory: NVMCON and NVMKEY.

The NVMCON register (Register 5-1) controls the blocks that need to be erased, which memory type is to be programmed and when the programming cycle starts.

NVMKEY is a write-only register that is used for write protection. To start a programming or erase sequence, the user must consecutively write 55h and AAh to the NVMKEY register. For more information, refer to Section 5.5 "Programming Operations".

5.5 Programming Operations

A complete programming sequence is necessary for programming or erasing the internal Flash in RTSP mode. During a programming or erase operation, the processor stalls (waits) until the operation is finished. Setting the WR bit (NVMCON<15>) starts the operation and the WR bit is automatically cleared when the operation is finished.

REGISTER 5-1: NVMCON: FLASH MEMORY CONTROL REGISTER

R/SO-0, HC	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
WR	WREN	WRERR	PGMONLY ⁽⁴⁾	_	_	_	_
bit 15			•				bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	ERASE	NVMOP5 ⁽¹⁾	NVMOP4 ⁽¹⁾	NVMOP3 ⁽¹⁾	NVMOP2 ⁽¹⁾	NVMOP1 ⁽¹⁾	NVMOP0 ⁽¹⁾
bit 7	,			•			bit 0

Legend:	SO = Settable Only bit	HC = Hardware Clearable b	pit
-n = Value at POR	'1' = Bit is set	R = Readable bit	W = Writable bit
'0' = Bit is cleared	x = Bit is unknown	U = Unimplemented bit, rea	d as '0'

- bit 15 WR: Write Control bit
 - 1 = Initiates a Flash memory program or erase operation. The operation is self-timed and the bit is cleared by hardware once the operation is complete.
 - 0 = Program or erase operation is complete and inactive
- bit 14 WREN: Write Enable bit
 - 1 = Enable Flash program/erase operations
 - 0 = Inhibit Flash program/erase operations
- bit 13 WRERR: Write Sequence Error Flag bit
 - 1 = An improper program or erase sequence attempt, or termination, has occurred (bit is set automatically on any set attempt of the WR bit)
 - 0 = The program or erase operation completed normally
- bit 12 **PGMONLY:** Program Only Enable bit⁽⁴⁾
- bit 11-7 Unimplemented: Read as '0'
- bit 6 **ERASE:** Erase/Program Enable bit
 - 1 = Perform the erase operation specified by NVMOP<5:0> on the next WR command
 - 0 = Perform the program operation specified by NVMOP<5:0> on the next WR command
- bit 5-0 **NVMOP<5:0>:** Programming Operation Command Byte bits⁽¹⁾

Erase operations (when ERASE bit is '1'):

- 1010xx = Erase entire boot block (including code-protected boot block)⁽²⁾
- 1001xx = Erase entire memory (including boot block, configuration block, general block)⁽²⁾
- 011010 = Erase 4 rows of Flash memory (3)
- 011001 = Erase 2 rows of Flash memory(3)
- 011000 = Erase 1 row of Flash memory (3)
- 0101xx = Erase entire configuration block (except code protection bits)
- 0100xx = Erase entire data EEPROM⁽⁴⁾
- 0011xx = Erase entire general memory block programming operations
- 0001xx = Write 1 row of Flash memory (when ERASE bit is '0')⁽³⁾
- **Note 1:** All other combinations of the NVMOP<5:0> bits are no operation.
 - 2: Available in ICSP™ mode only. Refer to the device programming specification.
 - 3: The address in the Table Pointer decides which rows will be erased.
 - 4: This bit is used only while accessing data EEPROM. It is implemented only in devices with data EEPROM.

5.5.1 PROGRAMMING ALGORITHM FOR FLASH PROGRAM MEMORY

The user can program one row of Flash program memory at a time by erasing the programmable row. The general process is as follows:

- Read a row of program memory (32 instructions) and store in data RAM.
- 2. Update the program data in RAM with the desired new data.
- 3. Erase a row (see Example 5-1):
 - a) Set the NVMOP bits (NVMCON<5:0>) to '011000' to configure for row erase. Set the ERASE (NVMCON<6>) and WREN (NVMCON<14>) bits.
 - Write the starting address of the block to be erased into the TBLPAG and W registers.
 - c) Write 55h to NVMKEY.
 - d) Write AAh to NVMKEY.
 - e) Set the WR bit (NVMCON<15>). The erase cycle begins and the CPU stalls for the duration of the erase cycle. When the erase is done, the WR bit is cleared automatically.

- 4. Write the first 32 instructions from data RAM into the program memory buffers (see Example 5-1).
- 5. Write the program block to Flash memory:
 - Set the NVMOP bits to '000100' to configure for row programming. Clear the ERASE bit and set the WREN bit.
 - b) Write 55h to NVMKEY.
 - c) Write AAh to NVMKEY.
 - d) Set the WR bit. The programming cycle begins and the CPU stalls for the duration of the write cycle. When the write to Flash memory is done, the WR bit is cleared automatically.

For protection against accidental operations, the write initiate sequence for NVMKEY must be used to allow any erase or program operation to proceed. After the programming command has been executed, the user must wait for the programming time until programming is complete. The two instructions following the start of the programming sequence should be NOPS, as shown in Example 5-5.

EXAMPLE 5-1: ERASING A PROGRAM MEMORY ROW – ASSEMBLY LANGUAGE CODE

```
; Set up NVMCON for row erase operation
       MOV
              #0x4058, W0
       MOV
              W0, NVMCON
                                             ; Initialize NVMCON
; Init pointer to row to be ERASED
       MOV
               #tblpage(PROG_ADDR), W0
       MOV
               WO, TBLPAG
                                             ; Initialize PM Page Boundary SFR
                                            ; Initialize in-page EA[15:0] pointer
       MOV
               #tbloffset(PROG_ADDR), W0
       TBLWTL W0, [W0]
                                             ; Set base address of erase block
              #5
                                             ; Block all interrupts
       DISI
                                               for next 5 instructions
       MOV
               #0x55, W0
       MOV
              WO, NVMKEY
                                             ; Write the 55 key
               #0xAA, W1
       MOV
       MOV
               W1, NVMKEY
                                             ; Write the AA key
              NVMCON, #WR
                                             ; Start the erase sequence
       BSET
       NOP
                                             ; Insert two NOPs after the erase
       NOP
                                             ; command is asserted
```

EXAMPLE 5-2: ERASING A PROGRAM MEMORY ROW – 'C' LANGUAGE CODE

```
// C example using MPLAB C30
 int __attribute__ ((space(auto_psv))) progAddr = &progAddr; // Global variable located in Pgm Memory
 unsigned int offset;
//Set up pointer to the first memory location to be written
 TBLPAG = __builtin_tblpage(&progAddr);
                                                             // Initialize PM Page Boundary SFR
 offset = &progAddr & 0xFFFF;
                                                              // Initialize lower word of address
 __builtin_tblwtl(offset, 0x0000);
                                                             // Set base address of erase block
                                                              // with dummy latch write
 NVMCON = 0x4058;
                                                              // Initialize NVMCON
 asm("DISI #5");
                                                              // Block all interrupts for next 5
                                                              // instructions
                                                              // C30 function to perform unlock
 __builtin_write_NVM();
                                                              // sequence and set WR
```

EXAMPLE 5-3: LOADING THE WRITE BUFFERS – ASSEMBLY LANGUAGE CODE

```
; Set up NVMCON for row programming operations
      MOV #0x4004, W0
             W0, NVMCON
                                         ; Initialize NVMCON
      MOV
; Set up a pointer to the first program memory location to be written
; program memory selected, and writes enabled
      MOV #0x0000, W0
      MOV
             W0, TBLPAG
                                          ; Initialize PM Page Boundary SFR
           #0x6000, W0
      MOV
                                         ; An example program memory address
; Perform the TBLWT instructions to write the latches
; 0th_program_word
           #LOW_WORD_0, W2
      MOV
      MOV #HIGH_BYTE_0, W3
      TBLWTL W2, [W0]
                                        ; Write PM low word into program latch
      TBLWTH W3, [W0++]
                                         ; Write PM high byte into program latch
; 1st_program_word
      MOV
            #LOW_WORD_1, W2
           #HIGH_BYTE_1, W3
      MOV
      TBLWTL W2, [W0]
                                         ; Write PM low word into program latch
      TBLWTH W3, [W0++]
                                         ; Write PM high byte into program latch
 2nd_program_word
           #LOW_WORD_2, W2
      MOV
                                          ;
                                         ;
      MOV
            #HIGH_BYTE_2, W3
      TBLWTL W2, [W0]
                                         ; Write PM low word into program latch
      TBLWTH W3, [W0++]
                                          ; Write PM high byte into program latch
; 32nd_program_word
      MOV #LOW_WORD_31, W2
      MOV #HIGH_BYTE_31, W3
      TBLWTL W2, [W0]
                                         ; Write PM low word into program latch
      TBLWTH W3, [W0]
                                          ; Write PM high byte into program latch
```

EXAMPLE 5-4: LOADING THE WRITE BUFFERS – 'C' LANGUAGE CODE

```
// C example using MPLAB C30
  #define NUM_INSTRUCTION_PER_ROW 64
  int __attribute__ ((space(auto_psv))) progAddr = &progAddr; // Global variable located in Pgm Memory
  unsigned int offset;
  unsigned int i;
  unsigned int progData[2*NUM_INSTRUCTION_PER_ROW];
                                                    // Buffer of data to write
  //Set up NVMCON for row programming
  NVMCON = 0x4004;
                                                            // Initialize NVMCON
  //Set up pointer to the first memory location to be written
  TBLPAG = __builtin_tblpage(&progAddr);
                                                          // Initialize PM Page Boundary SFR
  offset = &progAddr & 0xFFFF;
                                                            // Initialize lower word of address
  //Perform TBLWT instructions to write necessary number of latches
  for(i=0; i < 2*NUM_INSTRUCTION_PER_ROW; i++)</pre>
       _builtin_tblwtl(offset, progData[i++]);
                                                           // Write to address low word
      __builtin_tblwth(offset, progData[i]);
                                                           // Write to upper byte
      offset = offset + 2;
                                                            // Increment address
  }
```

EXAMPLE 5-5: INITIATING A PROGRAMMING SEQUENCE – ASSEMBLY LANGUAGE CODE

```
DISI
                                ; Block all interrupts
                                  for next 5 instructions
MOV
       #0x55, W0
MOV
       WO, NVMKEY
                                ; Write the 55 key
       #0xAA, W1
MOV
MOV
       W1, NVMKEY
                               ; Write the AA key
      NVMCON, #WR
BSET
                               ; Start the erase sequence
NOP
                                ; 2 NOPs required after setting WR
NOP
BTSC
     NVMCON, #15
                                ; Wait for the sequence to be completed
BRA
       $-2
```

EXAMPLE 5-6: INITIATING A PROGRAMMING SEQUENCE - 'C' LANGUAGE CODE

6.0 DATA EEPROM MEMORY

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on Data EEPROM, refer to the "PIC24F Family Reference Manual", Section 5. "Data EEPROM" (DS39720).

The data EEPROM memory is a Nonvolatile Memory (NVM), separate from the program and volatile data RAM. Data EEPROM memory is based on the same Flash technology as program memory, and is optimized for both long retention and a higher number of erase/write cycles.

The data EEPROM is mapped to the top of the user program memory space, with the top address at program memory address, 7FFFFFh. For PIC24FXXKL4XX devices, the size of the data EEPROM is 256 words (7FFE00h to 7FFFFFh). For PIC24FXXKL3XX devices, the size of the data EEPROM is 128 words (7FFF00h to 7FFFFFh). The data EEPROM is not implemented in PIC24F08KL20X or PIC24F04KL10X devices.

The data EEPROM is organized as 16-bit wide memory. Each word is directly addressable, and is readable and writable during normal operation over the entire VDD range.

Unlike the Flash program memory, normal program execution is not stopped during a data EEPROM program or erase operation.

The data EEPROM programming operations are controlled using the three NVM Control registers:

- NVMCON: Nonvolatile Memory Control Register
- · NVMKEY: Nonvolatile Memory Key Register
- NVMADR: Nonvolatile Memory Address Register

6.1 NVMCON Register

The NVMCON register (Register 6-1) is also the primary control register for data EEPROM program/erase operations. The upper byte contains the control bits used to start the program or erase cycle, and the flag bit to indicate if the operation was successfully performed. The lower byte of NVMCOM configures the type of NVM operation that will be performed.

6.2 NVMKEY Register

The NVMKEY is a write-only register that is used to prevent accidental writes or erasures of data EEPROM locations.

To start any programming or erase sequence, the following instructions must be executed first, in the exact order provided:

- 1. Write 55h to NVMKEY.
- 2. Write AAh to NVMKEY.

After this sequence, a write will be allowed to the NVMCON register for one instruction cycle. In most cases, the user will simply need to set the WR bit in the NVMCON register to start the program or erase cycle. Interrupts should be disabled during the unlock sequence.

The MPLAB® C30 C compiler provides a defined library procedure (builtin_write_NVM) to perform the unlock sequence. Example 6-1 illustrates how the unlock sequence can be performed with in-line assembly.

EXAMPLE 6-1: DATA EEPROM UNLOCK SEQUENCE

```
//Disable Interrupts For 5 instructions
asm volatile("disi #5");
//Issue Unlock Sequence
asm volatile("mov #0x55, W0
                                   \n"
                                   \n"
           "mov W0, NVMKEY
                                   \n"
           "mov #0xAA, W1
           "mov W1, NVMKEY
                                   \n");
// Perform Write/Erase operations
asm volatile ("bset NVMCON, #WR
                                   \n"
           "nop
                                   \n"
           "nop
                                   \n");
```

REGISTER 6-1: NVMCON: NONVOLATILE MEMORY CONTROL REGISTER

R/S-0, HC	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
WR	WREN	WRERR	PGMONLY	_	_	_	_
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	ERASE	NVMOP5 ⁽¹⁾	NVMOP4 ⁽¹⁾	NVMOP3 ⁽¹⁾	NVMOP2 ⁽¹⁾	NVMOP1 ⁽¹⁾	NVMOP0 ⁽¹⁾
bit 7							bit 0

Legend:	HC = Hardware Clearable	U = Unimplemented bit, read	d as '0'
R = Readable bit	W = Writable bit	S = Settable bit	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 WR: Write Control bit (program or erase)

1 = Initiates a data EEPROM erase or write cycle (can be set but not cleared in software)

0 = Write cycle is complete (cleared automatically by hardware)

bit 14 WREN: Write Enable bit (erase or program)

1 = Enable an erase or program operation

0 = No operation allowed (device clears this bit on completion of the write/erase operation)

bit 13 WRERR: Flash Error Flag bit

1 = A write operation is prematurely terminated (any \overline{MCLR} or WDT Reset during programming operation)

0 = The write operation completed successfully

bit 12 **PGMONLY:** Program Only Enable bit

1 = Write operation is executed without erasing target address(es) first

0 = Automatic erase-before-write. Write operations are preceded automatically by an erase of target address(es).

bit 11-7 **Unimplemented:** Read as '0'

bit 6 **ERASE:** Erase Operation Select bit

1 = Perform an erase operation when WR is set

0 = Perform a write operation when WR is set

bit 5-0 **NVMOP<5:0>:** Programming Operation Command Byte bits⁽¹⁾

Erase Operations (when ERASE bit is '1'):

011010 = Erase 8 words

011001 = Erase 4 words

011000 = Erase 1 word

0100xx = Erase entire data EEPROM

Programming Operations (when ERASE bit is 'o'):

001xxx = Write 1 word

Note 1: These NVMOP configurations are unimplemented on PIC24F04KL10X and PIC24F08KL20X devices.

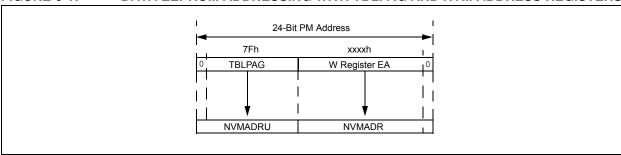
6.3 NVM Address Register

As with Flash program memory, the NVM Address Registers, NVMADRU and NVMADR, form the 24-bit Effective Address (EA) of the selected row or word for data EEPROM operations. The NVMADRU register is used to hold the upper 8 bits of the EA, while the NVMADR register is used to hold the lower 16 bits of the EA. These registers are not mapped into the Special Function Register (SFR) space; instead, they directly capture the EA<23:0> of the last table write instruction that has been executed and selects the data EEPROM row to erase. Figure 6-1 depicts the program memory EA that is formed for programming and erase operations.

Like program memory operations, the Least Significant bit (LSb) of NVMADR is restricted to even addresses. This is because any given address in the data EEPROM space consists of only the lower word of the program memory width; the upper word, including the uppermost "phantom byte", is unavailable. This means that the LSb of a data EEPROM address will always be '0'.

Similarly, the Most Significant bit (MSb) of NVMADRU is always '0', since all addresses lie in the user program space.

FIGURE 6-1: DATA EEPROM ADDRESSING WITH TBLPAG AND NVM ADDRESS REGISTERS



6.4 Data EEPROM Operations

The EEPROM block is accessed using table read and write operations, similar to those used for program memory. The TBLWTH and TBLRDH instructions are not required for data EEPROM operations since the memory is only 16 bits wide (data on the lower address is valid only). The following programming operations can be performed on the data EEPROM:

- · Erase one, four or eight words
- · Bulk erase the entire data EEPROM
- · Write one word
- · Read one word

Note:

Unexpected results will be obtained if the user attempts to read the EEPROM while a programming or erase operation is underway.

The C30 C compiler includes library procedures to automatically perform the table read and table write operations, manage the Table Pointer and write buffers, and unlock and initiate memory write sequences. This eliminates the need to create assembler macros or time critical routines in C for each application.

The library procedures are used in the code examples detailed in the following sections. General descriptions of each process are provided for users who are not using the C30 compiler libraries.

6.4.1 ERASE DATA EEPROM

The data EEPROM can be fully erased, or can be partially erased, at three different sizes: one word, four words or eight words. The bits, NVMOP<1:0> (NVMCON<1:0>), decide the number of words to be erased. To erase partially from the data EEPROM, the following sequence must be followed:

- 1. Configure NVMCON to erase the required number of words: one, four or eight.
- Load TBLPAG and WREG with the EEPROM address to be erased.
- Clear NVMIF status bit and enable the NVM interrupt (optional).
- 4. Write the key sequence to NVMKEY.
- 5. Set the WR bit to begin erase cycle.
- Either poll the WR bit or wait for the NVM interrupt (NVMIF is set).

A typical erase sequence is provided in Example 6-2. This example shows how to do a one-word erase. Similarly, a four-word erase and an eight-word erase can be done. This example uses C library procedures to manage the Table Pointer (builtin_tblpage and builtin_tbloffset) and the Erase Page Pointer (builtin_tblwtl). The memory unlock sequence (builtin_write_NVM) also sets the WR bit to initiate the operation and returns control when complete.

EXAMPLE 6-2: SINGLE-WORD ERASE

```
int __attribute__ ((space(eedata))) eeData = 0x1234; // Global variable located in EEPROM
   unsigned int offset;
   // Set up NVMCON to erase one word of data EEPROM
   NVMCON = 0x4058;
   // Set up a pointer to the EEPROM location to be erased
   offset = __builtin_tbloffset(&eeData);
                                              // Initizlize lower word of address
   __builtin_tblwtl(offset, 0);
                                              // Write EEPROM data to write latch
   asm volatile ("disi #5");
                                              // Disable Interrupts For 5 Instructions
   __builtin_write_NVM();
                                              // Issue Unlock Sequence & Start Write Cycle
   while(NVMCONbits.WR=1);
                                              // Optional: Poll WR bit to wait for
                                               // write sequence to complete
```

6.4.1.1 Data EEPROM Bulk Erase

To erase the entire data EEPROM (bulk erase), the address registers do not need to be configured because this operation affects the entire data EEPROM. The following sequence helps in performing a bulk erase:

- 1. Configure NVMCON to Bulk Erase mode.
- 2. Clear NVMIF status bit and enable NVM interrupt (optional).
- 3. Write the key sequence to NVMKEY.
- 4. Set the WR bit to begin erase cycle.
- 5. Either poll the WR bit or wait for the NVM interrupt (NVMIF is set).

A typical bulk erase sequence is provided in Example 6-3.

6.4.2 SINGLE-WORD WRITE

To write a single word in the data EEPROM, the following sequence must be followed:

- Erase one data EEPROM word (as mentioned in Section 6.4.1, Erase Data EEPROM) if PGMONLY bit (NVMCON<12>) is set to '1'.
- Write the data word into the data EEPROM latch.
- 3. Program the data word into the EEPROM:
 - Configure the NVMCON register to program one EEPROM word (NVMCON<5:0> = 0001xx).
 - Clear NVMIF status bit and enable NVM interrupt (optional).
 - Write the key sequence to NVMKEY.
 - Set the WR bit to begin erase cycle.
 - Either poll the WR bit or wait for the NVM interrupt (NVMIF set).
 - To get cleared, wait until NVMIF is set.

A typical single-word write sequence is provided in Example 6-4.

EXAMPLE 6-3: DATA EEPROM BULK ERASE

```
// Set up NVMCON to bulk erase the data EEPROM
NVMCON = 0x4050;

// Disable Interrupts For 5 Instructions
asm volatile ("disi #5");

// Issue Unlock Sequence and Start Erase Cycle
__builtin_write_NVM();
```

EXAMPLE 6-4: SINGLE-WORD WRITE TO DATA EEPROM

```
int __attribute__ ((space(eedata))) eeData = 0x1234;
                                                     // Global variable located in EEPROM
  int newData;
                                                     // New data to write to EEPROM
  unsigned int offset;
  // Set up NVMCON to erase one word of data EEPROM
  NVMCON = 0x4004;
  // Set up a pointer to the EEPROM location to be erased
  TBLPAG = __builtin_tblpage(&eeData); // Initialize EE Data page pointer
  offset = __builtin_tbloffset(&eeData);
                                                    // Initizlize lower word of address
  __builtin_tblwtl(offset, newData);
                                                     // Write EEPROM data to write latch
  asm volatile ("disi #5");
                                                     // Disable Interrupts For 5 Instructions
   _builtin_write_NVM();
                                                     // Issue Unlock Sequence & Start Write Cycle
  while(NVMCONbits.WR=1);
                                                     // Optional: Poll WR bit to wait for
                                                     // write sequence to complete
```

6.4.3 READING THE DATA EEPROM

To read a word from data EEPROM, the table read instruction is used. Since the EEPROM array is only 16 bits wide, only the TBLRDL instruction is needed. The read operation is performed by loading TBLPAG and WREG with the address of the EEPROM location followed by a TBLRDL instruction.

A typical read sequence, using the Table Pointer management (builtin_tblpage and builtin_tbloffset) and table read (builtin_tblrdl) procedures from the C30 compiler library, is provided in Example 6-5.

Program Space Visibility (PSV) can also be used to read locations in the data EEPROM.

EXAMPLE 6-5: READING THE DATA EEPROM USING THE TBLRD COMMAND

7.0 RESETS

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on Resets, refer to the "PIC24F Family Reference Manual", Section 40. "Reset with Programmable Brown-out Reset" (DS39728).

The Reset module combines all Reset sources and controls the device Master Reset Signal, SYSRST. The following is a list of device Reset sources:

POR: Power-on Reset
MCLR: Pin Reset
SWR: RESET Instruction

· WDTR: Watchdog Timer Reset

BOR: Brown-out ResetTRAPR: Trap Conflict Reset

IOPUWR: Illegal Opcode ResetUWR: Uninitialized W Register Reset

A simplified block diagram of the Reset module is shown in Figure 7-1.

Any active source of Reset will make the SYSRST signal active. Many registers associated with the CPU and peripherals are forced to a known Reset state. Most registers are unaffected by a Reset; their status is unknown on Power-on Reset (POR) and unchanged by all other Resets.

Note:

Refer to the specific peripheral or CPU section of this manual for register Reset states.

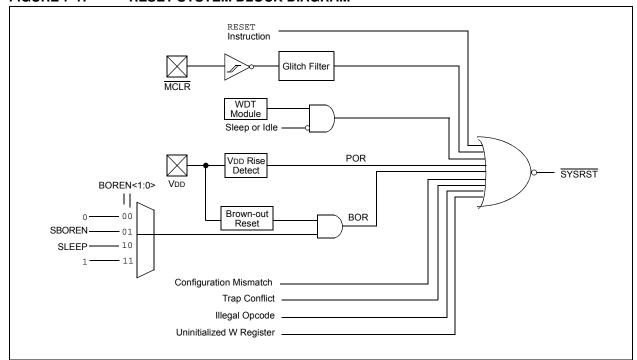
All types of device Reset will set a corresponding status bit in the RCON register to indicate the type of Reset (see Register 7-1). A POR will clear all bits except for the BOR and POR bits (RCON<1:0>) which are set. The user may set or clear any bit at any time during code execution. The RCON bits only serve as status bits. Setting a particular Reset status bit in software will not cause a device Reset to occur.

The RCON register also has other bits associated with the Watchdog Timer (WDT) and device power-saving states. The function of these bits is discussed in other sections of this manual.

Note:

The status bits in the RCON register should be cleared after they are read so that the next RCON register value, after a device Reset, will be meaningful.

FIGURE 7-1: RESET SYSTEM BLOCK DIAGRAM



REGISTER 7-1: RCON: RESET CONTROL REGISTER⁽¹⁾

R/W-0	R/W-0	R/W-0 ⁽³⁾	U-0	U-0	U-0	R/W-0	R/W-0
TRAPR	IOPUWR	SBOREN	_	_	-	СМ	PMSLP
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1	R/W-1
EXTR	SWR	SWDTEN ⁽²⁾	WDTO	SLEEP	IDLE	BOR	POR
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 TRAPR: Trap Reset Flag bit

1 = A Trap Conflict Reset has occurred0 = A Trap Conflict Reset has not occurred

bit 14 IOPUWR: Illegal Opcode or Uninitialized W Access Reset Flag bit

1 = An illegal opcode detection, an illegal address mode or an uninitialized W register is used as an

Address Pointer and caused a Reset

0 = An illegal opcode or uninitialized W Reset has not occurred

bit 13 SBOREN: Software Enable/Disable of BOR bit (3)

1 = BOR is turned on in software 0 = BOR is turned off in software

bit 12-10 **Unimplemented:** Read as '0'

bit 9 CM: Configuration Word Mismatch Reset Flag bit

1 = A Configuration Word Mismatch Reset has occurred

0 = A Configuration Word Mismatch Reset has not occurred

bit 8 PMSLP: Program Memory Power During Sleep bit

1 = Program memory bias voltage remains powered during Sleep

0 = Program memory bias voltage is powered down during Sleep

bit 7 **EXTR:** External Reset (MCLR) Pin bit

1 = A Master Clear (pin) Reset has occurred

0 = A Master Clear (pin) Reset has not occurred

bit 6 SWR: Software Reset (Instruction) Flag bit

1 = A RESET instruction has been executed

0 = A RESET instruction has not been executed

bit 5 **SWDTEN:** Software Enable/Disable of WDT bit⁽²⁾

1 = WDT is enabled

0 = WDT is disabled

bit 4 WDTO: Watchdog Timer Time-out Flag bit

1 = WDT time-out has occurred

0 = WDT time-out has not occurred

Note 1: All of the Reset status bits may be set or cleared in software. Setting one of these bits in software does not cause a device Reset.

- 2: If the FWDTEN Configuration bit is '1' (unprogrammed), the WDT is always enabled, regardless of the SWDTEN bit setting.
- **3:** The SBOREN bit is forced to '0' when disabled by the Configuration bits, BOREN<1:0> (FPOR<1:0>). When the Configuration bits are set to enable SBOREN, the default Reset state will be '1'.

REGISTER 7-1: RCON: RESET CONTROL REGISTER⁽¹⁾ (CONTINUED)

bit 3 SLEEP: Wake-up from Sleep Flag bit

1 = Device has been in Sleep mode

0 = Device has not been in Sleep mode

bit 2 IDLE: Wake-up from Idle Flag bit

1 = Device has been in Idle mode

0 = Device has not been in Idle mode

bit 1 **BOR:** Brown-out Reset Flag bit

1 = A Brown-out Reset has occurred (the BOR is also set after a POR)

0 = A Brown-out Reset has not occurred

bit 0 POR: Power-on Reset Flag bit

1 = A Power-up Reset has occurred

0 = A Power-up Reset has not occurred

Note 1: All of the Reset status bits may be set or cleared in software. Setting one of these bits in software does not cause a device Reset.

- 2: If the FWDTEN Configuration bit is '1' (unprogrammed), the WDT is always enabled, regardless of the SWDTEN bit setting.
- **3:** The SBOREN bit is forced to '0' when disabled by the Configuration bits, BOREN<1:0> (FPOR<1:0>). When the Configuration bits are set to enable SBOREN, the default Reset state will be '1'.

TABLE 7-1: RESET FLAG BIT OPERATION

Flag Bit	Setting Event	Clearing Event
TRAPR (RCON<15>)	Trap Conflict Event	POR
IOPUWR (RCON<14>)	Illegal Opcode or Uninitialized W Register Access	POR
CM (RCON<9>)	Configuration Mismatch Reset	POR
EXTR (RCON<7>)	MCLR Reset	POR
SWR (RCON<6>)	RESET Instruction	POR
WDTO (RCON<4>)	WDT Time-out	PWRSAV Instruction, POR
SLEEP (RCON<3>)	PWRSAV #SLEEP Instruction	POR
IDLE (RCON<2>)	PWRSAV #IDLE Instruction	POR
BOR (RCON<1>)	POR, BOR	_
POR (RCON<0>)	POR	_

Note: All Reset flag bits may be set or cleared by the user software.

7.1 Clock Source Selection at Reset

If clock switching is enabled, the system clock source at device Reset is chosen, as shown in Table 7-2. If clock switching is disabled, the system clock source is always selected according to the oscillator Configuration bits. For more information, see **Section 9.0 "Oscillator Configuration"**.

TABLE 7-2: OSCILLATOR SELECTION vs.
TYPE OF RESET (CLOCK
SWITCHING ENABLED)

Reset Type	Clock Source Determinant
POR	FNOSC Configuration bits
BOR	(FNOSC<10:8>)
MCLR	COSC Control bits
WDTO	(OSCCON<14:12>)
SWR	

7.2 Device Reset Times

The Reset times for various types of device Reset are summarized in Table 7-3. Note that the system Reset signal, SYSRST, is released after the POR and PWRT delay times expire.

The time at which the device actually begins to execute code will also depend on the system oscillator delays, which include the Oscillator Start-up Timer (OST) and the PLL lock time. The OST and PLL lock times occur in parallel with the applicable SYSRST delay times.

The FSCM delay determines the time at which the FSCM begins to monitor the system clock source after the SYSRST signal is released.

TABLE 7-3: RESET DELAY TIMES FOR VARIOUS DEVICE RESETS

Reset Type	Clock Source	SYSRST Delay	System Clock Delay	Notes
POR ⁽⁶⁾	EC	TPOR + TPWRT	_	1, 2
	FRC, FRCDIV	TPOR + TPWRT	TFRC	1, 2, 3
	LPRC	TPOR + TPWRT	TLPRC	1, 2, 3
	ECPLL	TPOR + TPWRT	TLOCK	1, 2, 4
	FRCPLL	TPOR + TPWRT	TFRC + TLOCK	1, 2, 3, 4
	XT, HS, SOSC	TPOR+ TPWRT	Tost	1, 2, 5
	XTPLL, HSPLL	TPOR + TPWRT	Tost + Tlock	1, 2, 4, 5
BOR	EC	TPWRT	_	2
	FRC, FRCDIV	Tpwrt	TFRC	2, 3
	LPRC	TPWRT	TLPRC	2, 3
	ECPLL	TPWRT	TLOCK	2, 4
	FRCPLL	Tpwrt	TFRC + TLOCK	2, 3, 4
	XT, HS, SOSC	TPWRT	Tost	2, 5
	XTPLL, HSPLL	TPWRT	TFRC + TLOCK	2, 3, 4
All Others	Any Clock	_	_	None

- Note 1: TPOR = Power-on Reset delay.
 - 2: TPWRT = 64 ms nominal if the Power-up Timer is enabled; otherwise, it is zero.
 - 3: TFRC and TLPRC = RC oscillator start-up times.
 - 4: TLOCK = PLL lock time.
 - **5:** Tost = Oscillator Start-up Timer (OST). A 10-bit counter waits 1024 oscillator periods before releasing the oscillator clock to the system.
 - **6:** If Two-Speed Start-up is enabled, regardless of the primary oscillator selected, the device starts with FRC, and in such cases, FRC start-up time is valid.

Note: For detailed operating frequency and timing specifications, see Section 26.0 "Electrical Characteristics".

7.2.1 POR AND LONG OSCILLATOR START-UP TIMES

The oscillator start-up circuitry and its associated delay timers are not linked to the device Reset delays that occur at power-up. Some crystal circuits (especially low-frequency crystals) will have a relatively long start-up time. Therefore, one or more of the following conditions is possible after SYSRST is released:

- · The oscillator circuit has not begun to oscillate.
- The Oscillator Start-up Timer (OST) has not expired (if a crystal oscillator is used).
- The PLL has not achieved a lock (if PLL is used).

The device will not begin to execute code until a valid clock source has been released to the system. Therefore, the oscillator and PLL start-up delays must be considered when the Reset delay time must be known.

7.2.2 FAIL-SAFE CLOCK MONITOR (FSCM) AND DEVICE RESETS

If the FSCM is enabled, it will begin to monitor the system clock source when SYSRST is released. If a valid clock source is not available at this time, the device will automatically switch to the FRC oscillator and the user can switch to the desired crystal oscillator in the Trap Service Routine (TSR).

7.3 Special Function Register Reset States

Most of the Special Function Registers (SFRs) associated with the PIC24F CPU and peripherals are reset to a particular value at a device Reset. The SFRs are grouped by their peripheral or CPU function and their Reset values are specified in each section of this manual.

The Reset value for each SFR does not depend on the type of Reset, with the exception of four registers. The Reset value for the Reset Control register, RCON, will depend on the type of device Reset. The Reset value for the Oscillator Control register, OSCCON, will depend on the type of Reset and the programmed values of the FNOSC bits in the Flash Configuration Word (FOSCSEL); see Table 7-2. The RCFGCAL and NVMCON registers are only affected by a POR.

7.4 Brown-out Reset (BOR)

PIC24F16KL402 family devices implement a BOR circuit, which provides the user several configuration and power-saving options. The BOR is controlled by the BORV<1:0> and BOREN<1:0> Configuration bits (FPOR<6:5,1:0>). There are a total of four BOR configurations, which are provided in Table 7-3.

The BOR threshold is set by the BORV<1:0> bits. If BOR is enabled (any values of BOREN<1:0>, except '00'), any drop of VDD below the set threshold point will reset the device. The chip will remain in BOR until VDD rises above the threshold.

If the Power-up Timer is enabled, it will be invoked after VDD rises above the threshold. Then, it will keep the chip in Reset for an additional time delay, TPWRT, if VDD drops below the threshold while the power-up timer is running. The chip goes back into a BOR and the Power-up Timer will be initialized. Once VDD rises above the threshold, the Power-up Timer will execute the additional time delay.

BOR and the Power-up Timer (PWRT) are independently configured. Enabling the BOR Reset does not automatically enable the PWRT.

7.4.1 SOFTWARE ENABLED BOR

When BOREN<1:0> = 01, the BOR can be enabled or disabled by the user in software. This is done with the control bit, SBOREN (RCON<13>). Setting SBOREN enables the BOR to function, as previously described. Clearing the SBOREN disables the BOR entirely. The SBOREN bit only operates in this mode; otherwise, it is read as '0'.

Placing BOR under software control gives the user the additional flexibility of tailoring the application to its environment without having to reprogram the device to change the BOR configuration. It also allows the user to tailor the incremental current that the BOR consumes. While the BOR current is typically very small, it may have some impact in low-power applications.

Note: Even when the BOR is under software control, the BOR Reset voltage level is still set by the BORV<1:0> Configuration bits; it can not be changed in software.

7.4.2 DETECTING BOR

When BOR is enabled, the BOR bit (RCON<1>) is always reset to '1' on any BOR or POR event. This makes it difficult to determine if a BOR event has occurred just by reading the state of BOR alone. A more reliable method is to simultaneously check the state of both POR and BOR. This assumes that the POR and BOR bits are reset to '0' in the software, immediately after any POR event. If the BOR bit is '1' while POR is '0', it can be reliably assumed that a BOR event has occurred.

Note: Even when the device exits from Deep Sleep mode, both the POR and BOR are set.

7.4.3 DISABLING BOR IN SLEEP MODE

When BOREN<1:0> = 10, BOR remains under hardware control and operates as previously described. However, whenever the device enters Sleep mode, BOR is automatically disabled. When the device returns to any other operating mode, BOR is automatically re-enabled.

This mode allows for applications to recover from brown-out situations, while actively executing code when the device requires BOR protection the most. At the same time, it saves additional power in Sleep mode by eliminating the small incremental BOR current.

8.0 INTERRUPT CONTROLLER

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the Interrupt Controller, refer to the "PIC24F Family Reference Manual", Section 8. "Interrupts" (DS39707).

The PIC24F interrupt controller reduces the numerous peripheral interrupt request signals to a single interrupt request signal to the CPU. It has the following features:

- Up to eight processor exceptions and software traps
- Seven user-selectable priority levels
- Interrupt Vector Table (IVT) with up to 118 vectors
- Unique vector for each interrupt or exception source
- · Fixed priority within a specified user priority level
- Alternate Interrupt Vector Table (AIVT) for debug support
- · Fixed interrupt entry and return latencies

8.1 Interrupt Vector Table (IVT)

The IVT is shown in Figure 8-1. The IVT resides in the program memory, starting at location, 000004h. The IVT contains 126 vectors, consisting of eight non-maskable trap vectors, plus up to 118 sources of interrupt. In general, each interrupt source has its own vector. Each interrupt vector contains a 24-bit wide address. The value programmed into each interrupt vector location is the starting address of the associated Interrupt Service Routine (ISR).

Interrupt vectors are prioritized in terms of their natural priority; this is linked to their position in the vector table. All other things being equal, lower addresses have a higher natural priority. For example, the interrupt associated with vector 0 will take priority over interrupts at any other vector address.

PIC24F16KL402 family devices implement 32 non-maskable traps and unique interrupts; these are summarized in Table 8-1 and Table 8-2.

8.1.1 ALTERNATE INTERRUPT VECTOR TABLE (AIVT)

The Alternate Interrupt Vector Table (AIVT) is located after the IVT, as shown in Figure 8-1. Access to the AIVT is provided by the ALTIVT control bit (INTCON2<15>). If the ALTIVT bit is set, all interrupt and exception processes will use the alternate vectors instead of the default vectors. The alternate vectors are organized in the same manner as the default vectors.

The AIVT supports emulation and debugging efforts by providing a means to switch between an application and a support environment without requiring the interrupt vectors to be reprogrammed. This feature also enables switching between applications for evaluation of different software algorithms at run time. If the AIVT is not needed, the AIVT should be programmed with the same addresses used in the IVT.

8.2 Reset Sequence

A device Reset is not a true exception, because the interrupt controller is not involved in the Reset process. The PIC24F devices clear their registers in response to a Reset, which forces the Program Counter (PC) to zero. The microcontroller then begins program execution at location, 000000h. The user programs a GOTO instruction at the Reset address, which redirects the program execution to the appropriate start-up routine.

Note:

Any unimplemented or unused vector locations in the IVT and AIVT should be programmed with the address of a default interrupt handler routine that contains a RESET instruction.

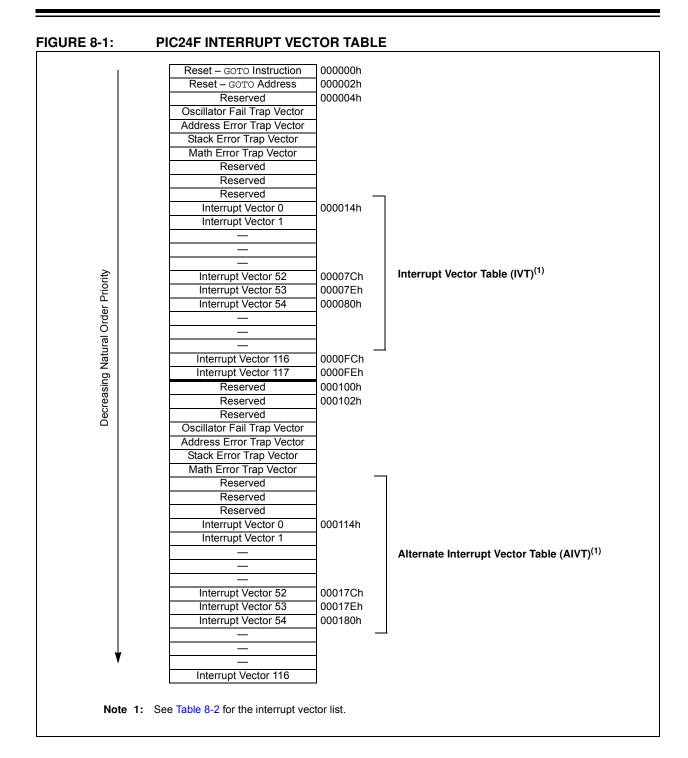


TABLE 8-1: TRAP VECTOR DETAILS

Vector Number	IVT Address	AIVT Address	Trap Source
0	000004h	000104h	Reserved
1	000006h	000106h	Oscillator Failure
2	000008h	000108h	Address Error
3	00000Ah	00010Ah	Stack Error
4	00000Ch	00010Ch	Math Error
5	00000Eh	00010Eh	Reserved
6	000010h	000110h	Reserved
7	000012h	000112h	Reserved

TABLE 8-2: IMPLEMENTED INTERRUPT VECTORS

Intermed Course	Vector	IV/T Address	AD/T Address	Inte	rrupt Bit Locat	ions
Interrupt Source	Number	IVT Address	AIVT Address	Flag	-	
ADC1 Conversion Done	13	00002Eh	00012Eh	IFS0<13>	IEC0<13>	IPC3<6:4>
Comparator Event	18	000038h	000138h	IFS1<2>	IEC1<2>	IPC4<10:8>
External Interrupt 0	0	000014h	000114h	IFS0<0>	IEC0<0>	IPC0<2:0>
External Interrupt 1	20	00003Ch	00013Ch	IFS1<4>	IEC1<4>	IPC5<2:0>
External Interrupt 2	29	00004Eh	00014Eh	IFS1<13>	IEC1<13>	IPC7<6:4>
MSSP1 Bus Collision Event	17	000036h	000136h	IFS1<1>	IEC1<1>	IPC4<6:4>
MSSP1 SPI or I ² C™ Event	16	000034h	000134h	IFS1<0>	IEC1<0>	IPC4<2:0>
MSSP2 Bus Collision Event	50	000078h	000178h	IFS3<2>	IEC3<2>	IPC12<10:8>
MSSP2 SPI or I ² C Event	49	000076h	000176h	IFS3<1>	IEC3<1>	IPC12<6:4>
Input Change Notification	19	00003Ah	00013Ah	IFS1<3>	IEC1<3>	IPC4<14:12>
HLVD (High/Low-Voltage Detect)	72	0000A4h	0001A4h	IFS4<8>	IEC4<8>	IPC17<2:0>
NVM (NVM Write Complete)	15	000032h	000132h	IFS0<15>	IEC0<15>	IPC3<14:12>
CCP1/ECCP1	2	000018h	000118h	IFS0<2>	IEC0<2>	IPC0<10:8>
CCP2	6	000020h	000120h	IFS0<6>	IEC0<6>	IPC1<10:8>
CCP3	25	000046h	000146h	IFS1<9>	IEC1<9>	IPC6<6:4>
Timer1	3	00001Ah	00011Ah	IFS0<3>	IEC0<3>	IPC0<14:12>
Timer2	7	000022h	000122h	IFS0<7>	IEC0<7>	IPC1<14:12>
Timer3	8	000024h	000124h	IFS0<8>	IEC0<8>	IPC2<2:0>
Timer4	27	00004Ah	00014Ah	IFS1<11>	IEC1<11>	IPC6<14:12>
Timer3 Gate External Count	37	00005Eh	00015Eh	IFS2<5>	IEC2<5>	IPC9<6:4>
UART1 Error	65	000096h	000196h	IFS4<1>	IEC4<1>	IPC16<6:4>
UART1 Receiver	11	00002Ah	00012Ah	IFS0<11>	IEC0<11>	IPC2<14:12>
UART1 Transmitter	12	00002Ch	00012Ch	IFS0<12>	IEC0<12>	IPC3<2:0>
UART2 Error	66	000098h	000198h	IFS4<2>	IEC4<2>	IPC16<10:8>
UART2 Receiver	30	000050h	000150h	IFS1<14>	IEC1<14>	IPC7<10:8>
UART2 Transmitter	31	000052h	000152h	IFS1<15>	IEC1<15>	IPC7<14:12>
ULPW (Ultra Low-Power Wake-up)	80	0000B4h	0001B4h	IFS5<0>	IEC5<0>	IPC20<2:0>

8.3 Interrupt Control and Status Registers

Depending on the particular device, the PIC24F16KL402 family of devices implements up to 28 registers for the interrupt controller:

- INTCON1
- INTCON2
- · IFS0 through IFS5
- · IEC0 through IEC5
- IPC0 through IPC7, ICP9, IPC12, ICP16, ICP18 and IPC20
- INTTREG

Global interrupt control functions are controlled from INTCON1 and INTCON2. INTCON1 contains the Interrupt Nesting Disable (NSTDIS) bit, as well as the control and status flags for the processor trap sources. The INTCON2 register controls the external interrupt request signal behavior and the use of the AIV table.

The IFSx registers maintain all of the interrupt request flags. Each source of interrupt has a status bit, which is set by the respective peripherals or external signal, and is cleared via software.

The IECx registers maintain all of the interrupt enable bits. These control bits are used to individually enable interrupts from the peripherals or external signals.

The IPCx registers are used to set the Interrupt Priority Level for each source of interrupt. Each user interrupt source can be assigned to one of eight priority levels. The INTTREG register contains the associated interrupt vector number and the new CPU Interrupt Priority Level, which are latched into the Vector Number (VECNUM<6:0>) and the Interrupt Level (ILR<3:0>) bit fields in the INTTREG register. The new Interrupt Priority Level is the priority of the pending interrupt.

The interrupt sources are assigned to the IFSx, IECx and IPCx registers in the same sequence listed in Table 8-2. For example, the INT0 (External Interrupt 0) is depicted as having a vector number and a natural order priority of 0. The INT0IF status bit is found in IFS0<0>, the INT0IE enable bit in IEC0<0> and the INT0IP<2:0> priority bits are in the first position of IPC0 (IPC0<2:0>).

Although they are not specifically part of the interrupt control hardware, two of the CPU control registers contain bits that control interrupt functionality. The ALU STATUS Register (SR) contains the IPL<2:0> bits (SR<7:5>). These indicate the current CPU Interrupt Priority Level. The user may change the current CPU priority level by writing to the IPL bits.

The CORCON register contains the IPL3 bit, which together with the IPL<2:0> bits, also indicates the current CPU priority level. IPL3 is a read-only bit so that the trap events cannot be masked by the user's software.

All interrupt registers are described in Register 8-3 through Register 8-30, in the following sections.

REGISTER 8-1: SR: ALU STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R-0
_	_	_	_	_	_	_	DC ⁽¹⁾
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
IPL2 ^(2,3)	IPL1 ^(2,3)	IPL0 ^(2,3)	RA ⁽¹⁾	N ⁽¹⁾	OV ⁽¹⁾	Z ⁽¹⁾	C ⁽¹⁾
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-9 **Unimplemented:** Read as '0'

bit 7-5 **IPL<2:0>:** CPU Interrupt Priority Level Status bits^(2,3)

111 = CPU Interrupt Priority Level is 7 (15); user interrupts disabled

110 = CPU Interrupt Priority Level is 6 (14)

101 = CPU Interrupt Priority Level is 5 (13)

100 = CPU Interrupt Priority Level is 4 (12)

011 = CPU Interrupt Priority Level is 3 (11)

010 = CPU Interrupt Priority Level is 2 (10)

001 = CPU Interrupt Priority Level is 1 (9)

000 = CPU Interrupt Priority Level is 0 (8)

Note 1: See Register 3-1 for the description of these bits, which are not dedicated to interrupt control functions.

2: The IPL bits are concatenated with the IPL3 bit (CORCON<3>) to form the CPU Interrupt Priority Level. The value in parentheses indicates the Interrupt Priority Level if IPL3 = 1.

3: The IPL Status bits are read-only when NSTDIS (INTCON1<15>) = 1.

Note: Bit 8 and bits 4 through 0 are described in Section 3.0 "CPU".

REGISTER 8-2: CORCON: CPU CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	R/C-0	R/W-0	U-0	U-0
_	_	_	_	IPL3 ⁽²⁾	PSV ⁽¹⁾	_	
bit 7							bit 0

Legend: C = Clearable bit

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-4 **Unimplemented:** Read as '0'

bit 3 **IPL3:** CPU Interrupt Priority Level Status bit⁽²⁾

1 = CPU Interrupt Priority Level is greater than 7

0 = CPU Interrupt Priority Level is 7 or less

bit 1-0 **Unimplemented:** Read as '0'

Note 1: See Register 3-2 for the description of this bit, which is not dedicated to interrupt control functions.

2: The IPL3 bit is concatenated with the IPL<2:0> bits (SR<7:5>) to form the CPU Interrupt Priority Level.

Note: Bit 2 is described in Section 3.0 "CPU".

REGISTER 8-3: INTCON1: INTERRUPT CONTROL REGISTER 1

R/W-0	U-0						
NSTDIS	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
_	_	_	MATHERR	ADDRERR	STKERR	OSCFAIL	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 NSTDIS: Interrupt Nesting Disable bit

1 = Interrupt nesting is disabled0 = Interrupt nesting is enabled

bit 14-5 **Unimplemented:** Read as '0'

bit 4 MATHERR: Arithmetic Error Trap Status bit

1 = Overflow trap has occurred0 = Overflow trap has not occurred

bit 3 ADDRERR: Address Error Trap Status bit

1 = Address error trap has occurred0 = Address error trap has not occurred

bit 2 STKERR: Stack Error Trap Status bit

1 = Stack error trap has occurred0 = Stack error trap has not occurred

bit 1 OSCFAIL: Oscillator Failure Trap Status bit

1 = Oscillator failure trap has occurred0 = Oscillator failure trap has not occurred

bit 0 **Unimplemented:** Read as '0'

REGISTER 8-4: INTCON2: INTERRUPT CONTROL REGISTER2

R/W-0	R-0, HSC	U-0	U-0	U-0	U-0	U-0	U-0
ALTIVT	DISI	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
_	_	_	_	_	INT2EP	INT1EP	INT0EP
bit 7							bit 0

Legend: HSC = Hardware Settable/Clearable bit

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 ALTIVT: Enable Alternate Interrupt Vector Table bit

1 = Use Alternate Interrupt Vector Table0 = Use standard (default) vector table

bit 14 DISI: DISI Instruction Status bit

1 = DISI instruction is active 0 = DISI instruction is not active

bit 13-3 **Unimplemented:** Read as '0'

bit 2 INT2EP: External Interrupt 2 Edge Detect Polarity Select bit

1 = Interrupt on negative edge0 = Interrupt on positive edge

bit 1 INT1EP: External Interrupt 1 Edge Detect Polarity Select bit

1 = Interrupt on negative edge0 = Interrupt on positive edge

bit 0 INT0EP: External Interrupt 0 Edge Detect Polarity Select bit

1 = Interrupt on negative edge0 = Interrupt on positive edge

REGISTER 8-5: IFS0: INTERRUPT FLAG STATUS REGISTER 0

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0
NVMIF	_	AD1IF	U1TXIF	U1RXIF	_	_	T3IF
bit 15							bit 8

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	U-0	R/W-0
T2IF	CCP2IF	_	_	T1IF	CCP1IF	_	INT0IF
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'

-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

-ii - value at i	OI\	0 - Dit is cleared
bit 15	NVMIF: NVM Interrupt Flag Status bit	
DIL 13	·	
	1 = Interrupt request has occurred	
	0 = Interrupt request has not occurred	
bit 14	Unimplemented: Read as '0'	
bit 13	AD1IF: A/D Conversion Complete Inte	rrupt Flag Status bit
	1 = Interrupt request has occurred	
	0 = Interrupt request has not occurred	
bit 12	U1TXIF: UART1 Transmitter Interrupt	Flag Status bit
	1 = Interrupt request has occurred	
	0 = Interrupt request has not occurred	
bit 11	U1RXIF: UART1 Receiver Interrupt Fla	ag Status bit
	1 = Interrupt request has occurred	
	0 = Interrupt request has not occurred	
bit 10-9	Unimplemented: Read as '0'	
bit 8	T3IF: Timer3 Interrupt Flag Status bit	
	1 = Interrupt request has occurred	
	0 = Interrupt request has not occurred	
bit 7	T2IF: Timer2 Interrupt Flag Status bit	
	1 = Interrupt request has occurred	
	0 = Interrupt request has not occurred	

	0 = Interrupt request has not occurred
bit 7	T2IF: Timer2 Interrupt Flag Status bit
	1 = Interrupt request has occurred
	0 = Interrupt request has not occurred
bit 6	CCP2IF: Capture/Compare/PWM 2 Interrupt Flag Status bit
	1 = Interrupt request has occurred
	0 = Interrupt request has not occurred

bit 5-4	Unimplemented: Read as '0'
bit 3	T1IF: Timer1 Interrupt Flag Status bit
	1 = Interrupt request has occurred
	0 = Interrupt request has not occurred

bit 2 CCP1IF: Capture/Compare/PWM1 Interrupt Flag Status bit (ECCP1 on PIC24FXXKL40X devices)

1 = Interrupt request has occurred 0 = Interrupt request has not occurred Unimplemented: Read as '0' INTOIF: External Interrupt 0 Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 1

bit 0

REGISTER 8-6: IFS1: INTERRUPT FLAG STATUS REGISTER 1

R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	U-0
U2TXIF ⁽¹⁾	U2RXIF ⁽¹⁾	INT2IF	_	T4IF ⁽¹⁾	_	CCP3IF ⁽¹⁾	_
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_	INT1IF	CNIF	CMIF	BCL1IF	SSP1IF
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **U2TXIF:** UART2 Transmitter Interrupt Flag Status bit⁽¹⁾

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 14 **U2RXIF:** UART2 Receiver Interrupt Flag Status bit⁽¹⁾

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 13 INT2IF: External Interrupt 2 Flag Status bit

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 12 Unimplemented: Read as '0'

bit 11 **T4IF:** Timer4 Interrupt Flag Status bit⁽¹⁾

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 10 **Unimplemented:** Read as '0'

bit 9 CCP3IF: Capture/Compare/PWM 3 Interrupt Flag Status bit (1)

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 8-5 **Unimplemented:** Read as '0'

bit 4 INT1IF: External Interrupt 1 Flag Status bit

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 3 CNIF: Input Change Notification Interrupt Flag Status bit

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 2 CMIF: Comparator Interrupt Flag Status bit

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 1 BCL1IF: MSSP1 I²C Bus Collision Interrupt Flag Status bit

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 0 SSP1IF: MSSP1 SPI/I²C Event Interrupt Flag Status bit

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 8-7: IFS2: INTERRUPT FLAG STATUS REGISTER 2

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
_	_	T3GIF	_	_	_	_	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-6 Unimplemented: Read as '0'

bit 5 T3GIF: Timer3 External Gate Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 4-0 **Unimplemented:** Read as '0'

REGISTER 8-8: IFS3: INTERRUPT FLAG STATUS REGISTER 3

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0
_	_	_	_	_	BCL2IF ⁽¹⁾	SSP2IF ⁽¹⁾	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-3 Unimplemented: Read as '0'

bit 2 BCL2IF: MSSP2 I²C Bus Collision Interrupt Flag Status bit⁽¹⁾

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 1 SSP2IF: MSSP2 SPI/I²C Event Interrupt Flag Status bit⁽¹⁾

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 0 **Unimplemented:** Read as '0'

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 8-9: IFS4: INTERRUPT FLAG STATUS REGISTER 4

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	_	_	_	_	_	HLVDIF
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0
_	_	_	_	_	U2ERIF ⁽¹⁾	U1ERIF	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-9 **Unimplemented:** Read as '0'

bit 8 HLVDIF: High/Low-Voltage Detect Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 7-3 **Unimplemented:** Read as '0'

bit 2 **U2ERIF:** UART2 Error Interrupt Flag Status bit⁽¹⁾

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 1 **U1ERIF:** UART1 Error Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 0 **Unimplemented:** Read as '0'

Note 1: This bit is unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 8-10: IFS5: INTERRUPT FLAG STATUS REGISTER 5

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	_	_	_	_	_	ULPWUIF
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-1 **Unimplemented:** Read as '0'

bit 0 ULPWUIF: Ultra Low-Power Wake-up Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

REGISTER 8-11: IEC0: INTERRUPT ENABLE CONTROL REGISTER 0

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0
NVMIE	_	AD1IE	U1TXIE	U1RXIE	_	_	T3IE
bit 15	•		•	•	•		bit 8

R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	U-0	R/W-0
T2IE	CCP2IE	_	_	T1IE	CCP1IE	_	INT0IE
bit 7	•	-	•	-	•		bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **NVMIE:** NVM Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 14 **Unimplemented:** Read as '0'

bit 13 AD1IE: A/D Conversion Complete Interrupt Enable bit

1 = Interrupt request is enabled0 = Interrupt request is not enabled

bit 12 **U1TXIE:** UART1 Transmitter Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 11 U1RXIE: UART1 Receiver Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 10-9 **Unimplemented:** Read as '0'

bit 8 **T3IE:** Timer3 Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 7 **T2IE:** Timer2 Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 6 CCP2IE: Capture/Compare/PWM 2 Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 5-4 **Unimplemented:** Read as '0'

bit 3 **T1IE:** Timer1 Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 2 **CCP1IE:** Capture/Compare/PWM 1 Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 1 IC1IE: Input Capture Channel 1 Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 0 **INTOIE:** External Interrupt 0 Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

REGISTER 8-12: IEC1: INTERRUPT ENABLE CONTROL REGISTER 1

R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0	R/W-0	U-0
U2TXIE ⁽¹⁾	U2RXIE ⁽¹⁾	INT2IE	_	T4IE ⁽¹⁾	_	CCP3IE ⁽¹⁾	_
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_	INT1IE	CNIE	CMIE	BCL1IE	SSP1IE
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **U2TXIE:** UART2 Transmitter Interrupt Enable bit⁽¹⁾

1 = Interrupt request is enabled0 = Interrupt request is not enabled

bit 14 **U2RXIE:** UART2 Receiver Interrupt Enable bit⁽¹⁾

1 = Interrupt request is enabled0 = Interrupt request is not enabled

bit 13 INT2IE: External Interrupt 2 Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 12 **Unimplemented:** Read as '0'

bit 11 **T4IE:** Timer4 Interrupt Enable bit⁽¹⁾

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 10 **Unimplemented:** Read as '0'

bit 9 **CCP3IE:** Capture/Compare/PWM 3 Interrupt Enable bit⁽¹⁾

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 8-5 **Unimplemented:** Read as '0'

bit 4 INT1IE: External Interrupt 1 Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 3 CNIE: Input Change Notification Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 2 **CMIE:** Comparator Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 1 **BCL1IE:** MSSP1 I²C Bus Collision Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

bit 0 SSP1IE: MSSP1 SPI/I²C Event Interrupt Enable bit

1 = Interrupt request is enabled

0 = Interrupt request is not enabled

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 8-13: IEC2: INTERRUPT ENABLE CONTROL REGISTER 2

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15	_	_					bit 8

U-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
_	_	T3GIE	_	_	_	_	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-6 Unimplemented: Read as '0'

bit 5 T3GIF: Timer3 External Gate Interrupt Enable bit

1 = Interrupt request is enabled0 = Interrupt request is not enabled

bit 4-2 **Unimplemented:** Read as '0'

REGISTER 8-14: IEC3: INTERRUPT ENABLE CONTROL REGISTER 3

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0
_	_	_	_	_	BCL2IE ⁽¹⁾	SSP2IE ⁽¹⁾	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-3 **Unimplemented:** Read as '0'

bit 2 BCL2IE: MSSP2 I²C Bus Collision Interrupt Enable bit⁽¹⁾

1 = Interrupt request is enabled0 = Interrupt request is not enabled

bit 1 SSP2IF: MSSP2 SPI/I²C Event Interrupt Enable bit⁽¹⁾

1 = Interrupt request is enabled0 = Interrupt request is not enabled

bit 0 **Unimplemented:** Read as '0'

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 8-15: IEC4: INTERRUPT ENABLE CONTROL REGISTER 4

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_					_	HLVDIE
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0
_	_	_	_	_	U2ERIE ⁽¹⁾	U1ERIE	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-9 **Unimplemented:** Read as '0'

bit 8 **HLVDIE:** High/Low-Voltage Detect Interrupt Enable bit

1 = Interrupt request is enabled 0 = Interrupt request is not enabled

bit 7-4 **Unimplemented:** Read as '0'

bit 2 **U2ERIE:** UART2 Error Interrupt Enable bit⁽¹⁾

1 = Interrupt request is enabled0 = Interrupt request is not enabled

bit 1 **U1ERIE:** UART1 Error Interrupt Enable bit

1 = Interrupt request is enabled0 = Interrupt request is not enabled

bit 0 **Unimplemented:** Read as '0'

Note 1: This bit is unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 8-16: IEC5: INTERRUPT ENABLE CONTROL REGISTER 5

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	_	_	_	_	_	ULPWUIE
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-1 **Unimplemented:** Read as '0'

bit 0 **ULPWUIE:** Ultra Low-Power Wake-up Interrupt Enable Bit

1 = Interrupt request is enabled0 = Interrupt request is not enabled

REGISTER 8-17: IPC0: INTERRUPT PRIORITY CONTROL REGISTER 0

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_	T1IP2	T1IP1	T1IP0	_	CCP1IP2	CCP1IP1	CCP1IP0
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
_	_	_	_	_	INT0IP2	INT0IP1	INT0IP0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 T1IP<2:0>: Timer1 Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 CCP1IP<2:0>: Capture/Compare/PWM 1 Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 7-3 **Unimplemented:** Read as '0'

bit 2-0 **INTOIP<2:0>:** External Interrupt 0 Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

REGISTER 8-18: IPC1: INTERRUPT PRIORITY CONTROL REGISTER 1

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_	T2IP2	T2IP1	T2IP0	_	CCP2IP2	CCP2IP1	CCP2IP0
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **T2IP<2:0>:** Timer2 Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 CCP2IP<2:0>: Capture/Compare/PWM 2 Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

.

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 7-0 **Unimplemented:** Read as '0'

REGISTER 8-19: IPC2: INTERRUPT PRIORITY CONTROL REGISTER 2

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_	U1RXIP2	U1RXIP1	U1RXIP0	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
_	_	_	_	_	T3IP2	T3IP1	T3IP0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 Unimplemented: Read as '0'

bit 14-12 U1RXIP<2:0>: UART1 Receiver Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 11-3 **Unimplemented:** Read as '0'

bit 2-0 T3IP<2:0>: Timer3 Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

REGISTER 8-20: IPC3: INTERRUPT PRIORITY CONTROL REGISTER 3

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_	NVMIP2	NVMIP1	NVMIP0	_			_
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_	AD1IP2	AD1IP1	AD1IP0	_	U1TXIP2	U1TXIP1	U1TXIP0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **NVMIP<2:0>:** NVM Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 11-7 **Unimplemented:** Read as '0'

bit 6-4 AD1IP<2:0>: A/D Conversion Complete Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **U1TXIP<2:0>:** UART1 Transmitter Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

REGISTER 8-21: IPC4: INTERRUPT PRIORITY CONTROL REGISTER 4

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_	CNIP2	CNIP1	CNIP0	_	CMIP2	CMIP1	CMIP0
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_	BCL1IP2	BCL1IP1	BCL1IP0	_	SSP1IP2	SSP1IP1	SSP1IP0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 CNIP<2:0>: Input Change Notification Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **CMIP<2:0>:** Comparator Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 7 Unimplemented: Read as '0'

bit 6-4 **BCL1IP<2:0>:** MSSP1 I²C Bus Collision Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 SSP1IP<2:0>: MSSP1 SPI/I²C Event Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

REGISTER 8-22: IPC5: INTERRUPT PRIORITY CONTROL REGISTER 5

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
_	_	_	_	_	INT1IP2	INT1IP1	INT1IP0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-3 **Unimplemented:** Read as '0'

bit 2-0 **INT1IP<2:0>:** External Interrupt 1 Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

:

001 = Interrupt is Priority 1

REGISTER 8-23: IPC6: INTERRUPT PRIORITY CONTROL REGISTER 6

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_	T4IP2 ⁽¹⁾	T4IP1 ⁽¹⁾	T4IP0 ⁽¹⁾	_	_	_	_
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_	CCP3IP2 ⁽¹⁾	CCP3IP1 ⁽¹⁾	CCP3IP0 ⁽¹⁾	_	_	_	_
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 bit 14-12	Unimplemented: Read as '0' T4IP<2:0>: Timer4 Interrupt Priority bits ⁽¹⁾ 111 = Interrupt is Priority 7 (highest priority interrupt)
bit 11-7	Unimplemented: Read as '0'
bit 6-4	CCP3IP: Capture/Compare/PWM 2 Interrupt Priority bits ⁽¹⁾ 111 = Interrupt is Priority 7 (highest priority interrupt)
bit 3-0	Unimplemented: Read as '0'

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 8-24: IPC7: INTERRUPT PRIORITY CONTROL REGISTER 7

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_	U2TXIP2 ⁽¹⁾	U2TXIP1 ⁽¹⁾	U2TXIP0 ⁽¹⁾	_	U2RXIP2 ⁽¹⁾	U2RXIP1 ⁽¹⁾	U2RXIP0 ⁽¹⁾
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_	INT2IP2	INT2IP1	INT2IP0	_	_	_	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **U2TXIP<2:0>:** UART2 Transmitter Interrupt Priority bits⁽¹⁾

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **U2RXIP<2:0>:** UART2 Receiver Interrupt Priority bits⁽¹⁾

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **INT2IP<2:0>:** External Interrupt 2 Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as '0'

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 8-25: IPC9: INTERRUPT PRIORITY CONTROL REGISTER 9

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_	T3GIP2	T3GIP1	T3GIP0	_	_	_	
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6-4 T3GIP<2:0>: Timer3 External Gate Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as '0'

REGISTER 8-26: IPC12: INTERRUPT PRIORITY CONTROL REGISTER 12

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
_	_	_	_	_	BCL2IP2 ⁽¹⁾	BCL2IP1 ⁽¹⁾	BCL2IP0 ⁽¹⁾
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_	SSP2IP2 ⁽¹⁾	SSP2IP1 ⁽¹⁾	SSP2IP0 ⁽¹⁾	_	_	_	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-11 **Unimplemented:** Read as '0'

bit 10-8 BCL2IP<2:0>: MSSP2 I²C™ Bus Collision Interrupt Priority bits⁽¹⁾

111 = Interrupt is Priority 7 (highest priority interrupt)

•

• 001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 SSP2IP<2:0>: MSSP2 SPI/I²C Event Interrupt Priority bits⁽¹⁾

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as '0'

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 8-27: IPC16: INTERRUPT PRIORITY CONTROL REGISTER 16

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
_	_	_	_	_	U2ERIP2 ⁽¹⁾	U2ERIP1 ⁽¹⁾	U2ERIP0 ⁽¹⁾
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_	U1ERIP2 ⁽¹⁾	U1ERIP1 ⁽¹⁾	U1ERIP0 ⁽¹⁾	_	_	_	_
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-11 bit 10-8	Unimplemented: Read as '0' U2ERIP<2:0>: UART2 Error Interrupt Priority bits ⁽¹⁾
	111 = Interrupt is Priority 7 (highest priority interrupt) .
	001 = Interrupt is Priority 1 000 = Interrupt source is disabled
bit 7	Unimplemented: Read as '0'
bit 6-4	U1ERIP<2:0>: UART1 Error Interrupt Priority bits ⁽¹⁾ 111 = Interrupt is Priority 7 (highest priority interrupt)
	001 = Interrupt is Priority 1 000 = Interrupt source is disabled
bit 3-0	Unimplemented: Read as '0'

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

REGISTER 8-28: IPC18: INTERRUPT PRIORITY CONTROL REGISTER 18

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15	_	_	_			_	bit 8

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
_	_	_	_	_	HLVDIP2	HLVDIP1	HLVDIP0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-3 **Unimplemented:** Read as '0'

bit 2-0 **HLVDIP<2:0>:** High/Low-Voltage Detect Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

REGISTER 8-29: IPC20: INTERRUPT PRIORITY CONTROL REGISTER 20

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
_	_	_	_	_	ULPWUIP2	ULPWUIP1	ULPWUIP0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-3 **Unimplemented:** Read as '0'

bit 6-4 **ULPWUIP<2:0>:** Ultra Low-Power Wake-up Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

:

001 = Interrupt is Priority 1

REGISTER 8-30: INTTREG: INTERRUPT CONTROL AND STATUS REGISTER

R-0	r-0	R/W-0	U-0	R-0	R-0	R-0	R-0
CPUIRQ	_	VHOLD	_	ILR3	ILR2	ILR1	ILR0
bit 15							bit 8

U-0	R-0						
_	VECNUM6	VECNUM5	VECNUM4	VECNUM3	VECNUM2	VECNUM1	VECNUM0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
n = Value at POP	'1' - Dit is sot	'0' - Pit is cleared	v - Bit is unknown

bit 15 **CPUIRQ:** Interrupt Request from Interrupt Controller CPU bit

1 = An interrupt request has occurred but has not yet been Acknowledged by the CPU (this will happen when the CPU priority is higher than the interrupt priority)

0 = No interrupt request is left unacknowledged

bit 14 **Reserved:** Maintain as '0'

VHOLD: Vector Hold bit

bit 13

Allows vector number capture and changes what Interrupt is stored in the VECNUM bit.

1 = VECNUM will contain the value of the highest priority pending interrupt, instead of the current interrupt

0 = VECNUM will contain the value of the last Acknowledged interrupt (last interrupt that has occurred with higher priority than the CPU, even if other interrupts are pending)

bit 12 **Unimplemented:** Read as '0'

bit 11-8 ILR<3:0>: New CPU Interrupt Priority Level bits

1111 = CPU Interrupt Priority Level is 15

•

0001 = CPU Interrupt Priority Level is 1 0000 = CPU Interrupt Priority Level is 0

bit 7 **Unimplemented:** Read as '0'

bit 6-0 **VECNUM<6:0>:** Vector Number of Pending Interrupt bits

0111111 = Interrupt vector pending is number 135

•

0000001 = Interrupt vector pending is Number 9 0000000 = Interrupt vector pending is Number 8

8.4 Interrupt Setup Procedures

8.4.1 INITIALIZATION

To configure an interrupt source:

- Set the NSTDIS Control bit (INTCON1<15>) if nested interrupts are not desired.
- Select the user-assigned priority level for the interrupt source by writing the control bits in the appropriate IPCx register. The priority level will depend on the specific application and the type of interrupt source. If multiple priority levels are not desired, the IPCx register control bits, for all enabled interrupt sources, may be programmed to the same non-zero value.

Note: At a device Reset, the IPCx registers are initialized, such that all user interrupt sources are assigned to Priority Level 4.

- Clear the interrupt flag status bit associated with the peripheral in the associated IFSx register.
- Enable the interrupt source by setting the interrupt enable control bit associated with the source in the appropriate IECx register.

8.4.2 INTERRUPT SERVICE ROUTINE

The method that is used to declare an ISR and initialize the IVT with the correct vector address depends on the programming language (i.e., C or assembler) and the language development toolsuite that is used to develop the application. In general, the user must clear the interrupt flag in the appropriate IFSx register for the source of the interrupt that the ISR handles. Otherwise, the ISR will be re-entered immediately after exiting the routine. If the ISR is coded in assembly language, it must be terminated using a RETFIE instruction to unstack the saved PC value, SRL value and old CPU priority level.

8.4.3 TRAP SERVICE ROUTINE (TSR)

A Trap Service Routine (TSR) is coded like an ISR, except that the appropriate trap status flag in the INTCON1 register must be cleared to avoid re-entry into the TSR.

8.4.4 INTERRUPT DISABLE

All user interrupts can be disabled using the following procedure:

- 1. Push the current SR value onto the software stack using the PUSH instruction.
- Force the CPU to Priority Level 7 by inclusive ORing the value, OEh with SRL.

To enable user interrupts, the ${\tt POP}$ instruction may be used to restore the previous SR value.

Only user interrupts with a priority level of 7 or less can be disabled. Trap sources (Level 8-15) cannot be disabled.

The DISI instruction provides a convenient way to disable interrupts of Priority Levels 1-6 for a fixed period. Level 7 interrupt sources are not disabled by the DISI instruction.

9.0 OSCILLATOR CONFIGURATION

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on Oscillator Configuration, refer to the "PIC24F Family Reference Manual", Section 38. "Oscillator with 500 kHz Low-Power FRC" (DS39726).

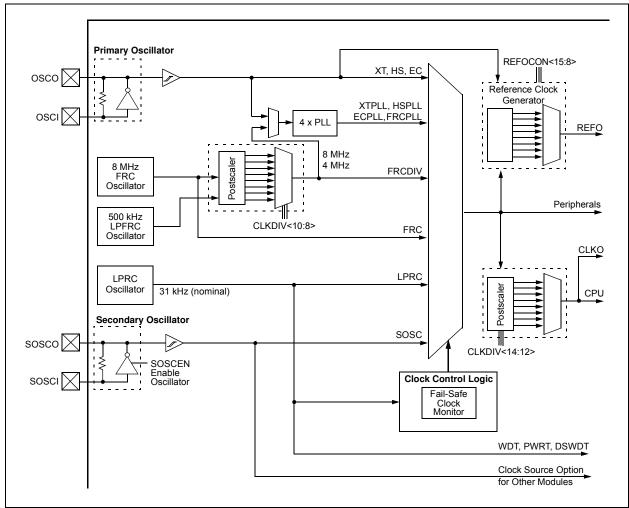
The oscillator system for the PIC24F16KL402 family of devices has the following features:

- A total of five external and internal oscillator options as clock sources, providing 11 different clock modes.
- On-chip 4x Phase Locked Loop (PLL) to boost internal operating frequency on select internal and external oscillator sources.

- Software-controllable switching between various clock sources.
- Software-controllable postscaler for selective clocking of CPU for system power savings.
- System frequency range declaration bits for EC mode. When using an external clock source, the current consumption is reduced by setting the declaration bits to the expected frequency range.
- A Fail-Safe Clock Monitor (FSCM) that detects clock failure and permits safe application recovery or shutdown.

A simplified diagram of the oscillator system is shown in Figure 9-1.

FIGURE 9-1: PIC24F16KL402 FAMILY CLOCK DIAGRAM



9.1 CPU Clocking Scheme

The system clock source can be provided by one of four sources:

- Primary Oscillator (POSC) on the OSCI and OSCO pins
- Secondary Oscillator (SOSC) on the SOSCI and SOSCO pins

PIC24F16KL402 family devices consist of two types of secondary oscillators:

- High-Power Secondary Oscillator
- Low-Power Secondary Oscillator

These can be selected by using the SOSCSEL (FOSC<5>) bit.

- · Fast Internal RC (FRC) Oscillator
 - 8 MHz FRC Oscillator
 - 500 kHz Lower Power FRC Oscillator
- Low-Power Internal RC (LPRC) Oscillator with two modes:
 - High-Power/High Accuracy mode
 - Low-Power/Low Accuracy mode

The primary oscillator and 8 MHz FRC sources have the option of using the internal 4x PLL. The frequency of the FRC clock source can optionally be reduced by the programmable clock divider. The selected clock source generates the processor and peripheral clock sources.

The processor clock source is divided by two to produce the internal instruction cycle clock, Fcy. In this document, the instruction cycle clock is also denoted by Fosc/2. The internal instruction cycle clock, Fosc/2, can be provided on the OSCO I/O pin for some operating modes of the primary oscillator.

9.2 Initial Configuration on POR

The oscillator source (and operating mode) that is used at a device Power-on Reset (POR) event is selected using Configuration bit settings. The oscillator Configuration bit settings are located in the Configuration registers in the program memory (For more information, see Section 23.1 "Configuration Bits"). The Primary Oscillator Configuration bits, POSCMD<1:0> (FOSC<1:0>), and the Initial Oscillator Configuration bits, FNOSC<2:0> (FOSCSEL<2:0>), select the oscillator source that is used at a POR. The FRC Primary Oscillator with Postscaler (FRCDIV) is the default (unprogrammed) selection. The secondary oscillator, or one of the internal oscillators, may be chosen by programming these bit locations. The EC mode Frequency Range Configuration bits, POSCFREQ<1:0> (FOSC<4:3>), optimize power consumption when running in EC mode. The default configuration is "frequency range is greater than 8 MHz".

The Configuration bits allow users to choose between the various clock modes, shown in Table 9-1.

9.2.1 CLOCK SWITCHING MODE CONFIGURATION BITS

The FCKSM Configuration bits (FOSC<7:6>) are used jointly to configure device clock switching and the FSCM. Clock switching is enabled only when FCKSM1 is programmed ('0'). The FSCM is enabled only when FCKSM<1:0> are both programmed ('00').

TABLE 9-1: CONFIGURATION BIT VALUES FOR CLOCK SELECTION

Oscillator Mode	Oscillator Source	POSCMD<1:0>	FNOSC<2:0>	Notes
8 MHz FRC Oscillator with Postscaler (FRCDIV)	Internal	11	111	1, 2
500 kHz FRC Oscillator with Postscaler (LPFRCDIV)	Internal	11	110	1
Low-Power RC Oscillator (LPRC)	Internal	11	101	1
Secondary (Timer1) Oscillator (SOSC)	Secondary	00	100	1
Primary Oscillator (HS) with PLL Module (HSPLL)	Primary	10	011	
Primary Oscillator (EC) with PLL Module (ECPLL)	Primary	00	011	
Primary Oscillator (HS)	Primary	10	010	
Primary Oscillator (XT)	Primary	01	010	
Primary Oscillator (EC)	Primary	00	010	
8 MHz FRC Oscillator with PLL Module (FRCPLL)	Internal	11	001	1
8 MHz FRC Oscillator (FRC)	Internal	11	000	1

Note 1: OSCO pin function is determined by the OSCIOFNC Configuration bit.

2: This is the default oscillator mode for an unprogrammed (erased) device.

9.3 Control Registers

The operation of the oscillator is controlled by three Special Function Registers (SFRs):

- OSCCON
- CLKDIV
- OSCTUN

The OSCCON register (Register 9-1) is the main control register for the oscillator. It controls clock source switching and allows the monitoring of clock sources.

The Clock Divider register (Register 9-2) controls the features associated with Doze mode, as well as the postscaler for the FRC oscillator.

The FRC Oscillator Tune register (Register 9-3) allows the user to fine tune the FRC oscillator. OSCTUN functionality has been provided to help customers compensate for temperature effects on the FRC frequency over a wide range of temperatures. The tuning step size is an approximation and is neither characterized nor tested.

REGISTER 9-1: OSCCON: OSCILLATOR CONTROL REGISTER

U-0	R-0, HSC	R-0, HSC	R-0, HSC	U-0	R/W-x ⁽¹⁾	R/W-x ⁽¹⁾	R/W-x ⁽¹⁾
_	COSC2	COSC1	COSC0	_	NOSC2	NOSC1	NOSC0
bit 15					_		bit 8

R/SO-0, HSC	U-0	R-0, HSC ⁽²⁾	U-0	R/CO-0, HS	R/W-0 ⁽³⁾	R/W-0	R/W-0
CLKLOCK	_	LOCK	_	CF	SOSCDRV	SOSCEN	OSWEN
bit 7							bit 0

Legend: HSC = Hardware Settable/Clearable bit

HS = Hardware Settable bit CO = Clearable Only bit SO = Settable Only bit

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 COSC<2:0>: Current Oscillator Selection bits

111 = 8 MHz Fast RC Oscillator with Postscaler (FRCDIV)

110 = 500 kHz Low-Power Fast RC Oscillator (FRC) with Postscaler (LPFRCDIV)

101 = Low-Power RC Oscillator (LPRC)

100 = Secondary Oscillator (SOSC)

011 = Primary Oscillator with PLL module (XTPLL, HSPLL, ECPLL)

010 = Primary Oscillator (XT, HS, EC)

001 = 8 MHz FRC Oscillator with Postscaler and PLL module (FRCPLL)

000 = 8 MHz FRC Oscillator (FRC)

bit 11 **Unimplemented:** Read as '0'

bit 10-8 NOSC<2:0>: New Oscillator Selection bits⁽¹⁾

111 = 8 MHz Fast RC Oscillator with Postscaler (FRCDIV)

110 = 500 kHz Low-Power Fast RC Oscillator (FRC) with Postscaler (LPFRCDIV)

101 = Low-Power RC Oscillator (LPRC)

100 = Secondary Oscillator (SOSC)

011 = Primary Oscillator with PLL module (XTPLL, HSPLL, ECPLL)

010 = Primary Oscillator (XT, HS, EC)

001 = 8 MHz FRC Oscillator with Postscaler and PLL module (FRCPLL)

000 = 8 MHz FRC Oscillator (FRC)

Note 1: Reset values for these bits are determined by the FNOSC Configuration bits.

2: Also resets to '0' during any valid clock switch or whenever a non-PLL Clock mode is selected.

3: When SOSC is selected to run from a digital clock input, rather than an external crystal (SOSCSRC = 0), this bit has no effect.

REGISTER 9-1: OSCCON: OSCILLATOR CONTROL REGISTER (CONTINUED)

bit 7 **CLKLOCK:** Clock Selection Lock Enabled bit If FSCM is enabled (FCKSM1 = 1):

1 = Clock and PLL selections are locked

0 = Clock and PLL selections are not locked and may be modified by setting the OSWEN bit

If FSCM is disabled (FCKSM1 = 0):

Clock and PLL selections are never locked and may be modified by setting the OSWEN bit.

bit 6 **Unimplemented:** Read as '0' bit 5 **LOCK:** PLL Lock Status bit⁽²⁾

1 = PLL module is in lock or the PLL module start-up timer is satisfied

0 = PLL module is out of lock, the PLL start-up timer is running or PLL is disabled

bit 4 **Unimplemented:** Read as '0'

bit 3 **CF:** Clock Fail Detect bit

1 = FSCM has detected a clock failure0 = No clock failure has been detected

bit 2 **SOSCDRV**: Secondary Oscillator Drive Strength bit⁽³⁾

1 = High-power SOSC circuit is selected

0 = Low/high-power select is done via the SOSCSRC Configuration bit

bit 1 SOSCEN: 32 kHz Secondary Oscillator (SOSC) Enable bit

1 = Enable secondary oscillator0 = Disable secondary oscillator

bit 0 OSWEN: Oscillator Switch Enable bit

1 = Initiate an oscillator switch to the clock source specified by the NOSC<2:0> bits

0 = Oscillator switch is complete

Note 1: Reset values for these bits are determined by the FNOSC Configuration bits.

2: Also resets to '0' during any valid clock switch or whenever a non-PLL Clock mode is selected.

3: When SOSC is selected to run from a digital clock input, rather than an external crystal (SOSCSRC = 0), this bit has no effect.

REGISTER 9-2: CLKDIV: CLOCK DIVIDER REGISTER

R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-1
ROI	DOZE2	DOZE1	DOZE0	DOZEN ⁽¹⁾	RCDIV2	RCDIV1	RCDIV0
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 ROI: Recover on Interrupt bit

1 = Interrupts clear the DOZEN bit, and reset the CPU and peripheral clock ratio to 1:1

0 = Interrupts have no effect on the DOZEN bit

bit 14-12 DOZE<2:0>: CPU-to-Peripheral Clock Ratio Select bits

111 = 1:128

110 = 1:64

101 = 1:32

100 = 1:16

011 = 1:8

010 = 1:4

001 = 1:2

000 = 1:1

bit 11 **DOZEN:** DOZE Enable bit⁽¹⁾

1 = DOZE<2:0> bits specify the CPU-to-peripheral clock ratio

0 = CPU and the peripheral clock ratio are set to 1:1

bit 10-8 RCDIV<2:0>: FRC Postscaler Select bits

When OSCCON (COSC<2:0>) = 111 or 001:

111 = 31.25 kHz (divide by 256)

110 = 125 kHz (divide by 64)

101 = 250 kHz (divide by 32)

100 = 500 kHz (divide by 16)

011 = 1 MHz (divide by 8)

010 = 2 MHz (divide by 4)

001 = 4 MHz (divide by 2) (default)

000 = 8 MHz (divide by 1)

When OSCCON (COSC<2:0>) = 110:

111 = 1.95 kHz (divide by 256)

110 = 7.81 kHz (divide by 64)

101 = 15.62 kHz (divide by 32)

100 = 31.25 kHz (divide by 16)

011 = 62.5 kHz (divide by 8)

010 = 125 kHz (divide by 4)

001 = 250 kHz (divide by 2) (default)

000 = 500 kHz (divide by 1)

bit 7-0 **Unimplemented:** Read as '0'

Note 1: This bit is automatically cleared when the ROI bit is set and an interrupt occurs.

REGISTER 9-3: OSCTUN: FRC OSCILLATOR TUNE REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	TUN5 ⁽¹⁾	TUN4 ⁽¹⁾	TUN3 ⁽¹⁾	TUN2 ⁽¹⁾	TUN1 ⁽¹⁾	TUN0 ⁽¹⁾
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit,	read as '0'
n = Value at POP	'1' = Rit is set	'0' = Rit is cleared	v = Rit is unknown

Note 1: Increments or decrements of TUN<5:0> may not change the FRC frequency in equal steps over the FRC tuning range and may not be monotonic.

9.4 Clock Switching Operation

With few limitations, applications are free to switch between any of the four clock sources (POSC, SOSC, FRC and LPRC) under software control and at any time. To limit the possible side effects that could result from this flexibility, PIC24F devices have a safeguard lock built into the switching process.

Note: The Primary Oscillator mode has three different submodes (XT, HS and EC), which are determined by the POSCMDx Configuration bits. While an application can switch to and from Primary Oscillator mode in software, it cannot switch between the different primary submodes without reprogramming the device.

9.4.1 ENABLING CLOCK SWITCHING

To enable clock switching, the FCKSM1 Configuration bit in the FOSC Configuration register must be programmed to '0'. (Refer to **Section 23.0 "Special Features"** for further details.) If the FCKSM1 Configuration bit is unprogrammed ('1'), the clock switching function and FSCM function are disabled; this is the default setting.

The NOSCx control bits (OSCCON<10:8>) do not control the clock selection when clock switching is disabled. However, the COSCx bits (OSCCON<14:12>) will reflect the clock source selected by the FNOSCx Configuration bits.

The OSWEN control bit (OSCCON<0>) has no effect when clock switching is disabled; it is held at '0' at all times.

9.4.2 OSCILLATOR SWITCHING SEQUENCE

At a minimum, performing a clock switch requires this basic sequence:

- If desired, read the COSCx bits (OSCCON<14:12>) to determine the current oscillator source.
- 2. Perform the unlock sequence to allow a write to the OSCCON register high byte.
- Write the appropriate value to the NOSCx bits (OSCCON<10:8>) for the new oscillator source.
- 4. Perform the unlock sequence to allow a write to the OSCCON register low byte.
- Set the OSWEN bit to initiate the oscillator switch.

Once the basic sequence is completed, the system clock hardware responds automatically, as follows:

- The clock switching hardware compares the COSCx bits with the new value of the NOSCx bits. If they are the same, then the clock switch is a redundant operation. In this case, the OSWEN bit is cleared automatically and the clock switch is aborted.
- If a valid clock switch has been initiated, the LOCK (OSCCON<5>) and CF (OSCCON<3>) bits are cleared.
- The new oscillator is turned on by the hardware if it is not currently running. If a crystal oscillator must be turned on, the hardware will wait until the OST expires. If the new source is using the PLL, then the hardware waits until a PLL lock is detected (LOCK = 1).
- The hardware waits for 10 clock cycles from the new clock source and then performs the clock switch.
- The hardware clears the OSWEN bit to indicate a successful clock transition. In addition, the NOSCx bits value is transferred to the COSCx bits.
- The old clock source is turned off at this time, with the exception of LPRC (if WDT, FSCM or RTCC with LPRC as a clock source are enabled) or SOSC (if SOSCEN remains enabled).
 - Note 1: The processor will continue to execute code throughout the clock switching sequence. Timing-sensitive code should not be executed during this time.
 - 2: Direct clock switches between any Primary Oscillator mode with PLL and FRCPLL mode are not permitted. This applies to clock switches in either direction. In these instances, the application must switch to FRC mode as a transition clock source between the two PLL modes.

The following code sequence for a clock switch is recommended:

- Disable interrupts during the OSCCON register unlock and write sequence.
- Execute the unlock sequence for the OSCCON high byte by writing 78h and 9Ah to OSCCON<15:8>, in two back-to-back instructions.
- Write the new oscillator source to the NOSCx bits in the instruction immediately following the unlock sequence.
- Execute the unlock sequence for the OSCCON low byte by writing 46h and 57h to OSCCON
 in two back-to-back instructions.
- 5. Set the OSWEN bit in the instruction immediately following the unlock sequence.
- 6. Continue to execute code that is not clock-sensitive (optional).
- Invoke an appropriate amount of software delay (cycle counting) to allow the selected oscillator and/or PLL to start and stabilize.
- Check to see if OSWEN is '0'. If it is, the switch was successful. If OSWEN is still set, then check the LOCK bit to determine the cause of failure.

The core sequence for unlocking the OSCCON register and initiating a clock switch is shown in Example 9-1.

EXAMPLE 9-1: BASIC CODE SEQUENCE FOR CLOCK SWITCHING

```
;Place the new oscillator selection in WO
;OSCCONH (high byte) Unlock Sequence
MOV
           #OSCCONH, w1
MOV
            #0x78, w2
MOV
           #0x9A, w3
MOV h
           w2, [w1]
MOV.b
           w3, [w1]
;Set new oscillator selection
MOV.b
           WREG, OSCCONH
;OSCCONL (low byte) unlock sequence
MOV
           #OSCCONT, w1
MOV
           #0x46, w2
VOM
           #0x57, w3
MOV.b
           w2, [w1]
MOV.b
           w3, [w1]
;Start oscillator switch operation
           OSCCON,#0
```

9.5 Reference Clock Output

In addition to the CLKO output (Fosc/2) available in certain oscillator modes, the device clock in the PIC24F16KL402 family devices can also be configured to provide a reference clock output signal to a port pin. This feature is available in all oscillator configurations and allows the user to select a greater range of clock submultiples to drive external devices in the application.

This reference clock output is controlled by the REFOCON register (Register 9-4). Setting the ROEN bit (REFOCON<15>) makes the clock signal available on the REFO pin. The RODIV bits (REFOCON<11:8>) enable the selection of 16 different clock divider options.

The ROSSLP and ROSEL bits (REFOCON<13:12>) control the availability of the reference output during Sleep mode. The ROSEL bit determines if the oscillator on OSC1 and OSC2, or the current system clock source, is used for the reference clock output. The ROSSLP bit determines if the reference source is available on REFO when the device is in Sleep mode.

To use the reference clock output in Sleep mode, both the ROSSLP and ROSEL bits must be set. The device clock must also be configured for one of the primary modes (EC, HS or XT). Therefore, if the ROSEL bit is also not set, the oscillator on OSC1 and OSC2 will be powered down when the device enters Sleep mode. Clearing the ROSEL bit allows the reference output frequency to change as the system clock changes during any clock switches.

REGISTER 9-4: REFOCON: REFERENCE OSCILLATOR CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ROEN	_	ROSSLP	ROSEL	RODIV3	RODIV2	RODIV1	RODIV0
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 7 bit 0							

Legend:				
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15 ROEN: Reference Oscillator Output Enable bit

1 = Reference oscillator enabled on REFO pin

0 = Reference oscillator disabled

bit 14 Unimplemented: Read as '0'

bit 13 ROSSLP: Reference Oscillator Output Stop in Sleep bit

1 = Reference oscillator continues to run in Sleep

0 = Reference oscillator is disabled in Sleep

bit 12 ROSEL: Reference Oscillator Source Select bit

1 = Primary oscillator is used as the base clock(1)

0 = System clock is used as the base clock; the base clock reflects any clock switching of the device

bit 11-8 RODIV<3:0>: Reference Oscillator Divisor Select bits

1111 = Base clock value divided by 32,768

1110 = Base clock value divided by 16,384

1101 = Base clock value divided by 8,192

1100 = Base clock value divided by 4,096

1011 = Base clock value divided by 2,048

1010 = Base clock value divided by 1,024

1001 = Base clock value divided by 512

1000 = Base clock value divided by 256 0111 = Base clock value divided by 128

0110 = Base clock value divided by 64

of of ... Deep clock value divided by 04

0101 = Base clock value divided by 32 0100 = Base clock value divided by 16

0011 = Base clock value divided by 8

0011 - base clock value divided by o

0010 = Base clock value divided by 4

0001 = Base clock value divided by 2

0000 = Base clock value

bit 7-0 **Unimplemented:** Read as '0'

Note 1: The crystal oscillator must be enabled using the FOSC<2:0> bits; the crystal maintains the operation in Sleep mode.

NOTES:

10.0 POWER-SAVING FEATURES

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on Power-Saving Features, refer to the "PIC24F Family Reference Manual", "Section 39. Power-Saving Features with Deep Sleep" (DS39727).

The PIC24F16KL402 family of devices provides the ability to manage power consumption by selectively managing clocking to the CPU and the peripherals. In general, a lower clock frequency and a reduction in the number of circuits being clocked constitutes lower consumed power. All PIC24F devices manage power consumption using several strategies:

- Clock frequency
- · Instruction-based Idle and Sleep modes
- · Hardware-based periodic wake-up from Sleep
- · Software Controlled Doze mode
- · Selective peripheral control in software

Combinations of these methods can be used to selectively tailor an application's power consumption, while still maintaining critical application features, such as timing-sensitive communications.

10.1 Clock Frequency and Clock Switching

PIC24F devices allow for a wide range of clock frequencies to be selected under application control. If the system clock configuration is not locked, users can choose low-power or high-precision oscillators by simply changing the NOSC bits. The process of changing a system clock during operation, as well as limitations to the process, are discussed in more detail in Section 9.0 "Oscillator Configuration".

10.2 Instruction-Based Power-Saving Modes

PIC24F devices have two special power-saving modes that are entered through the execution of a special PWRSAV instruction. Sleep mode stops clock operation and halts all code execution; Idle mode halts the CPU and code execution, but allows peripheral modules to continue operation.

The assembly syntax of the PWRSAV instruction is shown in Example 10-1.

Note:

SLEEP_MODE and IDLE_MODE are constants, defined in the assembler include file for the selected device.

Sleep and Idle modes can be exited as a result of an enabled interrupt, WDT time-out or a device Reset. When the device exits these modes, it is said to "wake-up".

EXAMPLE 10-1: PWRSAV INSTRUCTION SYNTAX

PWRSAV #SLEEP_MODE ; Put the device into SLEEP mode PWRSAV #IDLE_MODE ; Put the device into IDLE mode

10.2.1 SLEEP MODE

Sleep mode includes these features:

- The system clock source is shut down. If an on-chip oscillator is used, it is turned off.
- The device current consumption will be reduced to a minimum, provided that no I/O pin is sourcing current.
- The I/O pin directions and states are frozen.
- The Fail-Safe Clock Monitor does not operate during Sleep mode since the system clock source is disabled.
- The LPRC clock will continue to run in Sleep mode if the WDT or RTCC with LPRC as clock source is enabled.
- The WDT, if enabled, is automatically cleared prior to entering Sleep mode.
- Some device features, or peripherals, may continue to operate in Sleep mode. This includes items, such as the input change notification on the I/O ports, or peripherals that use an external clock input. Any peripheral that requires the system clock source for its operation will be disabled in Sleep mode.

The device will wake-up from Sleep mode on any of these events:

- On any interrupt source that is individually enabled
- · On any form of device Reset
- · On a WDT time-out

On wake-up from Sleep, the processor will restart with the same clock source that was active when Sleep mode was entered.

10.2.2 IDLE MODE

Idle mode has these features:

- · The CPU will stop executing instructions.
- The WDT is automatically cleared.
- The system clock source remains active. By default, all peripheral modules continue to operate normally from the system clock source, but can also be selectively disabled (see Section 10.5 "Selective Peripheral Module Control").
- If the WDT or FSCM is enabled, the LPRC will also remain active.

The device will wake from Idle mode on any of these events:

- · Any interrupt that is individually enabled
- · Any device Reset
- · A WDT time-out

On wake-up from Idle, the clock is re-applied to the CPU. Instruction execution begins immediately, starting with the instruction following the PWRSAV instruction or the first instruction in the ISR.

10.2.3 INTERRUPTS COINCIDENT WITH POWER SAVE INSTRUCTIONS

Any interrupt that coincides with the execution of a PWRSAV instruction will be held off until entry into Sleep or Idle mode has completed. The device will then wake-up from Sleep or Idle mode.

10.3 Ultra Low-Power Wake-up

The Ultra Low-Power Wake-up (ULPWU) on pin, RB0, allows a slow falling voltage to generate an interrupt without excess current consumption. This feature provides a low-power technique for periodically waking up the device from Sleep mode.

To use this feature:

- Charge the capacitor on RB0 by configuring the RB0 pin to an output and setting it to '1'.
- Stop charging the capacitor by configuring RB0 as an input.
- Discharge the capacitor by setting the ULPEN and ULPSINK bits in the ULPWCON register.
- 4. Configure Sleep mode.
- 5. Enter Sleep mode.

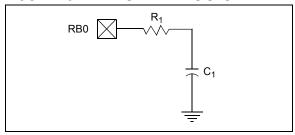
The time-out is dependent on the discharge time of the RC circuit on RB0. When the voltage on RB0 drops below VIL, the device wakes up and executes the next instruction.

When the ULPWU module wakes the device from Sleep mode, the ULPWUIF bit (IFS5<0>) is set. Software can check this bit upon wake-up to determine the wake-up source.

See Example 10-2 for initializing the ULPWU module.

A series resistor, between RB0 and the external capacitor, provides overcurrent protection for the RB0/AN0/ULPWU pin and enables software calibration of the time-out (see Figure 10-1).

FIGURE 10-1: SERIAL RESISTOR



A timer can be used to measure the charge time and discharge time of the capacitor. The charge time can then be adjusted to provide the desired delay in Sleep. This technique compensates for the affects of temperature, voltage and component accuracy. The peripheral can also be configured as a simple, programmable Low-Voltage Detect (LVD) or temperature sensor.

EXAMPLE 10-2: ULTRA LOW-POWER WAKE-UP INITIALIZATION

```
//*******
// 1. Charge the capacitor on RBO
  TRISBbits.TRISB0 = 0;
  LATBbits.LATB0 = 1;
  for(i = 0; i < 10000; i++) Nop();
//2. Stop Charging the capacitor on RBO
  TRISBbits.TRISB0 = 1;
//3. Enable ULPWU Interrupt
IFS5bits.ULPWUIF = 0;
IEC5bits.ULPWUIE = 1;
IPC20bits.ULPWUIP = 0x7;
//4. Enable the Ultra Low Power Wakeup module and allow capacitor discharge
//***************
  ULPWCONbits.ULPEN = 1;
  ULPWCONbits.ULPSINK = 1;
//5. Enter Sleep Mode
//for Sleep, execution will resume here
```

REGISTER 10-1: ULPWCON: ULPWU CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0
ULPEN	_	ULPSIDL	_	_	_	-	ULPSINK
bit 15 bit 8							

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	-	_	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **ULPEN:** ULPWU Module Enable bit

1 = Module is enabled0 = Module is disabled

bit 14 Unimplemented: Read as '0'

bit 13 ULPSIDL: ULPWU Stop in Idle Select bit

1 = Discontinue module operation when the device enters Idle mode

0 = Continue module operation in Idle mode

bit 12-9 **Unimplemented:** Read as '0'

bit 8 **ULPSINK:** ULPWU Current Sink Enable bit

1 = Current sink is enabled0 = Current sink is disabled

bit 7-0 **Unimplemented:** Read as '0'

10.4 Doze Mode

Generally, changing clock speed and invoking one of the power-saving modes are the preferred strategies for reducing power consumption. There may be circumstances, however, where this is not practical. For example, it may be necessary for an application to maintain uninterrupted, synchronous communication, even while it is doing nothing else. Reducing system clock speed may introduce communication errors, while using a power-saving mode may stop communications completely.

Doze mode is a simple and effective alternative method to reduce power consumption while the device is still executing code. In this mode, the system clock continues to operate from the same source and at the same speed. Peripheral modules continue to be clocked at the same speed, while the CPU clock speed is reduced. Synchronization between the two clock domains is maintained, allowing the peripherals to access the SFRs while the CPU executes code at a slower rate.

Doze mode is enabled by setting the DOZEN bit (CLKDIV<11>). The ratio between peripheral and core clock speed is determined by the DOZE<2:0> bits (CLKDIV<14:12>). There are eight possible configurations, from 1:1 to 1:128, with 1:1 being the default.

It is also possible to use Doze mode to selectively reduce power consumption in event driven applications. This allows clock-sensitive functions, such as synchronous communications, to continue without interruption. Meanwhile, the CPU Idles, waiting for something to invoke an interrupt routine. Enabling the automatic return to full-speed CPU operation on interrupts is enabled by setting the ROI bit (CLKDIV<15>). By default, interrupt events have no effect on Doze mode operation.

10.5 Selective Peripheral Module Control

Idle and Doze modes allow users to substantially reduce power consumption by slowing or stopping the CPU clock. Even so, peripheral modules still remain clocked and thus, consume power. There may be cases where the application needs what these modes do not provide: the allocation of power resources to CPU processing, with minimal power consumption from the peripherals.

PIC24F devices address this requirement by allowing peripheral modules to be selectively disabled, reducing or eliminating their power consumption. This can be done with two control bits:

- The Peripheral Enable bit, generically named, "XXXEN", located in the module's main control SER
- The Peripheral Module Disable (PMD) bit, generically named, "XXXMD", located in one of the PMD Control registers.

Both bits have similar functions in enabling or disabling its associated module. Setting the PMD bit for a module disables all clock sources to that module, reducing its power consumption to an absolute minimum. In this state, the control and status registers associated with the peripheral will also be disabled, so writes to those registers will have no effect, and read values will be invalid. Many peripheral modules have a corresponding PMD bit.

In contrast, disabling a module by clearing its XXXEN bit, disables its functionality, but leaves its registers available to be read and written to. Power consumption is reduced, but not by as much as when the PMD bits are used.

To achieve more selective power savings, peripheral modules can also be selectively disabled when the device enters Idle mode. This is done through the control bit of the generic name format, "XXXIDL". By default, all modules that can operate during Idle mode will do so. Using the disable on Idle feature disables the module while in Idle mode, allowing further reduction of power consumption during Idle mode. This enhances power savings for extremely critical power applications.

NOTES:

11.0 I/O PORTS

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the I/O Ports, refer to the "PIC24F Family Reference Manual", Section 12. "I/O Ports with Peripheral Pin Select (PPS)" (DS39711). Note that the PIC24F16KL402 family devices do not support Peripheral Pin Select features.

All of the device pins (except VDD and VSS) are shared between the peripherals and the parallel I/O ports. All I/O input ports feature Schmitt Trigger inputs for improved noise immunity.

Parallel I/O (PIO) Ports 11.1

A parallel I/O port that shares a pin with a peripheral is, in general, subservient to the peripheral. The peripheral's output buffer data and control signals are provided to a pair of multiplexers. The multiplexers select whether the peripheral or the associated port has ownership of the output data and control signals of the I/O pin. Figure 11-1 illustrates how ports are shared with other peripherals and the associated I/O pin to which they are connected.

When a peripheral is enabled and the peripheral is actively driving an associated pin, the use of the pin as a general purpose output pin is disabled. The I/O pin may be read, but the output driver for the parallel port bit will be disabled. If a peripheral is enabled, but the peripheral is not actively driving a pin, that pin may be driven by a port.

All port pins have three registers directly associated with their operation as digital I/O. The Data Direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is a '1', then the pin is an input. All port pins are defined as inputs after a Reset. Reads from the Data Latch register (LATx), read the latch. Writes to the Data Latch, write the latch. Reads from the port (PORTx), read the port pins, while writes to the port pins, write the latch.

Any bit and its associated data and control registers, that are not valid for a particular device, will be disabled. That means the corresponding LATx and TRISx registers, and the port pin will read as zeros.

When a pin is shared with another peripheral or function that is defined as an input only, it is nevertheless, regarded as a dedicated port because there is no other competing source of outputs.

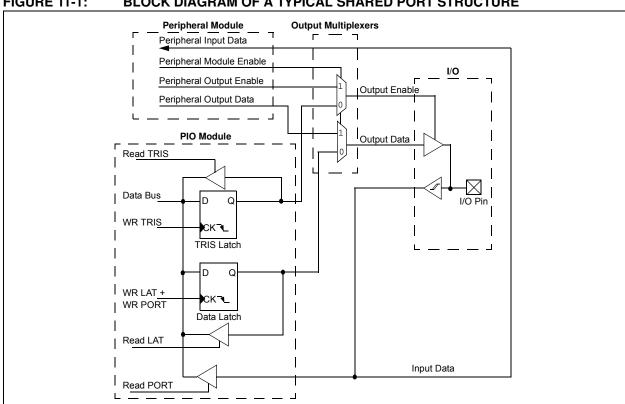


FIGURE 11-1: BLOCK DIAGRAM OF A TYPICAL SHARED PORT STRUCTURE

11.1.1 OPEN-DRAIN CONFIGURATION

In addition to the PORT, LAT and TRIS registers for data control, each port pin can be individually configured for either digital or open-drain output. This is controlled by the Open-Drain Control register, ODCx, associated with each port. Setting any of the bits configures the corresponding pin to act as an open-drain output.

The maximum open-drain voltage allowed is the same as the maximum VIH specification.

11.1.2 I/O PORT WRITE/READ TIMING

One instruction cycle is required between a port direction change or port write operation and a read operation of the same port. Typically, this instruction would be a NOP.

11.2 Configuring Analog Port Pins

The use of the ANS and TRIS registers control the operation of the A/D port pins. The port pins that are desired as analog inputs must have their corresponding TRIS bit set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted.

When reading the PORTx register, all pins configured as analog input channels will read as cleared (a low level). Analog levels on any pin that is defined as a digital input (including the ANx pins) may cause the input buffer to consume current that exceeds the device specifications.

11.2.1 ANALOG SELECTION REGISTER

I/O pins with shared analog functionality, such as A/D inputs and comparator inputs, must have their digital inputs shut off when analog functionality is used. Note that analog functionality includes an analog voltage being applied to the pin externally.

To allow for analog control, the ANSx registers are provided. There is one ANS register for each port (ANSA and ANSB, Register 11-1 and Register 11-2). Within each ANSx register, there is a bit for each pin that shares analog functionality with the digital I/O functionality. If a particular pin does not have an analog function, that bit is unimplemented.

REGISTER 11-1: ANSA: ANALOG SELECTION (PORTA)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_	_	ANSA3	ANSA2	ANSA1	ANSA0
bit 7							bit 0

Legend: U = Unimplemented bit, read as '0'

R = Readable bit W = Writable bit HSC = Hardware Settable/Clearable bit

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-4 Unimplemented: Read as '0'

bit 3-0 ANSA<3:0>: Analog Select Control bits

1 = Digital input buffer is not active (use for analog input)

0 = Digital input buffer is active

REGISTER 11-2: ANSB: ANALOG SELECTION (PORTB)

R/W-1	R/W-1	R/W-1	R/W-1	U-0	U-0	U-0	U-0
ANSB15	ANSB14	ANSB13 ⁽¹⁾	ANSB12 ⁽¹⁾	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_	ANSB4	ANSB3 ⁽²⁾	ANSB2 ⁽¹⁾	ANSB1 ⁽¹⁾	ANSB0 ⁽¹⁾
bit 7							bit 0

Legend: U = Unimplemented bit, read as '0'

R = Readable bit W = Writable bit HSC = Hardware Settable/Clearable bit

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-12 ANSB<15:12>: Analog Select Control bits⁽¹⁾

1 = Digital input buffer is not active (use for analog input)

0 = Digital input buffer is active

bit 11-5 **Unimplemented:** Read as '0'

bit 4-0 ANSB<4:0>: Analog Select Control bits⁽²⁾

1 = Digital input buffer is not active (use for analog input)

0 = Digital input buffer is active

Note 1: ANSB<13:12,2:0> are unimplemented on 14-pin devices.

2: ANSB<3> is unimplemented on 14-pin and 20-pin devices.

11.3 Input Change Notification

The input change notification function of the I/O ports allows the PIC24F16KL402 family of devices to generate interrupt requests to the processor in response to a Change-of-State (COS) on selected input pins. This feature is capable of detecting input Change-of-States, even in Sleep mode, when the clocks are disabled. Depending on the device pin count, there are up to 23 external signals that may be selected (enabled) for generating an interrupt request on a Change-of-State.

There are six control registers associated with the CN module. The CNEN1 and CNEN2 registers contain the interrupt enable control bits for each of the CN input pins. Setting any of these bits enables a CN interrupt for the corresponding pins.

Each CN pin also has a weak pull-up/pull-down connected to it. The pull-ups act as a current source that is connected to the pin. The pull-downs act as a current sink to eliminate the need for external resistors when push button or keypad devices are connected.

On any pin, only the pull-up resistor or the pull-down resistor should be enabled, but not both of them. If the push button or the keypad is connected to VDD, enable the pull-down, or if they are connected to Vss, enable the pull-up resistors. The pull-ups are enabled separately using the CNPU1 and CNPU2 registers, which contain the control bits for each of the CN pins.

Setting any of the control bits enables the weak pull-ups for the corresponding pins. The pull-downs are enabled separately, using the CNPD1 and CNPD2 registers, which contain the control bits for each of the CN pins. Setting any of the control bits enables the weak pull-downs for the corresponding pins.

When the internal pull-up is selected, the pin uses VDD as the pull-up source voltage. When the internal pull-down is selected, the pins are pulled down to Vss by an internal resistor. Make sure that there is no external pull-up source/pull-down sink when the internal pull-ups/pull-downs are enabled.

Note:

Pull-ups and pull-downs on change notification pins should always be disabled whenever the port pin is configured as a digital output.

EXAMPLE 11-1: PORT WRITE/READ EXAMPLE (ASSEMBLY LANGUAGE)

```
MOV #0xFF00, W0 ; Configure PORTB<15:8> as inputs and PORTB<7:0> as outputs
MOV W0, TRISB
MOV #0x00FF, W0 ; Enable PORTB<15:8> digital input buffers
MOV W0, ANSB
NOP ; Delay 1 cycle
BTSS PORTB, #13 ; Next Instruction
```

EXAMPLE 11-2: PORT WRITE/READ EXAMPLE (C LANGUAGE)

12.0 TIMER1

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on Timers, refer to the "PIC24F Family Reference Manual", Section 14. "Timers" (DS39704).

The Timer1 module is a 16-bit timer which can operate as a free-running, interval timer/counter, or serve as the time counter for a software-based Real-Time Clock (RTC). Timer1 is only reset on initial VDD power-on events. This allows the timer to continue operating as an RTC clock source through other types of device Reset.

Timer1 can operate in three modes:

- · 16-Bit Timer
- · 16-Bit Synchronous Counter
- · 16-Bit Asynchronous Counter

Timer1 also supports these features:

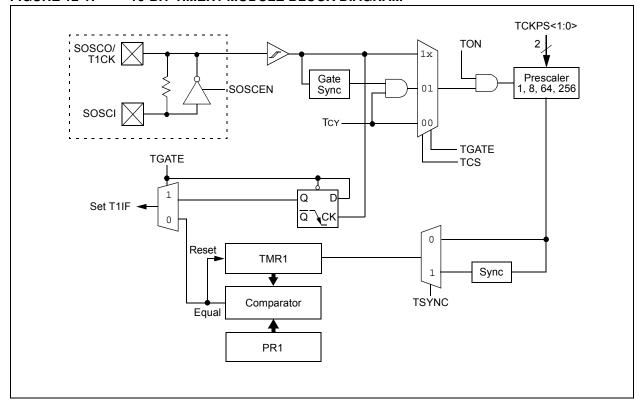
- · Timer Gate Operation
- · Selectable Prescaler Settings
- · Timer Operation During CPU Idle and Sleep modes
- Interrupt on 16-Bit Period Register Match or Falling Edge of External Gate Signal

Figure 12-1 illustrates a block diagram of the 16-bit Timer1 module.

To configure Timer1 for operation:

- Set the TON bit (= 1).
- Select the timer prescaler ratio using the TCKPS<1:0> bits.
- 3. Set the Clock and Gating modes using the TCS and TGATE bits.
- 4. Set or clear the TSYNC bit to configure synchronous or asynchronous operation.
- Load the timer period value into the PR1 register.
- 6. If interrupts are required, set the interrupt enable bit, T1IE. Use the priority bits, T1IP<2:0>, to set the interrupt priority.

FIGURE 12-1: 16-BIT TIMER1 MODULE BLOCK DIAGRAM



REGISTER 12-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0
TON	_	TSIDL	_	_	_	T1ECS1 ⁽¹⁾	T1ECS0 ⁽¹⁾
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0
_	TGATE	TCKPS1	TCKPS0	_	TSYNC	TCS	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 TON: Timer1 On bit

1 = Starts 16-bit Timer1
0 = Stops 16-bit Timer1

bit 14 **Unimplemented:** Read as '0'

bit 13 TSIDL: Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12-10 **Unimplemented:** Read as '0'

bit 9-8 T1ECS <1:0>: Timer1 Extended Clock Select bits(1)

11 = Reserved: do not use

10 = Timer1 uses the LPRC as the clock source

01 = Timer1 uses the External Clock from T1CK

00 = Timer1 uses the Secondary Oscillator (SOSC) as the clock source

bit 7 **Unimplemented:** Read as '0'

bit 6 TGATE: Timer1 Gated Time Accumulation Enable bit

When TCS = 1: This bit is ignored. When TCS = 0:

1 = Gated time accumulation is enabled0 = Gated time accumulation is disabled

bit 5-4 TCKPS<1:0>: Timer1 Input Clock Prescale Select bits

11 = 1:256 10 = 1:64

01 = 1:800 = 1:1

bit 3 **Unimplemented:** Read as '0'

bit 2 TSYNC: Timer1 External Clock Input Synchronization Select bit

When TCS = 1:

1 = Synchronize external clock input0 = Do not synchronize external clock input

When TCS = 0: This bit is ignored.

bit 1 TCS: Timer1 Clock Source Select bit

1 = Timer1 clock source is selected by T1ECS<1:0>

0 = Internal clock (Fosc/2)

bit 0 **Unimplemented:** Read as '0'

Note 1: The T1ECS bits are valid only when TCS = 1.

13.0 TIMER2 MODULE

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on Timers, refer to the "PIC24F Family Reference Manual", Section 14. "Timers" (DS39704).

The Timer2 module incorporates the following features:

- 8-bit Timer and Period registers (TMR2 and PR2, respectively)
- Readable and writable (both registers)
- Software programmable prescaler (1:1, 1:4 and 1:16)
- Software programmable postscaler (1:1 through 1:16)
- Interrupt on TMR2 to PR2 match
- · Optional Timer3 gate on TMR2 to PR2 match
- Optional use as the shift clock for the MSSP modules

This module is controlled through the T2CON register (Register 13-1), which enables or disables the timer and configures the prescaler and postscaler. Timer2 can be shut off by clearing control bit, TMR2ON (T2CON<2>), to minimize power consumption.

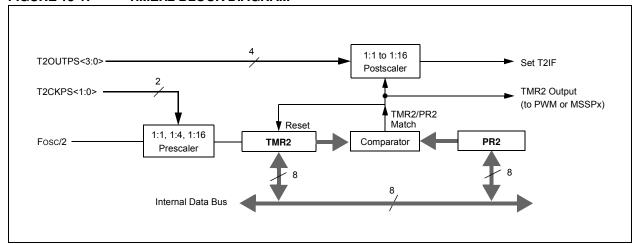
The prescaler and postscaler counters are cleared when any of the following occurs:

- · A write to the TMR2 register
- · A write to the T2CON register
- Any device Reset (POR, BOR, MCLR, or WDT Reset)

TMR2 is not cleared when T2CON is written.

A simplified block diagram of the module is shown in Figure 13-1.

FIGURE 13-1: TIMER2 BLOCK DIAGRAM



REGISTER 13-1: T2CON: TIMER2 CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	T2OUTPS3	T2OUTPS2	T2OUTPS1	T2OUTPS0	TMR2ON	T2CKPS1	T2CKPS0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6-3 **T2OUTPS<3:0>:** Timer2 Output Postscale Select bits

1111 = 1:16 Postscale 1110 = 1:15 Postscale

•

0001 = 1:2 Postscale 0000 = 1:1 Postscale

bit 2 TMR2ON: Timer2 On bit

1 = Timer2 is on 0 = Timer2 is off

bit 1-0 T2CKPS<1:0>: Timer2 Clock Prescale Select bits

10 = Prescaler is 16 01 = Prescaler is 4 00 = Prescaler is 1

14.0 TIMER3 MODULE

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on Timers, refer to the "PIC24F Family Reference Manual", Section 14. "Timers" (DS39704).

The Timer3 timer/counter modules incorporate these features:

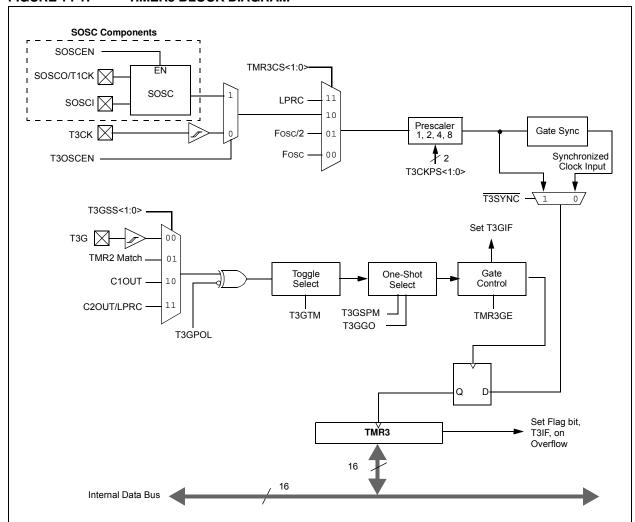
- Software-selectable operation as a 16-bit timer or counter
- One 16-bit readable and writable Timer Value register

- Selectable clock source (internal or external) with device clock, SOSC or LPRC oscillator options
- · Interrupt-on-overflow
- · Multiple timer gating options, including:
 - user-selectable gate sources and polarity
 - gate/toggle operation
 - Single-pulse (One-Shot) mode
- · Module Reset on ECCP Special Event Trigger

The Timer3 module is controlled through the T3CON register (Register 14-1). A simplified block diagram of the Timer3 module is shown in Figure 14-1.

The FOSC clock source should not be used with the ECCP capture/compare features. If the timer will be used with the capture or compare features, always select one of the other timer clocking options.

FIGURE 14-1: TIMER3 BLOCK DIAGRAM



REGISTER 14-1: T3CON: TIMER3 CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0
TMR3CS1	TMR3CS0	T3CKPS1	T3CKPS0	T3OSCEN	T3SYNC	_	TMR3ON
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7-6 TMR3CS<1:0>: Clock Source Select bits

11 = Low-Power RC Oscillator (LPRC)

10 = External clock source (selected by T3CON<3>)

01 = Instruction clock (Fosc/2) 00 = System clock (Fosc)⁽¹⁾

bit 5-4 T3CKPS<1:0>: Timer3 Input Clock Prescale Select bits

11 = 1:8 Prescale value 10 = 1:4 Prescale value 01 = 1:2 Prescale value 00 = 1:1 Prescale value

bit 3 T3OSCEN: Timer Oscillator Enable bit

1 = SOSC (Secondary Oscillator) is used as a clock source

0 = T3CK digital input pin is used as a clock source

bit 2 T3SYNC: External Clock Input Synchronization Control bit

When TMR3CS<1:0> = 1x:

1 = Do not synchronize the external clock input 0 = Synchronize the external clock input⁽²⁾

When TMR3CS<1:0> = 0x:

This bit is ignored; Timer3 uses the internal clock.

bit 1 **Unimplemented:** Read as '0'

bit 0 TMR3ON: Timer On bit

1 = Enables Timer

0 = Stops Timer

Note 1: The Fosc clock source should not be selected if the timer will be used with the ECCP Capture or Compare features.

2: This option must be selected when the timer will be used with ECCP/CCP.

REGISTER 14-2: T3GCON: TIMER3 GATE CONTROL REGISTER⁽¹⁾

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-x	R/W-0	R/W-0
TMR3GE	T3GPOL	T3GTM	T3GSPM	T3GGO/ T3DONE	T3GVAL	T3GSS1	T3GSS0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 TMR3GE: Timer Gate Enable bit

 $\frac{\text{If TMR3ON} = 0:}{\text{This bit is ignored.}}$ $\frac{\text{If TMR3ON} = 1:}{\text{If TMR3ON}}$

1 = Timer counting is controlled by the Timer3 gate function0 = Timer counts regardless of the Timer3 gate function

bit 6 T3GPOL: Gate Polarity bit

1 = Timer gate is active-high (Timer3 counts when the gate is high)0 = Timer gate is active-low (Timer3 counts when the gate is low)

bit 5 **T3GTM:** Gate Toggle Mode bit

1 = Timer Gate Toggle mode is enabled.

0 = Timer Gate Toggle mode is disabled and toggle flip-flop is cleared

Timer3 gate flip-flop toggles on every rising edge.

bit 4 T3GSPM: Timer Gate Single Pulse Mode bit

1 = Timer Gate Single Pulse mode is enabled and is controlling Timer3 gate

0 = Timer Gate Single Pulse mode is disabled

bit 3 T3GGO/T3DONE: Timer Gate Single Pulse Acquisition Status bit

1 = Timer gate single pulse acquisition is ready, waiting for an edge

0 = Timer gate single pulse acquisition has completed or has not been started

This bit is automatically cleared when TxGSPM is cleared.

bit 2 T3GVAL: Timer Gate Current State bit

Indicates the current state of the Timer gate that could be provided to the TMR3 register; unaffected by

the state of TMR3GE.

bit 1-0 T3GSS<1:0>: Timer Gate Source Select bits

11 = Comparator 2 output

10 = Comparator 1 output

01 = TMR2 to match PR2 output

00 = T3G input pin

Note 1: Initializing T3GCON prior to T3CON is recommended.

NOTES:

15.0 TIMER4 MODULE

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on Timers, refer to the "PIC24F Family Reference Manual", Section 14. "Timers" (DS39704).

The Timer4 module is implemented in PIC24FXXKL30X/40X devices only. It has the following features:

- Eight-bit Timer register (TMR4)
- Eight-bit Period register (PR4)
- Readable and writable (all registers)
- Software programmable prescaler (1:1, 1:4, 1:16)
- Software programmable postscaler (1:1 to 1:16)
- · Interrupt on TMR4 match of PR4

The Timer4 module has a control register shown in Register 15-1. Timer4 can be shut off by clearing control bit, TMR4ON (T4CON<2>), to minimize power consumption. The prescaler and postscaler selection of Timer4 is controlled by this register.

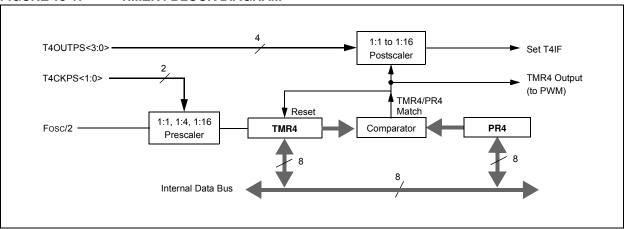
The prescaler and postscaler counters are cleared when any of the following occurs:

- · A write to the TMR4 register
- · A write to the T4CON register
- Any device Reset (POR, BOR, MCLR or WDT Reset)

TMR4 is not cleared when T4CON is written.

Figure 15-1 is a simplified block diagram of the Timer4 module.

FIGURE 15-1: TIMER4 BLOCK DIAGRAM



REGISTER 15-1: T4CON: TIMER4 CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	T4OUTPS3	T4OUTPS2	T4OUTPS1	T4OUTPS0	TMR4ON	T4CKPS1	T4CKPS0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6-3 **T40UTPS<3:0>:** Timer4 Output Postscale Select bits

1111 = 1:16 Postscale 1110 = 1:15 Postscale

•

•

0001 = 1:2 Postscale 0000 = 1:1 Postscale

bit 2 TMR4ON: Timer4 On bit

1 = Timer2 is on 0 = Timer2 is off

bit 1-0 T4CKPS<1:0>: Timer4 Clock Prescale Select bits

10 = Prescaler is 16 01 = Prescaler is 4 00 = Prescaler is 1

16.0 CAPTURE/COMPARE/PWM (CCP) AND ENHANCED CCP MODULES

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the Capture/Compare/PWM module, refer to the "PIC24F Family Reference Manual".

Depending on the particular device, PIC24F16KL402 family devices include up to three CCP and/or ECCP modules. Key features of all CCP modules include:

- · 16-bit input capture for a range of edge events
- 16-bit output compare with multiple output options
- Single-output Pulse Width Modulation (PWM) with up to 10 bits of resolution
- User-selectable time base from any available timer
- Special Event Trigger on capture and compare events to automatically trigger a range of peripherals

ECCP modules also include these features:

- Operation in Half-Bridge and Full-Bridge (Forward and Reverse) modes
- Pulse steering control across any or all Enhanced PWM pins, with user-configurable steering synchronization
- User-configurable External Fault Detect with Auto-Shutdown and Auto Restart

PIC24FXXKL40X/30X devices instantiate three CCP modules, one Enhanced (CCP1) and two standard (CCP2 and CCP). All other devices instantiate two standard CCP modules (CCP1 and CCP2).

16.1 Timer Selection

On all PIC24F16KL402 family devices, the CCP and ECCP modules use Timer3 as the time base for capture and compare operations. PWM and Enhanced PWM operations may use either Timer2 or Timer4. PWM time base selection is done through the CCPTMRS0 register (Register 16-6).

16.2 CCP I/O Pins

To configure I/O pins with a CCP function, the proper mode must be selected by setting the CCPxM<3:0> bits.

Where the Enhanced CCP module is available, it may have up to four PWM outputs, depending on the selected operating mode. These outputs are designated, P1A through P1D. The outputs that are active depend on the ECCP operating mode selected. To configure I/O pins for Enhanced PWM operation, the proper PWM mode must be selected by setting the PM<1:0> and CCPM<3:0> bits.

FIGURE 16-1: GENERIC CAPTURE MODE BLOCK DIAGRAM

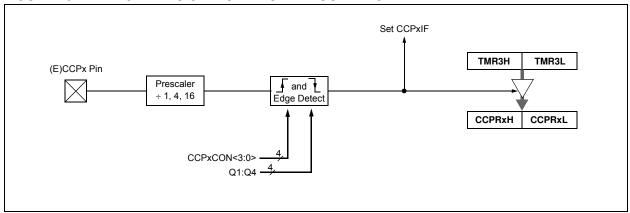


FIGURE 16-2: GENERIC COMPARE MODE BLOCK DIAGRAM

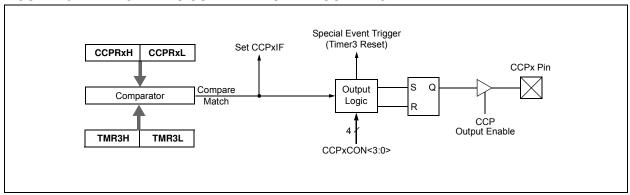


FIGURE 16-3: SIMPLIFIED PWM BLOCK DIAGRAM

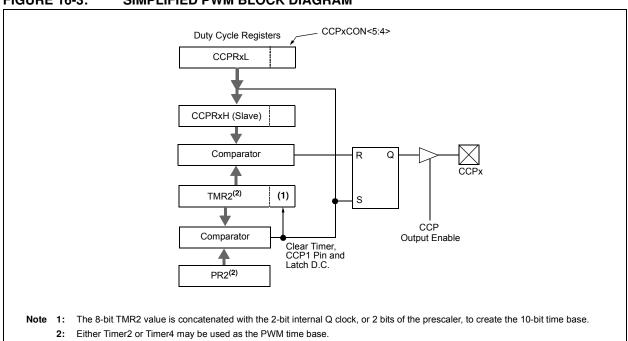
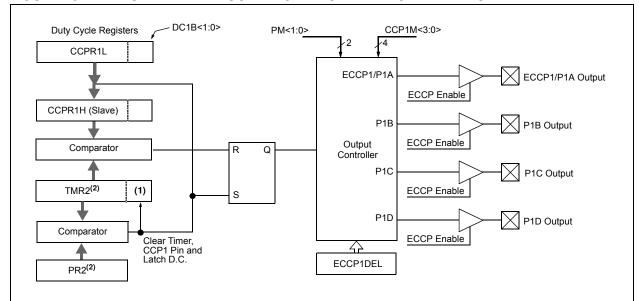


FIGURE 16-4: SIMPLIFIED BLOCK DIAGRAM OF ENHANCED PWM MODE



Note 1: The 8-bit TMR2 value is concatenated with the 2-bit internal Q clock, or 2 bits of the prescaler, to create the 10-bit time base.

2: Either Timer2 or Timer4 may be used as the Enhanced PWM time base.

REGISTER 16-1: CCPxCON: CCPx CONTROL REGISTER (STANDARD CCP MODULES)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	DCxB1	DCxB0	CCPxM3 ⁽¹⁾	CCPxM2 ⁽¹⁾	CCPxM1 ⁽¹⁾	CCPxM0 ⁽¹⁾
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-6 Unimplemented: Read as '0'

bit 5-4 DCxB<1:0>: PWM Duty Cycle Bit 1 and Bit 0 for CCPx Module

Capture and Compare modes:

Unused. PWM mode:

These bits are the two Least Significant bits (bit 1 and bit 0) of the 10-bit PWM duty cycle. The eight

Most Significant bits (DCxB<9:2>) of the duty cycle are found in CCPRxL.

CCPxM<3:0>: CCPx Module Mode Select bits(1) bit 3-0

1111 = Reserved

1110 = Reserved

1101 = Reserved

1100 = PWM mode

1011 = Compare mode: Special Event Trigger; reset timer on CCPx match (CCPxIF bit is set)

1010 = Compare mode: Generate software interrupt on compare match (CCPxIF bit is set, CCPx pin

reflects I/O state)

1001 = Compare mode: Initialize CCPx pin high; on compare match, force CCPx pin low (CCPxIF

bit is set)

1000 = Compare mode: Initialize CCPx pin low; on compare match, force CCPx pin high (CCPxIF bit is

0111 = Capture mode: Every 16th rising edge

0110 = Capture mode: Every 4th rising edge

0101 = Capture mode: Every rising edge

0100 = Capture mode: Every falling edge

0011 = Reserved

0010 = Compare mode: Toggle output on match (CCPxIF bit is set)

0001 = Reserved

0000 = Capture/Compare/PWM is disabled (resets CCPx module)

Note 1: CCPxM<3:0> = 1011 will only reset the timer and not start the A/D conversion on a CCPx match.

REGISTER 16-2: CCP1CON: ECCP1 CONTROL REGISTER (ECCP MODULES ONLY)(1)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PM1	PM0	DC1B1	DC1B0	CCP1M3 ⁽²⁾	CCP1M2 ⁽²⁾	CCP1M1 ⁽²⁾	CCP1M0 ⁽²⁾
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7-6 **PM<1:0>:** Enhanced PWM Output Configuration bits

If CCP1M<3:2> = 00, 01, 10:

xx = P1A is assigned as capture input or compare output; P1B, P1C and P1D are assigned as port pins If CCP1M<3:2> = 11:

11 = Full-bridge output reverse: P1B is modulated; P1C is active; P1A and P1D are inactive

10 = Half-bridge output: P1A, P1B are modulated with dead-band control; P1C and P1D are assigned as port pins

01 = Full-bridge output forward: P1D is modulated; P1A is active; P1B, P1C are inactive

00 = Single output: P1A, P1B, P1C and P1D are controlled by steering

bit 5-4 DC1B<1:0>: PWM Duty Cycle bit 1 and bit 0 for CCP1 Module

Capture and Compare modes:

Unused.

PWM mode:

These bits are the two Least Significant bits (bit 1 and bit 0) of the 10-bit PWM duty cycle. The eight Most Significant bits (DC1B<9:2>) of the duty cycle are found in CCPR1L.

bit 3-0 **CCP1M<3:0>**: CCP1 Module Mode Select bits⁽²⁾

1111 = PWM mode: PA and PC are active-low; PB and PD are active-low

1110 = PWM mode: PA and PC are active-low; PB and PD are active-high

1101 = PWM mode: PA and PC are active-high; PB and PD are active-low

1100 = PWM mode: PA and PC are active-high; PB and PD are active-high

1011 = Compare mode: Special Event Trigger; reset timer on CCP1 match (CCPxIF bit is set)

1010 = Compare mode: Generate software interrupt on compare match (CCP1IF bit is set, CCP1 pin reflects I/O state)

1001 = Compare mode: Initialize CCP1 pin high; on compare match, force CCP1 pin low (CCP1IF bit is set)

1000 = Compare mode: Initialize CCP1 pin low; on compare match, force CCP1 pin high (CCP1IF bit is set)

0111 = Capture mode: Every 16th rising edge

0110 = Capture mode: Every 4th rising edge

0101 = Capture mode: Every rising edge

0100 = Capture mode: Every falling edge

0011 = Reserved

0010 = Compare mode: Toggle output on match (CCP1IF bit is set)

0001 = Reserved

0000 = Capture/Compare/PWM is disabled (resets CCP1 module)

Note 1: This register is implemented only on PIC24FXXKL40X/30X devices. For all other devices, CCP1CON is configured as Register 16-1.

2: CCP1M<3:0> = 1011 will only reset timer and not start A/D conversion on CCP1 match.

REGISTER 16-3: ECCP1AS: ECCP1 AUTO-SHUTDOWN CONTROL REGISTER(1)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ECCPASE	ECCPAS2	ECCPAS1	ECCPAS0	PSSAC1	PSSAC0	PSSBD1	PSSBD0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 ECCPASE: ECCP Auto-Shutdown Event Status bit

1 = A shutdown event has occurred; ECCP outputs are in a shutdown state

0 = ECCP outputs are operating

bit 6-4 ECCPAS<2:0>: ECCP Auto-Shutdown Source Select bits

111 = VIL on $\overline{\text{FLT0}}$ pin, or either C10UT or C20UT is high

110 = VIL on FLTO pin, or C2OUT comparator output is high

101 = VIL on $\overline{\text{FLT0}}$ pin, or C1OUT comparator output is high

100 = VIL on \overline{FLTO} pin

011 = Either C1OUT or C2OUT is high

010 = C2OUT comparator output is high

001 = C1OUT comparator output is high

000 = Auto-shutdown is disabled

bit 3-2 PSSAC<1:0>: PxA and PxC Pins Shutdown State Control bits

1x = P1A and P1C pins tri-state

01 = Drive pins P1A and P1C to '1'

00 = Drive pins P1A and P1C to '0'

bit 1-0 PSSBD<1:0>: PxB and PxD Pins Shutdown State Control bits

1x = P1B and P1D pins tri-state

01 = Drive pins, P1B and P1D, to '1'

00 = Drive pins, P1B and P1D, to '0'

Note 1: This register is implemented only on PIC24FXXKL40X/30X devices.

Note 1: The auto-shutdown condition is a level-based signal, not an edge-based signal. As long as the level is present, the auto-shutdown will persist.

2: Writing to the ECCPASE bit is disabled while an auto-shutdown condition persists.

3: Once the auto-shutdown condition has been removed and the PWM restarted (either through firmware or auto-restart), the PWM signal will always restart at the beginning of the next PWM period.

REGISTER 16-4: ECCP1DEL: ECCP1 ENHANCED PWM CONTROL REGISTER⁽¹⁾

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| PRSEN | PDC6 | PDC5 | PDC4 | PDC3 | PDC2 | PDC1 | PDC0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0' bit 7 **PRSEN:** PWM Restart Enable bit

1 = Upon auto-shutdown, the ECCPASE bit clears automatically once the shutdown event goes away;

the PWM restarts automatically

0 = Upon auto-shutdown, ECCPASE must be cleared by software to restart the PWM

bit 6-0 PDC<6:0>: PWM Delay Count bits

PDCn = Number of Fcy (Fosc/2) cycles between the scheduled time when a PWM signal

should transition active and the **actual** time it transitions active.

Note 1: This register is implemented only on PIC24FXXKL40X/30X devices.

REGISTER 16-5: PSTR1CON: PULSE STEERING CONTROL REGISTER FOR ECCP1⁽¹⁾

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1
CMPL1	CMPL0	_	STRSYNC	STRD	STRC	STRB	STRA
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7-6 CMPL<1:0>: Complementary Mode Output Assignment Steering bits

00 = Complementary output assignment is disabled; the STR<D:A> bits are used to determine Steering mode

01 = PxA and PxB are selected as the complementary output pair

10 = PxA and PxC are selected as the complementary output pair

11 = PxA and PxD are selected as the complementary output pair

bit 5 **Unimplemented:** Read as '0'

bit 4 STRSYNC: Steering Sync bit

1 = Output steering update occurs on the next PWM period

0 = Output steering update occurs at the beginning of the instruction cycle boundary

bit 3 STRD: Steering Enable D bit

1 = P1D pin has the PWM waveform with polarity control from CCP1M<1:0>

0 = P1D pin is assigned to port pin

bit 2 STRC: Steering Enable C bit

1 = P1C pin has the PWM waveform with polarity control from CCP1M<1:0>

0 = P1C pin is assigned to port pin

bit 1 STRB: Steering Enable B bit

1 = P1B pin has the PWM waveform with polarity control from CCP1M<1:0>

0 = P1B pin is assigned to port pin

bit 0 STRA: Steering Enable A bit

1 = P1A pin has the PWM waveform with polarity control from CCP1M<1:0>

0 = P1A pin is assigned to port pin

Note 1: This register is only implemented on PIC24FXXKL40X/30X devices. In addition, PWM Steering mode is available only when CCP1M<3:2> = 11 and PM<1:0> = 00.

REGISTER 16-6: CCPTMRS0: CCP TIMER SELECT CONTROL REGISTER 0⁽¹⁾

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	-	_	_	_
bit 15							bit 8

U-0	R/W-0	U-0	U-0	R/W-0	U-0	U-0	R/W-0
_	C3TSEL0	_	_	C2TSEL0	_	_	C1TSEL0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6 C3TSEL0: CCP3 Timer Selection bit

1 = CCP3 uses TMR3/TMR4

0 = CCP3 uses TMR3/TMR2

bit 5-4 **Unimplemented:** Read as '0'

bit 3 **C2TSEL0:** CCP2 Timer Selection bit

1 = CCP2 uses TMR3/TMR4

0 = CCP2 uses TMR3/TMR2

bit 2-1 **Unimplemented:** Read as '0'

bit 0 C1TSEL0: CCP1/ECCP1 Timer Selection bit

1 = CCP1/ECCP1 uses TMR3/TMR4 0 = CCP1/ECCP1 uses TMR3/TMR2

Note 1: This register is unimplemented on PIC24FXXKL20X/10X devices; maintain as '0'.

NOTES:

17.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP)

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on MSSP, refer to the "PIC24F Family Reference Manual".

The Master Synchronous Serial Port (MSSP) module is an 8-bit serial interface, useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, Shift registers, display drivers, A/D Converters, etc. The MSSP module can operate in one of two modes:

- · Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I²C[™])
 - Full Master mode
 - Slave mode (with general address call)

The SPI interface supports these modes in hardware:

- · Master mode
- · Slave mode
- · Daisy-Chaining Operation in Slave mode
- · Synchronized Slave operation

The I²C interface supports the following modes in hardware:

- · Master mode
- Multi-Master mode
- Slave mode with 10-Bit And 7-Bit Addressing and Address Masking
- Byte NACKing
- Selectable Address and Data Hold and Interrupt Masking

17.1 I/O Pin Configuration for SPI

In SPI Master mode, the MSSP module will assert control over any pins associated with the SDOx and SCKx outputs. This does not automatically disable other digital functions associated with the pin, and may result in the module driving the digital I/O port inputs. To prevent this, the MSSP module outputs must be disconnected from their output pins while the module is in SPI Master mode. While disabling the module temporarily may be an option, it may not be a practical solution in all applications.

The SDOx and SCKx outputs for the module can be selectively disabled by using the SDOxDIS and SCKxDIS bits in the PADCFG1 register (Register 17-10). Setting the bit disconnects the corresponding output for a particular module from its assigned pin.

FIGURE 17-1: MSSP BLOCK DIAGRAM (SPI MODE)

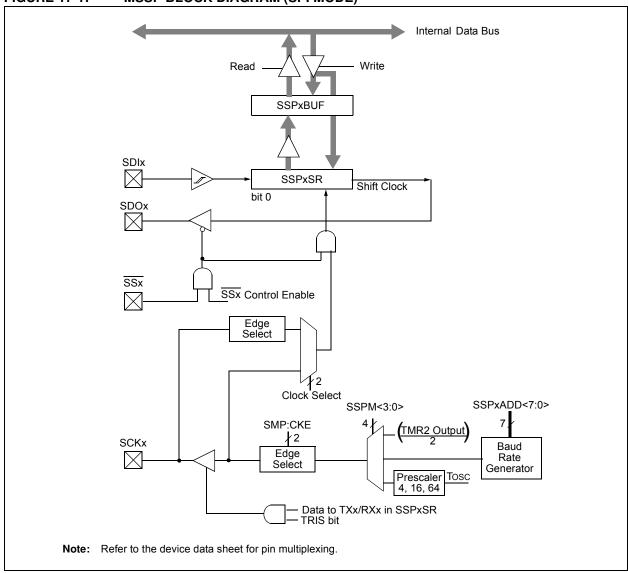


FIGURE 17-2: SPI MASTER/SLAVE CONNECTION

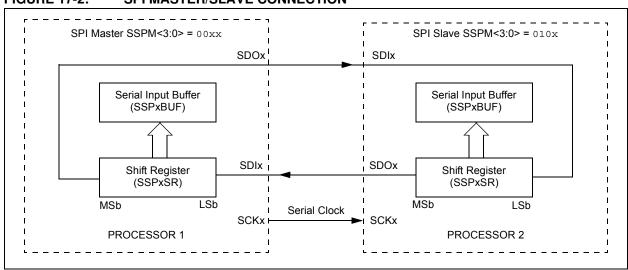


FIGURE 17-3: MSSP BLOCK DIAGRAM (I²C™ MODE)

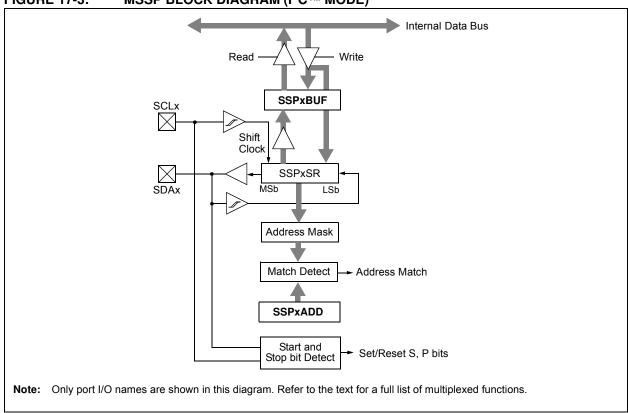
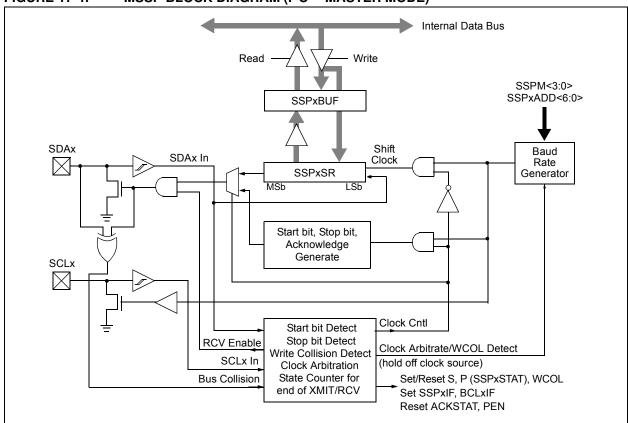


FIGURE 17-4: MSSP BLOCK DIAGRAM (I²C™ MASTER MODE)



REGISTER 17-1: SSPxSTAT: MSSPx STATUS REGISTER (SPI MODE)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	
bit 15							bit 8

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE ⁽¹⁾	D/\overline{A}	Р	S	R/W	UA	BF
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 SMP: Sample bit

SPI Master mode:

1 = Input data is sampled at the end of data output time0 = Input data is sampled at the middle of data output time

SPI Slave mode:

SMP must be cleared when SPI is used in Slave mode.

bit 6 **CKE:** SPI Clock Select bit⁽¹⁾

1 = Transmit occurs on transition from active to Idle clock state 0 = Transmit occurs on transition from Idle to active clock state

bit 5 D/A: Data/Address bit

Used in I^2C^{TM} mode only.

bit 4 P: Stop bit

Used in I²C mode only. This bit is cleared when the MSSPx module is disabled; SSPEN is cleared.

bit 3 S: Start bit

Used in I²C mode only.

bit 2 R/W: Read/Write Information bit

Used in I²C mode only.

bit 1 **UA:** Update Address bit

Used in I²C mode only.

bit 0 **BF:** Buffer Full Status bit

1 = Receive is complete, SSPxBUF is full

0 = Receive is not complete, SSPxBUF is empty

Note 1: Polarity of clock state is set by the CKP bit (SSPxCON1<4>).

REGISTER 17-2: SSPxSTAT: MSSPx STATUS REGISTER (I²C™ MODE)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/Ā	P ⁽¹⁾	S ⁽¹⁾	R/W	UA	BF
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0' **SMP:** Slew Rate Control bit

In Master or Slave mode:

1 = Slew rate control is disabled for Standard Speed mode (100 kHz and 1 MHz)

0 = Slew rate control is enabled for High-Speed mode (400 kHz)

bit 6 **CKE:** SMBus Select bit

In Master or Slave mode:

1 = Enable SMBus specific inputs0 = Disable SMBus specific inputs

bit 5 D/A: Data/Address bit

In Master mode: Reserved.

In Slave mode:

1 = Indicates that the last byte received or transmitted was data
 0 = Indicates that the last byte received or transmitted was address

bit 4 **P:** Stop bit⁽¹⁾

1 = Indicates that a Stop bit has been detected last

0 = Stop bit was not detected last

bit 3 S: Start bit⁽¹⁾

1 = Indicates that a Start bit has been detected last

0 = Start bit was not detected last

bit 2 R/W: Read/Write Information bit

In Slave mode:(2)

1 = Read

0 = Write

In Master mode: (3)

1 = Transmit is in progress

0 = Transmit is not in progress

bit 1 **UA:** Update Address bit (10-bit Slave mode only)

1 = Indicates that the user needs to update the address in the SSPxADD register

0 = Address does not need to be updated

Note 1: This bit is cleared on RESET and when SSPEN is cleared.

2: This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next Start bit, Stop bit or not ACK bit.

3: ORing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSPx is in Active mode.

REGISTER 17-2: SSPxSTAT: MSSPx STATUS REGISTER (I²C™ MODE) (CONTINUED)

bit 0 **BF:** Buffer Full Status bit

In Transmit mode:

- 1 = Transmit is in progress, SSPxBUF is full0 = Transmit is complete, SSPxBUF is empty
- In Receive mode
- 1 = SSPxBUF is full (does not include the \overline{ACK} and Stop bits) 0 = SSPxBUF is empty (does not include the \overline{ACK} and Stop bits)
- Note 1: This bit is cleared on RESET and when SSPEN is cleared.
 - 2: This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next Start bit, Stop bit or not ACK bit.
 - 3: ORing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSPx is in Active mode.

REGISTER 17-3: SSPxCON1: MSSPx CONTROL REGISTER 1 (SPI MODE)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV ⁽¹⁾	SSPEN ⁽²⁾	CKP	SSPM3 ⁽³⁾	SSPM2 ⁽³⁾	SSPM1 ⁽³⁾	SSPM0 ⁽³⁾
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 WCOL: Write Collision Detect bit

1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software)

0 = No collision

bit 6 SSPOV: Receive Overflow Indicator bit⁽¹⁾

SPI Slave mode:

1 = A new byte is received while the SSPxBUF register is still holding the previous data. In case of overflow, the data in SSPxSR is lost. Overflow can only occur in Slave mode. The user must read the SSPxBUF, even if only transmitting data, to avoid setting overflow (must be cleared in software).

0 = No overflow

bit 5 SSPEN: Master Synchronous Serial Port Enable bit (2)

1 = Enables serial port and configures SCKx, SDOx, SDIx and \overline{SSx} as serial port pins

0 = Disables serial port and configures these pins as I/O port pins

bit 4 **CKP:** Clock Polarity Select bit

1 = Idle state for clock is a high level

0 = Idle state for clock is a low level

bit 3-0 SSPM<3:0>: Master Synchronous Serial Port Mode Select bits⁽³⁾

1010 = SPI Master mode, Clock = Fosc/(2 * ([SSPxADD] + 1))

0101 = SPI Slave mode, Clock = SCKx pin; SSx pin control is disabled, SSx can be used as an I/O pin

0100 = SPI Slave mode, Clock = SCKx pin; SSx pin control is enabled

0011 = SPI Master mode, Clock = TMR2 output/2

0010 = SPI Master mode, Clock = Fosc/32

0001 = SPI Master mode. Clock = Fosc/8

0000 = SPI Master mode, Clock = Fosc/2

Note 1: In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPxBUF register.

2: When enabled, these pins must be properly configured as input or output.

3: Bit combinations not specifically listed here are either reserved or implemented in I²C mode only.

REGISTER 17-4: SSPxCON1: MSSPx CONTROL REGISTER 1 (I²C™ MODE)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV	SSPEN ⁽¹⁾	CKP	SSPM3 ⁽²⁾	SSPM2 ⁽²⁾	SSPM1 ⁽²⁾	SSPM0 ⁽²⁾
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 WCOL: Write Collision Detect bit

In Master Transmit mode:

1 = A write to the SSPxBUF register was attempted while the I²C conditions were not valid for a transmission to be started (must be cleared in software)

0 = No collision

In Slave Transmit mode:

1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software)

0 = No collision

In Receive mode (Master or Slave modes):

This is a "don't care" bit.

bit 6 SSPOV: Receive Overflow Indicator bit

In Receive mode:

1 = A byte is received while the SSPxBUF register is still holding the previous byte (must be cleared in software)

0 = No overflow

In Transmit mode:

This is a "don't care" bit in Transmit mode.

bit 5 SSPEN: Master Synchronous Serial Port Enable bit (1)

1 = Enables the serial port and configures the SDAx and SCLx pins as the serial port pins

0 = Disables the serial port and configures these pins as I/O port pins

bit 4 **CKP:** SCLx Release Control bit

In Slave mode:

1 = Releases clock

0 = Holds clock low (clock stretch), used to ensure data setup time

In Master mode:

Unused in this mode.

bit 3-0 SSPM<3:0>: Master Synchronous Serial Port Mode Select bits⁽²⁾

1111 = I²C Slave mode, 10-bit address with Start and Stop bit interrupts is enabled

1110 = I²C Slave mode, 7-bit address with Start and Stop bit interrupts is enabled

1011 = I²C Firmware Controlled Master mode (Slave Idle)

1000 = I^2C Master mode, clock = Fosc/(2 * ([SSPxADD] + 1))(3)

 $0111 = I^2C$ Slave mode, 10-bit address

 $0110 = I^2C$ Slave mode, 7-bit address

Note 1: When enabled, the SDAx and SCLx pins must be configured as inputs.

2: Bit combinations not specifically listed here are either reserved or implemented in SPI mode only.

3: SSPxADD values of 0, 1 or 2 are not supported when the Baud Rate Generator is used with I²C mode.

REGISTER 17-5: SSPxCON2: MSSPx CONTROL REGISTER 2 (I²C™ MODE)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GCEN	ACKSTAT	ACKDT ⁽¹⁾	ACKEN ⁽²⁾	RCEN ⁽²⁾	PEN ⁽²⁾	RSEN ⁽²⁾	SEN ⁽²⁾
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 GCEN: General Call Enable bit (Slave mode only)

1 = Enables interrupt when a general call address (0000h) is received in the SSPxSR

0 = General call address is disabled

bit 6 ACKSTAT: Acknowledge Status bit (Master Transmit mode only)

1 = Acknowledge was not received from slave0 = Acknowledge was received from slave

bit 5 ACKDT: Acknowledge Data bit (Master Receive mode only)⁽¹⁾

1 = No Acknowledge0 = Acknowledge

bit 4 ACKEN: Acknowledge Sequence Enable bit (Master mode only)(2)

1 = Initiates Acknowledge sequence on SDAx and SCLx pins and transmits ACKDT data bit; automatically cleared by hardware

0 = Acknowledge sequence is Idle

bit 3 **RCEN:** Receive Enable bit (Master Receive mode only)⁽²⁾

1 = Enables Receive mode for I^2C

0 = Receive is Idle

bit 2 **PEN:** Stop Condition Enable bit (Master mode only)⁽²⁾

1 = Initiates Stop condition on SDAx and SCLx pins; automatically cleared by hardware

0 = Stop condition is Idle

bit 1 RSEN: Repeated Start Condition Enable bit (Master mode only)(2)

1 = Initiates Repeated Start condition on SDAx and SCLx pins; automatically cleared by hardware

0 = Repeated Start condition is Idle

bit 0 SEN: Start Condition Enable bit⁽²⁾

Master Mode:

1 = Initiates Start condition on SDAx and SCLx pins; automatically cleared by hardware

0 = Start condition is Idle

Slave Mode:

1 = Clock stretching is enabled for both slave transmit and slave receive (stretch is enabled)

0 = Clock stretching is disabled

Note 1: The value that will be transmitted when the user initiates an Acknowledge sequence at the end of a receive.

2: If the I²C module is active, these bits may not be set (no spooling) and the SSPxBUF may not be written (or writes to the SSPxBUF are disabled).

REGISTER 17-6: SSPxCON3: MSSPx CONTROL REGISTER 3 (SPI MODE)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0			
_	_	_	_	_	_	_	_			
bit 15 bit 8										

R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ACKTIM	PCIE	SCIE	BOEN ⁽¹⁾	SDAHT	SBCDE	AHEN	DHEN
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 Unimplemented: Read as '0'

bit 7 **ACKTIM:** Acknowledge Time Status bit (I²C[™] mode only)

Unused in SPI mode.

bit 6 **PCIE**: Stop Condition Interrupt Enable bit (I²C mode only)

Unused in SPI mode.

bit 5 **SCIE**: Start Condition Interrupt Enable bit (I²C mode only)

Unused in SPI mode.

bit 4 **BOEN:** Buffer Overwrite Enable bit⁽¹⁾

In SPI Slave mode:

1 = SSPxBUF updates every time that a new data byte is shifted in, ignoring the BF bit

0 = If a new byte is received with the BF bit of the SSPxSTAT register already set, the SSPxOV bit of

the SSPxCON1 register is set and the buffer is not updated

bit 3 **SDAHT:** SDAx Hold Time Selection bit (I²C mode only)

Unused in SPI mode.

bit 2 SBCDE: Slave Mode Bus Collision Detect Enable bit (I²C Slave mode only)

Unused in SPI mode.

bit 1 AHEN: Address Hold Enable bit (I²C Slave mode only)

Unused in SPI mode.

bit 0 **DHEN:** Data Hold Enable bit (Slave mode only)

Unused in SPI mode.

Note 1: For daisy-chained SPI operation: Allows the user to ignore all but the last received byte. SSPxOV is still set when a new byte is received and BF = 1, but hardware continues to write the most recent byte to SSPxBUF.

REGISTER 17-7: SSPxCON3: MSSPx CONTROL REGISTER 3 (I²C™ MODE)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

R-0	R/W-0						
ACKTIM ⁽¹⁾	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 **ACKTIM:** Acknowledge Time Status bit⁽¹⁾

1 = Indicates the I²C bus is in an Acknowledge sequence, set on the 8th falling edge of the SCLx clock

0 = Not an Acknowledge sequence, cleared on 9th rising edge of SCLx clock

bit 6 **PCIE**: Stop Condition Interrupt Enable bit

1 = Enable interrupt on detection of Stop condition

0 = Stop detection interrupts are disabled⁽²⁾

bit 5 SCIE: Start Condition Interrupt Enable bit

1 = Enable interrupt on detection of Start or Restart conditions

0 = Start detection interrupts are disabled⁽²⁾

bit 4 **BOEN:** Buffer Overwrite Enable bit

<u>I.²C Master mode:</u>

This bit is ignored.

I²C Slave mode:

1 = SSPxBUF is updated and an ACK is generated for a received address/data byte, ignoring the state of the SSPxOV bit only if the BF bit = 0

0 = SSPxBUF is only updated when SSPxOV is clear

bit 3 SDAHT: SDAx Hold Time Selection bit

1 = Minimum of 300 ns hold time on SDAx after the falling edge of SCLx

0 = Minimum of 100 ns hold time on SDAx after the falling edge of SCLx

bit 2 SBCDE: Slave Mode Bus Collision Detect Enable bit (Slave mode only)

1 = Enables slave bus collision interrupts

0 = Slave bus collision interrupts are disabled

bit 1 AHEN: Address Hold Enable bit (Slave mode only)

1 = Following the 8th falling edge of SCLx for a matching received address byte; CKP bit of the

SSPxCON1 register will be cleared and the SCLx will be held low.

0 = Address holding is disabled

bit 0 **DHEN:** Data Hold Enable bit (Slave mode only)

1 = Following the 8th falling edge of SCLx for a received data byte; slave hardware clears the CKP bit of the SSPxCON1 register and SCLx is held low.

0 = Data holding is disabled

Note 1: This bit has no effect in Slave modes for which Start and Stop condition detection is explicitly listed as enabled

2: The ACKTIM status bit is active only when the AHEN bit or DHEN bit is set.

REGISTER 17-8: SSPxADD: MSSPx SLAVE ADDRESS/BAUD RATE GENERATOR REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| ADD7 | ADD6 | ADD5 | ADD4 | ADD3 | ADD2 | ADD1 | ADD0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7-0 ADD<7:0>: Slave Address/Baud Rate Generator Value bits

SPI Master and I²C Master modes:

Reload value for Baud Rate Generator. Clock period is (([SPxADD] + 1) *2)/Fosc.

<u>I²C™ Slave modes:</u>

Represents 7 or 8 bits of the slave address, depending on the addressing mode used:

7-Bit mode: Address is ADD<7:1>; ADD<0> is ignored.

10-Bit LSb mode: ADD<7:0> are the Least Significant bits of the address.

10-Bit MSb mode: ADD<2:1> are the two Most Significant bits of the address; ADD<7:3> are always

'11110' as a specification requirement; ADD<0> is ignored.

REGISTER 17-9: SSPxMSK: I²C SLAVE ADDRESS MASK REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

| R/W-1 |
|-------|-------|-------|-------|-------|-------|-------|---------------------|
| MSK7 | MSK6 | MSK5 | MSK4 | MSK3 | MSK2 | MSK1 | MSK0 ⁽¹⁾ |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7-0 MSK<7:0>: Slave Address Mask Select bit⁽¹⁾

1 = Masking of corresponding bit of SSPxADD enabled0 = Masking of corresponding bit of SSPxADD disabled

Note 1: MSK0 is not used as a mask bit in 7-bit addressing.

REGISTER 17-10: PADCFG1: PAD CONFIGURATION CONTROL REGISTER

U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_	_	SDO2DIS ⁽¹⁾	SCK2DIS ⁽¹⁾	SDO1DIS	SCK1DIS
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 7							bit 0

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

Legend:

bit 11 SDO2DIS: MSSP2 SDO Pin Disable bit⁽¹⁾

1 = The SPI output data (SDO2) of MSSP2 to the pin is disabled 0 = The SPI output data (SDO2) of MSSP2 is output to the pin

bit 10 SCK2DIS: MSSP2 SCK Pin Disable bit⁽¹⁾

1 = The SPI clock (SCK2) of MSSP2 to the pin is disabled 0 = The SPI clock (SCK2) of MSSP2 is output to the pin

bit 9 SDO1DIS: MSSP1 SDO Pin Disable bit

1 = The SPI output data (SDO1) of MSSP1 to the pin is disabled 0 = The SPI output data (SDO1) of MSSP1 is output to the pin

bit 8 SCK1DIS: MSSP1 SCK Pin Disable bit

1 = The SPI clock (SCK1) of MSSP1 to the pin is disabled 0 = The SPI clock (SCK1) of MSSP1 is output to the pin

bit 7-0 **Unimplemented:** Read as '0'

Note 1: These bits are implemented only on PIC24FXXKL40X/30X devices.

NOTES:

18.0 UNIVERSAL ASYNCHRONOUS RECEIVER TRANSMITTER (UART)

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the Universal Asynchronous Receiver Transmitter, refer to the "PIC24F Family Reference Manual", Section 21. "UART" (DS39708).

The Universal Asynchronous Receiver Transmitter (UART) module is one of the serial I/O modules available in this PIC24F device family. The UART is a full-duplex, asynchronous system that can communicate with peripheral devices, such as personal computers, LIN/J2602, RS-232 and RS-485 interfaces. This module also supports a hardware flow control option with the $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$ pins, and also includes an IrDA® encoder and decoder.

The primary features of the UART module are:

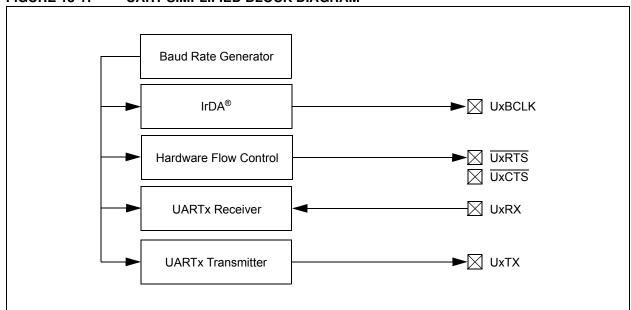
- Full-Duplex, 8-Bit or 9-Bit Data Transmission Through the UxTX and UxRX Pins
- Even, Odd or No Parity Options (for 8-bit data)
- · One or Two Stop bits
- Hardware Flow Control Option with UxCTS and UxRTS Pins

- Fully Integrated Baud Rate Generator (IBRG) with 16-Bit Prescaler
- Baud Rates Ranging from 1 Mbps to 15 bps at 16 MIPS
- Two-Level Deep, First-In-First-Out (FIFO)
 Transmit Data Buffer
- · Two-Level Deep, FIFO Receive Data Buffer
- Parity, Framing and Buffer Overrun Error Detection
- Support for 9-Bit mode with Address Detect (9th bit = 1)
- · Transmit and Receive Interrupts
- · Loopback mode for Diagnostic Support
- · Support for Sync and Break Characters
- · Supports Automatic Baud Rate Detection
- · IrDA Encoder and Decoder Logic
- 16x Baud Clock Output for IrDA Support

A simplified block diagram of the UART is shown in Figure 18-1. The UART module consists of these important hardware elements:

- · Baud Rate Generator
- Asynchronous Transmitter
- · Asynchronous Receiver

FIGURE 18-1: UART SIMPLIFIED BLOCK DIAGRAM



18.1 UART Baud Rate Generator (BRG)

The UART module includes a dedicated 16-bit Baud Rate Generator (BRG). The UxBRG register controls the period of a free-running, 16-bit timer. Equation 18-1 provides the formula for computation of the baud rate with BRGH = 0.

EQUATION 18-1: UART BAUD RATE WITH BRGH = $0^{(1)}$

Baud Rate =
$$\frac{FCY}{16 \cdot (UxBRG + 1)}$$

$$UxBRG = \frac{FCY}{16 \cdot Baud Rate} - 1$$

Note 1: Based on Fcy = Fosc/2; Doze mode and PLL are disabled.

Example 18-1 provides the calculation of the baud rate error for the following conditions:

- Fcy = 4 MHz
- · Desired Baud Rate = 9600

The maximum baud rate (BRGH = 0) possible is Fcy/16 (for UxBRG = 0) and the minimum baud rate possible is Fcy/(16 * 65536).

Equation 18-2 shows the formula for computation of the baud rate with BRGH = 1.

EQUATION 18-2: UART BAUD RATE WITH BRGH = $1^{(1)}$

Baud Rate =
$$\frac{FCY}{4 \cdot (UxBRG + 1)}$$

$$UxBRG = \frac{FCY}{4 \cdot Band Rate} - 1$$

Note 1: Based on Fcy = Fosc/2; Doze mode and PLL are disabled.

The maximum baud rate (BRGH = 1) possible is Fcy/4 (for UxBRG = 0) and the minimum baud rate possible is Fcy/(4 * 65536).

Writing a new value to the UxBRG register causes the BRG timer to be reset (cleared). This ensures the BRG does not wait for a timer overflow before generating the new baud rate.

EXAMPLE 18-1: BAUD RATE ERROR CALCULATION (BRGH = 0)⁽¹⁾

Desired Baud Rate = FCY/(16 (UxBRG + 1))

Solving for UxBRG value:

UxBRG = ((FCY/Desired Baud Rate)/16) - 1

UxBRG = ((4000000/9600)/16) - 1

UxBRG = 25

Calculated Baud Rate = 4000000/(16(25+1))

= 9615

Error = (Calculated Baud Rate – Desired Baud Rate)

Desired Baud Rate = (9615 – 9600)/9600

= 0.16%

Note 1: Based on Fcy = Fosc/2; Doze mode and PLL are disabled.

18.2 Transmitting in 8-Bit Data Mode

- 1. Set up the UART:
 - a) Write appropriate values for data, parity and Stop bits.
 - b) Write appropriate baud rate value to the UxBRG register.
 - Set up transmit and receive interrupt enable and priority bits.
- 2. Enable the UART.
- 3. Set the UTXEN bit (causes a transmit interrupt, two cycles after being set).
- 4. Write data byte to lower byte of UxTXREG word. The value will be immediately transferred to the Transmit Shift Register (TSR) and the serial bit stream will start shifting out with the next rising edge of the baud clock.
- Alternately, the data byte may be transferred while UTXEN = 0 and then, the user may set UTXEN. This will cause the serial bit stream to begin immediately, because the baud clock will start from a cleared state.
- A transmit interrupt will be generated as per interrupt control bit, UTXISELx.

18.3 Transmitting in 9-Bit Data Mode

- Set up the UART (as described in Section 18.2 "Transmitting in 8-Bit Data Mode").
- 2. Enable the UART.
- 3. Set the UTXEN bit (causes a transmit interrupt, two cycles after being set).
- 4. Write UxTXREG as a 16-bit value only.
- A word write to UxTXREG triggers the transfer of the 9-bit data to the TSR. The serial bit stream will start shifting out with the first rising edge of the baud clock.
- 6. A transmit interrupt will be generated as per the setting of control bit, UTXISELx.

18.4 Break and Sync Transmit Sequence

The following sequence will send a message frame header made up of a Break, followed by an auto-baud Sync byte.

- 1. Configure the UART for the desired mode.
- Set UTXEN and UTXBRK sets up the Break character.
- 3. Load the UxTXREG with a dummy character to initiate transmission (value is ignored).
- Write '55h' to UxTXREG loads the Sync character into the transmit FIFO.
- After the Break has been sent, the UTXBRK bit is reset by hardware. The Sync character now transmits.

18.5 Receiving in 8-Bit or 9-Bit Data Mode

- Set up the UART (as described in Section 18.2 "Transmitting in 8-Bit Data Mode").
- 2. Enable the UART.
- A receive interrupt will be generated when one or more data characters have been received as per interrupt control bit, URXISELx.
- Read the OERR bit to determine if an overrun error has occurred. The OERR bit must be reset in software.
- 5. Read UxRXREG.

The act of reading the UxRXREG character will move the next character to the top of the receive FIFO, including a new set of PERR and FERR values.

18.6 Operation of UxCTS and UxRTS Control Pins

UARTx Clear-to-Send (UxCTS) and Request-to-Send (UxRTS) are the two hardware-controlled pins that are associated with the UART module. These two pins allow the UART to operate in Simplex and Flow Control modes. They are implemented to control the transmission and reception between the Data Terminal Equipment (DTE). The UEN<1:0> bits in the UxMODE register configure these pins.

18.7 Infrared Support

The UART module provides two types of infrared UART support: one is the IrDA clock output to support an external IrDA encoder and decoder device (legacy module support), and the other is the full implementation of the IrDA encoder and decoder.

As the IrDA modes require a 16x baud clock, they will only work when the BRGH bit (UxMODE<3>) is '0'.

18.7.1 EXTERNAL IrDA SUPPORT – IrDA CLOCK OUTPUT

To support external IrDA encoder and decoder devices, the UxBCLK pin (same as the $\overline{\text{UxRTS}}$ pin) can be configured to generate the 16x baud clock. When UEN<1:0> = 11, the UxBCLK pin will output the 16x baud clock if the UART module is enabled; it can be used to support the IrDA codec chip.

18.7.2 BUILT-IN IrDA ENCODER AND DECODER

The UART has full implementation of the IrDA encoder and decoder as part of the UART module. The built-in IrDA encoder and decoder functionality is enabled using the IREN bit (UxMODE<12>). When enabled (IREN = 1), the receive pin (UxRX) acts as the input from the infrared receiver. The transmit pin (UxTX) acts as the output to the infrared transmitter.

REGISTER 18-1: UXMODE: UARTX MODE REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0 ⁽²⁾	R/W-0 ⁽²⁾
UARTEN	_	USIDL	IREN ⁽¹⁾	RTSMD	_	UEN1	UEN0
bit 15							bit 8

R/C-0, HC	R/W-0	R/W-0, HC	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL1	PDSEL0	STSEL
bit 7							bit 0

Legend:	C = Clearable bit	HC = Hardware Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15 **UARTEN:** UARTx Enable bit

1 = UARTx is enabled; all UARTx pins are controlled by UARTx as defined by UEN<1:0>

0 = UARTx is disabled; all UARTx pins are controlled by port latches, UARTx power consumption is minimal

bit 14 Unimplemented: Read as '0'

bit 13 USIDL: Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12 IREN: IrDA® Encoder and Decoder Enable bit⁽¹⁾

1 = IrDA encoder and decoder are enabled

0 = IrDA encoder and decoder are disabled

bit 11 RTSMD: Mode Selection for UxRTS Pin bit

 $1 = \overline{\text{UxRTS}}$ pin is in Simplex mode

 $0 = \overline{\text{UxRTS}}$ pin is in Flow Control mode

bit 10 **Unimplemented:** Read as '0'

bit 9-8 **UEN<1:0>:** UARTx Enable bits⁽²⁾

11 = UxTX, UxRX and UxBCLK pins are enabled and used; UxCTS pin is controlled by port latches

10 = UxTX, UxRX, $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$ pins are enabled and used

01 = UxTX, UxRX and $\overline{\text{UxRTS}}$ pins are enabled and used; $\overline{\text{UxCTS}}$ pin is controlled by port latches

00 = UxTX and UxRX pins are enabled and used; UxCTS and UxRTS/UxBCLK pins are controlled by port latches

bit 7 WAKE: Wake-up on Start Bit Detect During Sleep Mode Enable bit

1 = UARTx will continue to sample the UxRX pin; interrupt is generated on the falling edge, bit is cleared in hardware on the following rising edge

0 = No wake-up is enabled

bit 6 LPBACK: UARTx Loopback Mode Select bit

1 = Enable Loopback mode

0 = Loopback mode is disabled

bit 5 ABAUD: Auto-Baud Enable bit

1 = Enable baud rate measurement on the next character – requires reception of a Sync field (55h); cleared in hardware upon completion

0 = Baud rate measurement is disabled or completed

bit 4 **RXINV:** Receive Polarity Inversion bit

1 = UxRX Idle state is '0'

0 = UxRX Idle state is '1'

Note 1: This feature is is only available for the 16x BRG mode (BRGH = 0).

Bit availability depends on pin availability.

REGISTER 18-1: UXMODE: UARTX MODE REGISTER (CONTINUED)

bit 3 BRGH: High Baud Rate Enable bit

1 = BRG generates 4 clocks per bit period (4x baud clock, High-Speed mode)
 0 = BRG generates 16 clocks per bit period (16x baud clock, Standard mode)

bit 2-1 **PDSEL<1:0>:** Parity and Data Selection bits

11 = 9-bit data, no parity 10 = 8-bit data, odd parity 01 = 8-bit data, even parity 00 = 8-bit data, no parity

bit 0 STSEL: Stop Bit Selection bit

1 = Two Stop bits0 = One Stop bit

Note 1: This feature is is only available for the 16x BRG mode (BRGH = 0).

2: Bit availability depends on pin availability.

REGISTER 18-2: UxSTA: UARTX STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	U-0	R/W-0, HC	R/W-0	R-0, HSC	R-1, HSC
UTXISEL1	UTXINV	UTXISEL0	_	UTXBRK	UTXEN	UTXBF	TRMT
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R-1, HSC	R-0, HSC	R-0, HSC	R/C-0, HS	R-0, HSC
URXISEL1	URXISEL0	ADDEN	RIDLE	PERR	FERR	OERR	URXDA
bit 7							bit 0

Legend: HC = Hardware Clearable bit

HS = Hardware Settable bit C = Clearable bit HSC = Hardware Settable/Clearable bit R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15,13 UTXISEL<1:0>: Transmission Interrupt Mode Selection bits

- 11 = Reserved; do not use
- 10 = Interrupt when a character is transferred to the Transmit Shift Register (TSR) and as a result, the transmit buffer becomes empty
- 01 = Interrupt when the last character is shifted out of the Transmit Shift Register; all transmit operations are completed
- 00 = Interrupt when a character is transferred to the Transmit Shift Register (this implies there is at least one character open in the transmit buffer)

bit 14 UTXINV: IrDA® Encoder Transmit Polarity Inversion bit

If IREN = 0:

- 1 = UxTX Idle '0'
- 0 = UxTX Idle '1'

If IREN = 1:

- 1 = UxTX Idle '1'
- 0 = UxTX Idle '0'

bit 12 **Unimplemented:** Read as '0'

- bit 11 UTXBRK: Transmit Break bit
 - 1 = Send Sync Break on next transmission Start bit, followed by twelve '0' bits; followed by Stop bit; cleared by hardware upon completion
 - 0 = Sync Break transmission is disabled or completed

bit 10 UTXEN: Transmit Enable bit

- 1 = Transmit is enabled; UxTX pin is controlled by UARTx
- 0 = Transmit is disabled; any pending transmission is aborted and the buffer is reset. UxTX pin is controlled by the PORT register.

bit 9 **UTXBF:** Transmit Buffer Full Status bit (read-only)

- 1 = Transmit buffer is full
- 0 = Transmit buffer is not full, at least one more character can be written

bit 8 **TRMT:** Transmit Shift Register Empty bit (read-only)

- 1 = Transmit Shift Register is empty and the transmit buffer is empty (the last transmission has completed)
- 0 = Transmit Shift Register is not empty; a transmission is in progress or queued

bit 7-6 **URXISEL<1:0>:** Receive Interrupt Mode Selection bits

- 11 = Interrupt is set on the RSR transfer, making the receive buffer full (i.e., has 2 data characters)
- 10 = Reserved
- 01 = Reserved
- 00 = Interrupt is set when any character is received and transferred from the RSR to the receive buffer; receive buffer has one or more characters

REGISTER 18-2: UXSTA: UARTX STATUS AND CONTROL REGISTER (CONTINUED)

bit 5	ADDEN: Address Character Detect bit (bit 8 of the received data = 1)
	1 = Address Detect mode is enabled; if 9-bit mode is not selected, this does not take effect
	0 = Address Detect mode is disabled
bit 4	RIDLE: Receiver Idle bit (read-only)
	1 = Receiver is Idle
	0 = Receiver is active
bit 3	PERR: Parity Error Status bit (read-only)
	1 = Parity error has been detected for the current character (character at the top of the receive FIFO)
	0 = Parity error has not been detected
bit 2	FERR: Framing Error Status bit (read-only)
	1 = Framing error has been detected for the current character (character at the top of the receive FIFO)
	0 = Framing error has not been detected
bit 1	OERR: Receive Buffer Overrun Error Status bit (clear/read-only)
	1 = Receive buffer has overflowed
	0 = Receive buffer has not overflowed (clearing a previously set OERR bit (1 \rightarrow 0 transition) will reset
	the receiver buffer and the RSR to the empty state)
bit 0	URXDA: Receive Buffer Data Available bit (read-only)
	1 = Receive buffer has data; at least one more character can be read
	0 = Receive buffer is empty

NOTES:

19.0 10-BIT HIGH-SPEED A/D CONVERTER

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the 10-Bit High-Speed A/D Converter, refer to the "PIC24F Family Reference Manual", Section 17. "10-Bit A/D Converter" (DS39705).

The 10-bit A/D Converter has the following key features:

- · Successive Approximation (SAR) conversion
- · Conversion speeds of up to 500 ksps
- · Up to 12 analog input pins
- · External voltage reference input pins
- · Internal band gap reference input
- · Automatic Channel Scan mode
- Selectable conversion trigger source
- · Two-word conversion result buffer
- · Selectable Buffer Fill modes
- · Four result alignment options
- · Operation during CPU Sleep and Idle modes

Depending on the particular device, PIC24F16KL402 family devices implement up to 12 analog input pins, designated AN0 through AN4 and AN9 through AN15. In addition, there are two analog input pins for external voltage reference connections (VREF+ and VREF-). These voltage reference inputs may be shared with other analog input pins.

A block diagram of the A/D Converter is displayed in Figure 19-1.

To perform an A/D conversion:

- 1. Configure the A/D module:
 - a) Configure port pins as analog inputs and/or select band gap reference inputs (ANSA<3:0>, ANSB<15:12, 4:0> and ANCFG<0>).
 - Select the voltage reference source to match the expected range on analog inputs (AD1CON2<15:13>).
 - Select the analog conversion clock to match the desired data rate with the processor clock (AD1CON3<7:0>).
 - d) Select the appropriate sample/conversion sequence (AD1CON1<7:5> and AD1CON3<12:8>).
 - e) Select how conversion results are presented in the buffer (AD1CON1<9:8>).
 - f) Select interrupt rate (AD1CON2<5:2>).
 - g) Turn on A/D module (AD1CON1<15>).
- Configure A/D interrupt (if required):
 - a) Clear the AD1IF bit.
 - b) Select A/D interrupt priority.

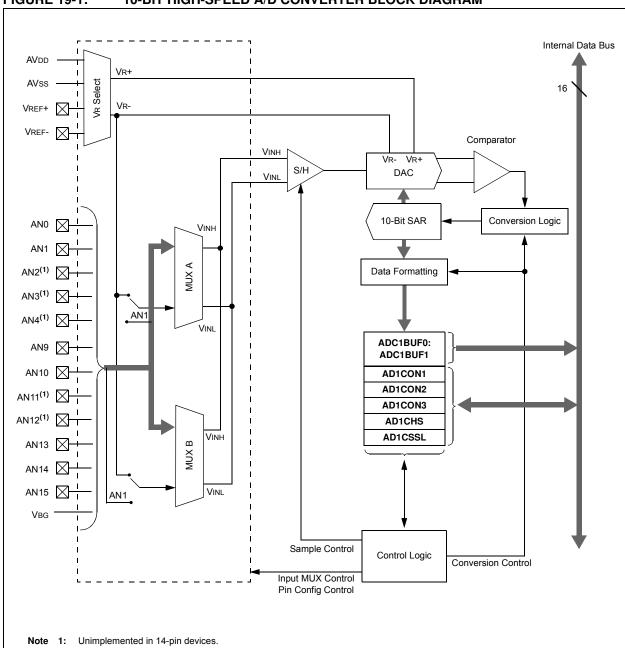


FIGURE 19-1: 10-BIT HIGH-SPEED A/D CONVERTER BLOCK DIAGRAM

REGISTER 19-1: AD1CON1: A/D CONTROL REGISTER 1

R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0
ADON ⁽¹⁾	_	ADSIDL	_	_	_	FORM1	FORM0
bit 15							bit 8

R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0, HSC	R-0, HSC
SSRC2	SSRC1	SSRC0	_	_	ASAM	SAMP	DONE
bit 7							bit 0

Legend:HSC = Hardware Settable/Clearable bitR = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is unknown

bit 15 **ADON:** A/D Operating Mode bit⁽¹⁾

1 = A/D Converter module is operating

0 = A/D Converter is off

bit 14 **Unimplemented:** Read as '0' bit 13 **ADSIDL:** Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12-10 Unimplemented: Read as '0'

bit 9-8 **FORM<1:0>:** Data Output Format bits

11 = Signed fractional (sddd dddd dd00 0000)

10 = Fractional (dddd dddd dd00 0000)

01 = Signed integer (ssss sssd dddd dddd)

00 = Integer (0000 00dd dddd dddd)

bit 7-5 SSRC<2:0>: Conversion Trigger Source Select bits

111 = Internal counter ends sampling and starts conversion (auto-convert)

110 = Reserved

101 = Reserved

100 = Reserved

011 = Reserved

010 = Timer1 compare ends sampling and starts conversion

001 = Active transition on INT0 pin ends sampling and starts conversion

000 = Clearing the SAMP bit ends sampling and starts conversion

bit 4-3 **Unimplemented:** Read as '0'

bit 2 ASAM: A/D Sample Auto-Start bit

1 = Sampling begins immediately after the last conversion completes; SAMP bit is auto-set

0 = Sampling begins when the SAMP bit is set

bit 1 SAMP: A/D Sample Enable bit

1 = A/D sample/hold amplifier is sampling input

0 = A/D sample/hold amplifier is holding

bit 0 **DONE:** A/D Conversion Status bit

1 = A/D conversion is done

0 = A/D conversion is not done

Note 1: Values of ADC1BUFx registers will not retain their values once the ADON bit is cleared. Read out the conversion values from the buffer before disabling the module.

REGISTER 19-2: AD1CON2: A/D CONTROL REGISTER 2

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0	U-0
VCFG2	VCFG1	VCFG0	OFFCAL ⁽¹⁾	_	CSCNA	_	_
bit 15							bit 8

R-x	U-0	R/W-0	R/W-0	R/W-0	R/W-0	r-0	R/W-0
_	_	SMPI3	SMPI2	SMPI1	SMPI0	_	ALTS
bit 7							bit 0

Legend:	r = Reserved bit	HSC = Hardware Settable/Clearable bit			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15-13 VCFG<2:0>: Voltage Reference Configuration bits

VCFG<2:0>	VR+	VR-
000	AVDD	AVss
001	External VREF+ pin	AVss
010	AVDD	External VREF- pin
011	External VREF+ pin	External VREF- pin
1xx	AVDD	AVss

bit 12 **OFFCAL:** Offset Calibration bit⁽¹⁾

1 = Conversions to get the offset calibration value

0 = Conversions to get the actual input value

bit 11 Unimplemented: Read as '0'

bit 10 CSCNA: Scan Input Selections for MUX A Input Multiplexer bit

1 = Scan inputs

0 = Do not scan inputs

bit 9-8 Unimplemented: Read as '0' bit 7 Reserved: Ignore this value bit 6 Unimplemented: Read as '0'

bit 5-2 SMPI<3:0>: Sample/Convert Sequences Per Interrupt Selection bits

1111

= Reserved, do not use (may cause conversion data loss)

0010

0001 = Interrupts at the completion of conversion for each 2nd sample/convert sequence 0000 = Interrupts at the completion of conversion for each sample/convert sequence

bit 1 Reserved: Always maintain as '0'

bit 0 **ALTS:** Alternate Input Sample Mode Select bit

- 1 = Uses MUX A input multiplexer settings for the first sample, then alternates between MUX B and MUX A input multiplexer settings for all subsequent samples
- 0 = Always uses MUX A input multiplexer settings

Note 1: When the OFFCAL bit is set, inputs are disconnected and tied to AVss. This sets the inputs of the A/D to zero. Then, the user can perform a conversion. Use of the Calibration mode is not affected by AD1PCFG contents nor channel input selection. Any analog input switches are disconnected from the A/D Converter in this mode. The conversion result is stored by the user software and used to compensate subsequent conversions. This can be done by adding the two's complement of the result obtained with the OFFCAL bit set to all normal A/D conversions.

REGISTER 19-3: AD1CON3: A/D CONTROL REGISTER 3

R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADRC	EXTSAM	PUMPEN	SAMC4	SAMC3	SAMC2	SAMC1	SAMC0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	ADCS5	ADCS4	ADCS3	ADCS2	ADCS1	ADCS0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 ADRC: A/D Conversion Clock Source bit

1 = A/D internal RC clock

0 = Clock derived from system clock

bit 14 **EXTSAM:** Extended Sampling Time bit

1 = A/D is still sampling after SAMP = 0

0 = A/D is finished sampling

bit 13 **PUMPEN:** Charge Pump Enable bit

1 = Charge pump for switches is enabled

0 = Charge pump for switches is disabled

bit 12-8 **SAMC<4:0>:** Auto-Sample Time bits

11111 **= 31** TAD

•

•

00001 **= 1** TAD

00000 = 0 TAD (not recommended)

bit 7-6 **Unimplemented:** Maintain as '0'

bit 5-0 ADCS<5:0>: A/D Conversion Clock Select bits

11111 = 64 • Tcy

11110 = 63 • Tcy

•

_

00001 = 2 • Tcy

00000 = Tcy

REGISTER 19-4: AD1CHS: A/D INPUT SELECT REGISTER

R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
CH0NB	_	_	_	CH0SB3	CH0SB2	CH0SB1	CH0SB0
bit 15							bit 8

R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
CH0NA	_	_	_	CH0SA3	CH0SA2	CH0SA1	CH0SA0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 CH0NB: Channel 0 Negative Input Select for MUX B Multiplexer Setting bit

1 = Channel 0 negative input is AN1

0 = Channel 0 negative input is VR-

bit 14-12 **Unimplemented:** Read as '0'

bit 11-8 CH0SB<3:0>: Channel 0 Positive Input Select for MUX B Multiplexer Setting bits

1111 **= AN15**

1110 **= AN14**

1101 **= AN13**

1100 = AN12⁽¹⁾

 $1011 = AN11^{(1)}$

1010 **= AN10**

1001 **= AN9**

1000 = Upper guardband rail (0.785 * VDD)

0111 = Lower guardband rail (0.215 * VDD)

0110 = Internal band gap reference (VBG)

0101 = Reserved; do not use

 $0100 = AN4^{(1)}$

 $0011 = AN3^{(1)}$

 $0010 = AN2^{(1)}$

0001 **= AN1**

0000 = ANO

bit 7 CHONA: Channel 0 Negative Input Select for MUX A Multiplexer Setting bit

1 = Channel 0 negative input is AN1

0 = Channel 0 negative input is VR-

bit 6-5 **Unimplemented:** Read as '0'

bit 4-0 CH0SA<3:0>: Channel 0 Positive Input Select for MUX A Multiplexer Setting bits

Bit combinations are identical to those for CH0SB<3:0> (above).

Note 1: Unimplemented on 14-pin devices; do not use.

REGISTER 19-5: AD1CSSL: A/D INPUT SCAN SELECT REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CSSL15	CSSL14	CSSL13	CSSL12 ⁽¹⁾	CSSL11 ⁽¹⁾	CSSL10	CSSL9	CSSL8
bit 15							bit 8

R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CSSL7	CSSL6	_	CSSL4 ⁽¹⁾	CSSL3 ⁽¹⁾	CSSL2 ⁽¹⁾	CSSL1	CSSL0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-6 CSSL<15:6>: A/D Input Pin Scan Selection bits⁽¹⁾

1 = Corresponding analog channel selected for input scan

0 = Analog channel omitted from input scan

bit 5 **Unimplemented:** Read as '0'

bit 4-0 CSSL<4:0>: A/D Input Pin Scan Selection bits⁽¹⁾

1 = Corresponding analog channel selected for input scan

0 = Analog channel omitted from input scan

Note 1: These bits are unimplemented on 14-pin devices.

REGISTER 19-6: ANCFG: ANALOG INPUT CONFIGURATION REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	_	_	_	_	_	VBGEN
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-1 **Unimplemented:** Read as '0'

bit 0 VBGEN: Internal Band Gap Reference Enable bit

1 = Internal Band Gap voltage is available as a channel input to the A/D Converter

0 = Band gap is not available to the A/D Converter

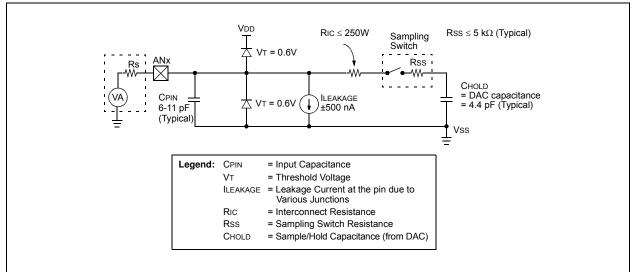
EQUATION 19-1: A/D CONVERSION CLOCK PERIOD⁽¹⁾

$$ADCS = \frac{TAD}{TCY} - 1$$

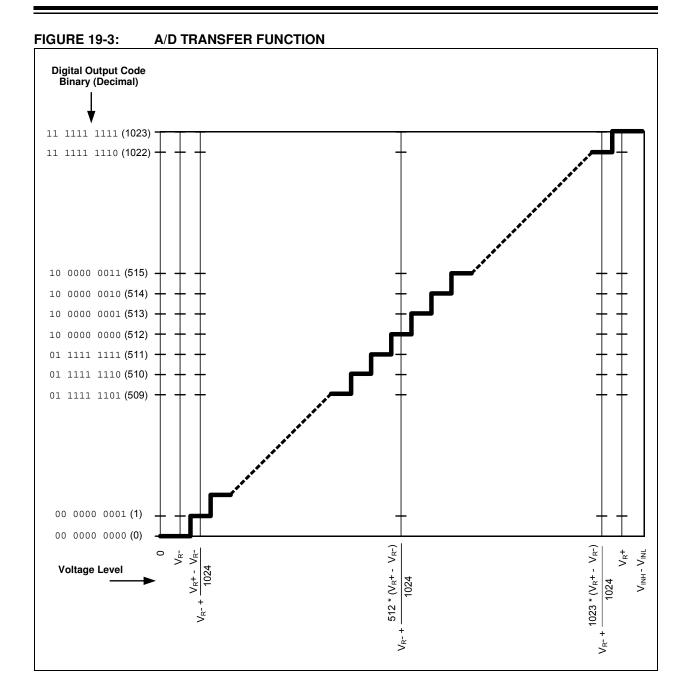
$$TAD = TCY \cdot (ADCS + 1)$$

Note 1: Based on Tcy = 2 * Tosc; Doze mode and PLL are disabled.

FIGURE 19-2: 10-BIT A/D CONVERTER ANALOG INPUT MODEL



Note: CPIN value depends on device package and is not tested. Effect of CPIN negligible if Rs \leq 5 k Ω .



NOTES:

20.0 COMPARATOR MODULE

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the Comparator module, refer to the "PIC24F Family Reference Manual", Section 19. "Dual Comparator Module" (DS39710).

Depending on the particular device, the comparator module provides one or two analog comparators. The inputs to the comparator can be configured to use any one of up to four external analog inputs, as well as a voltage reference input from either the internal band gap reference, divided by 2 (VBG/2), or the comparator voltage reference generator.

The comparator outputs may be directly connected to the CxOUT pins. When the respective COE equals '1', the I/O pad logic makes the unsynchronized output of the comparator available on the pin.

A simplified block diagram of the module is displayed in Figure 20-1. Diagrams of the possible individual comparator configurations are displayed in Figure 20-2.

Each comparator has its own control register, CMxCON (Register 20-1), for enabling and configuring its operation. The output and event status of all three comparators is provided in the CMSTAT register (Register 20-2).

FIGURE 20-1: COMPARATOR MODULE BLOCK DIAGRAM

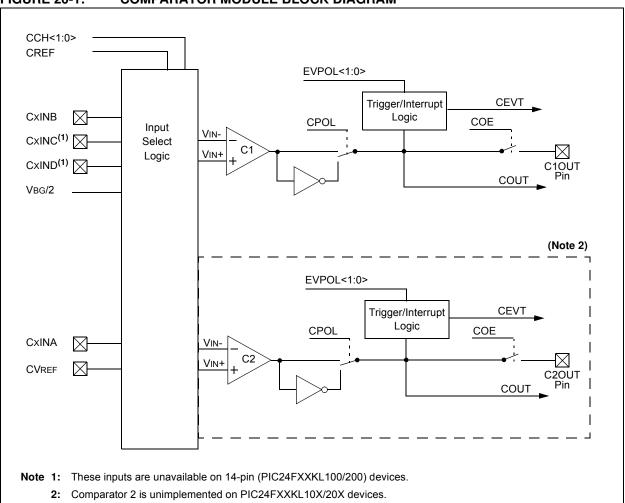
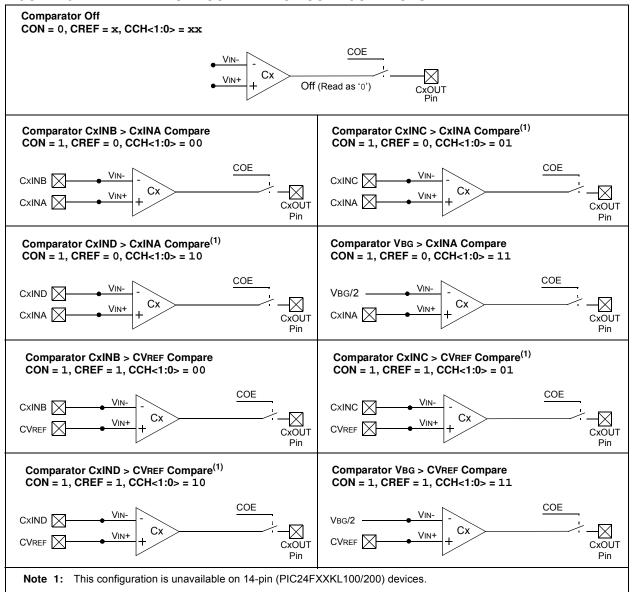


FIGURE 20-2: INDIVIDUAL COMPARATOR CONFIGURATIONS



REGISTER 20-1: CMxCON: COMPARATOR x CONTROL REGISTERS

R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R-0
CON	COE	CPOL	CLPWR	_	_	CEVT	COUT
bit 15							bit 8

R/W-0	R/W-0	U-0	R/W-0	U-0	U-0	R/W-0	R/W-0
EVPOL1	EVPOL0	_	CREF	_		CCH1	CCH0
bit 7		•	•				bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 CON: Comparator Enable bit

1 = Comparator is enabled

0 = Comparator is disabled

bit 14 **COE:** Comparator Output Enable bit

1 = Comparator output is present on the CxOUT pin

0 = Comparator output is internal only

bit 13 **CPOL:** Comparator Output Polarity Select bit

1 = Comparator output is inverted

0 = Comparator output is not inverted

bit 12 **CLPWR:** Comparator Low-Power Mode Select bit

1 = Comparator operates in Low-Power mode

0 = Comparator does not operate in Low-Power mode

bit 11-10 **Unimplemented:** Read as '0'

bit 9 **CEVT:** Comparator Event bit

1 = Comparator event defined by EVPOL<1:0> has occurred; subsequent triggers and interrupts are disabled until the bit is cleared

0 = Comparator event has not occurred

bit 8 **COUT:** Comparator Output bit

When CPOL = 0:

1 = VIN+ > VIN-

0 = VIN+ < VIN-

When CPOL = 1:

1 = VIN+ < VIN-

0 = VIN+ > VIN-

bit 7-6 **EVPOL<1:0>:** Trigger/Event/Interrupt Polarity Select bits

11 = Trigger/event/interrupt is generated on any change of the comparator output (while CEVT = 0)

10 = Trigger/event/interrupt is generated on transition of the comparator output:

If CPOL = 0 (non-inverted polarity):

High-to-low transition only.

If CPOL = 1 (inverted polarity):

Low-to-high transition only.

01 = Trigger/event/interrupt generated on transition of comparator output:

If CPOL = 0 (non-inverted polarity):

Low-to-high transition only.

If CPOL = 1 (inverted polarity):

High-to-low transition only.

00 = Trigger/event/interrupt generation is disabled

bit 5 **Unimplemented:** Read as '0'

Note 1: Unimplemented on 14-pin (PIC24FXXKL100/200) devices.

REGISTER 20-1: CMxCON: COMPARATOR x CONTROL REGISTERS (CONTINUED)

bit 4 CREF: Comparator Reference Select bits (non-inverting input)

1 = Non-inverting input connects to the internal CVREF voltage

0 = Non-inverting input connects to the CxINA pin

bit 3-2 **Unimplemented:** Read as '0'

bit 1-0 **CCH<1:0>:** Comparator Channel Select bits

11 = Inverting input of the comparator connects to VBG/2

10 = Inverting input of the comparator connects to CxIND pin(1)

01 = Inverting input of the comparator connects to CxINC pin⁽¹⁾

00 = Inverting input of the comparator connects to CxINB pin

Note 1: Unimplemented on 14-pin (PIC24FXXKL100/200) devices.

REGISTER 20-2: CMSTAT: COMPARATOR MODULE STATUS REGISTER

R/W-0	U-0	U-0	U-0	U-0	U-0	R-0, HSC	R-0, HSC
CMIDL	_	_	_	_	_	C2EVT ⁽¹⁾	C1EVT
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	R-0, HSC	R-0, HSC
_	_	_	_	_	_	C2OUT ⁽¹⁾	C1OUT
bit 7							bit 0

Legend: HSC = Hardware Settable/Clearable bit

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 CMIDL: Comparator Stop in Idle Mode bit

1 = Discontinue operation of all comparators when device enters Idle mode

0 = Continue operation of all enabled comparators in Idle mode

bit 14-10 **Unimplemented:** Read as '0'

bit 9 **C2EVT:** Comparator 2 Event Status bit (read-only)⁽¹⁾

Shows the current event status of Comparator 2 (CM2CON<9>).

bit 8 C1EVT: Comparator 1 Event Status bit (read-only)

Shows the current event status of Comparator 1 (CM1CON<9>).

bit 7-2 **Unimplemented:** Read as '0'

bit 1 **C2OUT:** Comparator 2 Output Status bit (read-only)⁽¹⁾

Shows the current output of Comparator 2 (CM2CON<8>).

bit 0 **C10UT:** Comparator 1 Output Status bit (read-only)

Shows the current output of Comparator 1 (CM1CON<8>).

Note 1: These bits are unimplemented on PIC24FXXKL10X/20X devices.

21.0 COMPARATOR VOLTAGE REFERENCE

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the Comparator Voltage Reference, refer to the "PIC24F Family Reference Manual", Section 20. "Comparator Voltage Reference Module" (DS39709).

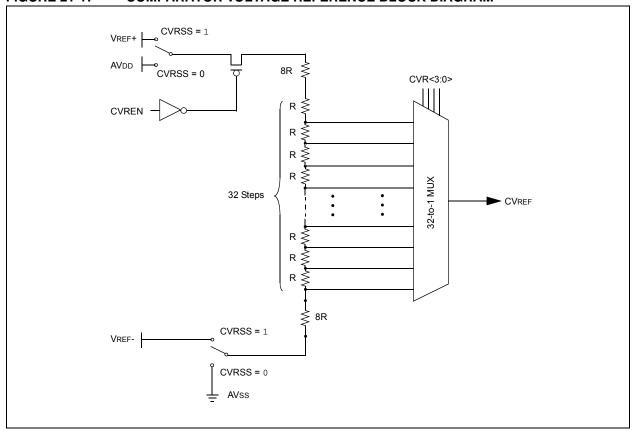
21.1 Configuring the Comparator Voltage Reference

The comparator voltage reference module is controlled through the CVRCON register (Register 21-1). The comparator voltage reference provides a range of output voltages, with 32 distinct levels.

The comparator voltage reference supply voltage can come from either VDD and VSS, or the external VREF+ and VREF-. The voltage source is selected by the CVRSS bit (CVRCON<5>).

The settling time of the comparator voltage reference must be considered when changing the CVREF output.

FIGURE 21-1: COMPARATOR VOLTAGE REFERENCE BLOCK DIAGRAM



REGISTER 21-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| CVREN | CVROE | CVRSS | CVR4 | CVR3 | CVR2 | CVR1 | CVR0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 CVREN: Comparator Voltage Reference Enable bit

1 = CVREF circuit is powered on0 = CVREF circuit is powered down

bit 6 **CVROE:** Comparator VREF Output Enable bit

1 = CVREF voltage level is output on the CVREF pin

0 = CVREF voltage level is disconnected from the CVREF pin

bit 5 CVRSS: Comparator VREF Source Selection bit

1 = Comparator reference source, CVRSRC = VREF+ - VREF-

0 = Comparator reference source, CVRSRC = AVDD - AVSS

bit 4-0 **CVR<4:0>:** Comparator VREF Value Selection $0 \le CVR<4:0> \le 31$ bits

When CVRSS = 1:

CVREF = (VREF-) + (CVR<4:0>/32) • (VREF+ - VREF-)

When CVRSS = 0:

 $CVREF = (AVSS) + (CVR < 4:0 > /32) \cdot (AVDD - AVSS)$

22.0 HIGH/LOW-VOLTAGE DETECT (HLVD)

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the High/Low-Voltage Detect, refer to the "PIC24F Family Reference Manual",

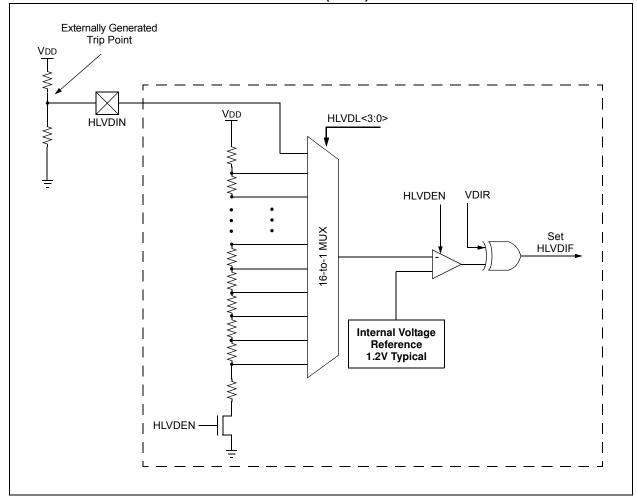
Section 36. "High-Level Integration with Programmable High/Low-Voltage Detect (HLVD)" (DS39725).

The High/Low-Voltage Detect module (HLVD) is a programmable circuit that allows the user to specify both the device voltage trip point and the direction of change.

An interrupt flag is set if the device experiences an excursion past the trip point in the direction of change. If the interrupt is enabled, the program execution will branch to the interrupt vector address and the software can then respond to the interrupt.

The HLVD Control register (see Register 22-1) completely controls the operation of the HLVD module. This allows the circuitry to be "turned off" by the user under software control, which minimizes the current consumption for the device.

FIGURE 22-1: HIGH/LOW-VOLTAGE DETECT (HLVD) MODULE BLOCK DIAGRAM



REGISTER 22-1: HLVDCON: HIGH/LOW-VOLTAGE DETECT CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
HLVDEN	_	HLSIDL	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
VDIR	BGVST	IRVST	_	HLVDL3	HLVDL2	HLVDL1	HLVDL0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15

HLVDEN: High/Low-Voltage Detect Power Enable bit

1 = HLVD is enabled
0 = HLVD is disabled

bit 14

Unimplemented: Read as '0'

bit 13

HLSIDL: HLVD Stop in Idle Mode bit

1 = Discontinue module operation when the device enters Idle mode
0 = Continue module operation in Idle mode

bit 12-8 **Unimplemented:** Read as '0'

bit 7 VDIR: Voltage Change Direction Select bit

1 = Event occurs when the voltage equals or exceeds the trip point (HLVDL<3:0>)
0 = Event occurs when the voltage equals or falls below the trip point (HLVDL<3:0>)

bit 6 BGVST: Band Gap Voltage Stable Flag bit

1 = Indicates that the band gap voltage is stable0 = Indicates that the band gap voltage is unstable

bit 5 IRVST: Internal Reference Voltage Stable Flag bit

1 = Indicates that the internal reference voltage is stable and the High-Voltage Detect logic generates the interrupt flag at the specified voltage range

0 = Indicates that the internal reference voltage is unstable and the High-Voltage Detect logic will not generate the interrupt flag at the specified voltage range, and the HLVD interrupt should not be enabled

bit 4 **Unimplemented:** Read as '0'

bit 3-0 **HLVDL<3:0>:** High/Low-Voltage Detection Limit bits

1111 = External analog input is used (input comes from the HLVDIN pin)

1110 = Trip point 14⁽¹⁾ 1101 = Trip point 13⁽¹⁾ 1100 = Trip point 12⁽¹⁾

. 0000 = Trip point 0⁽¹⁾

Note 1: For the actual trip point, see Section 26.0 "Electrical Characteristics".

23.0 SPECIAL FEATURES

Note:

This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information on the Watchdog Timer, High-Level Device Integration and Programming Diagnostics, refer to the individual sections of the "PIC24F Family Reference Manual" provided below:

- Section 9. "Watchdog Timer (WDT)" (DS39697)
- Section 36. "High-Level Integration with Programmable High/Low-Voltage Detect (HLVD)" (DS39725)
- Section 33. "Programming and Diagnostics" (DS39716)

PIC24F16KL402 family devices include several features intended to maximize application flexibility and reliability, and minimize cost through elimination of external components. These are:

- · Flexible Configuration
- · Watchdog Timer (WDT)
- · Code Protection
- In-Circuit Serial Programming™ (ICSP™)
- In-Circuit Emulation
- · Factory Programmed Unique ID

23.1 Configuration Bits

The Configuration bits can be programmed (read as '0'), or left unprogrammed (read as '1'), to select various device configurations. These bits are mapped starting at program memory location, F80000h. A complete list is provided in Table 23-1. A detailed explanation of the various bit functions is provided in Register 23-1 through Register 23-7.

The address, F80000h, is beyond the user program memory space. In fact, it belongs to the configuration memory space (800000h-FFFFFFh), which can only be accessed using table reads and table writes.

TABLE 23-1: CONFIGURATION REGISTERS LOCATIONS

Configuration Register	Address
FBS	F80000
FGS	F80004
FOSCSEL	F80006
FOSC	F80008
FWDT	F8000A
FPOR	F8000C
FICD	F8000E

REGISTER 23-1: FBS: BOOT SEGMENT CONFIGURATION REGISTER

U-0	U-0	U-0	U-0	R/C-1 ⁽¹⁾	R/C-1 ⁽¹⁾	R/C-1 ⁽¹⁾	R/C-1 ⁽¹⁾
_	_	_	_	BSS2	BSS1	BSS0	BWRP
bit 7							bit 0

Legend:

R = Readable bit C = Clearable Only bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-4 **Unimplemented:** Read as '0'

bit 3-1 BSS<2:0>: Boot Segment Program Flash Code Protection bits⁽¹⁾

111 = No boot segment; all program memory space is General Segment 110 = Standard security boot segment starts at 0200h, ends at 0AFEh

101 = Standard security boot segment starts at 0200h, ends at 15FEh(2)

100 = Reserved 011 = Reserved

010 = High-security boot segment starts at 0200h, ends at 0AFEh

001 = High-security boot segment starts at 0200h, ends at 15FEh⁽²⁾

000 = Reserved

bit 0 **BWRP:** Boot Segment Program Flash Write Protection bit⁽¹⁾

1 = Boot segment may be written

0 = Boot segment is write-protected

Note 1: Code protection bits can only be programmed by clearing them. They can be reset to their default factory state ('1'), but only by performing a bulk erase and reprogramming the entire device.

2: This selection is available only on PIC24F16KL40X devices.

REGISTER 23-2: FGS: GENERAL SEGMENT CONFIGURATION REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	R/C-1 ⁽¹⁾	R/C-1 ⁽¹⁾
_	_	_	_	_	_	GSS0	GWRP
bit 7							bit 0

Legend:

R = Readable bit C = Clearable Only bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-2 **Unimplemented:** Read as '0'

bit 1 GSS0: General Segment Code Flash Code Protection bit⁽¹⁾

1 = No protection

0 = Standard security is enabled

bit 0 **GWRP:** General Segment Code Flash Write Protection bit⁽¹⁾

1 = General segment may be written

0 = General segment is write-protected

Note 1: Code protection bits can only be programmed by clearing them. They can be reset to their default factory state ('1'), but only by performing a bulk erase and reprogramming the entire device.

REGISTER 23-3: FOSCSEL: OSCILLATOR SELECTION CONFIGURATION REGISTER

R/P-1	R/P-1	R/P-1	U-0	U-0	R/P-0	R/P-0	R/P-1
IESO	LPRCSEL	SOSCSRC	_	_	FNOSC2	FNOSC1	FNOSC0
bit 7							bit 0

Legend:

R = Readable bit P = Programmable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 IESO: Internal External Switchover bit

1 = Internal External Switchover mode is enabled (Two-Speed Start-up is enabled)
 0 = Internal External Switchover mode is disabled (Two-Speed Start-up is disabled)

bit 6 LPRCSEL: Internal LPRC Oscillator Power Select bit

1 = High-Power/High-Accuracy mode0 = Low-Power/Low-Accuracy mode

bit 5 SOSCSRC: Secondary Oscillator Clock Source Configuration bit

1 = SOSC analog crystal function is available on the SOSCI/SOSCO pins

0 = SOSC crystal is disabled; digital SCLKI function is selected on the SOSCO pin

bit 4-3 **Unimplemented:** Read as '0'

bit 2-0 FNOSC<2:0>: Oscillator Selection bits

111 = 8 MHz FRC Oscillator with divide-by-N (FRCDIV)

110 = 500 kHz Low-Power FRC Oscillator with divide-by-N (LPFRCDIV)

101 = Low-Power RC Oscillator (LPRC)

100 = Secondary Oscillator (SOSC)

011 = Primary Oscillator with PLL module (HS+PLL, EC+PLL)

010 = Primary Oscillator (XT, HS, EC)

001 = 8 MHz FRC Oscillator with divide-by-N with PLL module (FRCDIV+PLL)

000 = 8 MHz FRC Oscillator (FRC)

FOSC: OSCILLATOR CONFIGURATION REGISTER REGISTER 23-4:

R/P-0	R/P-0	R/P-1	R/P-1	R/P-1	R/P-0	R/P-1	R/P-1
FCKSM1	FCKSM0	SOSCSEL	POSCFREQ1	POSCFREQ0	OSCIOFNC	POSCMD1	POSCMD0
bit 7							bit 0

Legend:

R = Readable bit P = Programmable bit U = Unimplemented bit, read as '0'

-n = Value at POR '0' = Bit is cleared '1' = Bit is set x = Bit is unknown

bit 7-6 FCKSM<1:0>: Clock Switching and Monitor Selection Configuration bits

1x = Clock switching is disabled, Fail-Safe Clock Monitor is disabled

01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled

00 = Clock switching is enabled, Fail-Safe Clock Monitor is enabled

bit 5 SOSCSEL: Secondary Oscillator Power Selection Configuration bit

> 1 = Secondary oscillator is configured for high-power operation 0 = Secondary oscillator is configured for low-power operation

bit 4-3 POSCFREQ<1:0>: Primary Oscillator Frequency Range Configuration bits

11 = Primary oscillator/external clock input frequency is greater than 8 MHz 10 = Primary oscillator/external clock input frequency is between 100 kHz and 8 MHz

01 = Primary oscillator/external clock input frequency is less than 100 kHz

00 = Reserved; do not use

bit 2 OSCIOFNC: CLKO Enable Configuration bit

> 1 = CLKO output signal is active on the OSCO pin; primary oscillator must be disabled or configured for the External Clock mode (EC) for the CLKO to be active (POSCMD<1:0> = 11 or 00)

0 = CLKO output is disabled

bit 1-0 POSCMD<1:0>: Primary Oscillator Configuration bits

11 = Primary Oscillator mode is disabled

10 = HS Oscillator mode is selected

01 = XT Oscillator mode is selected

00 = External Clock mode is selected

REGISTER 23-5: FWDT: WATCHDOG TIMER CONFIGURATION REGISTER

R/P-1	R/P-1	R/P-0	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
FWDTEN1	WINDIS	FWDTEN0	FWPSA	WDTPS3	WDTPS2	WDTPS1	WDTPS0
bit 7							bit 0

Legend:

R = Readable bit P = Programmable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7,5 **FWDTEN<1:0>:** Watchdog Timer Enable bit

11 = WDT is enabled in hardware

10 = WDT is controlled with the SWDTEN bit setting

01 = WDT is enabled only while device is active; WDT is disabled in Sleep; SWDTEN bit is disabled

00 = WDT is disabled in hardware; SWDTEN bit is disabled

bit 6 WINDIS: Windowed Watchdog Timer Disable bit

1 = Standard WDT is selected; windowed WDT is disabled

0 = Windowed WDT is enabled; note that executing a CLRWDT instruction while the WDT is disabled in hardware and software (FWDTEN<1:0> = 00 and RCON bit, SWDTEN = 0) will not cause a device Reset

bit 4 **FWPSA:** WDT Prescaler bit

1 = WDT prescaler ratio of 1:128

0 = WDT prescaler ratio of 1:32

bit 3-0 WDTPS<3:0>: Watchdog Timer Postscale Select bits

1111 = 1:32,768

1110 = 1:16,384

1101 = 1:8,192

1100 = 1:4,096

1011 = 1:2,048

1010 = 1:1,024

1001 = 1:512

1001 = 1.5121000 = 1.256

0111 = 1:128

0110 = 1:64

0101 = 1:32

0100 = 1:16

0011 = 1:8

0011 - 1.00010 = 1.4

0001 = 1:2

0000 = 1:1

REGISTER 23-6: FPOR: RESET CONFIGURATION REGISTER

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	U-0	R/P-1	R/P-1
MCLRE ⁽¹⁾	BORV1 ⁽²⁾	BORV0 ⁽²⁾	I2C1SEL ⁽³⁾	PWRTEN	_	BOREN1	BOREN0
bit 7							bit 0

Legend:

R = Readable bit P = Programmable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 MCLRE: MCLR Pin Enable bit(1)

1 = $\overline{\text{MCLR}}$ pin is enabled; RA5 input pin is disabled 0 = RA5 input pin is enabled; $\overline{\text{MCLR}}$ is disabled

bit 6-5 **BORV<1:0>:** Brown-out Reset Enable bits⁽²⁾

11 = Brown-out Reset is set to the low trip point 10 = Brown-out Reset is set to the middle trip point 01 = Brown-out Reset is set to the high trip point

00 = Downside protection on POR is enabled (Low-Power BOR is selected)

bit 4 **I2C1SEL:** Alternate MSSP1 I²C[™] Pin Mapping bit⁽³⁾

1 = Default location for SCL1/SDA1 pins (RB8 and RB9)

0 = Alternate location for SCL1/SDA1 pins (ASCL1/RB6 and ASDA1/RB5)

bit 3 **PWRTEN:** Power-up Timer Enable bit

1 = PWRT is enabled 0 = PWRT is disabled

bit 2 Unimplemented: Read as '0'

bit 1-0 BOREN<1:0>: Brown-out Reset Enable bits

11 = BOR is enabled in hardware; SBOREN bit is disabled

10 = BOR is enabled only while device is active and disabled in Sleep; SBOREN bit is disabled

01 = BOR is controlled with the SBOREN bit setting

00 = BOR is disabled in hardware; SBOREN bit is disabled

Note 1: The MCLRE fuse can only be changed when using the VPP-Based ICSP™ mode entry. This prevents a user from accidentally locking out the device from the low-voltage test entry.

2: Refer to Table 26-5 for BOR trip point voltages.

3: Implemented in 28-pin devices only. This bit position must be programmed (= 1) in all other devices for I²C functionality to be available.

REGISTER 23-7: FICD: IN-CIRCUIT DEBUGGER CONFIGURATION REGISTER

R/P-1	U-1	U-1	U-0	U-0	U-0	R/P-1	R/P-1
DEBUG	_	_	_	_	_	ICS1	ICS0
bit 7							bit 0

Legend:

R = Readable bit P = Programmable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 **DEBUG:** Background Debugger Enable bit

1 = Background debugger is disabled

0 = Background debugger functions are enabled

bit 6-5 **Unimplemented:** Read as '1' bit 4-2 **Unimplemented:** Read as '0' bit 1-0 **ICS<1:0:>** ICD Pin Select bits

11 = PGEC1/PGED1 are used for programming and debugging the device 10 = PGEC2/PGED2 are used for programming and debugging the device

01 = PGEC3/PGED3 are used for programming and debugging the device

00 = Reserved; do not use

Note 1: PGEC1/PGED1 are not available on PIC24F04KL100 (14-pin) devices.

23.2 Unique ID

A read-only Unique ID value is stored at addresses, 800802h through 800808h. This factory programmed value is unique to each microcontroller produced in the PIC24F16KL402 family. To access this region, use table read instructions or Program Space Visibility.

To ensure a globally Unique ID across other Microchip microcontroller families, the "Unique ID" value should be further concatenated with the family and Device ID values stored at address, FF0000h.

REGISTER 23-8: DEVID: DEVICE ID REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 23							bit 16

R	R	R	R	R	R	R	R
FAMID7	FAMID6	FAMID5	FAMID4	FAMID3	FAMID2	FAMID1	FAMID0
bit 15							bit 8

R	R	R	R	R	R	R	R
DEV7	DEV6	DEV5	DEV4	DEV3	DEV2	DEV1	DEV0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 23-16 Unimplemented: Read as '0'

bit 15-8 **FAMID<7:0>:** Device Family Identifier bits

01001011 = PIC24F16KL402 family

bit 7-0 **DEV<7:0>:** Individual Device Identifier bits

00000001 = PIC24F04KL100 00000010 = PIC24F04KL101

00000101 = PIC24F08KL200 00000110 = PIC24F08KL201

00001010 = PIC24F08KL301 00000000 = PIC24F08KL302

00001110 = PIC24F08KL401 00000100 = PIC24F08KL402 00011110 = PIC24F16KL401 00010100 = PIC24F16KL402

REGISTER 23-9: DEVREV: DEVICE REVISION REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_		_
bit 23							bit 16

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	R	R	R	R
_	_	_	_	REV3	REV2	REV1	REV0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 23-4 **Unimplemented:** Read as '0' bit 3-0 **REV<3:0>:** Revision Identifier bits

23.3 Watchdog Timer (WDT)

For the PIC24F16KL402 family of devices, the WDT is driven by the LPRC oscillator. When the WDT is enabled, the clock source is also enabled.

The nominal WDT clock source from LPRC is 31 kHz. This feeds a prescaler that can be configured for either 5-bit (divide-by-32) or 7-bit (divide-by-128) operation. The prescaler is set by the FWPSA Configuration bit. With a 31 kHz input, the prescaler yields a nominal WDT time-out period (TWDT) of 1 ms in 5-bit mode or 4 ms in 7-bit mode.

A variable postscaler divides down the WDT prescaler output and allows for a wide range of time-out periods. The postscaler is controlled by the Configuration bits, WDTPS<3:0> (FWDT<3:0>), which allow the selection of a total of 16 settings, from 1:1 to 1:32,768. Using the prescaler and postscaler time-out periods, ranges from 1 ms to 131 seconds can be achieved.

The WDT, prescaler and postscaler are reset:

- · On any device Reset
- On the completion of a clock switch, whether invoked by software (i.e., setting the OSWEN bit after changing the NOSC bits) or by hardware (i.e., Fail-Safe Clock Monitor)
- When a PWRSAV instruction is executed (i.e., Sleep or Idle mode is entered)
- When the device exits Sleep or Idle mode to resume normal operation
- By a CLRWDT instruction during normal execution

If the WDT is enabled in hardware (FWDTEN<1:0> = 11), it will continue to run during Sleep or Idle modes. When the WDT time-out occurs, the device will wake and code execution will continue from where the PWRSAV instruction was executed. The corresponding SLEEP or IDLE bits (RCON<3:2>) will need to be cleared in software after the device wakes up.

The WDT Flag bit, WDTO (RCON<4>), is not automatically cleared following a WDT time-out. To detect subsequent WDT events, the flag must be cleared in software.

Note: The CLRWDT and PWRSAV instructions clear the prescaler and postscaler counts when executed.

23.3.1 WINDOWED OPERATION

The Watchdog Timer has an optional Fixed Window mode of operation. In this Windowed mode, CLRWDT instructions can only reset the WDT during the last 1/4 of the programmed WDT period. A CLRWDT instruction, executed before that window, causes a WDT Reset similar to a WDT time-out.

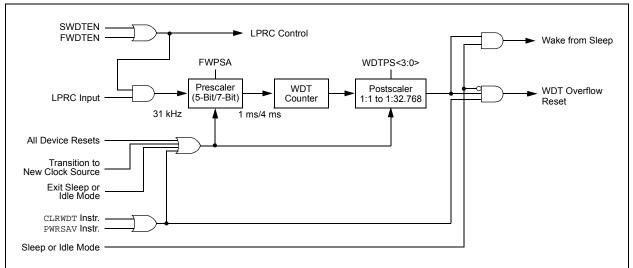
Windowed WDT mode is enabled by programming the Configuration bit, WINDIS (FWDT<6>), to '0'.

23.3.2 CONTROL REGISTER

The WDT is enabled or disabled by the FWDTEN<1:0> Configuration bits. When both the FWDTEN<1:0> Configuration bits are set, the WDT is always enabled.

The WDT can be optionally controlled in software when the FWDTEN<1:0> Configuration bits have been programmed to '10'. The WDT is enabled in software by setting the SWDTEN control bit (RCON<5>). The SWDTEN control bit is cleared on any device Reset. The software WDT option allows the user to enable the WDT for critical code segments, and disable the WDT during non-critical segments, for maximum power savings. When the FWTEN<1:0> bits are set to '01', the WDT is enabled only in Run and Idle modes, and is disabled in Sleep. Software control of the WDT SWDTEN bit (RCON<5>) is disabled with this setting.





23.4 Program Verification and Code Protection

For all devices in the PIC24F16KL402 family, code protection for the boot segment is controlled by the BSS<2:0> Configuration bits and the general segment by the Configuration bit, GSS0. These bits inhibit external reads and writes to the program memory space This has no direct effect in normal execution mode.

Write protection is controlled by bit, BWRP, for the boot segment and bit, GWRP, for the general segment in the Configuration Word. When these bits are programmed to '0', internal write and erase operations to program memory are blocked.

23.5 In-Circuit Serial Programming

PIC24F16KL402 family microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock (PGECx) and data (PGEDx), and three other lines for power, ground and the programming voltage. This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

23.6 In-Circuit Debugger

When MPLAB[®] ICD 3, MPLAB REAL ICE™ or PICkit™ 3 is selected as a debugger, the in-circuit debugging functionality is enabled. This function allows simple debugging functions when used with MPLAB IDE. Debugging functionality is controlled through the PGECx and PGEDx pins.

To use the in-circuit debugger function of the device, the design must implement ICSP connections to MCLR, VDD, VSS, PGECx, PGEDx and the pin pair. In addition, when the feature is enabled, some of the resources are not available for general use. These resources include the first 80 bytes of data RAM and two I/O pins.

NOTES:

24.0 DEVELOPMENT SUPPORT

The PIC® microcontrollers and dsPIC® digital signal controllers are supported with a full range of software and hardware development tools:

- · Integrated Development Environment
 - MPLAB® IDE Software
- · Compilers/Assemblers/Linkers
 - MPLAB C Compiler for Various Device Families
 - HI-TECH C® for Various Device Families
 - MPASM™ Assembler
 - MPLINK[™] Object Linker/ MPLIB[™] Object Librarian
 - MPLAB Assembler/Linker/Librarian for Various Device Families
- Simulators
 - MPLAB SIM Software Simulator
- Emulators
 - MPLAB REAL ICE™ In-Circuit Emulator
- · In-Circuit Debuggers
 - MPLAB ICD 3
 - PICkit™ 3 Debug Express
- · Device Programmers
 - PICkit™ 2 Programmer
 - MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards, Evaluation Kits, and Starter Kits

24.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16/32-bit microcontroller market. The MPLAB IDE is a Windows® operating system-based application that contains:

- A single graphical interface to all debugging tools
 - Simulator
 - Programmer (sold separately)
 - In-Circuit Emulator (sold separately)
 - In-Circuit Debugger (sold separately)
- · A full-featured editor with color-coded context
- · A multiple project manager
- Customizable data windows with direct edit of contents
- · High-level source code debugging
- · Mouse over variable inspection
- Drag and drop variables from source to watch windows
- · Extensive on-line help
- Integration of select third party tools, such as IAR C Compilers

The MPLAB IDE allows you to:

- Edit your source files (either C or assembly)
- One-touch compile or assemble, and download to emulator and simulator tools (automatically updates all project information)
- · Debug using:
 - Source files (C or assembly)
 - Mixed C and assembly
 - Machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost-effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increased flexibility and power.

24.2 MPLAB C Compilers for Various Device Families

The MPLAB C Compiler code development systems are complete ANSI C compilers for Microchip's PIC18, PIC24 and PIC32 families of microcontrollers and the dsPIC30 and dsPIC33 families of digital signal controllers. These compilers provide powerful integration capabilities, superior code optimization and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

24.3 HI-TECH C for Various Device Families

The HI-TECH C Compiler code development systems are complete ANSI C compilers for Microchip's PIC family of microcontrollers and the dsPIC family of digital signal controllers. These compilers provide powerful integration capabilities, omniscient code generation and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

The compilers include a macro assembler, linker, preprocessor, and one-step driver, and can run on multiple platforms.

24.4 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM Assembler features include:

- · Integration into MPLAB IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

24.5 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler and the MPLAB C18 C Compiler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

24.6 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC devices. MPLAB C Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- · Support for the entire device instruction set
- · Support for fixed-point and floating-point data
- · Command line interface
- · Rich directive set
- · Flexible macro language
- MPLAB IDE compatibility

24.7 MPLAB SIM Software Simulator

The MPLAB SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC® DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB SIM Software Simulator fully supports symbolic debugging using the MPLAB C Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

24.8 MPLAB REAL ICE In-Circuit Emulator System

MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs PIC[®] Flash MCUs and dsPIC[®] Flash DSCs with the easy-to-use, powerful graphical user interface of the MPLAB Integrated Development Environment (IDE), included with each kit.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with incircuit debugger systems (RJ11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB IDE. In upcoming releases of MPLAB IDE, new devices will be supported, and new features will be added. MPLAB REAL ICE offers significant advantages over competitive emulators including low-cost, full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, a ruggedized probe interface and long (up to three meters) interconnection cables.

24.9 MPLAB ICD 3 In-Circuit Debugger System

MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost effective high-speed hardware debugger/programmer for Microchip Flash Digital Signal Controller (DSC) and microcontroller (MCU) devices. It debugs and programs PIC® Flash microcontrollers and dsPIC® DSCs with the powerful, yet easy-to-use graphical user interface of MPLAB Integrated Development Environment (IDE).

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

24.10 PICkit 3 In-Circuit Debugger/ Programmer and PICkit 3 Debug Express

The MPLAB PICkit 3 allows debugging and programming of PIC[®] and dsPIC[®] Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB Integrated Development Environment (IDE). The MPLAB PICkit 3 is connected to the design engineer's PC using a full speed USB interface and can be connected to the target via an Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the reset line to implement in-circuit debugging and In-Circuit Serial Programming ™.

The PICkit 3 Debug Express include the PICkit 3, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

24.11 PICkit 2 Development Programmer/Debugger and PICkit 2 Debug Express

The PICkit™ 2 Development Programmer/Debugger is a low-cost development tool with an easy to use interface for programming and debugging Microchip's Flash families of microcontrollers. The full featured Windows® programming interface supports baseline (PIC10F, PIC12F5xx, PIC16F5xx), midrange (PIC12F6xx, PIC16F), PIC18F, PIC24, dsPIC30, dsPIC33, and PIC32 families of 8-bit, 16-bit, and 32-bit microcontrollers, and many Microchip Serial EEPROM products. With Microchip's powerful MPLAB Integrated Development Environment (IDE) the PICkit™ 2 enables in-circuit debugging on most PIC® microcontrollers. In-Circuit-Debugging runs, halts and single steps the program while the PIC microcontroller is embedded in the application. When halted at a breakpoint, the file registers can be examined and modified.

The PICkit 2 Debug Express include the PICkit 2, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

24.12 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages and a modular, detachable socket assembly to support various package types. The ICSP™ cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices and incorporates an MMC card for file storage and data applications.

24.13 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEMTM and dsPICDEMTM demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, Keeloq® security ICs, CAN, IrDA®, PowerSmart battery management, Seevaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

25.0 INSTRUCTION SET SUMMARY

Note:

This chapter is a brief summary of the PIC24F Instruction Set Architecture (ISA) and is not intended to be a comprehensive reference source.

The PIC24F instruction set adds many enhancements to the previous PIC® MCU instruction sets, while maintaining an easy migration from previous PIC MCU instruction sets. Most instructions are a single program memory word. Only three instructions require two program memory locations.

Each single-word instruction is a 24-bit word divided into an 8-bit opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction. The instruction set is highly orthogonal and is grouped into four basic categories:

- · Word or byte-oriented operations
- · Bit-oriented operations
- · Literal operations
- · Control operations

Table 25-1 lists the general symbols used in describing the instructions. The PIC24F instruction set summary in Table 25-2 lists all the instructions, along with the status flags affected by each instruction.

Most word or byte-oriented W register instructions (including barrel shift instructions) have three operands:

- The first source operand, which is typically a register 'Wb' without any address modifier
- The second source operand, which is typically a register 'Ws' with or without an address modifier
- The destination of the result, which is typically a register 'Wd' with or without an address modifier

However, word or byte-oriented file register instructions have two operands:

- · The file register specified by the value, 'f'
- The destination, which could either be the file register, 'f', or the W0 register, which is denoted as 'WREG'

Most bit-oriented instructions (including simple rotate/shift instructions) have two operands:

- The W register (with or without an address modifier) or file register (specified by the value of 'Ws' or 'f')
- The bit in the W register or file register (specified by a literal value or indirectly by the contents of register 'Wb')

The literal instructions that involve data movement may use some of the following operands:

- A literal value to be loaded into a W register or file register (specified by the value of 'k')
- The W register or file register where the literal value is to be loaded (specified by 'Wb' or 'f')

However, literal instructions that involve arithmetic or logical operations use some of the following operands:

- The first source operand, which is a register 'Wb' without any address modifier
- The second source operand, which is a literal value
- The destination of the result (only if not the same as the first source operand), which is typically a register 'Wd' with or without an address modifier

The control instructions may use some of the following operands:

- · A program memory address
- The mode of the table read and table write instructions

All instructions are a single word, except for certain double-word instructions, which were made double-word instructions so that all of the required information is available in these 48 bits. In the second word, the 8 MSbs are '0's. If this second word is executed as an instruction (by itself), it will execute as a NOP

Most single-word instructions are executed in a single instruction cycle, unless a conditional test is true or the Program Counter (PC) is changed as a result of the instruction. In these cases, the execution takes two instruction cycles, with the additional instruction cycle(s) executed as a NOP. Notable exceptions are the BRA (unconditional/computed branch), indirect CALL/GOTO, all table reads and writes, and RETURN/RETFIE instructions, which are single-word instructions but take two or three cycles.

Certain instructions that involve skipping over the subsequent instruction require either two or three cycles if the skip is performed, depending on whether the instruction being skipped is a single-word or two-word instruction. Moreover, double-word moves require two cycles. The double-word instructions execute in two instruction cycles.

TABLE 25-1: SYMBOLS USED IN OPCODE DESCRIPTIONS

Field	Description
#text	Means literal defined by "text"
(text)	Means "content of text"
[text]	Means "the location addressed by text"
{ }	Optional field or operation
<n:m></n:m>	Register bit field
.b	Byte mode selection
.d	Double-Word mode selection
.S	Shadow register select
.W	Word mode selection (default)
bit4	4-bit bit selection field (used in word addressed instructions) ∈ {015}
C, DC, N, OV, Z	MCU Status bits: Carry, Digit Carry, Negative, Overflow, Sticky Zero
Expr	Absolute address, label or expression (resolved by the linker)
f	File register address ∈ {0000h1FFFh}
lit1	1-bit unsigned literal ∈ {0,1}
lit4	4-bit unsigned literal ∈ {015}
lit5	5-bit unsigned literal ∈ {031}
lit8	8-bit unsigned literal ∈ {0255}
lit10	10-bit unsigned literal ∈ {0255} for Byte mode, {0:1023} for Word mode
lit14	14-bit unsigned literal ∈ {016384}
lit16	16-bit unsigned literal ∈ {065535}
lit23	23-bit unsigned literal ∈ {08388608}; LSB must be '0'
None	Field does not require an entry, may be blank
PC	Program Counter
Slit10	10-bit signed literal ∈ {-512511}
Slit16	16-bit signed literal ∈ {-3276832767}
Slit6	6-bit signed literal ∈ {-1616}
Wb	Base W register ∈ {W0W15}
Wd	Destination W register ∈ { Wd, [Wd], [Wd++], [Wd], [++Wd], [Wd] }
Wdo	Destination W register ∈ { Wnd, [Wnd], [Wnd++], [Wnd], [++Wnd], [Wnd], [Wnd+Wb] }
Wm,Wn	Dividend, Divisor working register pair (direct addressing)
Wn	One of 16 working registers ∈ {W0W15}
Wnd	One of 16 destination working registers ∈ {W0W15}
Wns	One of 16 source working registers ∈ {W0W15}
WREG	W0 (working register used in File register instructions)
Ws	Source W register ∈ { Ws, [Ws], [Ws++], [Ws], [++Ws], [Ws] }
Wso	Source W register ∈ { Wns, [Wns], [Wns++], [Wns], [++Wns], [Wns], [Wns+Wb] }

TABLE 25-2: INSTRUCTION SET OVERVIEW

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
ADD	ADD	f	f = f + WREG	1	1	C, DC, N, OV, Z
	ADD	f,WREG	WREG = f + WREG	1	1	C, DC, N, OV, Z
	ADD	#lit10,Wn	Wd = lit10 + Wd	1	1	C, DC, N, OV, Z
	ADD	Wb,Ws,Wd	Wd = Wb + Ws	1	1	C, DC, N, OV, Z
	ADD	Wb,#lit5,Wd	Wd = Wb + lit5	1	1	C, DC, N, OV, Z
ADDC	ADDC	f	f = f + WREG + (C)	1	1	C, DC, N, OV, Z
	ADDC	f,WREG	WREG = f + WREG + (C)	1	1	C, DC, N, OV, Z
	ADDC	#lit10,Wn	Wd = lit10 + Wd + (C)	1	1	C, DC, N, OV, Z
	ADDC	Wb,Ws,Wd	Wd = Wb + Ws + (C)	1	1	C, DC, N, OV, Z
	ADDC	Wb,#lit5,Wd	Wd = Wb + lit5 + (C)	1	1	C, DC, N, OV, Z
AND	AND	f	f = f .AND. WREG	1	1	N, Z
	AND	f,WREG	WREG = f .AND. WREG	1	1	N, Z
	AND	#lit10,Wn	Wd = lit10 .AND. Wd	1	1	N, Z
	AND	Wb,Ws,Wd	Wd = Wb .AND. Ws	1	1	N, Z
	AND	Wb,#lit5,Wd	Wd = Wb .AND. lit5	1	1	N, Z
ASR	ASR	f	f = Arithmetic Right Shift f	1	1	C, N, OV, Z
	ASR	f,WREG	WREG = Arithmetic Right Shift f	1	1	C, N, OV, Z
	ASR	Ws,Wd	Wd = Arithmetic Right Shift Ws	1	1	C, N, OV, Z
	ASR	Wb, Wns, Wnd	Wnd = Arithmetic Right Shift Wb by Wns	1	1	N, Z
	ASR	Wb,#lit5,Wnd	Wnd = Arithmetic Right Shift Wb by lit5	1	1	N, Z
BCLR	BCLR	f,#bit4	Bit Clear f	1	1	None
2021	BCLR	Ws,#bit4	Bit Clear Ws	1	1	None
BRA	BRA	C,Expr	Branch if Carry	1	1 (2)	None
Didi	BRA	GE, Expr	Branch if Greater than or Equal	1	1 (2)	None
	BRA	GEU, Expr	Branch if Unsigned Greater than or Equal	1	1 (2)	None
	BRA	GT, Expr	Branch if Greater than	1	1 (2)	None
	BRA	GTU, Expr	Branch if Unsigned Greater than	1	1 (2)	None
	BRA	LE, Expr	Branch if Less than or Equal	1	1 (2)	None
	BRA	LEU, Expr	Branch if Unsigned Less than or Equal	1	1 (2)	None
	BRA	LT, Expr	Branch if Less than	1	1 (2)	None
	BRA	LTU, Expr	Branch if Unsigned Less than	1	1 (2)	None
	BRA		Branch if Negative	1	1 (2)	None
		N, Expr	Branch if Not Carry	1		None
	BRA	NC, Expr	Branch if Not Negative	1	1 (2)	None
	BRA	NN, Expr	Branch if Not Overflow	1	1 (2)	None
	BRA	NOV, Expr		_		None
	BRA	NZ,Expr	Branch if Not Zero	1	1 (2)	
	BRA	OV,Expr	Branch if Overflow		1 (2)	None
	BRA	Expr	Branch Unconditionally	1	2	None
	BRA	Z,Expr	Branch if Zero	1	1 (2)	None
	BRA	Wn	Computed Branch	1	2	None
BSET	BSET	f,#bit4	Bit Set f	1	1	None
	BSET	Ws,#bit4	Bit Set Ws	1	1	None
BSW	BSW.C	Ws,Wb	Write C bit to Ws <wb></wb>	1	1	None
	BSW.Z	Ws,Wb	Write Z bit to Ws <wb></wb>	1	1	None
BTG	BTG	f,#bit4	Bit Toggle f	1	1	None
	BTG	Ws,#bit4	Bit Toggle Ws	1	1	None
BTSC	BTSC	f,#bit4	Bit Test f, Skip if Clear	1	1 (2 or 3)	None
	BTSC	Ws,#bit4	Bit Test Ws, Skip if Clear	1	1 (2 or 3)	None

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
BTSS	BTSS	f,#bit4	Bit Test f, Skip if Set	1	1 (2 or 3)	None
	BTSS	Ws,#bit4	Bit Test Ws, Skip if Set	1	1 (2 or 3)	None
BTST	BTST	f,#bit4	Bit Test f	1	1	Z
	BTST.C	Ws,#bit4	Bit Test Ws to C	1	1	С
	BTST.Z	Ws,#bit4	Bit Test Ws to Z	1	1	Z
	BTST.C	Ws,Wb	Bit Test Ws <wb> to C</wb>	1	1	С
	BTST.Z	Ws,Wb	Bit Test Ws <wb> to Z</wb>	1	1	Z
BTSTS	BTSTS	f,#bit4	Bit Test then Set f	1	1	Z
	BTSTS.C	Ws,#bit4	Bit Test Ws to C, then Set	1	1	С
	BTSTS.Z	Ws,#bit4	Bit Test Ws to Z, then Set	1	1	Z
CALL	CALL	lit23	Call Subroutine	2	2	None
	CALL	Wn	Call Indirect Subroutine	1	2	None
CLR	CLR	f	f = 0x0000	1	1	None
	CLR	WREG	WREG = 0x0000	1	1	None
	CLR	Ws	Ws = 0x0000	1	1	None
CLRWDT	CLRWDT		Clear Watchdog Timer	1	1	WDTO, Sleep
COM	COM	f	$f = \overline{f}$	1	1	N, Z
	COM	f,WREG	WREG = f	1	1	N, Z
	COM	Ws,Wd	$Wd = \overline{Ws}$	1	1	N, Z
CP	CP	f	Compare f with WREG	1	1	C, DC, N, OV, Z
	CP	Wb,#lit5	Compare Wb with lit5	1	1	C, DC, N, OV, Z
	CP	Wb,Ws	Compare Wb with Ws (Wb – Ws)	1	1	C, DC, N, OV, Z
CP0	CP0	f	Compare f with 0x0000	1	1	C, DC, N, OV, Z
	CP0	Ws	Compare Ws with 0x0000	1	1	C, DC, N, OV, Z
CPB	CPB	f	Compare f with WREG, with Borrow	1	1	C, DC, N, OV, Z
	CPB	Wb,#lit5	Compare Wb with lit5, with Borrow	1	1	C, DC, N, OV, Z
	СРВ	Wb,Ws	Compare Wb with Ws, with Borrow (Wb – Ws – C)	1	1	C, DC, N, OV, Z
CPSEQ	CPSEQ	Wb,Wn	Compare Wb with Wn, Skip if =	1	1 (2 or 3)	None
CPSGT	CPSGT	Wb,Wn	Compare Wb with Wn, Skip if >	1	1 (2 or 3)	None
CPSLT	CPSLT	Wb,Wn	Compare Wb with Wn, Skip if <	1	1 (2 or 3)	None
CPSNE	CPSNE	Wb,Wn	Compare Wb with Wn, Skip if ≠	1	1 (2 or 3)	None
DAW	DAW.B	Wn	Wn = Decimal Adjust Wn	1	1	С
DEC	DEC	f	f = f -1	1	1	C, DC, N, OV, Z
	DEC	f,WREG	WREG = f –1	1	1	C, DC, N, OV, Z
	DEC	Ws,Wd	Wd = Ws - 1	1	1	C, DC, N, OV, Z
DEC2	DEC2	f	f = f - 2	1	1	C, DC, N, OV, Z
	DEC2	f,WREG	WREG = f - 2	1	1	C, DC, N, OV, Z
	DEC2	Ws,Wd	Wd = Ws - 2	1	1	C, DC, N, OV, Z
DISI	DISI	#lit14	Disable Interrupts for k Instruction Cycles	1	1	None
DIV	DIV.SW	Wm,Wn	Signed 16/16-bit Integer Divide	1	18	N, Z, C, OV
	DIV.SD	Wm,Wn	Signed 32/16-bit Integer Divide	1	18	N, Z, C, OV
	DIV.UW	Wm,Wn	Unsigned 16/16-bit Integer Divide	1	18	N, Z, C, OV
	DIV.UD	Wm,Wn	Unsigned 32/16-bit Integer Divide	1	18	N, Z, C, OV
EXCH	EXCH	Wns,Wnd	Swap Wns with Wnd	1	1	None
FF1L	FF1L	Ws,Wnd	Find First One from Left (MSb) Side	1	1	С
FF1R	FF1R	Ws,Wnd	Find First One from Right (LSb) Side	1	1	С

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
GOTO	GOTO	Expr	Go to Address	2	2	None
	GOTO	Wn	Go to Indirect	1	2	None
INC	INC	f	f = f + 1	1	1	C, DC, N, OV, Z
	INC	f,WREG	WREG = f + 1	1	1	C, DC, N, OV, Z
	INC	Ws,Wd	Wd = Ws + 1	1	1	C, DC, N, OV, Z
INC2	INC2	f	f = f + 2	1	1	C, DC, N, OV, Z
	INC2	f,WREG	WREG = f + 2	1	1	C, DC, N, OV, Z
	INC2	Ws,Wd	Wd = Ws + 2	1	1	C, DC, N, OV, Z
IOR	IOR	f	f = f .IOR. WREG	1	1	N, Z
	IOR	f,WREG	WREG = f.IOR. WREG	1	1	N, Z
	IOR	#lit10,Wn	Wd = lit10 .IOR. Wd	1	1	N, Z
	IOR	Wb,Ws,Wd	Wd = Wb .IOR. Ws	1	1	N, Z
	IOR	Wb,#lit5,Wd	Wd = Wb .IOR. lit5	1	1	N, Z
LNK	LNK	#lit14	Link Frame Pointer	1	1	None
LSR	LSR	f	f = Logical Right Shift f	1	1	C, N, OV, Z
	LSR	f,WREG	WREG = Logical Right Shift f	1	1	C, N, OV, Z
	LSR	Ws,Wd	Wd = Logical Right Shift Ws	1	1	C, N, OV, Z
	LSR	Wb, Wns, Wnd	Wnd = Logical Right Shift Wb by Wns	1	1	N, Z
	LSR	Wb,#lit5,Wnd	Wnd = Logical Right Shift Wb by lit5	1	1	N, Z
MOV	MOV	f,Wn	Move f to Wn	1	1	None
	MOV	[Wns+Slit10],Wnd	Move [Wns+Slit10] to Wnd	1	1	None
	MOV	f	Move f to f	1	1	N, Z
	MOV	f,WREG	Move f to WREG	1	1	None
	MOV	#lit16,Wn	Move 16-bit Literal to Wn	1	1	None
	MOV.b	#lit8,Wn	Move 8-bit Literal to Wn	1	1	None
	MOV	Wn,f	Move Wn to f	1	1	None
	MOV	Wns,[Wns+Slit10]	Move Wns to [Wns+Slit10]	1	1	None
	MOV	Wso, Wdo	Move Ws to Wd	1	1	None
	MOV	WREG, f	Move WREG to f	1	1	None
	MOV.D	Wns,Wd	Move Double from W(ns):W(ns+1) to Wd	1	2	None
	MOV.D	Ws, Wnd	Move Double from Ws to W(nd+1):W(nd)	1	2	None
MUL	MUL.SS	Wb, Ws, Wnd	{Wnd+1, Wnd} = Signed(Wb) * Signed(Ws)	1	1	None
	MUL.SU	Wb, Ws, Wnd	{Wnd+1, Wnd} = Signed(Wb) * Unsigned(Ws)	1	1	None
	MUL.US	Wb, Ws, Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Signed(Ws)	1	1	None
	MUL.UU	Wb, Ws, Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Unsigned(Ws)	1	1	None
	MUL.SU	Wb,#lit5,Wnd	{Wnd+1, Wnd} = Signed(Wb) * Unsigned(lit5)	1	1	None
	MUL.UU	Wb,#lit5,Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Unsigned(lit5)	1	1	None
	MUL	f	W3:W2 = f * WREG	1	1	None
NEG	NEG	f	$f = \overline{f} + 1$	1	1	C, DC, N, OV, Z
	NEG	f,WREG	WREG = f + 1	1	1	C, DC, N, OV, Z
	NEG	Ws,Wd	$Wd = \overline{Ws} + 1$	1	1	C, DC, N, OV, Z
NOP	NOP	,	No Operation	1	1	None
-	NOPR		No Operation	1	1	None
POP	POP	f	Pop f from Top-of-Stack (TOS)	1	1	None
	POP	Wdo	Pop from Top-of-Stack (TOS) to Wdo	1	1	None
	POP.D	Wnd	Pop from Top-of-Stack (TOS) to W(nd):W(nd+1)	1	2	None
	POP.S		Pop Shadow Registers	1	1	All
PUSH	PUSH	f	Push f to Top-of-Stack (TOS)	1	1	None
	PUSH	Wso	Push Wso to Top-of-Stack (TOS)	1	1	None
	PUSH.D	Wns	Push W(ns):W(ns+1) to Top-of-Stack (TOS)	1	2	None
	PUSH.S		Push Shadow Registers	1	1	None

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
PWRSAV	PWRSAV	#lit1	Go into Sleep or Idle mode	1	1	WDTO, Sleep
RCALL	RCALL	Expr	Relative Call	1	2	None
	RCALL	Wn	Computed Call	1	2	None
REPEAT	REPEAT	#lit14	Repeat Next Instruction lit14 + 1 times	1	1	None
	REPEAT	Wn	Repeat Next Instruction (Wn) + 1 times	1	1	None
RESET	RESET		Software Device Reset	1	1	None
RETFIE	RETFIE		Return from Interrupt	1	3 (2)	None
RETLW	RETLW	#lit10,Wn	Return with Literal in Wn	1	3 (2)	None
RETURN	RETURN		Return from Subroutine	1	3 (2)	None
RLC	RLC	f	f = Rotate Left through Carry f	1	1	C, N, Z
	RLC	f,WREG	WREG = Rotate Left through Carry f	1	1	C, N, Z
	RLC	Ws,Wd	Wd = Rotate Left through Carry Ws	1	1	C, N, Z
RLNC	RLNC	f	f = Rotate Left (No Carry) f	1	1	N, Z
	RLNC	f,WREG	WREG = Rotate Left (No Carry) f	1	1	N, Z
	RLNC	Ws,Wd	Wd = Rotate Left (No Carry) Ws	1	1	N, Z
RRC	RRC	f	f = Rotate Right through Carry f	1	1	C, N, Z
1410	RRC	f,WREG	WREG = Rotate Right through Carry f	1	1	C, N, Z
	RRC	Ws, Wd	Wd = Rotate Right through Carry Ws	1	1	C, N, Z
RRNC	RRNC	f	f = Rotate Right (No Carry) f	1	1	N, Z
KKIVC	RRNC	f,WREG	WREG = Rotate Right (No Carry) f	1	1	N, Z
			G (),	1	1	-
25	RRNC	Ws, Wd	Wd = Rotate Right (No Carry) Ws		1	N, Z
SE	SE	Ws, Wnd	Wnd = Sign-Extended Ws	1	1	C, N, Z
SETM	SETM	f	f = FFFFh	1	1	None
	SETM	WREG	WREG = FFFFh	1	1	None
	SETM	Ws	Ws = FFFFh	1	1	None
SL	SL	f	f = Left Shift f	1	1	C, N, OV, Z
	SL	f,WREG	WREG = Left Shift f	1	1	C, N, OV, Z
	SL	Ws,Wd	Wd = Left Shift Ws	1	1	C, N, OV, Z
	SL	Wb, Wns, Wnd	Wnd = Left Shift Wb by Wns	1	1	N, Z
	SL	Wb,#lit5,Wnd	Wnd = Left Shift Wb by lit5	1	1	N, Z
SUB	SUB	f	f = f – WREG	1	1	C, DC, N, OV, Z
	SUB	f,WREG	WREG = f – WREG	1	1	C, DC, N, OV, Z
	SUB	#lit10,Wn	Wn = Wn – lit10	1	1	C, DC, N, OV, Z
	SUB	Wb,Ws,Wd	Wd = Wb - Ws	1	1	C, DC, N, OV, Z
	SUB	Wb,#lit5,Wd	Wd = Wb - lit5	1	1	C, DC, N, OV, Z
SUBB	SUBB	f	$f = f - WREG - (\overline{C})$	1	1	C, DC, N, OV, Z
	SUBB	f,WREG	WREG = $f - WREG - (\overline{C})$	1	1	C, DC, N, OV, Z
	SUBB	#lit10,Wn	$Wn = Wn - lit10 - (\overline{C})$	1	1	C, DC, N, OV, Z
	SUBB	Wb,Ws,Wd	$Wd = Wb - Ws - (\overline{C})$	1	1	C, DC, N, OV, Z
	SUBB	Wb,#lit5,Wd	$Wd = Wb - lit5 - (\overline{C})$	1	1	C, DC, N, OV, Z
SUBR		f	f = WREG – f	1	1	C, DC, N, OV, Z
SUBR	SUBR				1	
	SUBR	f,WREG	WREG = WREG - f	1	1	C, DC, N, OV, Z
	SUBR	Wb, Ws, Wd	Wd = Ws - Wb	1		C, DC, N, OV, Z
	SUBR	Wb,#lit5,Wd	Wd = lit5 – Wb	1	1	C, DC, N, OV, Z
SUBBR	SUBBR	f	f = WREG – f – (C)	1	1	C, DC, N, OV, Z
	SUBBR	f,WREG	WREG = WREG – f – (\overline{C})	1	1	C, DC, N, OV, Z
	SUBBR	Wb,Ws,Wd	$Wd = Ws - Wb - (\overline{C})$	1	1	C, DC, N, OV, Z
	SUBBR	Wb,#lit5,Wd	$Wd = lit5 - Wb - (\overline{C})$	1	1	C, DC, N, OV, Z
SWAP	SWAP.b	Wn	Wn = Nibble Swap Wn	1	1	None
	SWAP	Wn	Wn = Byte Swap Wn	1	1	None
TBLRDH	TBLRDH	Ws,Wd	Read Prog<23:16> to Wd<7:0>	1	2	None

Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
TBLRDL	TBLRDL	Ws,Wd	Read Prog<15:0> to Wd	1	2	None
TBLWTH	TBLWTH	Ws,Wd	Write Ws<7:0> to Prog<23:16>	1	2	None
TBLWTL	TBLWTL	Ws,Wd	Write Ws to Prog<15:0>	1	2	None
ULNK	ULNK		Unlink Frame Pointer	1	1	None
XOR	XOR	f	f = f .XOR. WREG	1	1	N, Z
	XOR	f,WREG	WREG = f .XOR. WREG	1	1	N, Z
	XOR	#lit10,Wn	Wd = lit10 .XOR. Wd	1	1	N, Z
	XOR	Wb,Ws,Wd	Wd = Wb .XOR. Ws	1	1	N, Z
	XOR	Wb,#lit5,Wd	Wd = Wb .XOR. lit5	1	1	N, Z
ZE	ZE	Ws, Wnd	Wnd = Zero-Extend Ws	1	1	C, Z, N

NOTES:

26.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of the PIC24F16KL402 family electrical characteristics. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC24F16KL402 family are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these, or any other conditions above the parameters indicated in the operation listings of this specification, is not implied.

Absolute Maximum Ratings^(†)

Ambient temperature under bias	40°C to +125°C
Storage temperature	65°C to +150°C
Voltage on VDD with respect to Vss	0.3V to +4.5V
Voltage on any combined analog and digital pin, with respect to Vss	0.3V to (VDD + 0.3V)
Voltage on any digital only pin with respect to Vss	0.3V to (VDD + 0.3V)
Voltage on MCLR/VPP pin with respect to Vss	0.3V to +9.0V
Maximum current out of Vss pin	300 mA
Maximum current into VDD pin ⁽¹⁾	250 mA
Maximum output current sunk by any I/O pin	25 mA
Maximum output current sourced by any I/O pin	25 mA
Maximum current sunk by all ports	
Maximum current sourced by all ports ⁽¹⁾	200 mA

Note 1: Maximum allowable current is a function of device maximum power dissipation (see Table 26-1).

†Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

26.1 DC Characteristics

FIGURE 26-1: PIC24F16KL402 FAMILY VOLTAGE-FREQUENCY GRAPH (INDUSTRIAL)

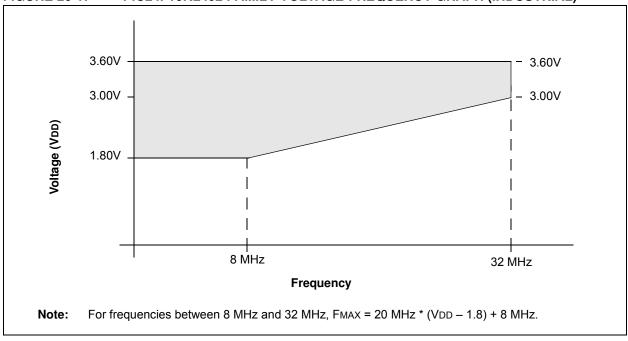


TABLE 26-1: THERMAL OPERATING CONDITIONS

Rating	Symbol	Min	Тур	Max	Unit
Operating Junction Temperature Range	TJ	-40	_	+125	°C
Operating Ambient Temperature Range	TA	-40	_	+85	°C
Power Dissipation: Internal Chip Power Dissipation: $PINT = VDD \ x \ (IDD - \Sigma \ IOH)$ I/O Pin Power Dissipation: $PI/O = \Sigma \ (\{VDD - VOH\} \ x \ IOH) + \Sigma \ (VOL \ x \ IOL)$	PD		Pint + Pi/c)	W
Maximum Allowed Power Dissipation	PDMAX	(TJ – TA)/θJA			W

TABLE 26-2: THERMAL PACKAGING CHARACTERISTICS

Characteristic	Symbol	Тур	Max	Unit	Notes
Package Thermal Resistance, 20-Pin SPDIP	θЈА	62.4	_	°C/W	1
Package Thermal Resistance, 28-Pin SPDIP	θЈА	60	_	°C/W	1
Package Thermal Resistance, 20-Pin SSOP	θЈА	108	_	°C/W	1
Package Thermal Resistance, 28-Pin SSOP	θЈА	71	_	°C/W	1
Package Thermal Resistance, 20-Pin SOIC	θЈА	75	_	°C/W	1
Package Thermal Resistance, 28-Pin SOIC	θЈА	80.2	_	°C/W	1
Package Thermal Resistance, 20-Pin QFN	θЈА	43	_	°C/W	1
Package Thermal Resistance, 28-Pin QFN	θЈА	32	_	°C/W	1
Package Thermal Resistance, 14-Pin SPDIP	θЈА	62.4	_	°C/W	1
Package Thermal Resistance, 14-Pin TSSOP	θЈА	108	_	°C/W	1

Note 1: Junction to ambient thermal resistance, Theta-JA (θ JA) numbers are achieved by package simulations.

TABLE 26-3: DC CHARACTERISTICS: TEMPERATURE AND VOLTAGE SPECIFICATIONS

DC CH	ARACTER		•	_		ns: 1.8V to 3.6V C ≤ TA ≤ +85°C for Industrial			
Para m No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions		
DC10	VDD	Supply Voltage	1.8	_	3.6	V			
DC12	VDR	RAM Data Retention Voltage ⁽²⁾	1.5	_	_	V			
DC16	VPOR	VDD Start Voltage to Ensure Internal Power-on Reset Signal	Vss	_	0.7	V			
DC17	SVDD	VDD Rise Rate to Ensure Internal Power-on Reset Signal	0.05	_	_	V/ms	0-3.3V in 0.1s 0-2.5V in 60 ms		
	VBG	Band Gap Voltage Reference	1.14	1.2	1.26	V			

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

^{2:} This is the limit to which VDD can be lowered without losing RAM data.

TABLE 26-4: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS

Standard Operating Conditions (unless otherwise stated)

Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial

Param No.	Symbol	Characteristic		Min	Тур	Max	Units	Conditions
DC18	VHLVD	HLVD Voltage on VDD	HLVDL<3:0> = 0000	_	1.85	1.94	V	
		Transition	HLVDL<3:0> = 0001	1.81	1.90	2.00	V	
		HLVDL<3:0> = 0010	1.85	1.95	2.05	V		
			HLVDL<3:0> = 0011	1.90	2.00	2.10	V	
			HLVDL<3:0> = 0100	1.95	2.05	2.15	V	
			HLVDL<3:0> = 0101	2.06	2.17	2.28	V	
			HLVDL<3:0> = 0110	2.12	2.23	2.34	V	
			HLVDL<3:0> = 0111	2.24	2.36	2.48	V	
			HLVDL<3:0> = 1000	2.31	2.43	2.55	V	
			HLVDL<3:0> = 1001	2.47	2.60	2.73	V	
			HLVDL<3:0> = 1010	2.64	2.78	2.92	V	
			HLVDL<3:0> = 1011	2.74	2.88	3.02	V	
			HLVDL<3:0> = 1100	2.85	3.00	3.15	V	
			HLVDL<3:0> = 1101	2.96	3.12	3.28	V	
			HLVDL<3:0> = 1110	3.22	3.39	3.56	V	

TABLE 26-5: BOR TRIP POINTS

Standard Operating Conditions: 1.8V to 3.6V

Operating temperature -40°C ≤ TA ≤ +85°C for Industrial

Operating temperature 40 6 2 18 2 100 6 101 industrial									
Param No.	Symbol	Characteristic	Characteristic			Max	Units	Conditions	
DC19		BOR Voltage on VDD	BORV = 00	1.85	2.0	2.15	V	Note 1	
		Transition	BORV = 01	2.90	3.0	3.38	V		
			BORV = 10	2.53	2.7	3.07	V		
			BORV = 11	1.75	1.85	2.05	V		

Note 1: LPBOR re-arms the POR circuit but does not cause a BOR.

TABLE 26-6: DC CHARACTERISTICS: OPERATING CURRENT (IDD)*

DC CHARACTERISTIC	cs			•	ditions: 1.8V to 3.6V °C ≤ TA ≤ +85°C for Industrial			
Parameter No.	Typical ⁽¹⁾	Max	Units		Conditions			
IDD Current								
DC20	0.154 0.350 mA 1.8V		0.5 MIPS,					
	0.301	0.630	mA	3.3V	Fosc = 1 MHz			
DC22	0.300	_	mA	1.8V	1 MIPS,			
	0.585	_	mA	3.3V	Fosc = 2 MHz			
DC24	7.76	12.0	mA	3.3V	16 MIPS, Fosc = 32 MHz			
DC26	1.44	_	mA	1.8V	FRC (4 MIPS),			
	2.71	_	mA	3.3V	Fosc = 8 MHz			
DC30	4.00	28.0	μA	1.8V	LPRC (15.5 KIPS),			
	9.00	55.0	μA	3.3V	Fosc = 31 kHz			

Note 1: Data in the Typical column is at 3.3V, 25°C, unless otherwise stated.

TABLE 26-7: DC CHARACTERISTICS: IDLE CURRENT (IIDLE)*

DC CHARACTERIST	ics				tions: 1.8V to 3.6V C ≤ TA ≤ +85°C for Industrial			
Parameter No.	Typical ⁽¹⁾	Max	Units		Conditions			
Idle Current (IIDLE)								
DC40	0.035	0.080	mA	1.8V	0.5 MIPS,			
	0.077	0.150	IIIA	3.3V	Fosc = 1 MHz			
DC42	0.076	_	A	1.8V	1 MIPS,			
	0.146	_	- mA	3.3V	Fosc = 2 MHz			
DC44	2.52	3.20	mA	3.3V	16 MIPS, Fosc = 32 MHz			
DC46	0.45	_	mA	1.8V	FRC (4 MIPS),			
	0.76	_	mA	3.3V	Fosc = 8 MHz			
DC50	0.87	18.0	μΑ	1.8V	LPRC (15.5 KIPS),			
	1.55	40.0	μΑ	3.3V	Fosc = 31 kHz			

Note 1: Data in the Typical column is at 3.3V, 25°C, unless otherwise stated.

^{*} IDD is measured with all peripherals disabled. All I/Os are configured as outputs and set low; PMDx bits are set to '1' and WDT, etc., are all disabled.

^{*} IIDLE is measured with all I/Os configured as outputs and set low; PMDx bits are set to '1' and WDT, etc., are all disabled.

TABLE 26-8: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

DC CHARACTERIS	STICS		Standard Operating Conditions: 1.8V to 3.6V Operating temperature -40°C ≤ TA ≤ +85°C for Industrial					
Parameter No.	Typical ⁽¹⁾	Max	Units		Con	ditions		
Power-Down Curre	ent (IPD)							
DC60	0.01	0.20	μA	-40°C				
	0.03	0.20	μA	+25°C	1.8V			
	0.06	0.87	μA	+60°C				
	0.20	1.35	μA	+85°C		Sleep Mode ⁽²⁾		
	0.01	0.54	μA	-40°C		Sieeb Mode,		
	0.03	0.54	μA	+25°C	3.3V			
	0.08	1.68	μA	+60°C	3.30			
	0.25	2.45	μA	+85°C				

Note 1: Data in the Typical column is at 3.3V, 25°C unless otherwise stated.

TABLE 26-9: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

DC CHARACTERIS	TICS			Standard Operating Conditions: 1.8V to 3.6V Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial				
Parameter No.	Typical ⁽¹⁾	Max	Units Conditions					
Module Differential	Current (∆I	PD)						
DC71	0.21	0.65	μΑ	1.8V	Watchdog Timer Current			
	0.45	0.95	μΑ	3.3V	ΔWDT ^(2,3)			
DC72	0.69	1.50	μΑ	1.8V	32 kHz Crystal with Timer1:			
	1.00	1.50	μΑ	3.3V	\triangle SOSC (SOSCSEL = 0) ⁽²⁾			
DC75	5.24	_	μΑ	1.8V	ΔHLVD ^(2,3)			
	5.16	11.00	μΑ	3.3V	ΔΠLVDC→-/			
DC76	4.15	9.00	μA	3.3V	ΔBOR ^(2,3)			
DC78	0.03	0.20	μΑ	1.8V	ΔLPBOR ⁽²⁾			
	0.03	0.20	μΑ	3.3V	ALFBOR ⁽⁻⁾			

Note 1: Data in the Typical column is at 3.3V, 25°C unless otherwise stated.

^{2:} Base IPD is measured with all peripherals and clocks disabled. All I/Os are configured as outputs and set low; PMDx bits are set to '1' and WDT, etc., are all disabled

^{2:} The Δ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current.

^{3:} This current applies to Sleep only.

TABLE 26-10: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS

DC CHA	ARACTI		Standard Op Operating te				3.6V 5°C for Industrial
Param No.	Sym	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions
	VIL	Input Low Voltage ⁽⁴⁾	_	_	_	_	
DI10		I/O Pins	Vss	_	0.2 Vdd	V	
DI15		MCLR	Vss	_	0.2 Vdd	V	
DI16		OSCI (XT mode)	Vss		0.2 VDD	V	
DI17		OSCI (HS mode)	Vss	_	0.2 Vdd	V	
DI18		I/O Pins with I ² C™ Buffer	Vss	_	0.3 VDD	V	SMBus disabled
DI19		I/O Pins with SMBus Buffer	Vss	_	0.8	V	SMBus enabled
	ViH	Input High Voltage ^(4,5)	_	_	_	_	
DI20		I/O Pins: with Analog Functions Digital Only	0.8 Vdd 0.8 Vdd	_ _	VDD VDD	V V	
DI25		MCLR	0.8 VDD	_	VDD	V	
DI26		OSCI (XT mode)	0.7 VDD	_	VDD	V	
DI27		OSCI (HS mode)	0.7 VDD		VDD	V	
DI28		I/O Pins with I ² C Buffer: with Analog Functions Digital Only	0.7 VDD 0.7 VDD	_ _	Vdd Vdd	V V	
DI29		I/O Pins with SMBus	2.1	_	Vdd	V	$2.5V \le VPIN \le VDD$
DI30	ICNPU	CNx Pull-up Current	50	250	500	μΑ	VDD = 3.3V, VPIN = VSS
DI31	IPU	Maximum Load Current	_	_	30	μΑ	VDD = 2.0V
		for Digital High Detection w/Internal Pull-up	_	_	1000	μΑ	VDD = 3.3V
	lı∟	Input Leakage Current ^(2,3)					
DI50		I/O Ports	_	0.050	±0.100	μΑ	Vss ≤ VPIN ≤ VDD, Pin at high-impedance
DI51		VREF+, VREF-, AN0, AN1	_	0.300	±0.500	μΑ	Vss ≤ VPIN ≤ VDD, Pin at high-impedance

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

- 3: Negative current is defined as current sourced by the pin.
- 4: Refer to Table 1-4 and Table 1-5 for I/O pin buffer types.
- **5:** VIH requirements are met when the internal pull-ups are enabled.

^{2:} The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

TABLE 26-11: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS

DC CHA	RACTE	RISTICS	Standard Operating Conditions: 1.8V to 3.6V Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for Industrial							
Param No.	Sym	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Cond	ditions		
	Vol	Output Low Voltage	_	_						
DO10		All I/O Pins	_	_	0.4	V	IOL = 4.0 mA	VDD = 3.6V		
			_	_	0.4	V	IOL = 3.5 mA	VDD = 2.0V		
DO16		OSC2/CLKO	_	_	0.4	V	IOL = 1.2 mA	VDD = 3.6V		
			_	_	0.4	V	IOL = 0.4 mA	VDD = 2.0V		
	Vон	Output High Voltage								
DO20		All I/O Pins	3	_	_	V	Iон = -3.0 mA	VDD = 3.6V		
			1.6	_	_	V	Iон = -1.0 mA	VDD = 2.0V		
DO26		OSC2/CLKO	3	_	_	V	Iон = -1.0 mA	VDD = 3.6V		
			1.6	_	_	V	Iон = -0.5 mA	VDD = 2.0V		

Note 1: Data in "Typ" column is at 25°C unless otherwise stated.

TABLE 26-12: DC CHARACTERISTICS: PROGRAM MEMORY

DC CHARACTERISTICS			Standard Operating Conditions: 1.8V to 3.6V Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial						
Param No.	Sym	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions		
		Program Flash Memory							
D130	ЕР	Cell Endurance	10,000 ⁽²⁾	_	_	E/W			
D131	VPR	VDD for Read	VMIN	_	3.6	V	VміN = Minimum operating voltage		
D133A	Tıw	Self-Timed Write Cycle Time	_	2	_	ms			
D134	TRETD	Characteristic Retention	40	_	_	Year	Provided no other specifications are violated		
D135	IDDP	Supply Current During Programming	_	10	_	mA			

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

2: Self-write and block erase.

TABLE 26-13: DC CHARACTERISTICS: DATA EEPROM MEMORY

DC CHA	DC CHARACTERISTICS			Standard Operating Conditions: 1.8V to 3.6V Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for Industrial						
Param No.	Sym	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions			
		Data EEPROM Memory								
D140	EPD	Cell Endurance	100,000	_	_	E/W				
D141	VPRD	VDD for Read	VMIN	_	3.6	V	VMIN = Minimum operating voltage			
D143A	TIWD	Self-Timed Write Cycle Time	_	4	_	ms				
D143B	TREF	Number of Total Write/Erase Cycles Before Refresh	_	10M	_	E/W				
D144	TRETDD	Characteristic Retention	40	_	_	Year	Provided no other specifications are violated			
D145	IDDPD	Supply Current during Programming	_	7	_	mA				

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

TABLE 26-14: DC SPECIFICATIONS: COMPARATOR

Operatir	Operating Conditions: 2.0V < VDD < 3.6V, -40°C < TA < +85°C (unless otherwise stated)										
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Comments				
D300	VIOFF	Input Offset Voltage	-	20	40	mV					
D301	VICM	Input Common Mode Voltage	0	_	VDD	V					
D302	CMRR	Common Mode Rejection Ratio	55			dB					

TABLE 26-15: DC SPECIFICATIONS: COMPARATOR VOLTAGE REFERENCE S

Operating	Operating Conditions: 2.0V < VDD < 3.6V, -40°C < TA < +85°C (unless otherwise stated)										
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Comments				
VRD310	CVRES	Resolution		_	VDD/32	LSb					
VRD311	CVRAA	Absolute Accuracy	_	_	AVDD - 1.5	LSb					
VRD312	CVRur	Unit Resistor Value (R)	_	2k		Ω					

26.2 AC Characteristics and Timing Parameters

The information contained in this section defines the PIC24F16KL402 Family AC characteristics and timing parameters.

TABLE 26-16: TEMPERATURE AND VOLTAGE SPECIFICATIONS - AC

	Standard Operating Conditions: 1.8V to 3.6V
AC CHARACTERISTICS	Operating temperature-40 °C ≤ TA ≤ +85 °C for Industrial
	Operating voltage VDD range as described in Section 26.1 "DC Characteristics".

FIGURE 26-2: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

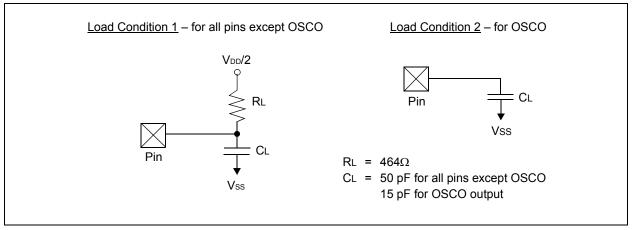


TABLE 26-17: CAPACITIVE LOADING REQUIREMENTS ON OUTPUT PINS

Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions
DO50	Cosc2	OSCO/CLKO Pin	_	_	15	pF	In XT and HS modes when external clock is used to drive OSCI
DO56	Сю	All I/O Pins and OSCO	_	_	50	pF	EC mode
DO58	Св	SCLx, SDAx	_		400	pF	In I ² C™ mode

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

FIGURE 26-3: EXTERNAL CLOCK TIMING

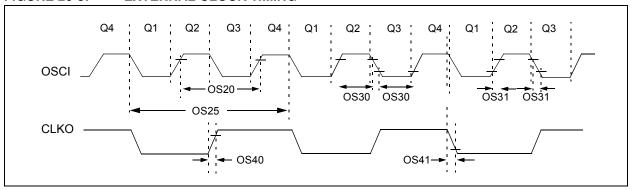


TABLE 26-18: EXTERNAL CLOCK TIMING REQUIREMENTS

AC CH	ARACT	ERISTICS	Standard Operating Conditions: 1.8V to 3.6V Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial						
Param No.	Sym	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions		
OS10	Fosc	External CLKI Frequency (External clocks allowed only in EC mode)	DC 4	_	32 8	MHz MHz	EC ECPLL		
		Oscillator Frequency	0.2 4 4 31		4 25 8 33	MHz MHz MHz kHz	XT HS XTPLL SOSC		
OS20	Tosc	Tosc = 1/Fosc	_		_	_	See Parameter #OS10 for Fosc value		
OS25	TCY	Instruction Cycle Time ⁽²⁾	62.5	_	DC	ns			
OS30	TosL, TosH	External Clock in (OSCI) High or Low Time	0.45 x Tosc		1	ns	EC		
OS31	TosR, TosF	External Clock in (OSCI) Rise or Fall Time	_		20	ns	EC		
OS40	TckR	CLKO Rise Time ⁽³⁾	_	6	10	ns			
OS41	TckF	CLKO Fall Time ⁽³⁾	_	6	10	ns			

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

- 2: Instruction cycle period (TcY) equals two times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "Min." values with an external clock applied to the OSCI/CLKI pin. When an external clock input is used, the "Max." cycle time limit is "DC" (no clock) for all devices.
- 3: Measurements are taken in EC mode. The CLKO signal is measured on the OSCO pin. CLKO is low for the Q1-Q2 period (1/2 TcY) and high for the Q3-Q4 period (1/2 TcY).

TABLE 26-19: PLL CLOCK TIMING SPECIFICATIONS

			Standard Operating Conditions: 1.8V to 3.6V Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial						
Param No.	Sym	Characteristic ⁽¹⁾	Min	Min Typ ⁽²⁾ Max Units			Conditions		
OS50	FPLLI	PLL Input Frequency Range	4	_	8	MHz	ECPLL, HSPLL modes, -40°C ≤ TA ≤ +85°C		
OS51	Fsys	PLL Output Frequency Range	16	_	32	MHz	-40°C ≤ TA ≤ +85°C		
OS52	TLOCK	PLL Start-up Time (Lock Time)	_	1	2	ms			
OS53	Dclk	CLKO Stability (Jitter)	-2	1	2	%	Measured over 100 ms period		

Note 1: These parameters are characterized but not tested in manufacturing.

TABLE 26-20: INTERNAL RC OSCILLATOR ACCURACY

.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	TABLE 20 201 HATEHIALE HO OCCILEATOR ACCOUNCE										
AC CHA	RACTERISTICS	Standard Operating Conditions: 1.8V to 3.6V Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial									
Param No.	Characteristic	Min	Тур	Max	Units	Conditions					
F20	FRC @ 8 MHz ⁽¹⁾	-2	_	+2	%	+25°C	$3.0V \le V \text{DD} \le 3.6V$				
		-5		+5	%	$-40^{\circ}C \le TA \le +85^{\circ}C$ $1.8V \le VDD \le 3.6V$					
F21	LPRC @ 31 kHz ⁽²⁾	-15	_	+15	%	-40°C ≤ TA ≤ +85°C	$1.8V \le V \text{DD} \le 3.6V$				

Note 1: The frequency is calibrated at 25°C and 3.3V. The OSCTUN bits can be used to compensate for temperature drift.

TABLE 26-21: INTERNAL RC OSCILLATOR SPECIFICATIONS

AC CHA	ARACTE		Standard Operating Conditions: 1.8V to 3.6V Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$ for Extended						
Param No.	Sym	Characteristic	Min	Conditions					
	TFRC	FRC Start-up Time	_	5	_	μS			
	TLPRC	LPRC Start-up Time	_	70	_	μS			

^{2:} Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

^{2:} The change of LPRC frequency as VDD changes.

FIGURE 26-4: CLKO AND I/O TIMING CHARACTERISTICS

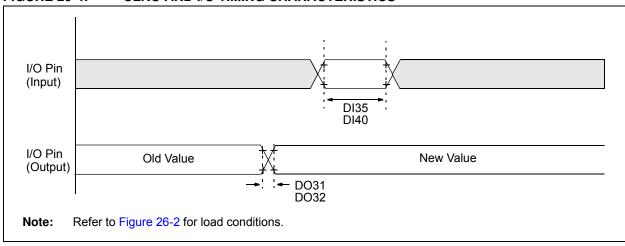


TABLE 26-22: CLKO AND I/O TIMING REQUIREMENTS

IADEL	20-22.	CEICO AIAD I/O TIMIIAO	TILGOIIL	ADEL 20-22. GERO AND I/O HIMING TE GOTTEMENTS											
AC CHA	ARACTI	ERISTICS	Standard Operating Conditions: 1.8V to 3.6V Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial												
Param No.	Sym	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions								
DO31	TioR	Port Output Rise Time	_	10	25	ns									
DO32	TioF	Port Output Fall Time	_	10	25	ns									
DI35	TINP	INTx pin High or Low Time (output)	20	_	_	ns									
DI40	TRBP	CNx High or Low Time (input)	2	_	_	Tcy									

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

TABLE 26-23: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER, AND BROWN-OUT RESET TIMING REQUIREMENTS

1		AND BIIOWIN-OUT HESE		<u> </u>	O L.W. L.		
			Standard Operating Cond Operating temperature				1.8V to 3.6V 4 ≤ +85°C for Industrial
Param No.	Symbol	Characteristic	Min.	Typ ⁽¹⁾	Max.	Units	Conditions
SY10	TmcL	MCLR Pulse Width (low)	2	_		μS	
SY11	TPWRT	Power-up Timer Period	50	64	90	ms	
SY12	TPOR	Power-on Reset Delay	1	5	10	μS	
SY13	Tioz	I/O High-Impedance from MCLR Low or Watchdog Timer Reset	_	_	100	ns	
SY20	Twdt	Watchdog Timer Time-out	0.85	1.0	1.15	ms	1.32 prescaler
		Period	3.4	4.0	4.6	ms	1:128 prescaler
SY25	TBOR	Brown-out Reset Pulse Width	1	_	_	μS	
SY45	Trst	Internal State Reset Time	_	5	_	μS	
SY55	TLOCK	PLL Start-up Time	_	100	_	μS	
SY65	Tost	Oscillator Start-up Time	_	1024	_	Tosc	
SY71	ТРМ	Program Memory Wake-up Time	_	1		μS	Sleep wake-up with PMSLP = 0

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

TABLE 26-24: COMPARATOR TIMINGS

Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Comments
300	TRESP	Response Time*(1)	_	150	400	ns	
301	Тмс2оv	Comparator Mode Change to Output Valid*	_	_	10	μS	

^{*} Parameters are characterized but not tested.

Note 1: Response time is measured with one comparator input at (VDD – 1.5)/2, while the other input transitions from Vss to VDD.

TABLE 26-25: COMPARATOR VOLTAGE REFERENCE SETTLING TIME SPECIFICATIONS

Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Comments
VR310	TSET	Settling Time ⁽¹⁾			10	μS	

Note 1: Settling time is measured while CVRSS = 1 and CVR<3:0> bits transition from '0000' to '1111'.

FIGURE 26-5: CAPTURE/COMPARE/PWM TIMINGS (ECCP1, ECCP2 MODULES)

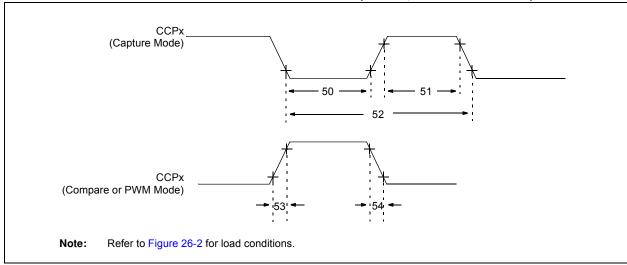


TABLE 26-26: CAPTURE/COMPARE/PWM REQUIREMENTS (ECCP1, ECCP2 MODULES)

Param No.	Symbol	С	haracteristic	Min	Max	Units	Conditions
50	TccL	CCPx Input Low	No prescaler	0.5 Tcy + 20	_	ns	
	Time	With prescaler	20	_	ns		
51	TccH	CH CCPx Input High Time	No prescaler	0.5 Tcy + 20	_	ns	
			With prescaler	20	_	ns	
52	TCCP	CCPx Input Perio	od	greater of: 40, or 2 Tcy + 40 N	_	ns	N = prescale value (1, 4 or 16)
53	TccR	CCPx Output Fall Time		_	25	ns	
54	TccF	CCPx Output Fa	CCPx Output Fall Time		25	ns	

FIGURE 26-6: EXAMPLE SPI MASTER MODE TIMING (CKE = 0)

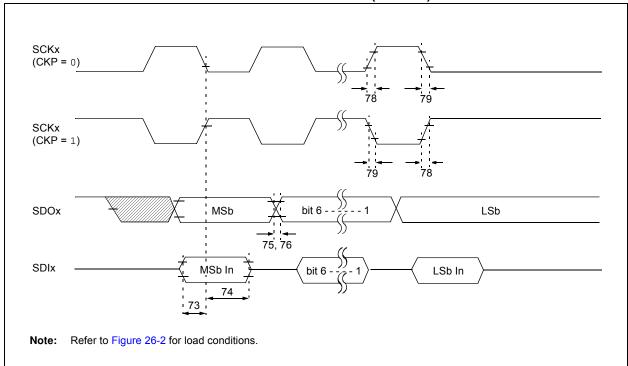


TABLE 26-27: EXAMPLE SPI MODE REQUIREMENTS (MASTER MODE, CKE = 0)

Param No.	Symbol	Characteristic	Min	Max	Units	Conditions
73	TDIV2SCH, TDIV2SCL	Setup Time of SDIx Data Input to SCKx Edge	20	_	ns	
74	TscH2DIL, TscL2DIL	Hold Time of SDIx Data Input to SCKx Edge	40	_	ns	
75	TDOR	SDOx Data Output Rise Time	_	25	ns	
76	TDOF	SDOx Data Output Fall Time	_	25	ns	
78	TscR	SCKx Output Rise Time (Master mode)	_	25	ns	
79	TscF	SCKx Output Fall Time (Master mode)	_	25	ns	
	Fsck	SCKx Frequency	_	10	MHz	

FIGURE 26-7: EXAMPLE SPI MASTER MODE TIMING (CKE = 1)

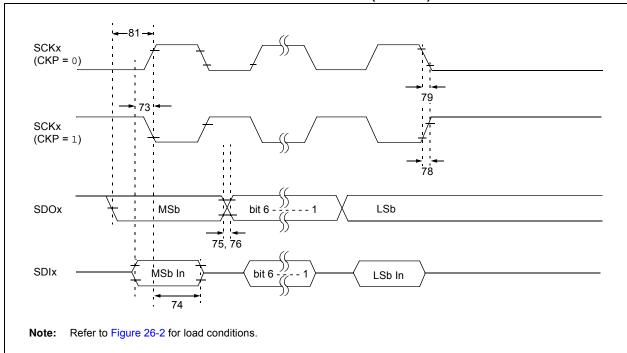


TABLE 26-28: EXAMPLE SPI MODE REQUIREMENTS (MASTER MODE, CKE = 1)

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
73	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge	35	_	ns	
74	TscH2DIL, TscL2DIL	Hold Time of SDIx Data Input to SCKx Edge	40	_	ns	
75	TDOR	SDOx Data Output Rise Time	_	25	ns	
76	TDOF	SDOx Data Output Fall Time	_	25	ns	
78	TscR	SCKx Output Rise Time (Master mode)	_	25	ns	
79	TscF	SCKx Output Fall Time (Master mode)	_	25	ns	
81	TDOV2scH, TDOV2scL	SDOx Data Output Setup to SCKx Edge	Tcy	_	ns	
	Fsck	SCKx Frequency	_	10	MHz	

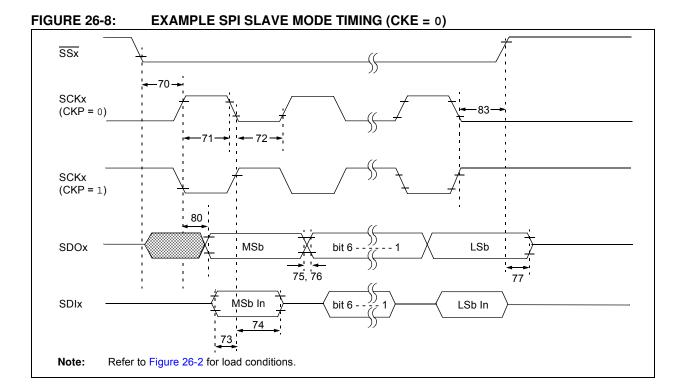


TABLE 26-29: EXAMPLE SPI MODE REQUIREMENTS (SLAVE MODE TIMING, CKE = 0)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	SSx ↓ to SCKx ↓ or SCKx ↑ Input		3 Tcy	1	ns	
70A	TssL2WB	SSx to write to SSPxBUF		3 Tcy		ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30		ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	Slave mode) Single Byte		l	ns	(Note 1)
73	TDIV2scH, TDIV2scL	Setup Time of SDIx Data Input to SCKx Edge		20	-	ns	
73A	Тв2в	Last Clock Edge of Byte 1 to the First Clock Edge of Byte 2		1.5 Tcy + 40	_	ns	(Note 2)
74	TscH2DIL, TscL2DIL	Hold Time of SDIx Data Input to SCKx Edge		40	_	ns	
75	TDOR	SDOx Data Output Rise Time		_	25	ns	
76	TDOF	SDOx Data Output Fall Time		_	25	ns	
77	TssH2DoZ	SSx ↑ to SDOx Output High-Impedance	;	10	50	ns	
80	TscH2DoV, TscL2DoV	SDOx Data Output Valid after SCKx Edge		_	50	ns	
83	TscH2ssH, TscL2ssH	x ↑ after SCKx Edge		1.5 Tcy + 40	_	ns	
	FSCK	SCKx Frequency		_	10	MHz	

Note 1: Requires the use of Parameter #73A.

2: Only if Parameter #71A and #72A are used.

FIGURE 26-9: EXAMPLE SPI SLAVE MODE TIMING (CKE = 1) SSx SCKx (CKP = 0)73 SCKx (CKP = 1) MSb bit 6 LSb SDOx 75, 76 SDIx LSb In bit 6 Note: Refer to Figure 26-2 for load conditions.

TABLE 26-30: EXAMPLE SPI SLAVE MODE REQUIREMENTS (CKE = 1)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
70	TssL2scH, TssL2scL	SSx ↓ to SCKx ↓ or SCKx ↑ Input		3 Tcy	1	ns	
70A	TssL2WB	SSx to Write to SSPxBUF		3 Tcy	_	ns	
71	TscH	SCKx Input High Time	Continuous	1.25 Tcy + 30	_	ns	
71A		(Slave mode)	Single Byte	40	_	ns	(Note 1)
72	TscL	SCKx Input Low Time	Continuous	1.25 Tcy + 30	_	ns	
72A		(Slave mode)	ave mode) Single Byte		_	ns	(Note 1)
73A	Тв2в	Last Clock Edge of Byte 1 to the First	1.5 Tcy + 40	_	ns	(Note 2)	
74	TscH2DIL, TscL2DIL	Hold Time of SDIx Data Input to SCI	Kx Edge	40	_	ns	
75	TDOR	SDOx Data Output Rise Time		_	25	ns	
76	TDOF	SDOx Data Output Fall Time		_	25	ns	
77	TssH2DoZ	SSx ↑ to SDOx Output High-Impeda	ince	10	50	ns	
80	TscH2DoV, TscL2DoV	SDOx Data Output Valid After SCKx Edge		_	50	ns	
82	TssL2DoV	SDOx Data Output Valid After SSx ↓ Edge		_	50	ns	
83	TscH2ssH, TscL2ssH	SSx ↑ After SCKx Edge		1.5 Tcy + 40	_	ns	
	FSCK	SCKx Frequency		_	10	MHz	

Note 1: Requires the use of Parameter #73A.

2: Only if Parameter #71A and #72A are used.

FIGURE 26-10: I²C™ BUS START/STOP BITS TIMING

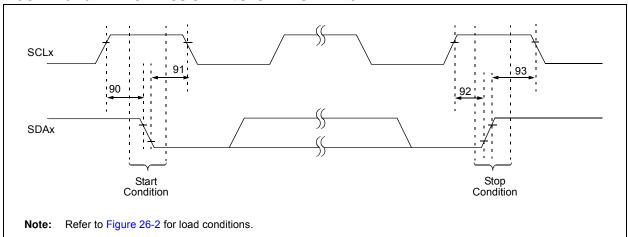


TABLE 26-31: I²C™ BUS START/STOP BITS REQUIREMENTS (SLAVE MODE)

Param. No.	Symbol	Characte	ristic	Min	Max	Units	Conditions
90	Tsu:sta	Start Condition	100 kHz mode	4700	_	ns	Only relevant for Repeated
		Setup Time	400 kHz mode	600	_		Start condition
91	THD:STA	Start Condition	100 kHz mode	4000	_	ns	After this period, the first
		Hold Time	400 kHz mode	600	_		clock pulse is generated
92	Tsu:sto	Stop Condition	100 kHz mode	4700	_	ns	
		Setup Time	400 kHz mode	600	_		
93	THD:STO	Stop Condition	100 kHz mode	4000	_	ns	
		Hold Time	400 kHz mode	600	_		

FIGURE 26-11: I²C™ BUS DATA TIMING

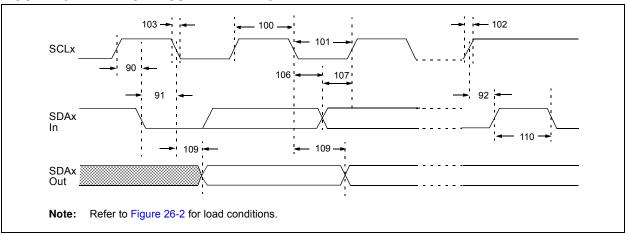


TABLE 26-32: I²C™ BUS DATA REQUIREMENTS (SLAVE MODE)

Param. No.	Symbol	Characteris	tic	Min	Max	Units	Conditions
100	THIGH	Clock High Time	100 kHz mode	4.0	_	μS	Must operate at a minium of 1.5 MHz
			400 kHz mode	0.6	_	μS	Must operate at a minium of 10 MHz
			MSSP module	1.5 TcY	_		
101	TLOW	Clock Low Time	100 kHz mode	4.7	_	μS	Must operate at a minium of 1.5 MHz
			400 kHz mode	1.3	_	μS	Must operate at a minium of 10 MHz
			MSSP module	1.5 Tcy	_		
102	TR	SDAx and SCLx Rise Time	100 kHz mode	_	1000	ns	
			400 kHz mode	20 + 0.1 CB	300	ns	CB is specified to be from 10 to 400 pF
103	TF	SDAx and SCLx Fall Time	100 kHz mode	_	300	ns	
			400 kHz mode	20 + 0.1 CB	300	ns	CB is specified to be from 10 to 400 pF
90	Tsu:sta	Start Condition Setup Time	100 kHz mode	4.7	_	μS	Only relevant for Repeated
			400 kHz mode	0.6	_	μS	Start condition
91	THD:STA	Start Condition Hold Time	100 kHz mode	4.0	_	μS	After this period, the first clock
			400 kHz mode	0.6	_	μS	pulse is generated
106	THD:DAT	Data Input Hold Time	100 kHz mode	0	_	ns	
			400 kHz mode	0	0.9	μS	
107	TSU:DAT	Data Input Setup Time	100 kHz mode	250	_	ns	(Note 2)
			400 kHz mode	100	_	ns	
92	Tsu:sto	Stop Condition Setup Time	100 kHz mode	4.7	_	μS	
			400 kHz mode	0.6	_	μS	
109	TAA	Output Valid from Clock	100 kHz mode	_	3500	ns	(Note 1)
			400 kHz mode	_	_	ns	
110	TBUF	Bus Free Time	100 kHz mode	4.7	_	μS	Time the bus must be free before
			400 kHz mode	1.3	_	μS	a new transmission can start
D102	Св	Bus Capacitive Loading		_	400	pF	

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCLx to avoid unintended generation of Start or Stop conditions.

^{2:} A Fast mode I²C™ bus device can be used in a Standard mode I²C bus system, but the requirement, Tsu:DAT ≥ 250 ns, must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line, TR max. + Tsu:DAT = 1000 + 250 = 1250 ns (according to the Standard mode I²C bus specification), before the SCLx line is released.

MSSP I²C™ BUS START/STOP BITS TIMING WAVEFORMS FIGURE 26-12:

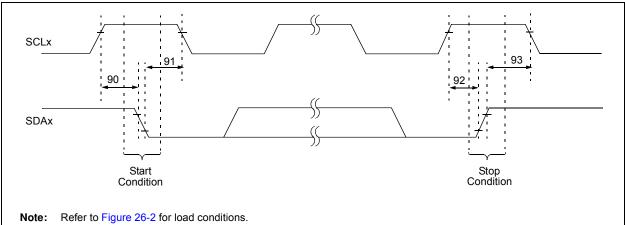


TABLE 26-33: I²C™ BUS START/STOP BITS REQUIREMENTS (MASTER MODE)

				•			,
Param. No.	Symbol	Characte	ristic	Min	Max	Units	Conditions
90	Tsu:sta	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	Only relevant for
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		Repeated Start condition
91	THD:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	After this period, the
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_		first clock pulse is generated
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	ns	
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		
93	THD:STO	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)		ns	
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_		

FIGURE 26-13: MSSP I²C™ BUS DATA TIMING

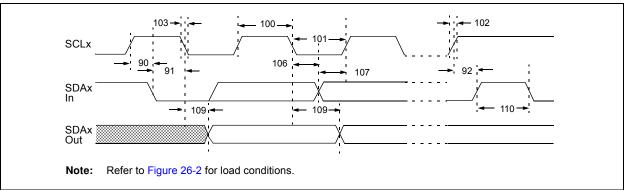


TABLE 26-34: I²C™ BUS DATA REQUIREMENTS (MASTER MODE)

Param. No.	Symbol	Charac	teristic	Min	Max	Units	Conditions	
100	THIGH	Clock High Time	100 kHz mode	2(Tosc)(BRG + 1)	_	_		
			400 kHz mode	2(Tosc)(BRG + 1)	_	_		
101	TLOW	Clock Low Time	100 kHz mode	2(Tosc)(BRG + 1)	_			
			400 kHz mode	2(Tosc)(BRG + 1)	_	_		
102	TR	SDAx and SCLx	100 kHz mode	_	1000	ns	CB is specified to be from	
		Rise Time	400 kHz mode	20 + 0.1 CB	300	ns	10 to 400 pF	
103	TF	SDAx and SCLx	100 kHz mode	_	300	ns	CB is specified to be from	
		Fall Time	400 kHz mode	20 + 0.1 CB	300	ns	10 to 400 pF	
90	Tsu:sta	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_		Only relevant for Repeated	
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_		Start condition	
91	THD:STA	Start Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	_	After this period, the first	
		Hold Time	400 kHz mode	2(Tosc)(BRG + 1)	_		clock pulse is generated	
106	THD:DAT	Data Input	100 kHz mode	0	_	ns		
		Hold Time	400 kHz mode	0	0.9	μS		
107	TSU:DAT	Data Input	100 kHz mode	250	_	ns	(Note 1)	
		Setup Time	400 kHz mode	100	_	ns		
92	Tsu:sto	Stop Condition	100 kHz mode	2(Tosc)(BRG + 1)	_	_		
		Setup Time	400 kHz mode	2(Tosc)(BRG + 1)	_	_		
109	TAA	Output Valid	100 kHz mode	_	3500	ns		
		from Clock	400 kHz mode	_	1000	ns		
110	TBUF	Bus Free Time	100 kHz mode	4.7	_	μS	Time the bus must be free	
			400 kHz mode	1.3	_	μS	before a new transmission can start	
D102	Св	Bus Capacitive L	oading		400	pF		

Note 1: A Fast mode I²C bus device can be used in a Standard mode I²C bus system, but Parameter ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLx signal. If such a device does stretch the LOW period of the SCLx signal, it must output the next data bit to the SDAx line, Parameter + Parameter = 1000 + 250 = 1250 ns (for 100 kHz mode), before the SCLx line is released.

TABLE 26-35: A/D MODULE SPECIFICATIONS

	ARACTERIS	STICS	Standard O stated)		-		3.6V (unless otherwise 85°C for Industrial			
Param No.	Symbol	Characteristic	Min.	Тур	Max.	Units	Conditions			
			Device S	upply						
AD01	AVDD	Module VDD Supply	Greater of VDD – 0.3 or 1.8	_	Lesser of VDD + 0.3 or 3.6	V				
AD02	AVss	Module Vss Supply	Vss - 0.3	_	Vss + 0.3	V				
			Reference	Inputs						
AD05	VREFH	Reference Voltage High	AVss + 1.7	_	AVDD	V				
AD06	VREFL	Reference Voltage Low	AVss	_	AVDD - 1.7	V				
AD07	VREF	Absolute Reference Voltage	AVss – 0.3	_	AVDD + 0.3	>				
			Analog	Input						
AD10	VINH-VINL	Full-Scale Input Span	VREFL	_	VREFH	٧	(Note 1)			
AD11	VIN	Absolute Input Voltage	AVss - 0.3	_	AVDD + 0.3	٧				
AD12	VINL	Absolute VINL Input Voltage	AVss - 0.3		AVDD/2	V				
AD17	RIN	Recommended Impedance of Analog Voltage Source		_	2.5K	Ω	10-bit			
			A/D Acc	uracy						
AD20b	NR	Resolution	_	10	_	bits				
AD21b	INL	Integral Nonlinearity	_	±1	±2	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3V			
AD22b	DNL	Differential Nonlinearity		±1	±1.5	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3V			
AD23b	GERR	Gain Error	_	±1	±3	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3V			
AD24b	EOFF	Offset Error	_	±1	±2	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3V			
AD25b		Monotonicity	_	_	_	_	(Note 2)			

Note 1: Measurements are taken with external VREF+ and VREF- used as the A/D voltage reference.

^{2:} The A/D conversion result never decreases with an increase in the input voltage.

TABLE 26-36: A/D CONVERSION TIMING REQUIREMENTS⁽¹⁾

AC CHA	AC CHARACTERISTICS			s other	erating Co rwise state perature	ed)	s: 1.8V to 3.6V ≤ Ta ≤ +85°C for Industrial			
Param No.	Symbol	Characteristic	Min. Typ Max. Units Conditions							
		Clock P	aramete	ers						
AD50	TAD	A/D Clock Period	75	_	_	ns	Tcy = 75 ns, AD1CON3 in default state			
AD51	TRC	A/D Internal RC Oscillator Period	_	250	_	ns				
		Conver	sion Ra	te						
AD55	TCONV	Conversion Time	_	12	_	TAD				
AD56	FCNV	Throughput Rate	_	_	500	ksps	$AVDD \ge 2.7V$			
AD57	TSAMP	Sample Time	_	1	_	TAD				
AD58	TACQ	Acquisition Time	750	_	_	ns	(Note 2)			
AD59	Tswc	Switching Time from Convert to Sample	_	_	(Note 3)					
AD60	TDIS	Discharge Time	0.5	_	_	TAD				
		Clock P	aramete	ers						
AD61	TPSS	Sample Start Delay from setting Sample bit (SAMP)	2	_	3	TAD				

Note 1: Because the sample caps will eventually lose charge, clock rates below 10 kHz can affect linearity performance, especially at elevated temperatures.

^{2:} The time for the holding capacitor to acquire the "New" input voltage when the voltage changes full scale after the conversion (VDD to Vss or Vss to VDD).

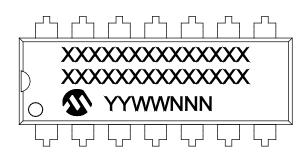
^{3:} On the following cycle of the device clock.

NOTES:

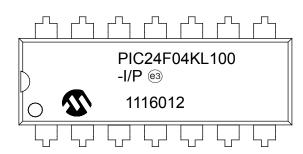
27.0 PACKAGING INFORMATION

27.1 **Package Marking Information**

14-Lead PDIP (300 mil)

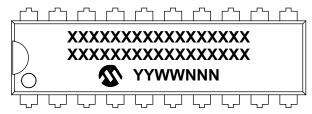


Example



20-Lead PDIP (300 mil)

Example

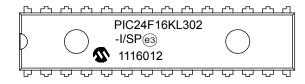




28-Lead SPDIP (.300")

Example





Legend: XX...X Product-specific information

Year code (last digit of calendar year) Υ ΥY Year code (last 2 digits of calendar year) WW Week code (week of January 1 is week '01')

NNN Alphanumeric traceability code

Pb-free JEDEC designator for Matte Tin (Sn) (e3)

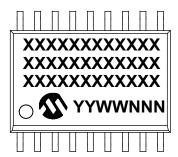
This package is Pb-free. The Pb-free JEDEC designator (e3)

can be found on the outer packaging for this package.

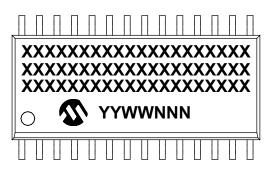
Note:

In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

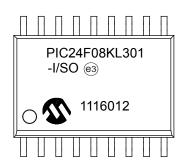
20-Lead SOIC (7.50 mm)



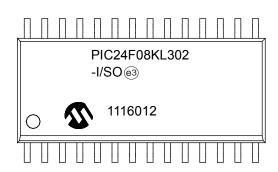
28-Lead SOIC (7.50 mm)



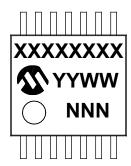
Example



Example



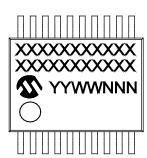
14-Lead TSSOP (4.4 mm)



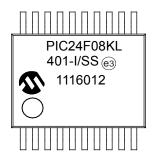


Example

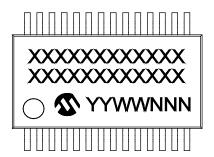
20-Lead SSOP (5.30 mm)



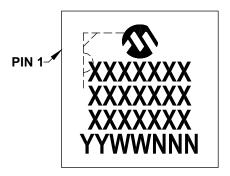
Example



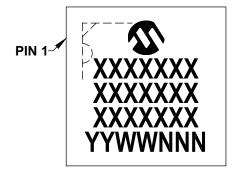
28-Lead SSOP (5.30 mm)



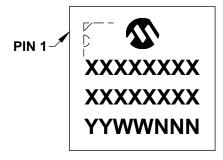
20-Lead QFN (5x5x0.9 mm)



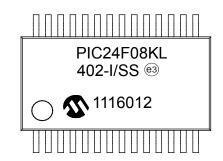
28-Lead QFN (5x5x0.9 mm)



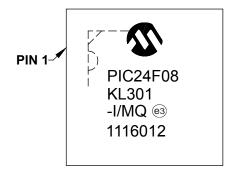
28-Lead QFN (6x6 mm)



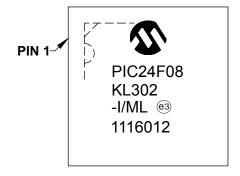
Example



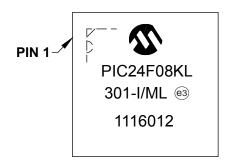
Example



Example



Example

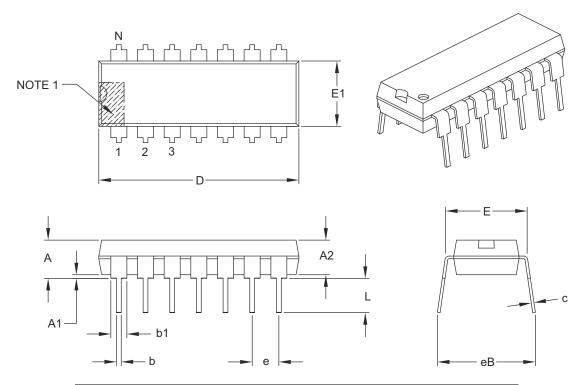


27.2 Package Details

The following sections give the technical details of the packages.

14-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units			INCHES			
Dimension	Dimension Limits			MAX			
Number of Pins	N		14				
Pitch	е		.100 BSC				
Top to Seating Plane	Α	ı	_	.210			
Molded Package Thickness	A2	.115	.130	.195			
Base to Seating Plane	A1	.015	_	_			
Shoulder to Shoulder Width	Е	.290	.310	.325			
Molded Package Width	E1	.240	.250	.280			
Overall Length	D	.735	.750	.775			
Tip to Seating Plane	L	.115	.130	.150			
Lead Thickness	С	.008	.010	.015			
Upper Lead Width	b1	.045	.060	.070			
Lower Lead Width	b	.014	.018	.022			
Overall Row Spacing §	eB	_	_	.430			

Notes:

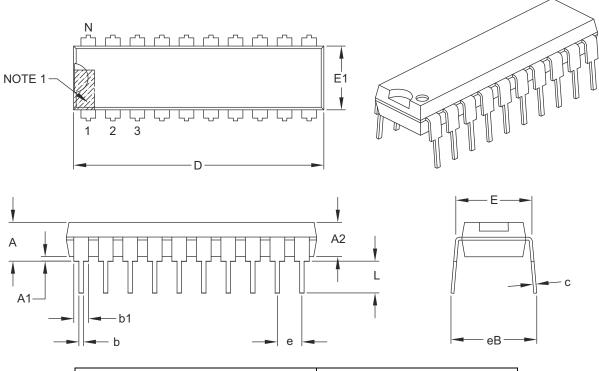
- 1. Pin 1 visual index feature may vary, but must be located with the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-005B

20-Lead Plastic Dual In-Line (P) - 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		INCHES	
Dime	nsion Limits	MIN	NOM	MAX
Number of Pins	N		20	
Pitch	е		.100 BSC	
Top to Seating Plane	А	_	_	.210
Molded Package Thickness	A2	.115	.130	.195
Base to Seating Plane	A1	.015	_	_
Shoulder to Shoulder Width	E	.300	.310	.325
Molded Package Width	E1	.240	.250	.280
Overall Length	D	.980	1.030	1.060
Tip to Seating Plane	L	.115	.130	.150
Lead Thickness	С	.008	.010	.015
Upper Lead Width	b1	.045	.060	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	_	_	.430

Notes:

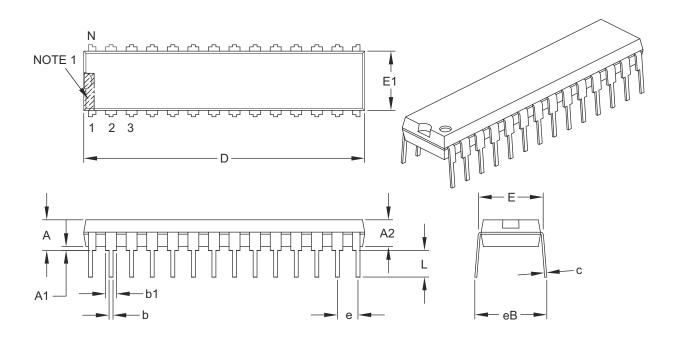
- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-019B

28-Lead Skinny Plastic Dual In-Line (SP) - 300 mil Body [SPDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		INCHES	
Dimensio	n Limits	MIN	NOM	MAX
Number of Pins	Ν		28	
Pitch	е		.100 BSC	
Top to Seating Plane	Α	_	_	.200
Molded Package Thickness	A2	.120	.135	.150
Base to Seating Plane	A1	.015	_	_
Shoulder to Shoulder Width	Е	.290	.310	.335
Molded Package Width	E1	.240	.285	.295
Overall Length	D	1.345	1.365	1.400
Tip to Seating Plane	L	.110	.130	.150
Lead Thickness	С	.008	.010	.015
Upper Lead Width	b1	.040	.050	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	ı	1	.430

Notes:

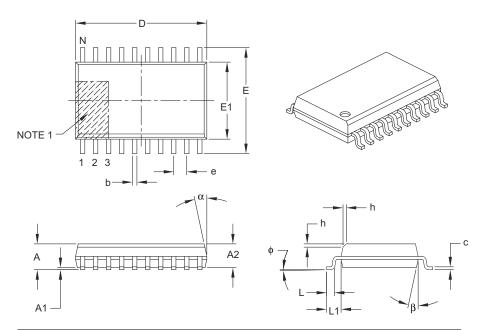
- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B

20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS			
	Dimension Limits	MIN	NOM	MAX	
Number of Pins	N		20		
Pitch	е		1.27 BSC		
Overall Height	A	_	_	2.65	
Molded Package Thickness	A2	2.05	_	_	
Standoff §	A1	0.10	_	0.30	
Overall Width	Е	10.30 BSC			
Molded Package Width	E1	7.50 BSC			
Overall Length	D	12.80 BSC			
Chamfer (optional)	h	0.25	_	0.75	
Foot Length	L	0.40	_	1.27	
Footprint	L1		1.40 REF		
Foot Angle	ф	0°	_	8°	
Lead Thickness	С	0.20	_	0.33	
Lead Width	b	0.31	_	0.51	
Mold Draft Angle Top	α	5°	_	15°	
Mold Draft Angle Bottom	β	5°	_	15°	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

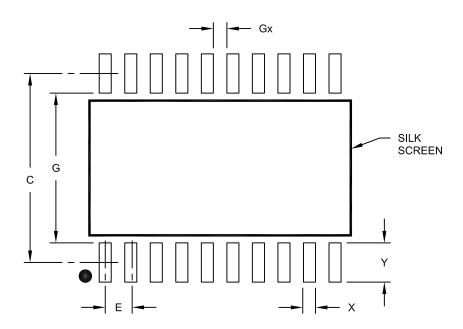
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-094B

20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	N	MILLIMETERS				
Dimension	MIN	NOM	MAX			
Contact Pitch	E		1.27 BSC			
Contact Pad Spacing	С		9.40			
Contact Pad Width (X20)	Х			0.60		
Contact Pad Length (X20)	Υ			1.95		
Distance Between Pads	Gx	0.67				
Distance Between Pads	G	7.45				

Notes:

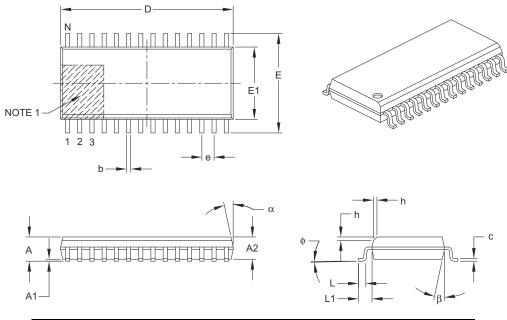
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2094A

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS		
	Dimension Limits	MIN	NOM	MAX	
Number of Pins	N		28		
Pitch	е		1.27 BSC		
Overall Height	A	_	_	2.65	
Molded Package Thickness	A2	2.05	_	_	
Standoff §	A1	0.10	_	0.30	
Overall Width	E	10.30 BSC			
Molded Package Width	E1	7.50 BSC			
Overall Length	D		17.90 BSC		
Chamfer (optional)	h	0.25	_	0.75	
Foot Length	L	0.40	_	1.27	
Footprint	L1		1.40 REF		
Foot Angle Top	ф	0°	_	8°	
Lead Thickness	С	0.18	_	0.33	
Lead Width	b	0.31	_	0.51	
Mold Draft Angle Top	α	5°	_	15°	
Mold Draft Angle Bottom	β	5°	_	15°	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

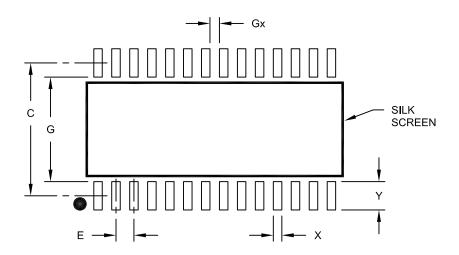
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-052B

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	N	IILLIMETER	S	
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Spacing	С		9.40	
Contact Pad Width (X28)	Х			0.60
Contact Pad Length (X28)	Υ			2.00
Distance Between Pads	Gx	0.67		
Distance Between Pads	G	7.40		

Notes:

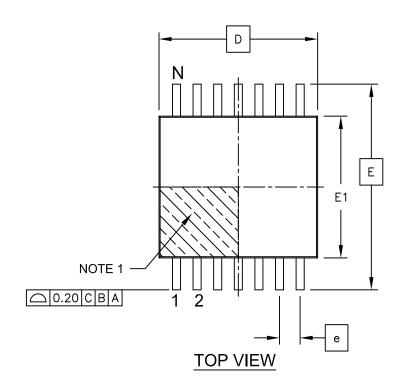
1. Dimensioning and tolerancing per ASME Y14.5M

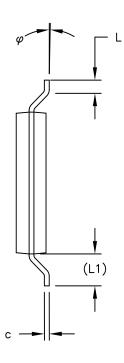
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

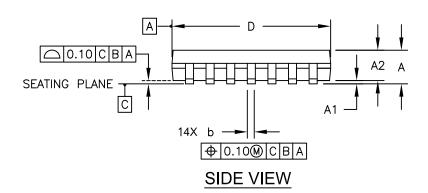
Microchip Technology Drawing No. C04-2052A

14-Lead Plastic Thin Shrink Small Outline (ST) - 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



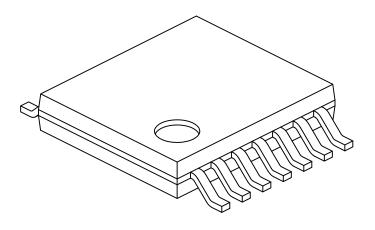




Microchip Technology Drawing C04-087C Sheet 1 of 2

14-Lead Plastic Thin Shrink Small Outline (ST) - 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		14	
Pitch	е		0.65 BSC	
Overall Height	Α	-	-	1.20
Molded Package Thickness	A2	0.80	1.00	1.05
Standoff	A1	0.05	-	0.15
Overall Width	E	6.40 BSC		
Molded Package Width	E1	4.30	4.40	4.50
Molded Package Length	D	4.90	5.00	5.10
Foot Length	L	0.45	0.60	0.75
Footprint	(L1)	1.00 REF		
Foot Angle	φ	0°	-	8°
Lead Thickness	С	0.09	-	0.20
Lead Width	b	0.19	-	0.30

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
- 3. Dimensioning and tolerancing per ASME Y14.5M

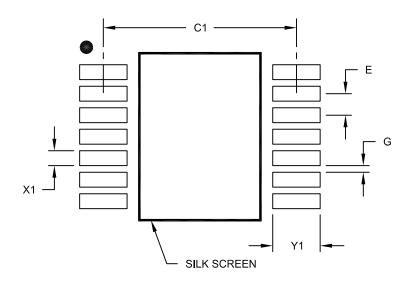
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-087C Sheet 2 of 2

14-Lead Plastic Thin Shrink Small Outline (ST) - 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units			MILLIMETERS			
Dimension Limits		MIN	NOM	MAX			
Contact Pitch	Е		0.65 BSC				
Contact Pad Spacing	C1		5.90				
Contact Pad Width (X14)	X1			0.45			
Contact Pad Length (X14)	Y1			1.45			
Distance Between Pads	G	0.20					

Notes:

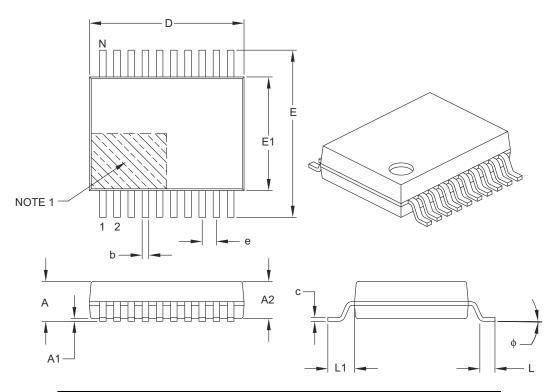
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2087A

20-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS			
Dimension	on Limits	MIN	NOM	MAX	
Number of Pins	N		20		
Pitch	е		0.65 BSC		
Overall Height	Α	ı	_	2.00	
Molded Package Thickness	A2	1.65	1.75	1.85	
Standoff	A1	0.05	_	_	
Overall Width	Е	7.40	7.80	8.20	
Molded Package Width	E1	5.00	5.30	5.60	
Overall Length	D	6.90	7.20	7.50	
Foot Length	L	0.55	0.75	0.95	
Footprint	L1		1.25 REF		
Lead Thickness	С	0.09	_	0.25	
Foot Angle	ф	0°	4°	8°	
Lead Width	b	0.22	_	0.38	

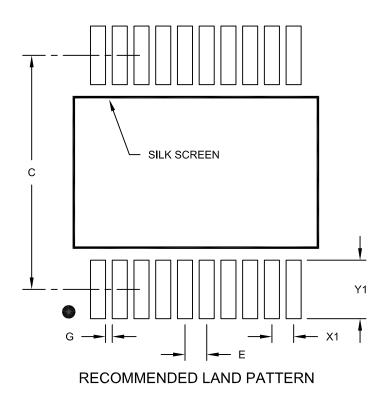
Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
- 3. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-072B

20-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units MILLIMETERS **Dimension Limits** MIN NOM MAX Contact Pitch Ε 0.65 BSC Contact Pad Spacing С 7.20 Contact Pad Width (X20) X1 0.45 Contact Pad Length (X20) Y1 1.75 Distance Between Pads G 0.20

Notes:

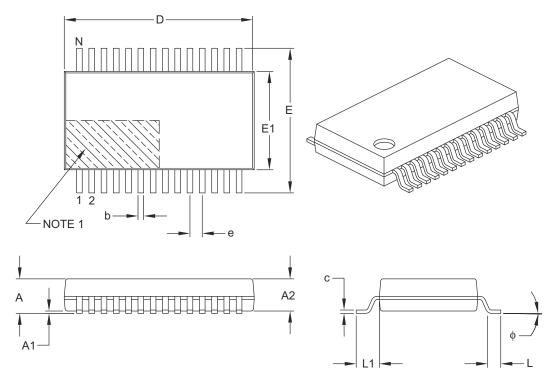
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2072A

28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS		
	Dimension Limits	MIN	NOM	MAX	
Number of Pins	N		28		
Pitch	е		0.65 BSC		
Overall Height	A	_	_	2.00	
Molded Package Thickness	A2	1.65	1.75	1.85	
Standoff	A1	0.05	_	-	
Overall Width	E	7.40	7.80	8.20	
Molded Package Width	E1	5.00	5.30	5.60	
Overall Length	D	9.90	10.20	10.50	
Foot Length	L	0.55	0.75	0.95	
Footprint	L1	1.25 REF			
Lead Thickness	С	0.09	_	0.25	
Foot Angle	ф	0°	4°	8°	
Lead Width	b	0.22	_	0.38	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
- 3. Dimensioning and tolerancing per ASME Y14.5M.

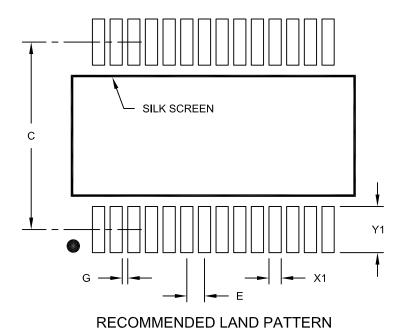
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073B

28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



MILLIMETERS Units **Dimension Limits** MIN NOM MAX Contact Pitch Ε 0.65 BSC Contact Pad Spacing С 7.20 Contact Pad Width (X28) X1 0.45 Contact Pad Length (X28) 1.75 Υ1 0.20 Distance Between Pads G

Notes:

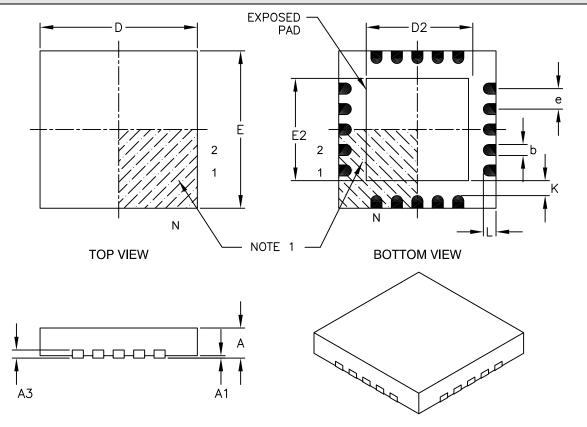
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2073A

20-Lead Plastic Quad Flat, No Lead Package (MQ) – 5x5x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX	
Number of Pins	N		20		
Pitch	е		0.65 BSC		
Overall Height	Α	0.80	0.90	1.00	
Standoff	A1	0.00	0.02	0.05	
Contact Thickness	A3		0.20 REF		
Overall Width	Е		5.00 BSC		
Exposed Pad Width	E2	3.15	3.25	3.35	
Overall Length	D		5.00 BSC		
Exposed Pad Length	D2	3.15	3.25	3.35	
Contact Width	b	0.25	0.30	0.35	
Contact Length	L	0.35	0.40	0.45	
Contact-to-Exposed Pad	K	0.20	-	-	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.

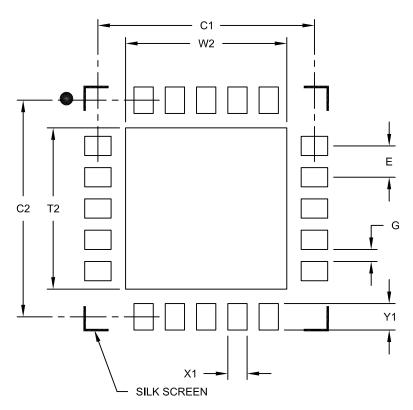
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-139B

20-Lead Plastic Quad Flat, No Lead Package (MQ) - 5x5 mm Body [QFN] With 0.40mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX	
Contact Pitch	Е	E 0.65 BSC			
Optional Center Pad Width	W2			3.35	
Optional Center Pad Length	T2			3.35	
Contact Pad Spacing	C1		4.50		
Contact Pad Spacing	C2		4.50		
Contact Pad Width (X20)	X1			0.40	
Contact Pad Length (X20)	Y1			0.55	
Distance Between Pads	G	0.20			

Notes:

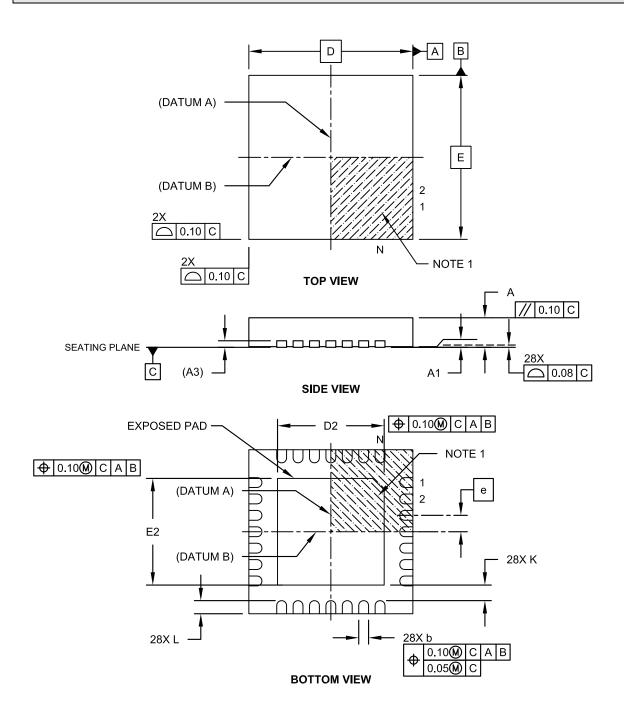
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2139A

28-Lead Plastic Quad Flat, No Lead Package (MQ) - 5x5x0.9 mm Body [QFN]

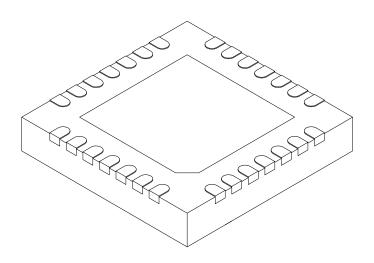
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-140B Sheet 1 of 2

28-Lead Plastic Quad Flat, No Lead Package (MQ) – 5x5x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS			
Dimension	Dimension Limits		NOM	MAX	
Number of Pins	N		28		
Pitch	е		0.50 BSC		
Overall Height	Α	0.80	0.90	1.00	
Standoff	A1	0.00	0.02	0.05	
Contact Thickness	A3	0.20 REF			
Overall Width	Е		5.00 BSC		
Exposed Pad Width	E2	3.15	3.25	3.35	
Overall Length	D		5.00 BSC		
Exposed Pad Length	D2	3.15	3.25	3.35	
Contact Width	b	0.18	0.25	0.30	
Contact Length	L	0.35	0.40	0.45	
Contact-to-Exposed Pad	K	0.20	-	-	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.

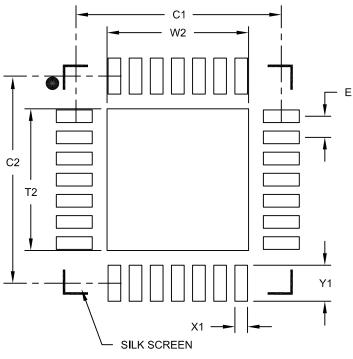
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-140B Sheet 2 of 2

28-Lead Plastic Quad Flat, No Lead Package (MQ) – 5x5 mm Body [QFN] Land Pattern With 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX	
Contact Pitch	E	0.50 BSC			
Optional Center Pad Width	W2			3.35	
Optional Center Pad Length	T2			3.35	
Contact Pad Spacing	C1		4.90		
Contact Pad Spacing	C2		4.90		
Contact Pad Width (X28)	X1			0.30	
Contact Pad Length (X28)	Y1			0.85	

Notes

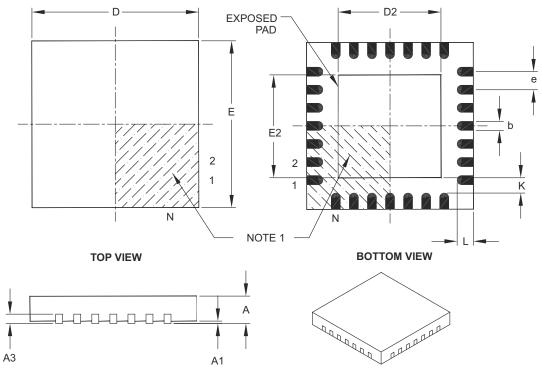
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-2140A

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS		
Dimension	n Limits	MIN	NOM	MAX	
Number of Pins	N		28		
Pitch	е		0.65 BSC		
Overall Height	Α	0.80	0.90	1.00	
Standoff	A1	0.00	0.02	0.05	
Contact Thickness	А3		0.20 REF		
Overall Width	Е		6.00 BSC		
Exposed Pad Width	E2	3.65	3.70	4.20	
Overall Length	D		6.00 BSC		
Exposed Pad Length	D2	3.65	3.70	4.20	
Contact Width	b	0.23	0.30	0.35	
Contact Length	L	0.50	0.55	0.70	
Contact-to-Exposed Pad	K	0.20	_	_	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.

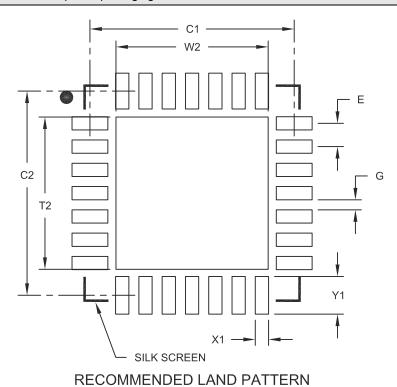
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-105B

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units			MILLIM	ETERS
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Optional Center Pad Width	W2			4.25
Optional Center Pad Length	T2			4.25
Contact Pad Spacing	C1		5.70	
Contact Pad Spacing	C2		5.70	
Contact Pad Width (X28)	X1			0.37
Contact Pad Length (X28)	Y1			1.00
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2105A

APPENDIX A: REVISION HISTORY

Revision A (September 2011)

Original data sheet for the PIC24F16KL402 family of devices.

Revision B (November 2011)

Updates DC Specifications in Tables 26-6 through 26-9 (all Typical and Maximum values).

Updates AC Specifications in Tables 26-7 through 26-30 (SPI Timing Requirements) with the addition of the FSCK specification.

Other minor typographic corrections throughout.

APPENDIX B: MIGRATING FROM PIC18/PIC24 TO PIC24F16KL402

The PIC24F16KL402 family combines traditional PIC18 peripherals with a faster PIC24 core to provide a low-cost, high-performance microcontroller with low-power consumption.

Code written for PIC18 devices can be migrated to the PIC24F16KL402 by using a C compiler that generates PIC24 machine level instructions. Assembly language code will need to be rewritten using PIC24 instructions. The PIC24 instruction set shares similarities to the PIC18 instruction set, which should ease porting of assembly code. Application code will require changes to support certain PIC24 peripherals.

Code written for PIC24 devices can be migrated to the PIC24F16KL402 without many code changes. Certain peripherals, however, will require application changes to support modules that were traditionally available only on PIC18 devices.

Refer to Table B-1 for a list of peripheral modules on the PIC24F16KL402 and where they originated from.

TABLE B-1: TABLE B-1: PIC24F16KL402
PERIPHERAL MODULE
ORIGINATING
ARCHITECTURE

Peripheral Module	PIC18	PIC24
ECCP/CCP	Х	_
MSSP (I ² C™/SPI)	Х	
Timer2/4 (8-bit)	X	_
Timer3 (16-bit)	X	
Timer1 (16-bit)	_	X
10-Bit A/D Converter	_	X
Comparator	_	X
Comparator Voltage Reference	_	X
UART	_	Х
HLVD	_	Х

NOTES:

INDEX

A
A/D
10-Bit High-Speed A/D Converter159
Conversion Timing Requirements
Module Specifications
Analog Input Model166
Transfer Function
AC Characteristics
Capacitive Loading Requirements on
Output Pins
Internal RC Accuracy212 Internal RC Oscillator Specifications212
Load Conditions and Requirements
Temperature and Voltage Specifications
Assembler
MPASM Assembler190
В
Block Diagrams
10-Bit High-Speed A/D Converter160
16-Bit Timer1
Accessing Program Memory with
Table Instructions47
CALL Stack Frame45
Capture Mode Operation128
Comparator Module169
Comparator Voltage Reference
Compare Mode Operation128
CPU Programmer's Model
Data Access From Program Space
Address Generation46 Data EEPROM Addressing with TBLPAG
and NVM Registers57
Enhanced PWM Mode
High/Low-Voltage Detect (HLVD)
Individual Comparator Configurations170
MSSP (I ² C Master Mode) 139
MSSP (I ² C Mode)139
MSSP (SPI Mode)138
PIC24F CPU Core28
PIC24F16KL402 Family (General)15
PSV Operation
PWM Operation (Simplified)
Reset System
Shared I/O Port Structure
Simplified UART
SPI Master/Slave Connection
System Clock
Table Register Addressing49
Timer2119
Timer3121
Timer4
Watchdog Timer (WDT)186
C
C Compilers
MPLAB C18190
Capture/Compare/PWM (CCP)127 CCP/ECCP
CCP I/O Pins127
Timer Selection

Data EEPROM Bulk Erase	59
Data EEPROM Unlock Sequence	55
Erasing a Program Memory Row,	
'C' Language Code	53
Erasing a Program Memory Row,	
Assembly Language Code	52
I/O Port Write/Read	
Initiating a Programming Sequence,	
'C' Language Code	54
Initiating a Programming Sequence,	34
	5 4
Assembly Language Code	
Loading the Write Buffers, 'C' Language Code	54
Loading the Write Buffers, Assembly	
Language Code	
PWRSAV Instruction Syntax	107
Reading the Data EEPROM Using the	
TBLRD Command	
Sequence for Clock Switching	104
Single-Word Erase	
Single-Word Write to Data EEPROM	59
Ultra Low-Power Wake-up Initialization	
Code Protection	
Comparator	
Comparator Voltage Reference	
Configuring	
Configuration Bits	
Core Features	
CPU	11
ALU	21
Control Registers	
Core Registers	
Programmer's Model	
Customer Change Notification Service	
Customer Notification Service	
Customer Notification Service Customer Support	
Customer Support	
Customer Support D	257
Customer Support D Data EEPROM Memory	257
Customer Support D Data EEPROM Memory Erasing	257 55 58
Customer Support D Data EEPROM Memory	257 55 58
Customer Support D Data EEPROM Memory Erasing Operations Programming	257 55 58 57
Customer Support D Data EEPROM Memory Erasing Operations Programming Bulk Erase	257 55 58 57
Customer Support D Data EEPROM Memory Erasing Operations Programming	257 55 58 57
Customer Support D Data EEPROM Memory	257 55 58 57 59 60
Customer Support D Data EEPROM Memory	257 55 58 57 59 60
Customer Support D Data EEPROM Memory Erasing Operations Programming Bulk Erase Reading Data EEPROM Single-Word Write Programming Control Registers	257 55 58 57 59 60
Customer Support D Data EEPROM Memory	257 55 58 57 59 60 59
Customer Support D Data EEPROM Memory	257 55 58 57 59 59 59 59
Customer Support	257 55 58 57 59 59 59 59
Customer Support	257 55 58 57 59 60 59 57 55
Data EEPROM Memory	257 55 58 57 59 60 57 55 55 35
Customer Support	257 55 58 57 59 60 57 55 55 35 35
Data EEPROM Memory	257 55 58 57 59 60 57 55 55 35 35 36
Data EEPROM Memory	257 55 58 57 59 59 57 55 55 35 35 36 36
Data EEPROM Memory Erasing Operations Programming Bulk Erase Reading Data EEPROM Single-Word Write Programming Control Registers NVMADR(U) NVMCON NVMKEY Data Memory Address Space Memory Map Near Data Space Organization SFR Space	257 55 58 57 59 60 55 55 55 35 35 36 36 36
Data EEPROM Memory	257 55 58 57 59 59 55 55 35 35 36 36 36 36 36

DC Characteristics	Interrupt Sources	
BOR Trip Points204	TMR3 Overflow	121
Comparator209	TMR4 to PR4 Match (PWM)	125
Comparator Voltage Reference209	Interrupts	
Data EEPROM Memory209	Alternate Interrupt Vector Table (AIVT)	67
High/Low-Voltage Detect204	Control and Status Registers	
I/O Pin Input Specifications207	Implemented Vectors	
I/O Pin Output Specifications	Interrupt Vector Table (IVT)	
Idle Current (IIDLE)205	Reset Sequence	
Operating Current (IDD)205	Setup Procedures	
Power-Down Current (IPD)	Trap Vectors	
Program Memory208	Vector Table	
Temperature and Voltage Specifications		
Development Support	M	
Device Features for PIC24F16KL20X/10X	Master Synchronous Serial Port (MSSP)	137
Family (Summary)14	Microchip Internet Web Site	257
Device Features for PIC24F16KL40X/30X	MPLAB ASM30 Assembler, Linker, Librarian	190
Family (Summary)13	MPLAB Integrated Development	
	Environment Software	189
E	MPLAB PM3 Device Programmer	192
Electrical Characteristics	MPLAB REAL ICE In-Circuit Emulator System	191
Absolute Maximum Ratings201	MPLINK Object Linker/MPLIB Object Librarian	
Thermal Operating Conditions202		
Thermal Packaging Characteristics202	N	
V/F Graphs202	Near Data Space	36
Enhanced CCP127	•	
Equations	0	
A/D Conversion Clock Period166	Oscillator Configuration	
UART Baud Rate with BRGH = 0152	Clock Switching	103
UART Baud Rate with BRGH = 1152	Sequence	103
Errata9	Configuration Bit Values for Clock Selection	98
Examples	CPU Clocking Scheme	98
Baud Rate Error Calculation (BRGH = 0)152	Initial Configuration on POR	98
	Reference Clock Output	104
F	Oscillator, Timer3	121
Flash Program Memory	Р	
Control Registers50	•	
Enhanced ICSP Operation50	Packaging	
Programming Algorithm52	Details	
Programming Operations50	Marking	
RTSP Operation50	Pinout Descriptions for PIC24F16KL20X/10X Family	
Table Instructions49	Pinout Descriptions for PIC24F16KL40X/30X Family	
•	Power-Saving	
G	Power-Saving Features	
Getting Started Guidelines for 16-Bit MCUs23	Clock Frequency, Clock Switching	
ш	Coincident Interrupts	
Н	Instruction-Based Modes	107
High/Low-Voltage Detect (HLVD)175	ldle	108
I	Sleep	
	Selective Peripheral Control	111
I/O Ports	Ultra Low-Power Wake-up (ULPWU)	109
Analog Port Configuration114	Product Identification System	259
Analog Selection Registers114	Program and Data Memory	
Input Change Notification116	Access Using Table Instructions	
Open-Drain Configuration114	Program Space Visibility	48
Parallel (PIO)113	Program and Data Memory Spaces	
In-Circuit Debugger187	Addressing	45
In-Circuit Serial Programming (ICSP)187	Interfacing	45
Instruction Set	Program Memory	
Opcode Symbols194	Address Space	33
Overview195	Device Configuration Words	34
Summary193	Hard Memory Vectors	
Inter-Integrated Circuit. See I ² C.	Memory Map	
Internet Address257	Organization	34

Program Verification187	IFS3 (Interrupt Flag Status 3)	77
PWM (CCP Module)	IFS4 (Interrupt Flag Status 4)	
TMR4 to PR4 Match125	IFS5 (Interrupt Flag Status 5)	
TWING TO FINA MICELE	INTCON 2 (Interrupt Control 2)	
R	INTCON1 (Interrupt Control 1)	
Reader Response	INTTREG (Interrupt Control and Status)	
Register Maps	IPC0 (Interrupt Priority Control 0)	
A/D Converter43	IPC1 (Interrupt Priority Control 1)	
Analog Select43	IPC12 (Interrupt Priority Control 12)	
CCP/ECCP	IPC16 (Interrupt Priority Control 16)	
Comparator	IPC18 (Interrupt Priority Control 18)	
CPU Core	IPC2 (Interrupt Priority Control 2)	
ICN	` ' '	
Interrupt Controller	IPC20 (Interrupt Priority Control 20)	
MSSP41	IPC3 (Interrupt Priority Control 3)	
	IPC4 (Interrupt Priority Control 4)	
NVM	IPC5 (Interrupt Priority Control 5)	
Pad Configuration	IPC6 (Interrupt Priority Control 6)	
PMD	IPC7 (Interrupt Priority Control 7)	
PORTA	IPC9 (Interrupt Priority Control 9)	
PORTB42	NVMCON (Flash Memory Control)	
System, Clock Control44	NVMCON (Nonvolatile Memory Control)	
Timer40	OSCCON (Oscillator Control)	
UART41	OSCTUN (FRC Oscillator Tune)	
Ultra Low-Power Wake-up44	PADCFG1 (Pad Configuration Control)	149
Registers	PSTR1CON (ECCP Pulse Steering)	134
AD1CHS (A/D Input Select)164	RCON (Reset Control)	62
AD1CON1 (A/D Control 1) 161	REFOCON (Reference Oscillator Control)	105
AD1CON2 (A/D Control 2)162	SR (ALU STATUS)	30, 71
AD1CON3 (A/D Control 3) 163	SSPxADD (MSSPx Slave Address/Baud	•
AD1CSSL (A/D Input Scan Select, Low)	Rate Generator)	148
ANCFG (Analog Input Configuration) 165	SSPxCON1 (MSSPx Control 1)	
ANSA (Analog Selection, PORTA)115	I ² C mode	144
ANSB (Analog Selection, PORTB)115	SPI mode	
CCP1CON	SSPxCON2 (MSSPx Control 2)	
Enhanced (ECCP1)131	,	143
,	SSPxCON3 (MSSPx Control 3)	4.47
CCPTMRS0 (CCP Timer Select)135	I ² C mode	
CCPxCON Standard CCP130	SPI mode	
	SSPxMSK (I ² C Slave Address Mask)	148
CLKDIV (Clock Divider)	SSPxSTAT (MSSPx Status)	
CMSTAT (Comparator Status)172	I ² C Mode	
CMxCON (Comparator x Control)171	SPI mode	
CORCON (CPU Control)31	T1CON (Timer1 Control)	
CORCON (CPU Core Control)72	T2CON (Timer2 Control)	
CVRCON (Comparator Voltage	T3GCON (Timer3 Gate Control)	
Reference Control)174	T4CON (Timer4 Control)	
DEVID (Device ID)184	ULPWCON (ULPWU Control)	110
DEVREV (Device Revision)185	UxMODE (UARTx Mode)	
ECCP1AS (ECCP1 Auto-Shutdown Control) 132	UxSTA (UARTx Status and Control)	
ECCP1DEL (ECCP1 Enhanced PWM Control) 133	Resets	
FBS (Boot Segment Configuration) 178	Brown-out Reset (BOR)	65
FGS (General Segment Configuration) 178	Clock Source Selection	
FICD (In-Circuit Debugger Configuration)183	Delay Times	
FOSC (Oscillator Configuration)	Device Times	
FOSCSEL (Oscillator Selection Configuration) 179	RCON Flag Operation	
FPOR (Reset Configuration)182	SFR States	
FWDT (Watchdog Timer Configuration)		
, , , , , , , , , , , , , , , , , , , ,	Revision History	251
HLVDCON (High/Low-Voltage Detect Control)	S	
IEC0 (Interrupt Enable Control 0)		
IEC1 (Interrupt Enable Control 1)	Serial Peripheral Interface. See SPI Mode.	00
IEC2 (Interrupt Enable Control 2)	SFR Space	
IEC3 (Interrupt Enable Control 3)	Software Simulator (MPLAB SIM)	
IEC4 (Interrupt Enable Control 4)82	Software Stack	45
IEC5 (Interrupt Enable Control 5)82		
IFS0 (Interrupt Flag Status 0)75		
IFS1 (Interrupt Flag Status 1)76		
IFS2 (Interrupt Flag Status 2)		

1	
Timer1	117
Timer2	119
Timer3	121
Oscillator	121
Overflow Interrupt	121
Timer4	125
PR4 Register	125
TMR4 Register	125
TMR4 to PR4 Match Interrupt	125
Timing Diagrams	
Capture/Compare/PWM (ECCP1, ECCP2)	
CLKO and I/O Timing	213
Example SPI Master Mode (CKE = 0)	216
Example SPI Master Mode (CKE = 1)	217
Example SPI Slave Mode (CKE = 0)	218
Example SPI Slave Mode (CKE = 1)	
External Clock	
I ² C Bus Data	
I ² C Bus Start/Stop Bits	
MSSP I ² C Bus Data	
MSSP I ² C Bus Start/Stop Bits	222
Timing Requirements	
Capture/Compare/PWM (ECCP1, ECCP2)	
CLKO and I/O	
Comparator	
Comparator Voltage Reference Settling Time	
External Clock	
I ² C Bus Data (Slave Mode)	
I ² C Bus Data Requirements (Master Mode)	
I ² C Bus Start/Stop Bits (Master Mode)	
I ² C Bus Start/Stop Bits (Slave Mode)	
PLL Clock Specifications	
SPI Mode (Master Mode, CKE = 0)	
SPI Mode (Master Mode, CKE = 1)	
SPI Slave Mode (CKE = 1)	219
Timing Requirements SPI Mode	
(Slave Mode, CKE = 0)	218

U	
UART	151
Baud Rate Generator (BRG)	152
Break and Sync Transmit Sequence	153
IrDA Support	153
Operation of UxCTS and UxRTS Control Pins	153
Receiving in 8-Bit or 9-Bit Data Mode	153
Transmitting in 8-Bit Data Mode	153
Transmitting in 9-Bit Data Mode	153
W	
Watchdog Timer (WDT)	186
Windowed Operation	
WWW Address	257
WWW, On-Line Support	9

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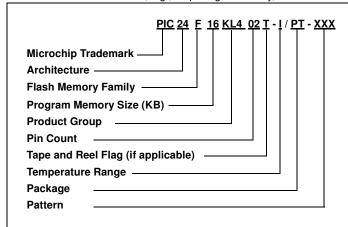
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Architecture 24 = 16-bit modified Harvard without DSP

Flash Memory Family F = Standard voltage range Flash program memory

Product Group KL4 = General purpose microcontrollers

KL3 KL2 KI 1

Pin Count 00 = 14-pin 01 = 20-pin 02 = 28-pin

Temperature Range

Pattern Three-digit QTP, SQTP, Code or Special Requirements

= -40°C to +85°C (Industrial)

(blank otherwise)

ES = Engineering Sample

Examples:

- PIC24F16KL402-I/ML: General Purpose, 16-Kbyte program memory, 28-pin, Industrial temp, QFN package
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